Pin Diagram – 24-Pin QFN (MCP19118)

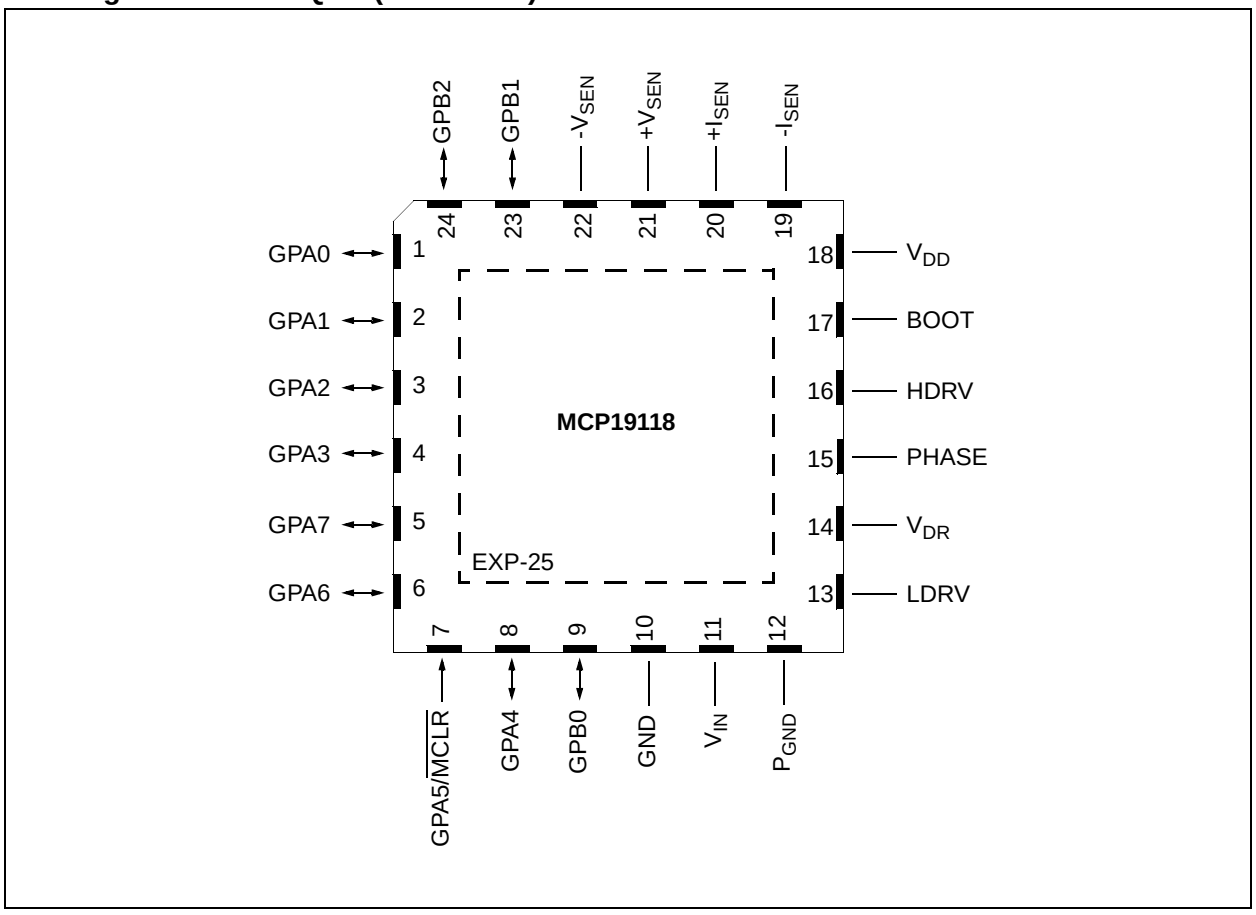


TABLE 1: 24-PIN SUMMARY

I/O	24-Pin QFN	ANSEL	A/D	Timers	MSSP	Interrupt	Pull-Up	Basic	Additional
GPA0	1	Y	AN0	—	—	IOC	Y	—	Analog Debug Output (1)
GPA1	2	Y	AN1	—	—	IOC	Y	—	Sync. Signal In/Out (2, 3)
GPA2	3	Y	AN2	T0CKI	—	IOC INT	Y	—	—
GPA3	5	Y	AN3		—	IOC	Y	—	—
GPA4	8	N	—	—	—	IOC	N	—	—
GPA5	7	N	—	—	—	IOC(4)	Y(5)	$\overline{\text{MCLR}}$	—
GPA6	6	N	—	—	—	IOC	N	ICSPDAT	—
GPA7	5	N	—	—	SCL	IOC	N	ICSPCLK	—
GPB0	9	N	—	—	SDA	IOC	N	—	—
GPB1	23	Y	AN4	—	—	IOC	Y	—	Error Signal In/Out (3)
GPB2	24	Y	AN5	—	—	IOC	Y	—	—
V_{IN}	11	N	—	—	—	—	—	V_{IN}	Device Input Voltage
V_{DR}	14	N	—	—	—	—	—	V_{DR}	Gate Drive Supply Input Voltage
V_{DD}	18	N	—	—	—	—	—	V_{DD}	Internal Regulator Output
GND	10	N	—	—	—	—	—	GND	Small Signal Ground
P_{GND}	12	N	—	—	—	—	—	—	Large Signal Ground
LDRV	13	N	—	—	—	—	—	—	Low-Side MOSFET Connection
HDRV	16	N	—	—	—	—	—	—	High-Side MOSFET Connection
PHASE	15	N	—	—	—	—	—	—	Switch Node
BOOT	17	N	—	—	—	—	—	—	Floating Bootstrap Supply
$+V_{SEN}$	21	N	—	—	—	—	—	—	Output Voltage Differential Sense
$-V_{SEN}$	22	N	—	—	—	—	—	—	Output Voltage Differential Sense
$+I_{SEN}$	20	N	—	—	—	—	—	—	Current Sense Input
$-I_{SEN}$	19	N	—	—	—	—	—	—	Current Sense Input

Note 1: The Analog Debug Output is selected when the ATSTCON<BNCHEN> bit is set.

2: Selected when the device is functioning as multiple output master or slave by proper configuration of the MLTPH<2:0> bits in the BUFFCON register.

3: Selected when the device is functioning as multi-phase master or slave by proper configuration of the MLTPH<2:0> bits in the BUFFCON register.

4: The IOC is disabled when $\overline{\text{MCLR}}$ is enabled.

5: Weak pull-up always enabled when $\overline{\text{MCLR}}$ is enabled, otherwise the pull-up is under user control.

Pin Diagram – 28-Pin QFN (MCP19119)

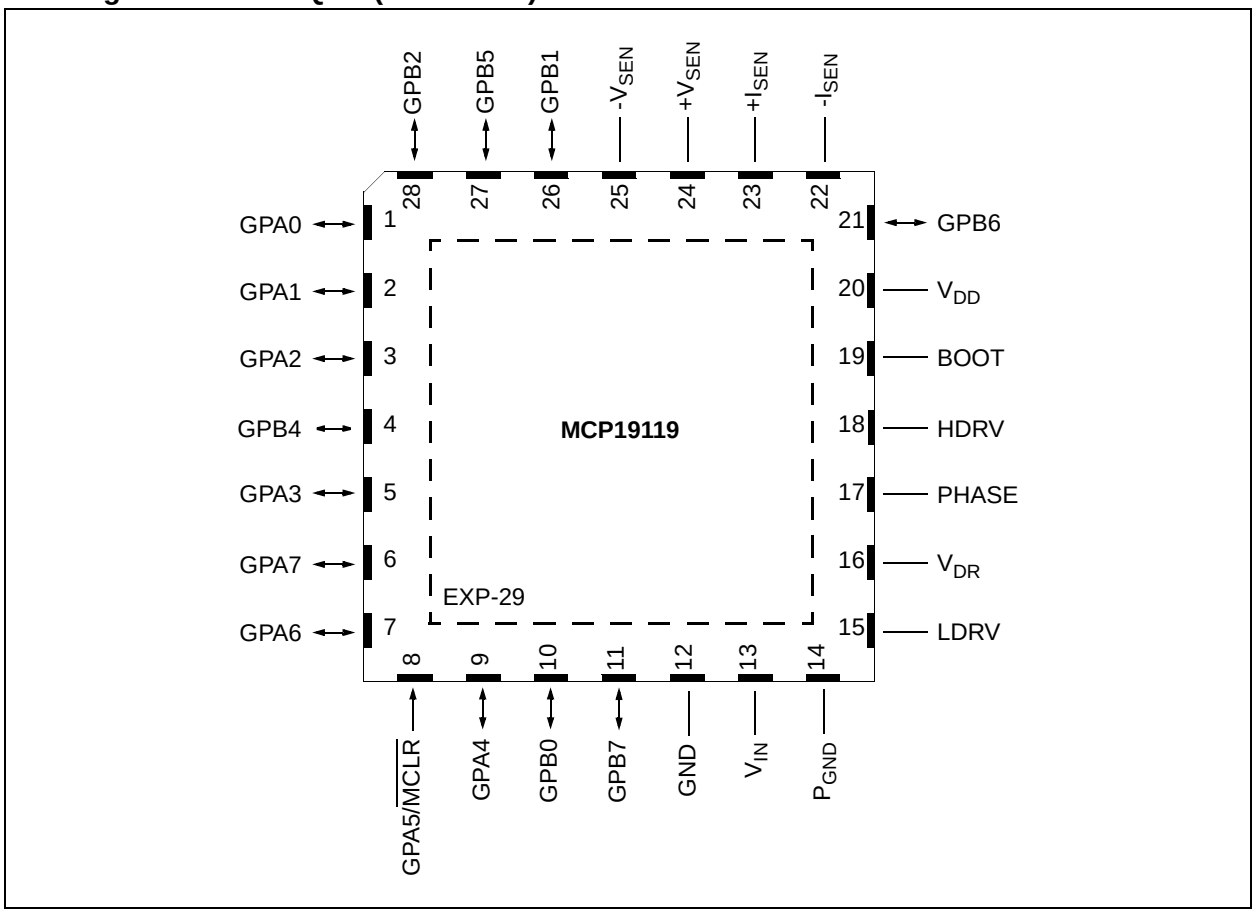


TABLE 2: 28-PIN SUMMARY

I/O	28-Pin QFN	ANSEL	A/D	Timers	MSSP	Interrupt	Pull-Up	Basic	Additional
GPA0	1	Y	AN0	—	—	IOC	Y	—	Analog Debug Output (1)
GPA1	2	Y	AN1	—	—	IOC	Y	—	Sync. Signal In/Out (2, 3)
GPA2	3	Y	AN2	T0CKI	—	IOC INT	Y	—	—
GPA3	5	Y	AN3		—	IOC	Y	—	—
GPA4	9	N	—	—	—	IOC	N	—	—
GPA5	8	N	—	—	—	IOC(4)	Y(5)	$\overline{\text{MCLR}}$	—
GPA6	7	N	—	—	—	IOC	N	—	—
GPA7	6	N	—	—	SCL	IOC	N	—	—
GPB0	10	N	—	—	SDA	IOC	N	—	—
GPB1	26	Y	AN4	—	—	IOC	Y	—	Error Signal In/Out (3)
GPB2	28	Y	AN5	—	—	IOC	Y	—	—
GPB4	4	Y	AN6	—	—	IOC	Y	ICSPDAT ICDDAT	—
GPB5	27	Y	AN7	—	—	IOC	Y	ICSPCLK ICDCLK	Alternate Sync Signal In/Out (2, 3)
GPB6	21	N	—	—	—	IOC	Y	—	—
GPB7	11	N	—	—	—	IOC	Y	—	—
V_{IN}	13	N	—	—	—	—	—	V_{IN}	Device Input Voltage
V_{DR}	16	N	—	—	—	—	—	V_{DR}	Gate Drive Supply Input Voltage
V_{DD}	20	N	—	—	—	—	—	V_{DD}	Internal Regulator Output
GND	12	N	—	—	—	—	—	GND	Small Signal Ground
P_{GND}	14	N	—	—	—	—	—	—	Large Signal Ground
LDRV	15	N	—	—	—	—	—	—	Low-Side MOSFET Connection
HDRV	18	N	—	—	—	—	—	—	High-Side MOSFET Connection
PHASE	17	N	—	—	—	—	—	—	Switch Node
BOOT	19	N	—	—	—	—	—	—	Floating Bootstrap Supply
$+V_{SEN}$	24	N	—	—	—	—	—	—	Output Voltage Differential Sense
$-V_{SEN}$	25	N	—	—	—	—	—	—	Output Voltage Differential Sense
$+I_{SEN}$	23	N	—	—	—	—	—	—	Current Sense Input
$-I_{SEN}$	22	N	—	—	—	—	—	—	Current Sense Input

Note 1: The Analog Debug Output is selected when the ATSTCON<BNCHEN> bit is set.

2: Selected when the device is functioning as multiple output master or slave by proper configuration of the MLTPH<2:0> bits in the BUFFCON register.

3: Selected when the device is functioning as multi-phase master or slave by proper configuration of the MLTPH<2:0> bits in the BUFFCON register.

4: The IOC is disabled when $\overline{\text{MCLR}}$ is enabled.

5: Weak pull-up always enabled when $\overline{\text{MCLR}}$ is enabled, otherwise the pull-up is under user control.

Table of Contents

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at **docerrors@microchip.com**. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000000A is version A of document DS30000000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; **http://www.microchip.com**
- Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at **www.microchip.com** to receive the most current information on all of our products.

NOTES:

1.0 DEVICE OVERVIEW

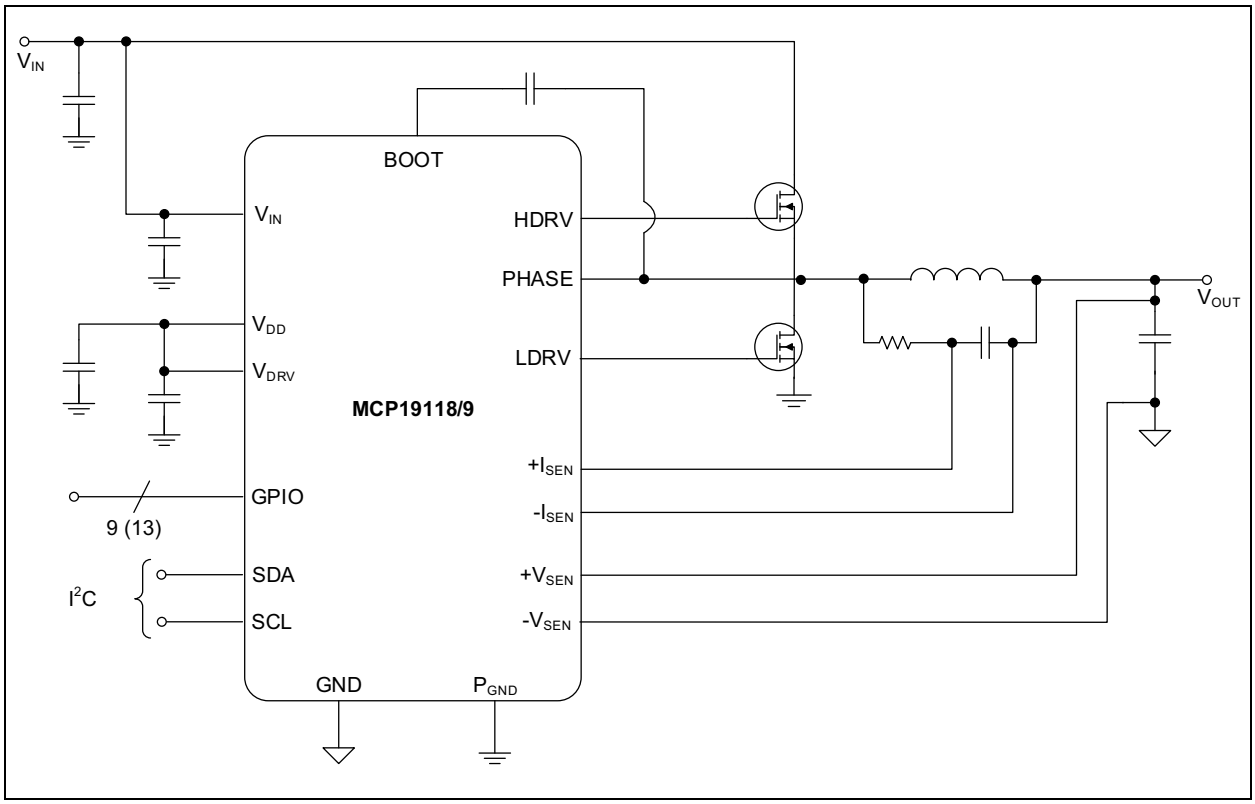
The MCP19118/19 is a highly integrated, mixed signal, analog pulse-width modulation (PWM) current mode controller with an integrated microcontroller core for synchronous DC/DC step-down applications. Since the MCP19118/19 uses traditional analog control circuitry to regulate the output of the DC/DC converter, the integration of the PIC® microcontroller mid-range core is used to provide complete customization of device operating parameters, start-up and shutdown profiles, protection levels and fault handling procedures.

The MCP19118/19 is designed to efficiently operate from a single 4.5V to 40V supply. It features integrated synchronous drivers, bootstrap device, internal linear regulator and 4 kW nonvolatile memory, all in a space-saving 24-pin 4 mm x 4 mm QFN package (MCP19118) or 28-pin 5 mm x 5 mm QFN package (MCP19119).

After initial device configuration using Microchip's MPLAB® X Integrated Development Environment (IDE) software, the PMBus or I^2C can be used by a host to communicate with, or modify, the operation of the MCP19118/19.

Two internal linear regulators generate two 5V rails. One 5V rail is used to provide power for the internal analog circuitry and is contained on-chip. The second 5V rail provides power to the PIC device and is present on the V_{DD} pin. It is recommended that a 1 µF capacitor be placed between V_{DD} and P_{GND}. The V_{DD} pin may also be directly connected to the V_{DR} pin or connected through a low-pass RC filter. The V_{DR} pin provides power to the internal synchronous driver.

FIGURE 1-1: TYPICAL APPLICATION CIRCUIT



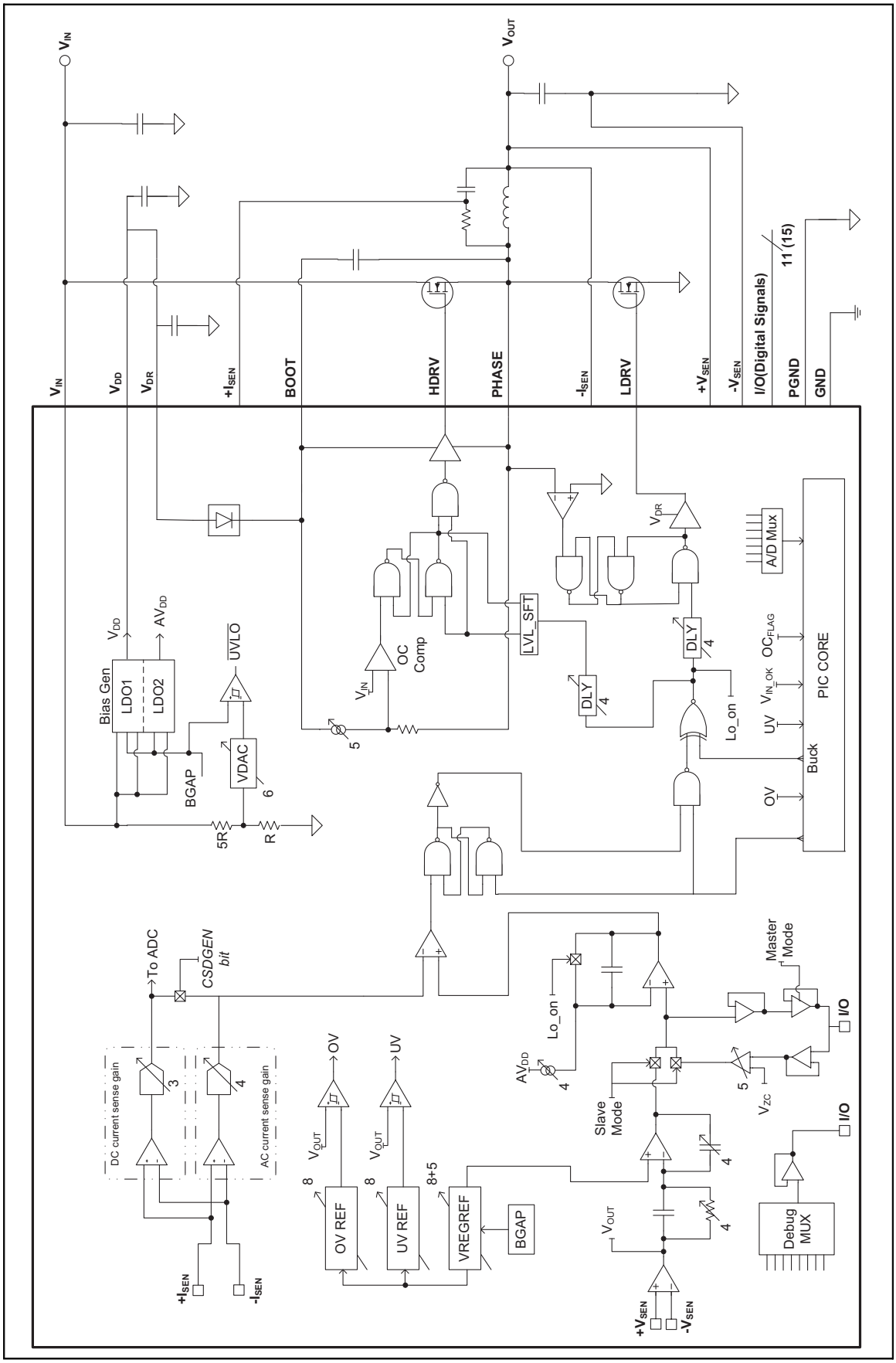
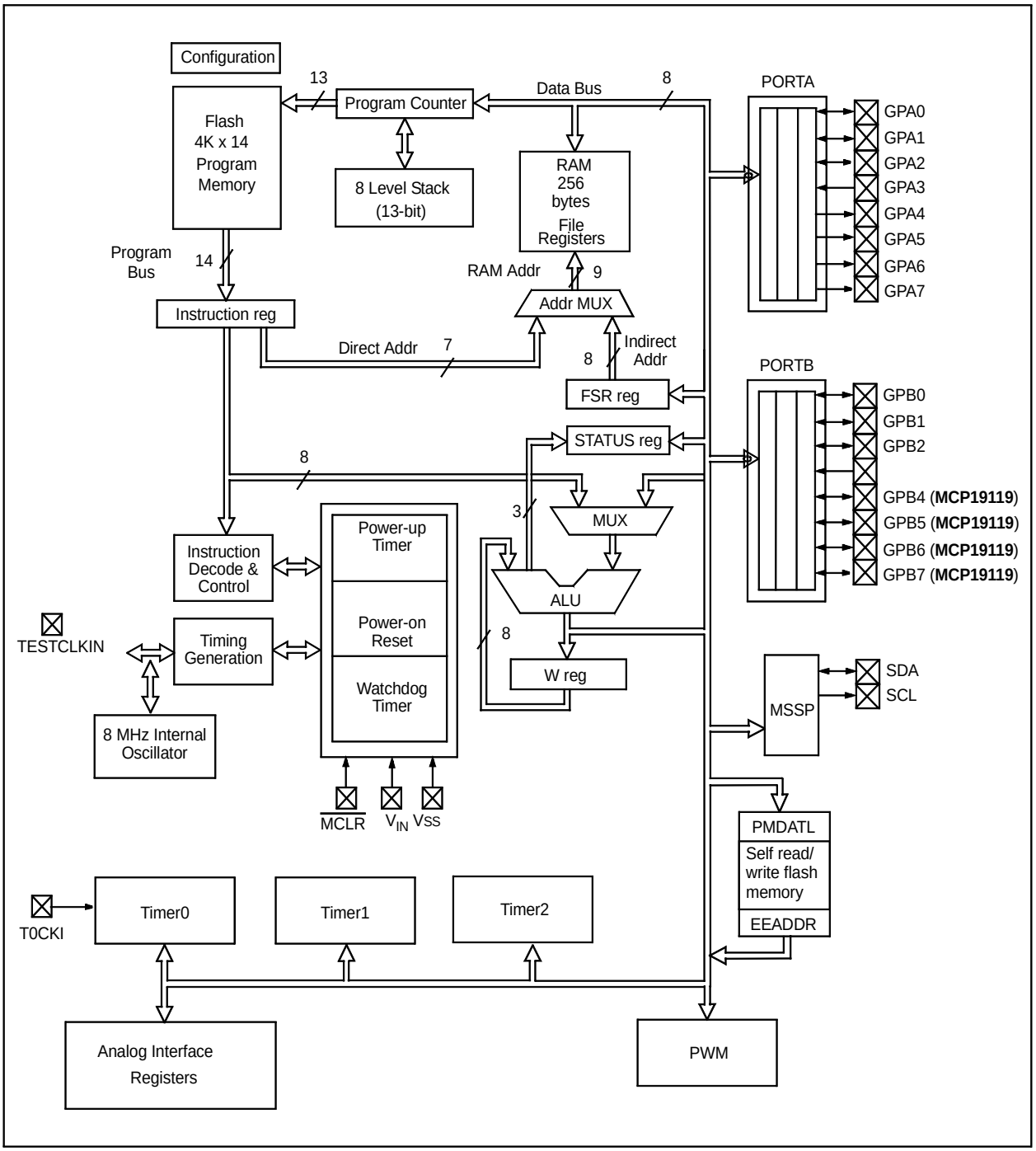


FIGURE 1-2: MCP19118/19 SYNCHRONOUS BUCK BLOCK DIAGRAM

FIGURE 1-3: MICROCONTROLLER CORE BLOCK DIAGRAM



2.0 PIN DESCRIPTION

The MCP19118/19 family of devices features pins that have multiple functions associated with each pin. Table 2-1 provides a description of the different functions. See **Section 2.1 "Detailed Pin Functional Description"** for more detailed information.

TABLE 2-1: MCP19118/19 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
GPA0/AN0/ANALOG_TEST	GPA0	TTL	CMOS	General purpose I/O
	AN0	AN	—	A/D Channel 0 input
	ANALOG_TEST	—	—	Internal analog signal multiplexer output (1)
GPA1/AN1/CLKPIN	GPA1	TTL	CMOS	General purpose I/O
	AN1	AN	—	A/D Channel 1 input
	CLKPIN	—	—	Switching frequency clock input or output (2 ,3)
GPA2/AN2/T0CKI/INT	GPA2	TTL	CMOS	General purpose I/O
	AN2	AN	—	A/D Channel 2 input
	T0CKI	ST	—	Timer0 clock input
	INT	ST	—	External interrupt
GPA3/AN3	GPA3	TTL	CMOS	General purpose I/O
	AN3	AN	—	A/D Channel 3 input
GPA4	GPA4	TTL	OD	General purpose I/O
GPA5/$\overline{\text{MCLR}}$	GPA5	TTL	—	General purpose input only
	$\overline{\text{MCLR}}$	ST	—	Master Clear with internal pull-up
GPA6/ICSPDAT	GPA6	ST	CMOS	General purpose I/O
	ICSPDAT		CMOS	Serial Programming Data I/O (**MCP19118 Only**)
GPA7/SCL/ICSPCLK	GPA7	ST	OD	General purpose open-drain I/O
	SCL	I^2C™	OD	I^2C clock
	ICSPCLK	ST	—	Serial Programming Clock (**MCP19118 Only**)
GPB0/SDA	GPB0	TTL	OD	General purpose I/O
	SDA	I^2C	OD	I^2C data input/output
GPB1/AN4/EAPIN	GPB1	TTL	CMOS	General purpose I/O
	AN4	AN	—	A/D Channel 4 input
	EAPIN	—	—	Error amplifier signal input/output (3)
GPB2/AN5	GPB2	TTL	CMOS	General purpose I/O
	AN5	AN	—	A/D Channel 5 input
GPB4/AN6/ICSPDAT (**MCP19119 Only**)	GPB4	TTL	CMOS	General purpose I/O
	AN6	AN	—	A/D Channel 6 input
	ICSPDAT	ST	CMOS	Serial Programming Data I/O

Legend: AN = Analog input or output CMOS =CMOS compatible input or output OD = Open Drain
TTL = TTL compatible input ST =Schmitt Trigger input with CMOS levels I^2C = Schmitt Trigger input with I^2C

Note 1: Analog Test is selected when the ATSTCON<BNCHEN> bit is set.

2: Selected when the device is functioning as multiple output master or slave by proper configuration of the MLTPH<2:0> bits in the BUFFCON register.

3: Selected when the device is functioning as multi-phase master or slave by proper configuration of the MLTPH<2:0> bits in the BUFFCON register.

TABLE 2-1: MCP19118/19 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
GPB5/AN7/ICSPCLK/ ALT_CLKPIN (**MCP19119 Only**)	GPB5	TTL	CMOS	General purpose I/O
	AN7	AN	—	A/D Channel 7 input
	ISCPCLK	ST	—	Serial Programming Clock
	ALT_CLKPIN	—	—	Alternate switching frequency clock input or output (2,3)
GPB6 (**MCP19119 Only**)	GPB6	TTL	CMOS	General purpose I/O
GPB7 (**MCP19119 Only**)	GPB7	TTL	CMOS	General purpose I/O
V_{IN}	V_{IN}	—	—	Device input supply voltage
V_{DD}	V_{DD}	—	—	Internal +5V LDO output pin
V_{DR}	V_{DR}	—	—	Gate drive supply input voltage pin
GND	GND	—	—	Small signal quiet ground
P_{GND}	P_{GND}	—	—	Large signal power ground
LDRV	LDRV	—	—	High-current drive signal connected to the gate of the low-side MOSFET
HDRV	HDRV	—	—	Floating high-current drive signal connected to the gate of the high-side MOSFET
PHASE	PHASE	—	—	Synchronous buck switch node connection
BOOT	BOOT	—	—	Floating bootstrap supply
$+V_{SEN}$	$+V_{SEN}$	—	—	Positive input of the output voltage sense differential amplifier
$-V_{SEN}$	$-V_{SEN}$	—	—	Negative input of the output voltage sense differential amplifier
$+I_{SEN}$	$+I_{SEN}$	—	—	Current sense input
$-I_{SEN}$	$-I_{SEN}$	—	—	Current sense input
EP	—	—	—	Exposed Thermal Pad

Legend: AN = Analog input or output CMOS =CMOS compatible input or output OD = Open Drain
TTL = TTL compatible input ST =Schmitt Trigger input with CMOS levels I^2C = Schmitt Trigger input with I^2C

Note 1: Analog Test is selected when the ATSTCON<BNCHEN> bit is set.

2: Selected when the device is functioning as multiple output master or slave by proper configuration of the MLTPH<2:0> bits in the BUFFCON register.

3: Selected when the device is functioning as multi-phase master or slave by proper configuration of the MLTPH<2:0> bits in the BUFFCON register.

2.1 Detailed Pin Functional Description

2.1.1 GPA0 PIN

GPA0 is a general purpose TTL input or CMOS output pin whose data direction is controlled in TRISGPA. An internal weak pull-up and interrupt-on-change are also available.

AN0 is an input to the A/D. To configure this pin to be read by the A/D on channel 0, bits TRISA0 and ANSA0 must be set.

When the ATSTCON<BNCHEN> bit is set, this pin is configured as the ANALOG_TEST function. It is a buffered output of the internal analog signal multiplexer. Signals present on this pin are controlled by the BUFFCON register.

2.1.2 GPA1 PIN

GPA1 is a general purpose TTL input or CMOS output pin whose data direction is controlled in TRISGPA. An internal weak pull-up and interrupt-on-change are also available.

AN1 is an input to the A/D. To configure this pin to be read by the A/D on channel 1, bits TRISA1 and ANSA1 must be set.

When the MCP19118/19 is configured as a multiple output or multi-phase master or slave, this pin is configured to be the switching frequency synchronization input or output, CLKPIN. See **Section 3.10.6 "Multi-Phase System"** and **Section 3.10.7 "Multiple Output System"** for more information.

2.1.3 GPA2 PIN

GPA2 is a general purpose TTL input or CMOS output pin whose data direction is controlled in TRISGPA. An internal weak pull-up and interrupt-on-change are also available.

AN2 is an input to the A/D. To configure this pin to be read by the A/D on channel 2, bits TRISA2 and ANSA2 must be set.

When bit T0CS is set, the T0CKI function is enabled. See **Section 23.0 "Timer0 Module"** for more information.

GPA2 can also be configured as an external interrupt by setting the INTE bit. See **Section 15.2 "GPA2/INT Interrupt"** for more information.

2.1.4 GPA3 PIN

GPA3 is a general purpose TTL input or CMOS output pin whose data direction is controlled in TRISGPA. An internal weak pull-up and interrupt-on-change are also available.

AN3 is an input to the A/D. To configure this pin to be read by the A/D on channel 3, bits TRISA3 and ANSA3 must be set.

2.1.5 GPA4 PIN

GPA4 is a true open-drain general purpose pin whose data direction is controlled in TRISGPA. There is no internal connection between this pin and the device V_{DD}, making this pin ideal to be used as an SMBus Alert pin. This pin does not have a weak pull-up, but interrupt-on-change is available.

2.1.6 GPA5 PIN

GPA5 is a general purpose TTL input-only pin. An internal weak pull-up and interrupt-on-change are also available.

For programming purposes, this pin is to be connected to the $\overline{MCLR}$ pin of the serial programmer. See **Section 28.0 "In-Circuit Serial Programming™ (ICSP™)"** for more information.

2.1.7 GPA6 PIN

GPA6 is a general purpose CMOS input/output pin whose data direction is controlled in TRISGPA. An interrupt-on-change is also available.

On the MCP19118, the ISCPDAT is the serial programming data input function. This is used in conjunction with ICSPCLK to serial program the device. This pin function is only implemented on the MCP19118.

2.1.8 GPA7 PIN

GPA7 is a true open-drain general purpose pin whose data direction is controlled in TRISGPA. There is no internal connection between this pin and the device V_{DD}. This pin does not have a weak pull-up, but interrupt-on-change is available.

When the MCP19118/19 is configured for I^2C communication (see **Section 27.2 "I^2C Mode Overview"**), GPA7 functions as the I^2C clock, SCL.

On the MCP19118, the ISCPCLK is the serial programming clock function. This is used in conjunction with ICSPDAT to serial program the device. This pin function is only implemented on the MCP19118.

2.1.9 GPB0 PIN

GPB0 is a true open-drain general purpose pin whose data direction is controlled in TRISGPB. There is no internal connection between this pin and the device V_{DD}. This pin does not have a weak pull-up, but interrupt-on-change is available.

When the MCP19118/19 is configured for I^2C communication (see **Section 27.2 "I^2C Mode Overview"**), GPB0 functions as the I^2C clock, SDA.

2.1.10 GPB1 PIN

GPB1 is a general purpose TTL input or CMOS output pin whose data direction is controlled in TRISGPB. An internal weak pull-up and interrupt-on-change are also available.

AN4 is an input to the A/D. To configure this pin to be read by the A/D on channel 4, bits TRISB1 and ANSB1 must be set.

When the MCP19118/19 is configured as a multiple output or multi-phase master or slave, this pin is configured to be the error amplifier signal input or output. See **Section 3.10.6 "Multi-Phase System"** and **Section 3.10.7 "Multiple Output System"** for more information.

2.1.11 GPB2 PIN

GPB2 is a general purpose TTL input or CMOS output pin whose data direction is controlled in TRISGPB. An internal weak pull-up and interrupt-on-change are also available.

AN5 is an input to the A/D. To configure this pin to be read by the A/D on channel 5, bits TRISB2 and ANSB2 must be set.

2.1.12 GPB4 PIN

This pin and its associated functions are only available on the MCP19119 device.

GPB4 is a general purpose TTL input or CMOS output pin whose data direction is controlled in TRISGPB. An internal weak pull-up and interrupt-on-change are also available.

AN6 is an input to the A/D. To configure this pin to be read by the A/D on channel 6, bits TRISB4 and ANSB4 must be set.

On the MCP19119, the ISCPDAT is the serial programming data input function. This is used in conjunction with ICSPCLK to serial program the device. This pin function is only implemented on the MCP19119.

2.1.13 GBP5 PIN

This pin and its associated functions are only available on the MCP19119 device.

GPB5 is a general purpose TTL input or CMOS output pin whose data direction is controlled in TRISGPB. An internal weak pull-up and interrupt-on-change are also available.

AN7 is an input to the A/D. To configure this pin to be read by the A/D on channel 7, bits TRISB5 and ANSB5 must be set.

On the MCP19119, the ISCPCLK is the serial programming clock function. This is used in conjunction with ICSPDAT to serial program the device. This pin function is only implemented on the MCP19119.

This pin can also be configured as an alternate switching frequency synchronization input or output, ALT_CLKPIN, for use in multiple output or multi-phase systems. See **Section 19.1 "Alternate Pin Function"** for more information.

2.1.14 GPB6 PIN

This pin and its associated functions are only available on the MCP19119 device.

GPB6 is a general purpose TTL input or CMOS output pin whose data direction is controlled in TRISGPB. An internal weak pull-up and interrupt-on-change are also available.

2.1.15 GPB7 PIN

This pin and its associated functions are only available on the MCP19119 device.

GPB7 is a general purpose TTL input or CMOS output pin whose data direction is controlled in TRISGPB. An internal weak pull-up and interrupt-on-change are also available.

2.1.16 V_{IN} PIN

Device input power connection pin. It is recommended that capacitance be placed between this pin and the GND pin of the device.

2.1.17 V_{DD} PIN

The output of the internal +5.0V regulator is connected to this pin. It is recommended that a 1.0 µF bypass capacitor be connected between this pin and the GND pin of the device. The bypass capacitor should be placed physically close to the device.

2.1.18 V_{DR} PIN

The 5V supply for the low-side driver is connected to this pin. The pin can be connected by an RC filter to the V_{DD} pin.

2.1.19 GND PIN

GND is the small signal ground connection pin. This pin should be connected to the exposed pad on the bottom of the package.

2.1.20 P_{GND} PIN

Connect all large signal level ground returns to P_{GND}. These large-signal level ground traces should have a small loop area and minimal length to prevent coupling of switching noise to sensitive traces.

2.1.21 LDRV PIN

The gate of the low-side or rectifying MOSFET is connected to LDRV. The PCB trace connecting LDRV to the gate must be of minimal length and appropriate width to handle the high peak drive currents and fast voltage transitions.

2.1.22 HDRV PIN

The gate of the high-side MOSFET is connected to HDRV. This is a floating driver referenced to PHASE. The PCB trace connecting HDRV to the gate must be of minimal length and appropriate width to handle the high-peak drive current and fast voltage transitions.

2.1.23 PHASE PIN

The PHASE pin provides the return path for the high-side gate driver. The source of the high-side MOSFET, the drain of the low-side MOSFET and the inductor are connected to this pin.

2.1.24 BOOT PIN

The BOOT pin is the floating bootstrap supply pin for the high-side gate driver. A capacitor is connected between this pin and the PHASE pin to provide the necessary charge to turn on the high-side MOSFET.

2.1.25 $+V_{SEN}$ PIN

The noninverting input of the unity gain amplifier used for output voltage remote sensing is connected to the $+V_{SEN}$ pin. This pin can be internally pulled-up to V_{DD} by setting the PE1<PUEN> bit.

2.1.26 $-V_{SEN}$ PIN

The inverting input of the unity gain amplifier used for output voltage remote sensing is connected to the $-V_{SEN}$ pin. This pin can be internally pulled-down to GND by setting the PE1<PDEN> bit.

2.1.27 $+I_{SEN}$ PIN

The noninverting input of the current sense amplifier is connected to the $+I_{SEN}$ pin.

2.1.28 $-I_{SEN}$ PIN

The inverting input of the current sense amplifier is connected to the $-I_{SEN}$ pin.

2.1.29 EXPOSED PAD (EP)

There is no internal connection to the Exposed Thermal Pad. The EP should be connected to the GND pin and to the GND PCB plane to aid in the removal of the heat.

3.0 FUNCTIONAL DESCRIPTION

3.1 Linear Regulators

Two internal linear regulators generate two 5V rails. One 5V rail is used to provide power for the internal analog circuitry and is contained on-chip. The second 5V rail provides power to the internal PIC core and is present on the V_{DD} pin. It is recommended that a 1 µF capacitor be placed between V_{DD} and P_{GND}.

The V_{DR} pin provides power to the internal synchronous MOSFET driver. V_{DD} can be directly connected to V_{DR} or connected through a low-pass RC filter to provide noise filtering. A 1 µF ceramic bypass capacitor should be placed between V_{DR} and P_{GND}. When connecting V_{DD} to V_{DR}, the gate drive current required to drive the external MOSFETs must be added to the MCP19118/19 quiescent current, $I_{Q(max)}$. This total current must be less than the maximum current, I_{DD-OUT}, available from V_{DD}, that is specified in **Section 4.2 "Electrical Characteristics"**.

EQUATION 3-1: TOTAL REGULATOR CURRENT

$$I_{DD-OUT} > (I_Q + I_{DRIVE} + I_{EXT})$$

Where:

- I_{DD-OUT} is the total current available from V_{DD}
- I_Q is the device quiescent current
- I_{DRIVE} is the current required to drive the external MOSFETs
- I_{EXT} is the amount of current used to power additional external circuitry

EQUATION 3-2: GATE DRIVE CURRENT

$$I_{DRIVE} = (Q_{gHIGH} + Q_{gLOW}) \times F_{SW}$$

Where:

- I_{DRIVE} is the current required to drive the external MOSFETs
- Q_{gHIGH} is the total gate charge of the high-side MOSFET
- Q_{gLOW} is the total gate charge of the low-side MOSFET
- F_{SW} is the switching frequency

Alternatively, an external regulator can be used to power the synchronous driver. An external 5V source can be connected to V_{DR}. The amount of current required from this external source can be found in Equation 3-2. Care must be taken that the voltage applied to V_{DR} does not exceed the maximum ratings found in **Section 4.1 "Absolute Maximum Ratings(†)"**.

3.2 Internal Synchronous Driver

The internal synchronous driver is capable of driving two N-Channel MOSFETs in a synchronous rectified buck converter topology. The gate of the floating MOSFET is connected to the HDRV pin. The source of this MOSFET is connected to the PHASE pin. The HDRV pin source and sink current is configurable. By setting the PE1<DRVSTR> bit, the high-side is capable of sourcing and sinking a peak current of 1A. By clearing this bit, the source and sink peak current is 2A.

Note 1: The PE1<DRVSTR> bit configures the peak source/sink current of the HDRV pin.

The MOSFET connected to the LDRV pin is not floating. The low-side MOSFET gate is connected to the LDRV pin and the source of this MOSFET is connected to P_{GND}. The drive strength of the LDRV pin is not configurable. This pin is capable of sourcing a peak current of 2A. The peak sink current is 4A. This helps keep the low-side MOSFET off when the high-side MOSFET is turning on.

Note 1: Refer to Figure 1-1 for a graphical representation of the MOSFET connections.

3.2.1 MOSFET DRIVER DEAD TIME

The MOSFET driver dead time is defined as the time between one drive signal going low and the complimentary drive signal going high. Refer to Figure 6-2. The MCP19118/19 has the capability to adjust both the high-side and low-side driver dead time independently. The adjustment of the driver dead time is controlled by the DEADCON register and is adjustable in 4 ns increments.

Note 1: The DEADCON register controls the amount of dead time added to the HDRV or LDRV signal. The dead time circuitry is enabled by the PE1<LDLYBY> and PE1<HDLYBY> bits.

3.2.2 MOSFET DRIVER CONTROL

The MCP19118/19 has the ability to disable the entire synchronous driver or just one side of the synchronous drive signal. The bits that control the MOSFET driver can be found in Register 8-1.

By setting the ATSTCON<DRVDIS> bit, the entire synchronous driver is disabled. The HDRV and LDRV signals are set low and the PHASE pin is floating. Clearing this bit allows normal operation.

Individual control of the HDRV or LDRV signal is accomplished by setting or clearing the ATSTCON<HIDIS> or ATSTCON<LODIS> bits. When either driver is disabled, the output signal is set low.

3.3 Output Voltage

The output voltage is configured by the settings contained in the OVCCON and OVFCON registers. No external resistor divider is needed to set the output voltage. Refer to **Section 6.10 "Output Voltage Configuration"**.

The MCP19118/19 contains a unity gain differential amplifier used for remote sensing of the output voltage. Connect the $+V_{SEN}$ and $-V_{SEN}$ pins directly at the load for better load regulation. The $+V_{SEN}$ and $-V_{SEN}$ are the positive and negative inputs, respectively, of the differential amplifier.

3.4 Switching Frequency

The switching frequency is configurable over the range of 100 kHz to 1.6 MHz. The Timer2 module is used to generate the HDRV/LDRV switching frequency. Refer to **Section 26.0 "PWM Module"** for more information. Example 3-1 shows how to configure the MCP19118/19 for a switching frequency of 300 kHz.

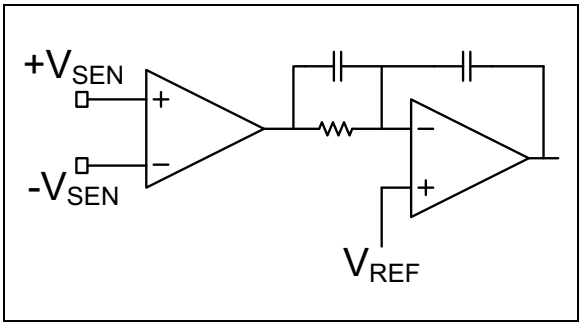
EXAMPLE 3-1: CONFIGURING F_{SW}

```
BANKSEL    T2CON
CLRF       T2CON   ;Turn off Timer2
CLRF       TMR2    ;Initialize module
MOVLW      0x19    ;Fsw=300 kHz
MOVWF      PR2
MOVLW      0x0A    ;Max duty cycle=40%
MOVWF      PWMRL
MOVLW      0x00    ;No phase shift
MOVWF      PWMPHL
MOVLW      0x04    ;Turn on Timer2
MOVWF      T2CON
```

3.5 Compensation

The MCP19118/19 is an analog peak current mode controller with integrated adjustable compensation. The CMPZCON register is used to adjust the compensation zero frequency and gain. Figure 3-1 shows the internal compensation network with the output differential amplifier.

FIGURE 3-1: SIMPLIFIED INTERNAL COMPENSATION



3.6 Slope Compensation

In current mode control systems, slope compensation needs to be added to the control path to help prevent subharmonic oscillation when operating with greater than 50% duty cycle. In the MCP19118/19, a negative slope is added to the error amplifier output signal before it is compared to the current sense signal. The amount of slope added is controlled by the SLPCRCON register.

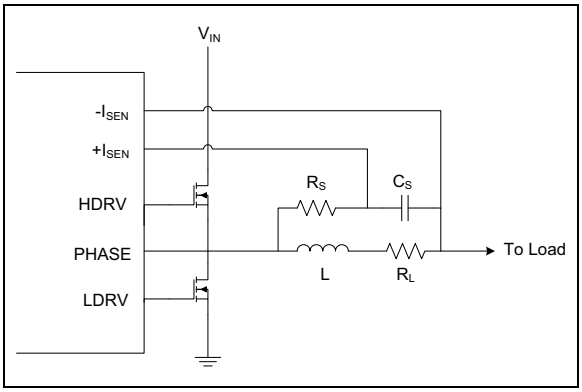
Note 1: To enable the slope compensation circuitry, the ABECON<SLCPBY> bit must be cleared.

The amount of slope compensation added should be equal to the inductor current down slope during the high-side off time.

3.7 Current Sense

The output current is differentially sensed by the MCP19118/19. The sense element can be either a resistor placed in series with the output or the series resistance of the inductor. If the inductor series resistance is used, a filter is needed to remove the large AC component of the voltage that appears across the inductor and leave only the small AC voltage that appears across the inductor resistance, as shown in Figure 3-2. This small AC voltage is representative of the output current.

FIGURE 3-2: INDUCTOR CURRENT SENSE FILTER



The value of R_S and C_S can be found by using Equation 3-3. When the current sense filter time constant is set equal to the inductor time constant, the voltage appearing across C_S approximates the current flowing in the inductor, multiplied by the inductor resistance.

EQUATION 3-3: CALCULATING FILTER VALUES

$$\frac{L}{R_L} = (R_S \times C_S)$$

Where:

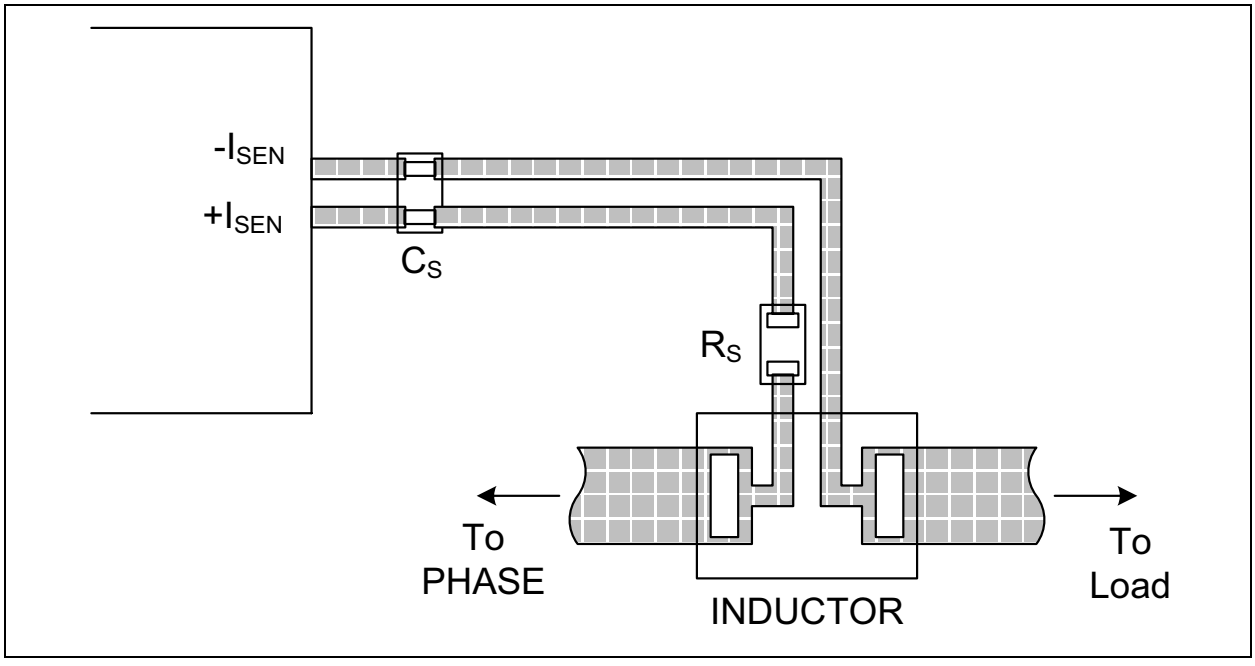
- L is the inductance value of the output inductor
- R_L is the series resistance of the output inductor
- R_S is the current sense filter resistor
- C_S is the current sense filter capacitor

Both AC gain and DC gain can be added to the current sense signal. Refer to **Section 6.3 "Current Sense AC Gain"** and **Section 6.4 "Current Sense DC Gain"** for more information.

3.7.1 PLACEMENT OF THE CURRENT SENSE FILTER COMPONENTS

The amplitude of the current sense signal is typically less than 100 mV peak-to-peak. Therefore, the small signal current sense traces are very susceptible to circuit noise. When designing the printed circuit board, placement of R_S and C_S is very important. The $+I_{SEN}$ and $-I_{SEN}$ traces should be routed parallel to each other with minimum spacing. This Kelvin sense routing technique helps minimize noise sensitivity. The filter capacitor, C_S, should be placed as close to the MCP19118/19 as possible. This will help filter any noise that is injected onto the current sense lines. The trace connecting C_S to the inductor should occur directly at the inductor and not at any other $+V_{SEN}$ trace. The filter resistor, R_S, should be placed close to the inductor. See Figure 3-3 for component placement. Care should also be taken to avoid routing the $+I_{SEN}$ and $-I_{SEN}$ traces near the high current switching nodes of the HDRV, LDRV, PHASE or BOOST traces. It is recommended that a ground layer be placed between these high current traces and the small signal current sense traces.

FIGURE 3-3: CURRENT SENSE FILTER COMPONENT PLACEMENT



3.8 Protection Features

3.8.1 INPUT UNDERVOLTAGE LOCKOUT

The input undervoltage lockout (UVLO) threshold is configurable by the VINLVL register. When the voltage at the V_{IN} pin of the MCP19118/19 is below the configurable threshold, the PIR2<VINIF> flag will be set. This flag is cleared by hardware once the V_{IN} voltage is greater than the configurable threshold. By enabling the global interrupts or polling the VINIF bit, the MCP19118/19 can be disabled when the V_{IN} voltage is below the threshold.

Note 1: The UVLO DAC must be enabled by setting the VINLVL<UVLOEN> bit.

2: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable (GIE) bit in the INTCON register.

Some techniques that can be used to disable the switching of the MCP19118/19 while the VINIF flag is set include setting the ATSTCON<DVRDIS> bit, setting the reference voltage to 0V, setting the PE1<PUEN> bit or setting the ATSTCON<HIDIS> and ATSTCON<LODIS> bits.

3.8.2 OUTPUT OVERCURRENT

The MCP19118/19 senses the voltage drop across the high-side MOSFET to determine when an output overcurrent (OC) exists. This voltage drop is configurable by the OCCON register and is measured when the high-side MOSFET is conducting. To avoid false OC events, leading edge blanking is applied to the measurements. The amount of blanking is controlled by the OCLEB<1:0> bits in the OCCON register. See **Section 6.2 "Output Overcurrent"** for more information.

Note 1: The OC DAC must be enabled by setting the OCCON<OCEN> bit.

3.8.3 OUTPUT UNDERVOLTAGE

When the output undervoltage DAC is enabled by setting the ABECON<UVDCEN> bit, the voltage measured between the $+V_{SEN}$ and $-V_{SEN}$ pins is monitored and compared to the UV threshold controlled by the OUVCON register. When the output voltage is below the threshold, the PIR2<UVIF> flag will be set. Once set, firmware can determine how the MCP19118/19 responds to the fault condition and it must clear the UVIF flag.

By setting the PE1<UVTEE> bit, the HDRV and LDRV signals will be asserted low when the UVIF flag is set. The signals will remain low until the flag is cleared.

Note 1: The UV DAC must be enabled by setting the ABECON<UVDCEN> bit.

2: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable (GIE) bit in the INTCON register.

3: The output of the remote sense comparator is compared to the UV threshold. Therefore, the offset in this comparator should be considered when calculating the UV threshold.

3.8.4 OUTPUT OVERVOLTAGE

When the output overvoltage DAC is enabled by setting the ABECON<OVDCEN> bit, the voltage measured between the $+V_{SEN}$ and $-V_{SEN}$ pins is monitored and compared to the OV threshold controlled by the OOVCON register. When the output voltage is above the threshold, the PIR2<OVIF> flag will be set. Once set, firmware can determine how the MCP19118/19 responds to the fault condition and it must clear the OVIF flag.

By setting the PE1<OVTEE> bit, the HDRV and LDRV signals will be asserted low when the OVIF flag is set. The signals will remain low until the flag is cleared.

Note 1: The OV DAC must be enabled by setting the ABECON<UVDCEN> bit.

2: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable (GIE) bit in the INTCON register.

3: The output of the remote sense comparator is compared to the OV threshold. Therefore, the offset in this comparator should be considered when calculating the OV threshold.

3.8.5 OVERTEMPERATURE

The MCP19118/19 features a hardware overtemperature shutdown protection typically set at +160°C. No firmware fault-handling procedure is required to shutdown the MCP19118/19 for an overtemperature condition.

3.9 PIC Microcontroller Core

Integrated into the MCP19118/19 is the PIC microcontroller mid-range core. This is a fully functional microcontroller, allowing proprietary features to be implemented. Setting the CONFIG<$\overline{CP}$> bit enables the code protection. The firmware is then protected from external reads or writes. Various status and fault bits are available to customize the fault handling response.

A minimal amount of firmware is required to properly configure the MCP19118/19. **Section 6.0 "Configuring the MCP19118/19"** contains detailed information about each register that needs to be set for the MCP19118/19 device to operate. To aid in the development of the required firmware, a Graphical User Interface (GUI) has been developed. This GUI can be used to quickly configure the MCP19118/19 for basic operation. Customized or proprietary features can then be added to the GUI-generated firmware.

Note 1:	The GUI can be found on the MCP19118/19 product page on www.microchip.com.
2:	Microchip's MPLAB X Integrated Development Environment Software is required to use the GUI.

The MCP19118/19 device features firmware debug support. See **Section 30.0 "Development Support"** for more information.

3.10 Miscellaneous Features

3.10.1 DEVICE ADDRESSING

The communication address of the MCP19118/19 is stored in the SSPADD register. This value can be loaded when the device firmware is programmed or configured by external components. By reading a voltage on a GPIO with the ADC, a device-specific address can be stored into the SSPADD register.

The MCP19118/19 contains a second address register, SSPADD2. This is a 7-bit address that can be used as the SMBus alert address when PMBus communication is used. See **Section 27.0 "Master Synchronous Serial Port (MSSP) Module"** for more information.

3.10.2 DEVICE ENABLE

A GPIO pin can be configured to be a device enable pin. By configuring the pin as an input, the PORT register or the interrupt-on-change (IOC) can be used to enable the device. Example 3-2 shows how to configure a GPIO as an enable pin by testing the PORTGPA register.

EXAMPLE 3-2: CONFIGURING GPA3 AS DEVICE ENABLE

```
    BANKSEL     TRISGPA
    BSF         TRISGPA, 3      ;Set GPA3 as input
    BANKSEL     ANSELA
    BCF         ANSELA, 3       ;Set GPA3 as digital input
    :
    :                           ;Insert additional user code here
    :
WAIT_ENABLE:
    BANKSEL     PORTGPA
    BTFSS       PORTGPA, 3      ;Test GPA3 to see if pulled high
                                ;A high on GPA3 indicated device to be enabled
    GOTO        WAIT_ENABLE     ;Stay in loop waiting for device enable
    BANKSEL     ATSTCON
    BSF         ATSTCON, 0      ;Enable the device by enabling drivers
    :
    :                           ;Insert additional code here
    :
```

3.10.3 OUTPUT POWER GOOD

The output voltage measured between the $+V_{SEN}$ and $-V_{SEN}$ pins can be monitored by the internal ADC. In firmware, when this ADC reading matches a user-defined power good value, a GPIO can be toggled to indicate the system output voltage is within a specified range. Delays, hysteresis and time-out values can all be configured in firmware.

3.10.4 OUTPUT VOLTAGE SOFT START

During start-up, soft start of the output voltage is accomplished in firmware. By using one of the internal timers and incrementing the OVCCON or OVFCON register on a timer overflow, very long soft start times can be achieved.

3.10.5 OUTPUT VOLTAGE TRACKING

The MCP19118/19 can be configured to track another voltage signal at start-up or shutdown. The ADC is configured to read a GPIO that has the desired tracking voltage applied to it. The firmware then handles the tracking of the internal output voltage reference to this ADC reading.

3.10.6 MULTI-PHASE SYSTEM

In a multi-phase system, the output of each converter is connected together. There is one master device that sets the system switching frequency and provides each slave device with an error signal, in order to regulate the output to the same value.

The MCP19118/19 can be configured as a multi-phase master or slave by setting the MLTPH<2:0> bits in the BUFFCON register. When set as a multi-phase master device, the internal switching frequency clock is connected to GPA1 and the output of the error amplifier is connected to GPB1. The GPIOs need to be configured as outputs.

When set as a multi-phase slave device, the GPA1 pin is configured as the CLKPIN function. The switching frequency clock from the master device must be connected to GPA1. The slave device will synchronize its internal switching frequency clock to the master clock. Phase shift can be applied by setting the PWMPHL register of the slave device. The slave GPB1 pin is configured as the error signal input pin (EAPIN). The master error amplifier output must be connected to GPB1. Gain can be added to the master error amplifier output signal by the SLVGNCON register setting (Register 6-8). The slave device will use this master error signal to regulate the output voltage. When set as a slave device, GPA1 and GPB1 need to be configured as inputs. Refer to **Section 26.1 "Standard Pulse-Width Modulation (PWM) Mode"** for additional information.

Note 1:	The ALT_CLKPIN can also be used by setting the APFCON<CLKSEL> bit. This function is only available in the MCP19119.

3.10.7 MULTIPLE OUTPUT SYSTEM

In a multiple output system, the switching frequency of each converter should be synchronized to a master clock to prevent beat frequencies from developing. Phase shift is often added to the master clock to help smooth the system input current. The MCP19118/19 has the ability to function as a multiple output master or slave by setting the appropriate MLTPH<2:0> bits in the BUFFCON register.

When configured as a multiple output master, the GPA1 pin is set as the CLKPIN output function. The internal switching frequency clock is applied to this pin and is to be connected to the GPA1 pin of the slave units.

When configured as a multiple output slave, the GPA1 pin is set as the CLKPIN input function. The switching frequency clock of the master device is connected to this pin. Phase shift can be applied by appropriately setting the PWMPHL register of the slave device. Refer to **Section 26.1 "Standard Pulse-Width Modulation (PWM) Mode"**.

Note 1:	The ALT_CLKPIN can also be used by setting the APFCON<CLKSEL> bit. This function is only available in the MCP19119.

3.10.8 SYSTEM BENCH TESTING

The MCP19118/19 is a highly integrated controller. To facilitate system prototyping, various internal signals can be measured by configuring the MCP19118/19 in Bench Test mode. To accomplish this, the ATSTCON<BNCHEN> bit is set. This configures GPA0 as the ANALOG_TEST feature. The signals measured on GPA0 are controlled by the ASEL<4:0> bits in the BUFFCON register. See **Section 8.0 "System Bench Testing"** for more information.

Note 1:	The factory-set calibration words are write-protected even when the MCP19118/19 is placed in Bench Test mode.

4.0 ELECTRICAL CHARACTERISTICS

4.1 Absolute Maximum Ratings(†)

V_{IN} - V_{GND} ..... -0.3V to +42V
V_{IN} - V_{GND} (non-switching transient < 500 ms) ..... -0.3V to +48V
V_{BOOT} - V_{PHASE} ..... -0.3V to +6.5V
V_{PHASE} (continuous) ..... GND – 0.3V to +38V
V_{PHASE} (transient < 100 ns) ..... GND – 5.0V to +38V
V_{DD} internally generated ..... +5V ±20%
V_{HDRV}, HDRV Pin ..... $+V_{PHASE}$ – 0.3V to V_{BOOT} + 0.3V
V_{LDRV}, LDRV Pin ..... +(V_{GND} – 0.3V) to (V_{DD} + 0.3V)
Voltage on $\overline{MCLR}$ with respect to GND ..... -0.3V to +13.5V
Maximum Voltage: any other pin ..... +(V_{GND} – 0.3V) to (V_{DD} + 0.3V)
Maximum output current sunk by any single I/O pin ..... 25 mA
Maximum output current sourced by any single I/O pin ..... 25 mA
Maximum current sunk by all GPIO ..... 65 mA
Maximum current sourced by all GPIO ..... 65 mA
ESD protection on all pins (HBM) ..... 1.0 kV
ESD protection on all pins (MM) 100V

† **Notice:** Stresses above those listed under “Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

4.2 Electrical Characteristics

Electrical Specifications: Unless otherwise noted, V_{IN} = 12V, V_{REF} = 1.2V, F_{SW} = 300 kHz, T_A = +25°C. **Boldface** specifications apply over the T_A range of -40°C to +125°C.

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Input						
Input Voltage	V_{IN}	**4.5**	—	**40**	V	
Input Quiescent Current	I_Q	—	5	**10**	mA	Not switching
Shutdown Current	I_{SHDN}	—	1.8	**—**	mA	Note 4
Adjustable Input Undervoltage Lockout Range	UVLO	**3**	—	**32**	V	VINLVL is a LOG DAC
Input Undervoltage Lockout Hysteresis	$UVLO_{HYS}$	**—**	13	**—**	%	Hysteresis applied to adjustable UVLO setpoint
Overcurrent						
Overcurrent Minimum Threshold	OC_{MIN}	—	160	—	mV	
Overcurrent Maximum Threshold	OC_{MAX}	—	620	—	mV	
Overcurrent Mid-Scale Threshold	OC_{MID}	**240**	400	**550**	mV	
Overcurrent Step Size	OC_{STEP_SIZE}	**10**	15	**25**	mV	
Adjustable OC Leading Edge Blanking Minimum Set Point	LEB_{min}	—	114	—	ns	
Adjustable OC Leading Edge Blanking Maximum Set Point	LEB_{max}	—	780	—	ns	
Current Sense						
Current Sense Minimum AC Gain	I_{AC_GAIN}	—	0	—	dB	
Current Sense Maximum AC Gain	I_{AC_GAIN}	—	22.8	—	dB	
Current Sense AC Gain Mid-Set Point	I_{AC_GAIN}	8.5	11.5	14	dB	
Current Sense AC Gain Step Size	$I_{AC\_GAIN\_STEP}$	—	1.5	—	dB	
Current Sense AC Gain Offset Voltage	I_{AC_OFFSET}	-175	9	135	mV	
Current Sense Minimum DC Gain	I_{DC_GAIN}	—	19.5	—	dB	
Current Sense Maximum DC Gain	I_{DC_GAIN}	—	35.7	—	dB	
Current Sense DC Gain Mid-Set Point	I_{DC_GAIN}	27	28.6	30.3	dB	
Current Sense DC Gain Step Size	$I_{DC\_GAIN\_STEP}$	—	2.3	—	dB	

Note 1: Ensured by design. Not production tested.

2: V_{DD-OUT} is the voltage present at the V_{DD} pin. V_{DD} is the internally generated bias voltage.

3: This is the total source current for all GPIO pins combined. Individually, each pin can source a maximum of 25 mA.

4: PE1 = 0x00h, ABECON = 0x00h, ATSTCON = 0x80h, WPUGPA = 0x00h, WPUGPB = 0x00h and SLEEP command issued to PIC core, see **Section 16.0 "Power-Down Mode (Sleep)"**.

4.2 Electrical Characteristics (Continued)

Electrical Specifications: Unless otherwise noted, V_{IN} = 12V, V_{REF} = 1.2V, F_{SW} = 300 kHz, T_A = +25°C. **Boldface** specifications apply over the T_A range of -40°C to +125°C.

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Current Sense DC Gain Offset Voltage	I_{DC_OFFSET}	1.4	1.56	1.7	V	
Voltage for Zero Current	VZC	—	1.45	—	V	VZCCON = 0x80h
Voltage Reference						
Adjustable V_{OUT} Range	V_{OUT_RANGE}	**0.5**	—	**3.6**	V	V_{OUT} range with no external voltage divider
V_{OUT} Coarse Resolution	V_{OUT_COARSE}	**10.8**	15.8	**25.8**	mV	
V_{OUT} Coarse Mid-Set Point	$V_{OUT\_COARSE\_MID}$	**1.85**	2.04	**2.25**	V	
V_{OUT} Fine Resolution	V_{OUT_FINE}	—	0.8	**1**	mV	
Output Overvoltage						
Adjustable Overvoltage Range	OV_{RANGE}	**0**	—	**4.5**	V	
Adjustable Overvoltage Mid-Set Point	OV_{MID}	**1.8**	2	**2.3**	V	
Adjustable Overvoltage Resolution	OV_R	**—**	15	**—**	mV	
Output Undervoltage						
Adjustable Undervoltage Range	UV_{RANGE}	**0**	—	**4.5**		
Adjustable Undervoltage Mid-Set Point	UV_{MID}	**1.8**	2	**2.3**	V	
Adjustable Undervoltage Resolution	UV_R	**—**	15	**—**	mV	
Remote Sense Differential Amplifier						
Closed-Loop Voltage Gain	A_{VOL}	**0.95**	1	**1.05**	V/V	
Common Mode Range	V_{CMR}	**GND – 0.3**	—	**V_{DD} + 1.0**	V	Note 1
Common-Mode Reject Ratio	CMRR	**—**	57	—	dB	
Differential Amplifier Offset	V_{OS}	—	30	—	mV	See **Section 9.4 "Calibration Word 4 and Calibration Word 5"** and **Section 9.5 "Calibration Word 6 and Calibration Word 7"**
Compensation						
Minimum Zero Frequency	F_{ZERO_MIN}	—	350	—	Hz	
Maximum Zero Frequency	F_{ZERO_MAX}	—	35000	—	Hz	
Minimum Error Amplifier Gain	G_{EA_MIN}	—	0	—	dB	
Maximum Error Amplifier Gain	G_{EA_MAX}	—	36.15	—	dB	

Note 1: Ensured by design. Not production tested.

2: V_{DD-OUT} is the voltage present at the V_{DD} pin. V_{DD} is the internally generated bias voltage.

3: This is the total source current for all GPIO pins combined. Individually, each pin can source a maximum of 25 mA.

4: PE1 = 0x00h, ABECON = 0x00h, ATSTCON = 0x80h, WPUGPA = 0x00h, WPUGPB = 0x00h and SLEEP command issued to PIC core, see **Section 16.0 "Power-Down Mode (Sleep)"**.

4.2 Electrical Characteristics (Continued)

Electrical Specifications: Unless otherwise noted, V_{IN} = 12V, V_{REF} = 1.2V, F_{SW} = 300 kHz, T_A = +25°C.
Boldface specifications apply over the T_A range of -40°C to +125°C.

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Oscillator						
Internal Oscillator Frequency	F_{OSC}	**7.60**	8.00	**8.40**	MHz	
Switching Frequency	F_{SW}	—	F_{OSC}/N	—	kHz	
Switching Frequency Range Select	N	**5**	—	**80**		
Maximum Duty Cycle		—	(N–1)/N	—	%/ 100	
Dead Time Adjustment						
Dead Time Step Size	DT_{STEP}	—	4	—	ns	
HDRV Output Driver						
HDRV Source Resistance	$R_{HDRV-SCR}$	—	1	**2.6**	Ω	Measured at 500 mA Note 1, High Range
		—	2	**3.5**	Ω	Measured at 500 mA Note 1, Low Range
HDRV Sink Resistance	$R_{HDRV-SINK}$	—	1	**2.6**	Ω	Measured at 500 mA Note 1, High Range
		—	2	**3.5**	Ω	Measured at 500 mA Note 1, Low Range
HDRV Source Current	$I_{HDRV-SCR}$	—	2	—	A	Note 1, High Range
		—	1	—	A	Note 1, Low Range
HDRV Sink Current	$I_{HDRV-SINK}$	—	2	—	A	Note 1, High Range
		—	1	—	A	Note 1, Low Range
HDRV Rise Time	t_{RH}	—	15	**30**	ns	Note 1, C_{LOAD} = 3.3 nF, High Range
HDRV Fall Time	t_{FH}	—	15	**30**	ns	Note 1, C_{LOAD} = 3.3 nF, High Range
LDRV Output Driver						
LDRV Source Resistance	$R_{LDRV-SCR}$	—	1	**2.5**	Ω	Measured at 500 mA Note 1
LDRV Sink Resistance	$R_{LDRV-SINK}$	—	0.5	**1.0**	Ω	Measured at 500 mA Note 1
LDRV Source Current	$I_{LDRV-SCR}$	—	2	—	A	Note 1
LDRV Sink Current	$I_{LDRV-SINK}$	—	4	—	A	Note 1
LDRV Rise Time	t_{RL}	—	15	**30**	ns	Note 1, C_{LOAD} = 3.3 nF
LDRV Fall Time	t_{FL}	—	7	**15**	ns	Note 1, C_{LOAD} = 3.3 nF

Note 1: Ensured by design. Not production tested.

2: V_{DD-OUT} is the voltage present at the V_{DD} pin. V_{DD} is the internally generated bias voltage.

3: This is the total source current for all GPIO pins combined. Individually, each pin can source a maximum of 25 mA.

4: PE1 = 0x00h, ABECON = 0x00h, ATSTCON = 0x80h, WPUGPA = 0x00h, WPUGPB = 0x00h and SLEEP command issued to PIC core, see **Section 16.0 "Power-Down Mode (Sleep)"**.

4.2 Electrical Characteristics (Continued)

Electrical Specifications: Unless otherwise noted, V_{IN} = 12V, V_{REF} = 1.2V, F_{SW} = 300 kHz, T_A = +25°C.
Boldface specifications apply over the T_A range of -40°C to +125°C.

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
Linear Regulator						
Bias Voltage, LDO Output	V_{DD}	**4.6**	5.0	**5.4**	V	V_{IN} = 6.0V to 40V, Note 2
Internal Circuitry Bias Voltage	AV_{DD}	**—**	5.0	**—**	V	V_{IN} = 6.0V to 40V, Note 2
Maximum V_{DD} Output Current	I_{DD}	**30**	—	—	mA	
Line Regulation	$\Delta V_{DD}/(V_{DD} \times \Delta V_{IN})$	—	0.05	**0.1**	%/V	$(V_{DD}+1.0V) \le V_{IN} \le 40V$ Note 2
Load Regulation	$\Delta V_{DD}/V_{DD}$	**-1.75**	-0.8	**+0.5**	%	I_{DD} = 1 mA to 30 mA Note 2
Output Short-Circuit Current	I_{DD_SC}	—	65	—	mA	$V_{IN} = (V_{DD} + 1.0V)$ Note 2
Dropout Voltage	$V_{IN} - V_{DD}$	—	0.5	**1**	V	I_{DD} = 30 mA, $V_{IN} = V_{DD} + 1.0V$ Note 2
Power Supply Rejection Ratio	$PSRR_{LDO}$	—	60	—	dB	f ≤ 1000 Hz, I_{DD} = 25 mA, C_{IN} = 0 µF, C_{DD} = 1 µF
Band Gap Voltage	BG	**-2.5%**	1.23	**+2.5%**	V	
GPIO Pins						
Maximum GPIO Sink Current	I_{SINK_GPIO}	—	—	90	mA	Note 3, Note 1
Maximum GPIO Source Current	I_{SOURCE_GPIO}	—	—	90	mA	Note 3, Note 1
GPIO Weak Pull-Up Current	$I_{PULL-UP\_GPIO}$	50	250	400	µA	V_{DD} = 5V
GPIO Output Low Voltage	V_{OL}	—	—	0.6	V	I_{OL} = 7 mA, V_{DD}= 5V, T_A = +90°C
GPIO Output High Voltage	V_{OH}	V_{DD} – 0.7	—	—	V	I_{OH} = -2.5 mA, V_{DD} = 5V, T_A = +90°C
GPIO Input Leakage Current	$GPIO\_I_{IL}$	—	±0.1	±1	µA	Negative current is defined as current sourced by the pin, T_A = +90°C
GPIO Input Low Voltage	V_{IL}	GND	—	0.8	V	I/O Port with TTL buffer V_{DD} = 5V, T_A = +90°C
		GND		$0.2V_{DD}$	V	I/O Port with Schmitt Trigger buffer, V_{DD} = 5V, T_A = +90°C
		GND		$0.2V_{DD}$	V	$\overline{MCLR}$, T_A = +90°C

Note 1: Ensured by design. Not production tested.

2: V_{DD-OUT} is the voltage present at the V_{DD} pin. V_{DD} is the internally generated bias voltage.

3: This is the total source current for all GPIO pins combined. Individually, each pin can source a maximum of 25 mA.

4: PE1 = 0x00h, ABECON = 0x00h, ATSTCON = 0x80h, WPUGPA = 0x00h, WPUGPB = 0x00h and SLEEP command issued to PIC core, see **Section 16.0 "Power-Down Mode (Sleep)"**.

4.2 Electrical Characteristics (Continued)

Electrical Specifications: Unless otherwise noted, V_{IN} = 12V, V_{REF} = 1.2V, F_{SW} = 300 kHz, T_A = +25°C.
Boldface specifications apply over the T_A range of -40°C to +125°C.

Parameter	Sym.	Min.	Typ.	Max.	Units	Conditions
GPIO Input High Voltage	V_{IH}	2.0	—	V_{DD}	V	I/O Port with TTL buffer, V_{DD} = 5V, T_A = +90°C
		$0.8V_{DD}$	—	V_{DD}	V	I/O Port with Schmitt Trigger buffer, V_{DD} = 5V, T_A = +90°C
		$0.8V_{DD}$	—	V_{DD}	V	$\overline{MCLR}$, T_A = +90°C
Thermal Shutdown						
Thermal Shutdown	T_{SHD}	—	160	—	°C	
Thermal Shutdown Hysteresis	T_{SHD_HYS}	—	20	—	°C	

Note 1: Ensured by design. Not production tested.

2: V_{DD-OUT} is the voltage present at the V_{DD} pin. V_{DD} is the internally generated bias voltage.

3: This is the total source current for all GPIO pins combined. Individually, each pin can source a maximum of 25 mA.

4: PE1 = 0x00h, ABECON = 0x00h, ATSTCON = 0x80h, WPUGPA = 0x00h, WPUGPB = 0x00h and SLEEP command issued to PIC core, see **Section 16.0 "Power-Down Mode (Sleep)"**.

4.3 Thermal Specifications

Parameter	Sym.	Min.	Typ.	Max.	Units	Test Conditions
Temperature Ranges						
Specified Temperature Range	T_A	-40	—	+125	°C	
Operating Temperature Range	T_A	-40	—	+125	°C	
Maximum Junction Temperature	T_J	—	—	+150	°C	
Storage Temperature Range	T_A	-65	—	+150	°C	
Thermal Package Resistances						
Thermal Resistance, 24L-QFN 4x4	θ_{JA}	—	42	—	°C/W	
Thermal Resistance, 28L-QFN 5x5	θ_{JA}	—	35.3	—	°C/W	

5.0 DIGITAL ELECTRICAL CHARACTERISTICS

5.1 Timing Parameter Symbology

The timing parameter symbols have been created with one of the following formats:

1. TppS2ppS
2. TppS
3. TCC:ST (I^2C specifications only)
4. Ts (I^2C specifications only)

T			
F	Frequency	TTime	

Lowercase letters (pp) and their meanings:

pp			
cc	CCP1	osc	OSC1
ck	CLKOUT	rd	$\overline{RD}$
cs	$\overline{CS}$	rw	$\overline{RD}$ or $\overline{WR}$
di	SDI	sc	SCK
do	SDO	ss	$\overline{SS}$
dt	Data in	t0	T0CKI
io	I/O port	t1	T1CKI
mc	$\overline{MCLR}$	wr	$\overline{WR}$

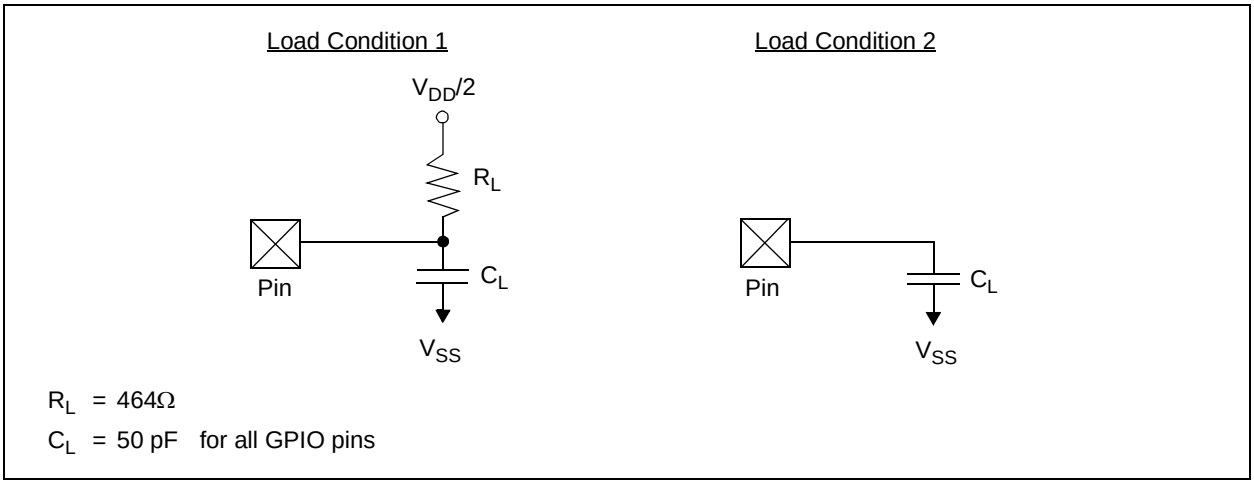
Uppercase letters and their meanings:

S			
F	Fall	P	Period
H	High	R	Rise
I	Invalid (high-impedance)	V	Valid
L	Low	Z	High-impedance
I^2C™ only			
AA	Output access	High	High
BUF	Bus free	Low	Low

TCC:ST (I^2C specifications only)

CC			
HD	Hold	SU	Setup
ST			
DAT	Data input hold	STO	Stop condition
STA	Start condition		

FIGURE 5-1: LOAD CONDITIONS



R_L = 464Ω

C_L = 50 pF for all GPIO pins

5.2 AC Characteristics: MCP19118/19 (Industrial, Extended)

FIGURE 5-2: EXTERNAL CLOCK TIMING

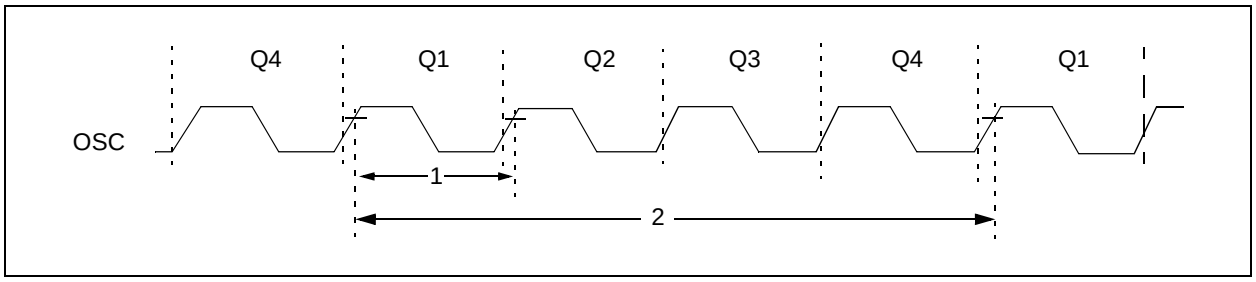


TABLE 5-1: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym.	Characteristic	Min.	Typ.†	Max.	Units	Conditions
	F_{OSC}	Oscillator Frequency(1)	—	8	—	MHz	
1	T_{OSC}	Oscillator Period(1)	—	250	—	ns	
2	T_{CY}	Instruction Cycle Time(1)	—	1000	—	ns	

* These parameters are characterized but not tested.

† Data in the "Typ." column is at V_{IN} = 12V (V_{DD} = 5V), +25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (T_{CY}) equals four times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code.

FIGURE 5-3: CLKOUT AND I/O TIMING

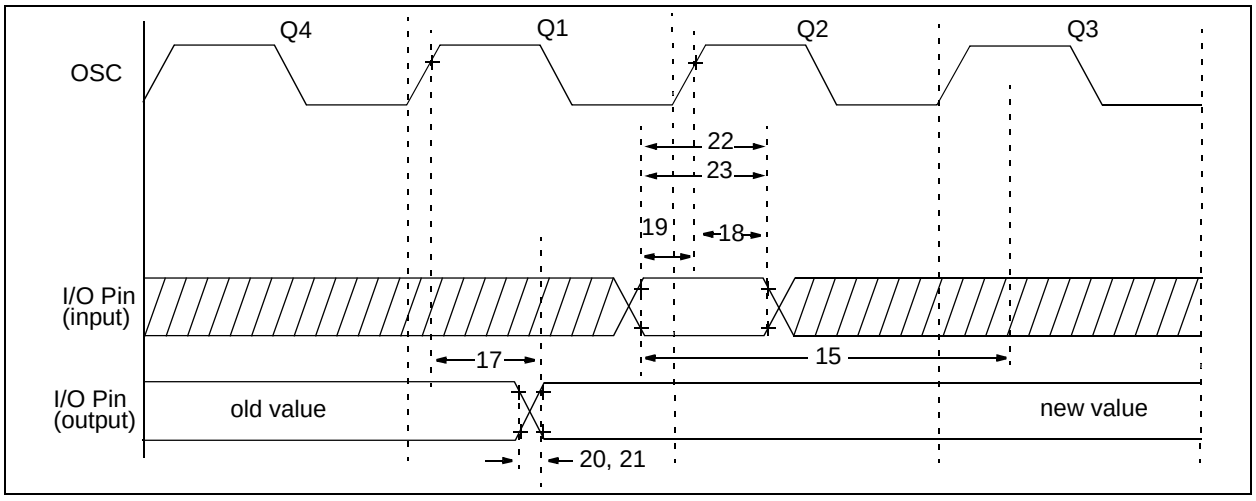


TABLE 5-2: CLKOUT AND I/O TIMING REQUIREMENTS

Param No.	Sym.	Characteristic	Min.	Typ.†	Max.	Units	Conditions
17	TosH2ioV	OSC1↑ (Q1 cycle) to	—	50	150*	ns	
		Port output valid	—	—	300	ns	
18	TosH2ioI	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)	100	—	—	ns	
19	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)	0	—	—	ns	
20	TioR	Port output rise time	—	10	40	ns	
21	TioF	Port output fall time	—	10	40	ns	
22	Tinp	INT pin high	25	—	—	ns	
22A		or low time	40	—	—	ns	
23	Trbp	Port A change INT	Tcy	—	—	ns	
23A	Trbp	high or low time					

* These parameters are characterized but not tested.

† Data in the "Typ." column is at V_{IN} = 12V (V_{DD} = 5V), +25°C unless otherwise stated.

FIGURE 5-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

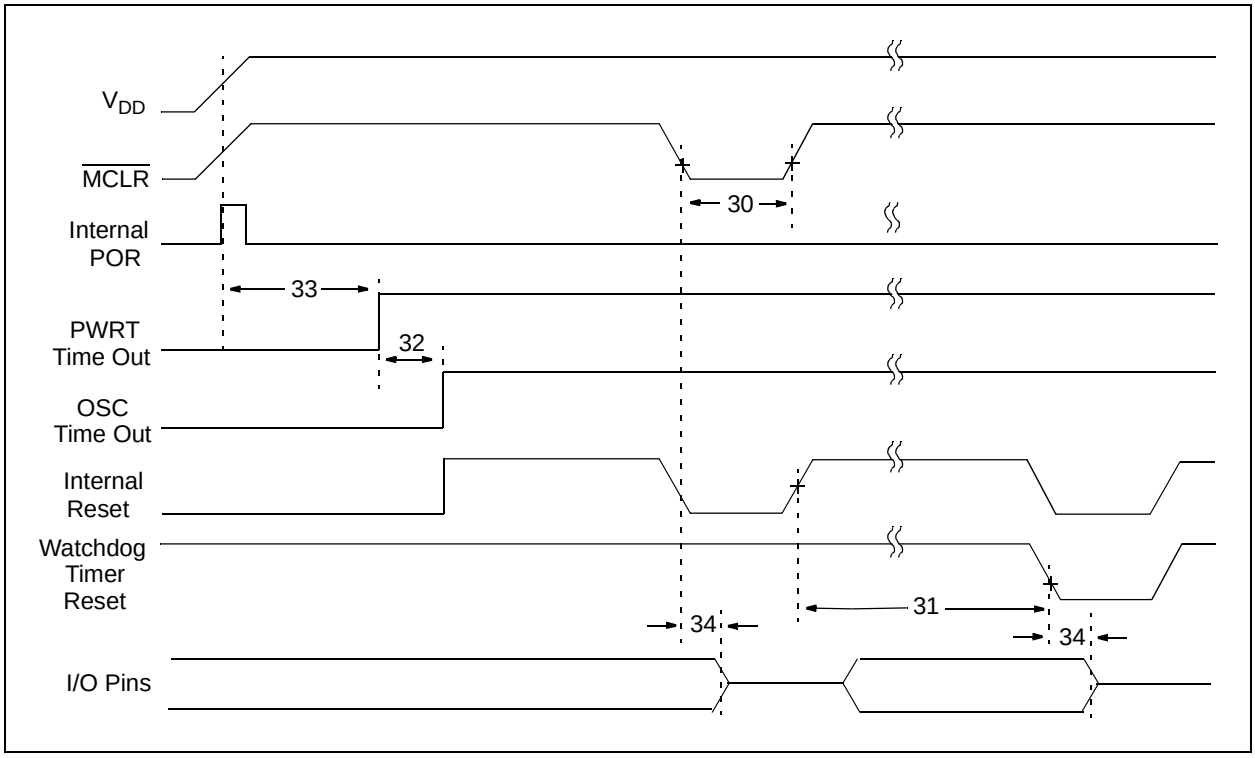


TABLE 5-3: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER REQUIREMENTS

Param No.	Sym.	Characteristic	Min.	Typ.†	Max.	Units	Conditions
30	T_{MCL}	$\overline{MCLR}$ Pulse Width (Low)	2	—	—	µs	V_{DD} = 5V, -40°C to +85°C
31	T_{WDT}	Watchdog Timer Time-Out Period (No Prescaler)	7	18	33	ms	V_{DD} = 5V, -40°C to +85°C
32	T_{OST}	Oscillation Start-Up Timer Period	—	$1024T_{OSC}$	—	—	T_{OSC} = OSC1 period
33*	T_{PWRT}	Power-Up Timer Period ($4 \times T_{WDT}$)	28	64	132	ms	V_{DD} = 5V, -40°C to +85°C
34	T_{IOZ}	I/O High-Impedance from $\overline{MCLR}$ Low or Watchdog Timer Reset	—	—	2.0	µs	

* These parameters are characterized but not tested.

† Data in the "Typ." column is at V_{IN} = 12V (V_{DD} = 5V), +25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 5-5: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

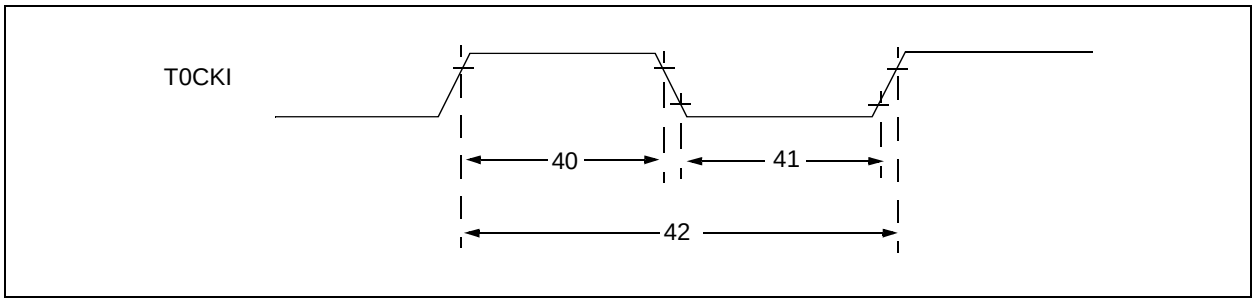


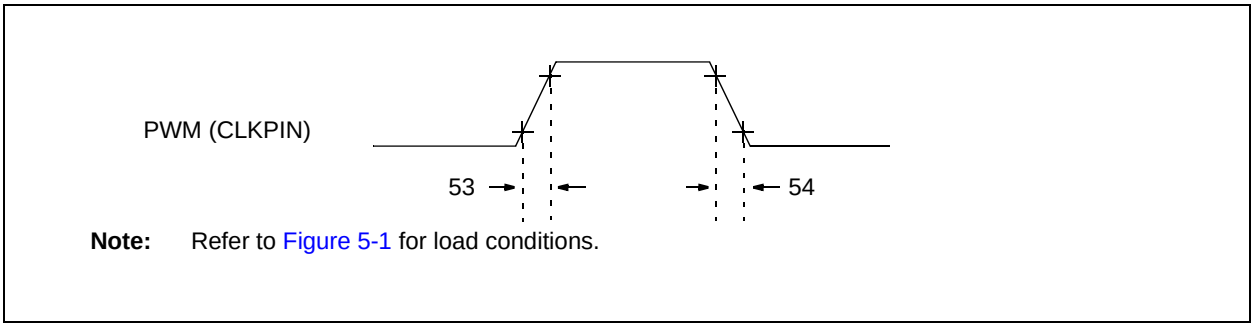
TABLE 5-4: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym.	Characteristic		Min.	Typ.†	Max.	Units	Conditions
40*	Tt0H	T0CKI High Pulse Width	No Prescaler	$0.5T_{CY}$ + 20	—	—	ns	
			With Prescaler	10	—	—	ns	
41*	Tt0L	T0CKI Low Pulse Width	No Prescaler	$0.5T_{CY}$ + 20	—	—	ns	
			With Prescaler	10	—	—	ns	
42*	Tt0P	T0CKI Period		Greater of: 20 or $\frac{T_{CY} + 40}{N}$	—	—	ns	N = prescale value (2, 4, ..., 256)

* These parameters are characterized but not tested.

† Data in the "Typ." column is at V_{IN} = 12V (V_{DD} = 5V), +25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 5-6: PWM TIMING



Note: Refer to Figure 5-1 for load conditions.

TABLE 5-5: PWM REQUIREMENTS

Param No.	Sym.	Characteristic	Min.	Typ.†	Max.	Units	Conditions
53*	TccR	PWM (CLKPIN) output rise time	—	10	25	ns	
54*	TccF	PWM (CLKPIN) output fall time	—	10	25	ns	

* These parameters are characterized but not tested.

† Data in the "Typ." column is at V_{IN} = 12V (V_{DD} = 5V), +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

TABLE 5-6: MCP19118/19 A/D CONVERTER (ADC) CHARACTERISTICS

Standard Operating Conditions (unless otherwise stated)
Operating temperature -40°C ≤ TA ≤ +125°C

Param No.	Sym.	Characteristic	Min.	Typ.†	Max.	Units	Conditions
AD01	N_R	Resolution	—	—	10	bit	
AD02	E_{IL}	Integral Error	—	—	±1	LSb	AV_{DD} = 5.0V
AD03	E_{DL}	Differential Error	—	—	±1	LSb	No missing codes to 10 bits AV_{DD} = 5.0V
AD04	E_{OFF}	Offset Error	—	+3.0	+5.0	LSb	AV_{DD} = 5.0V
AD07	E_{GN}	Gain Error	—	±2	±5	LSb	AV_{DD} = 5.0V
AD06 AD06A	V_{REF}	Reference Voltage(3)	—	AV_{DD}	—	V	
AD07	V_{AIN}	Full-Scale Range	GND	—	AV_{DD}	V	
AD08	Z_{AIN}	Recommended Impedance of Analog Voltage Source	—	—	10	kΩ	

* These parameters are characterized but not tested.

† Data in the "Typ." column is at V_{IN} = 12V (V_{DD} = 5V), +25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Total Absolute Error includes integral, differential, offset and gain errors.

2: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

3: When ADC is off, it will not consume any current other than leakage current. The power-down current specification includes any such leakage from the ADC module.

TABLE 5-7: MCP19118/19 A/D CONVERSION REQUIREMENTS

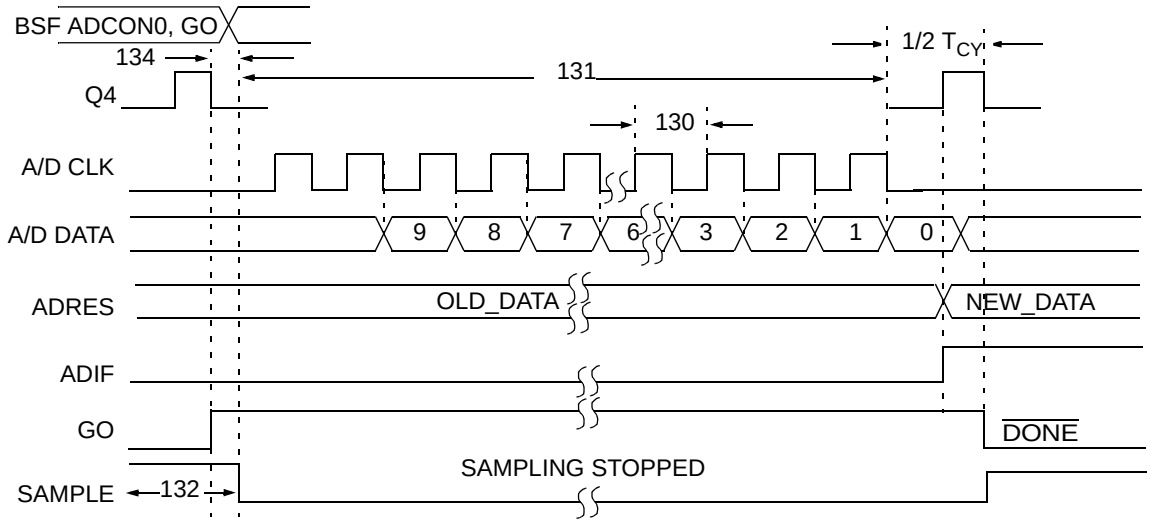
Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ T_A ≤ +125°C							
Param No.	**Sym.**	**Characteristic**	**Min.**	**Typ.†**	**Max.**	**Units**	**Conditions**
AD130*	T_{AD}	A/D Clock Period A/D Internal RC Oscillator Period	3.0 1.6	— 4.0	9.0 6.0	µs µs	T_{OSC}-based, V_{DD} = 5.0V At V_{DD} = 5.0V
AD131	T_{CNV}	Conversion Time (not including Acquisition Time)(1)	—	11	—	T_{AD}	Set GO/$\overline{DONE}$ bit to new data in A/D Result register
AD132*	T_{ACQ}	Acquisition Time		11.5	—	µs	
AD133*	T_{AMP}	Amplifier Settling Time	—	—	5	µs	
AD134	T_{GO}	Q4 to A/D Clock Start	— —	$T_{OSC}/2$ $T_{OSC}/2 + T_{CY}$	— —	— —	If the A/D clock source is selected as RC, a time of T_{CY} is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

* These parameters are characterized but not tested.

† Data in the "Typ." column is at V_{IN} = 12V (V_{DD} = 5V), +25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

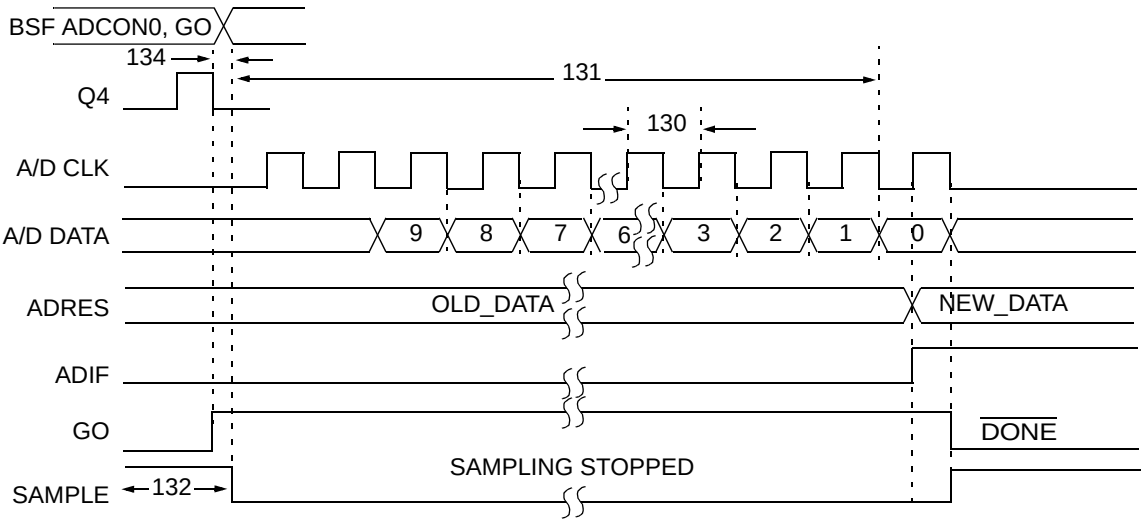
Note 1: ADRESH and ADRESL registers may be read on the following T_{CY} cycle.

FIGURE 5-7: A/D CONVERSION TIMING (NORMAL MODE)



Note 1: If the A/D clock source is selected as RC, a time of T_{CY} is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

FIGURE 5-8: A/D CONVERSION TIMING (SLEEP MODE)



Note 1: If the A/D clock source is selected as RC, a time of T_{CY} is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

NOTES:

6.0 CONFIGURING THE MCP19118/19

The MCP19118/19 is an analog controller with digital peripheral. This means that device configuration is handled through register settings instead of adding external components. The following sections detail how to set the analog control registers.

6.1 Input Undervoltage Lockout

The VINLVL register contains the digital value that sets the input undervoltage lockout. When the input voltage on the V_{IN} pin to the MCP19118/19 is below this programmed level, the INTCON<VINIF> flag will be set. This bit is automatically cleared when the MCP19118/19 V_{IN} voltage rises above this programmed level.

The VINLVL<UVLOEN> bit must be set to enable the input undervoltage lockout circuitry.

Note:	The VINIF interrupt flag bit is set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable (GIE) bit in the INTCON register.

REGISTER 6-1: VINLVL: INPUT UNDERVOLTAGE LOCKOUT CONTROL REGISTER

R/W-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
UVLOEN	—	UVLO5	UVLO4	UVLO3	UVLO2	UVLO1	UVLO0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **UVLOEN:** Undervoltage Lockout DAC Control bit
1 = Undervoltage Lockout DAC is enabled
0 = Undervoltage Lockout DAC is disabled

bit 6 **Unimplemented:** Read as ‘0’

bit 5-0 **UVLO<5:0>:** Undervoltage Lockout Configuration bits
UVLO<5:0> = 26.5*ln($UVLO_{SET\_POINT}$/4)

6.2 Output Overcurrent

The MCP19118/19 features a cycle-by-cycle peak current limit. By monitoring the OCIF interrupt flag, custom overcurrent fault handling can be implemented.

To detect an output overcurrent, the MCP19118/19 senses the voltage drop across the high-side MOSFET while it is conducting. Leading edge blanking is incorporated to mask the overcurrent measurement for a given amount of time. This helps prevent false overcurrent readings.

When an output overcurrent is sensed, the OCIF flag is set and the high-side drive signal is immediately terminated. Without any custom overcurrent handling implemented, the high-side drive signal will be asserted high at the beginning of the next clock cycle. If the overcurrent condition still exists, the high-drive signal will again be terminated.

The OCIF interrupt flag must be cleared in software. However, if a subsequent switching cycle without an overcurrent condition has not occurred, hardware will immediately set the OCIF interrupt flag.

The OCCON register contains the bits used to configure both the output overcurrent limit and the amount of leading edge blanking (see Register 6-2).

The OCCON<OCEN> bit must be set to enable the input overcurrent circuitry.

Note:	The OCIF interrupt flag bit is set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable (GIE) bit in the INTCON register.

REGISTER 6-2: OCCON: OUTPUT OVERCURRENT CONTROL REGISTER

R/W-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
OCEN	OCLEB1	OCLEB0	OOC4	OOC3	OOC2	OOC1	OOC0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **OCEN:** Output Overcurrent DAC Control bit
1 = Output Overcurrent DAC is enabled
0 = Output Overcurrent DAC is disabled

bit 6-5 **OCLEB<1:0>:** Leading Edge Blanking
00 = 114 ns blanking
01 = 213 ns blanking
10 = 400 ns blanking
11 = 780 ns blanking

bit 4-0 **OOC<4:0>:** Output Overcurrent Configuration bits
00000 = 160 mV drop
00001 = 175 mV drop
00010 = 190 mV drop
00011 = 205 mV drop
00100 = 220 mV drop
00101 = 235 mV drop
00110 = 250 mV drop
00111 = 265 mV drop
01000 = 280 mV drop
01001 = 295 mV drop
01010 = 310 mV drop
01011 = 325 mV drop
01100 = 340 mV drop
01101 = 355 mV drop
01110 = 370 mV drop
01111 = 385 mV drop
10000 = 400 mV drop
10001 = 415 mV drop
10010 = 430 mV drop
10011 = 445 mV drop
10100 = 460 mV drop
10101 = 475 mV drop
10110 = 490 mV drop
10111 = 505 mV drop
11000 = 520 mV drop
11001 = 535 mV drop
11010 = 550 mV drop
11011 = 565 mV drop
11100 = 580 mV drop
11101 = 595 mV drop
11110 = 610 mV drop
11111 = 625 mV drop

6.3 Current Sense AC Gain

The current measured across the inductor is a square wave that is averaged by the capacitor (C_S) connected between $+I_{SEN}$ and $-I_{SEN}$. This very small voltage plus the ripple can be amplified by the current sense AC gain circuitry. The amount of gain is controlled by the CSGSCON register.

REGISTER 6-3: CSGSCON: CURRENT SENSE AC GAIN CONTROL REGISTER

U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	Reserved	Reserved	Reserved	CSGS3	CSGS2	CSGS1	CSGS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **Reserved**

bit 3-0 **CSGS<3:0>:** Current Sense AC Gain Setting bits

0000 = 0 dB
0001 = 1.0 dB
0010 = 2.5 dB
0011 = 4.0 dB
0100 = 5.5 dB
0101 = 7.0 dB
0110 = 8.5 dB
0111 = 10.0 dB
1000 = 11.5 dB
1001 = 13.0 dB
1010 = 14.5 dB
1011 = 16.0 dB
1100 = 17.5 dB
1101 = 19.0 dB
1110 = 20.5 dB
1111 = 22.0 dB

6.4 Current Sense DC Gain

DC gain can be added to the sensed inductor current to allow it to be read by the ADC. The amount of DC gain added is controlled by the CSDGCON register.

Adding DC gain to the current sense signal used by the control loop may also be needed in some multi-phase systems to account for device and component differences. The CSDGEN bit determines if the gained current sense signal is added back to the AC current signal (see Register 6-4). If the CSDGEN bit is cleared, DC gain can still be added but the gained signal is not added back to the AC current signal.

REGISTER 6-4: CSDGCON: CURRENT SENSE DC GAIN CONTROL REGISTER

R/W-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x
CSDGEN	—	—	—	Reserved	CSDG2	CSDG1	CSDG0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **CSDGEN:** Current Sense DC Gain Enable bit
1 = DC gain current sense signal used in control loop
0 = DC gain current sense signal only read by ADC

bit 6-4 **Unimplemented:** Read as ‘0’

bit 3 **Reserved**

bit 2-0 **CSDG<2:0>:** Current Sense DC Gain Setting bits
000 = 19.5 dB
001 = 21.8 dB
010 = 24.1 dB
011 = 26.3 dB
100 = 28.6 dB
101 = 30.9 dB
110 = 33.2 dB
111 = 35.7 dB

6.5 Voltage for Zero Current

In multi-phase systems, it may be necessary to provide some offset to the sensed inductor current. The VZCCON register can be used to provide a positive or negative offset in the sensed current. Typically, the VZCCON will be set to 0x80h, which corresponds to the sensed inductor current centered around 1.45V. However, by adjusting the VZCCON register, this centered voltage can be shifted up or down by approximately 3.28 mV per step.

REGISTER 6-5: VZCCON: VOLTAGE FOR ZERO CURRENT CONTROL REGISTER

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
VZC<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

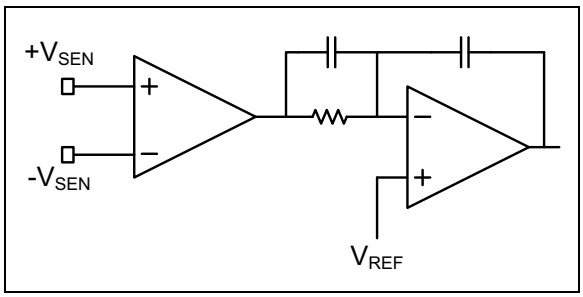
bit 7-0 **VZC<7:0>:** Voltage for Zero Current Setting bits

`00000000` = -420.00 mV Offset
`00000001` = -416.72 mV Offset
•
•
•
`10000000` = 0 mV Offset
•
•
•
`11111110` = +413.12 mV Offset
`11111111` = +416.40 mV Offset

6.6 Compensation Setting

The MCP19118/19 uses a peak current mode control architecture. A control reference is used to regulate the peak current of the converter directly. The inner current loop essentially turns the inductor into a voltage-controlled current source. This reduces the control-to-output transfer function to a simple single-pole model of a current source feeding a capacitor. The desired response of the overall loop can be tuned by proper placement of the compensation zero frequency and gain. Figure 6-1 shows a simplified drawing of the internal compensation. See Register 6-6 for the adjustable zero frequency and gain settings.

FIGURE 6-1: SIMPLIFIED COMPENSATION



REGISTER 6-6: CMPZCON: COMPENSATION SETTING CONTROL REGISTER

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
CMPZF3	CMPZF2	CMPZF1	CMPZF0	CMPZG3	CMPZG2	CMPZG1	CMPZG0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-4 **CMPZF<3:0>:** Compensation Zero Frequency Setting bits
0000 = 1500 Hz
0001 = 1850 Hz
0010 = 2300 Hz
0011 = 2840 Hz
0100 = 3460 Hz
0101 = 4300 Hz
0110 = 5300 Hz
0111 = 6630 Hz
1000 = 8380 Hz
1001 = 9950 Hz
1010 = 12200 Hz
1011 = 14400 Hz
1100 = 18700 Hz
1101 = 23000 Hz
1110 = 28400 Hz
1111 = 35300 Hz

bit 3-0 **CMPZG<3:0>:** Compensation Gain Setting bits
0000 = 36.15 dB
0001 = 33.75 dB
0010 = 30.68 dB
0011 = 28.43 dB
0100 = 26.10 dB
0101 = 23.81 dB
0110 = 21.44 dB
0111 = 19.10 dB
1000 = 16.78 dB
1001 = 14.32 dB
1010 = 12.04 dB
1011 = 9.54 dB
1100 = 7.23 dB
1101 = 4.61 dB
1110 = 2.28 dB
1111 = 0.00 dB

6.7 Slope Compensation

A negative voltage slope is added to the output of the error amplifier. This is done to prevent subharmonic instability when:

1. the operating duty cycle is greater than 50%
2. wide changes in the duty cycle occur.

The amount of negative slope added to the error amplifier output is controlled by Register 6-7.

The slope compensation is enabled by setting the ABECON<SLCPBY> bit.

REGISTER 6-7: SLPCRCON: SLOPE COMPENSATION RAMP CONTROL REGISTER

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
SLPG3	SLPG2	SLPG1	SLPG0	SLPS3	SLPS2	SLPS1	SLPS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-4 **SLPG<3:0>:** Slope Compensation Amplitude Configuration bits
0000 = 0.017 V_{PK-PK}, measured for 50% duty cycle waveform
0001 = 0.022 V_{PK-PK}, measured for 50% duty cycle waveform
0010 = 0.030 V_{PK-PK}, measured for 50% duty cycle waveform
0011 = 0.040 V_{PK-PK}, measured for 50% duty cycle waveform
0100 = 0.053 V_{PK-PK}, measured for 50% duty cycle waveform
0101 = 0.070 V_{PK-PK}, measured for 50% duty cycle waveform
0110 = 0.094 V_{PK-PK}, measured for 50% duty cycle waveform
0111 = 0.125 V_{PK-PK}, measured for 50% duty cycle waveform
1000 = 0.170 V_{PK-PK}, measured for 50% duty cycle waveform
1001 = 0.220 V_{PK-PK}, measured for 50% duty cycle waveform
1010 = 0.300 V_{PK-PK}, measured for 50% duty cycle waveform
1011 = 0.400 V_{PK-PK}, measured for 50% duty cycle waveform
1100 = 0.530 V_{PK-PK}, measured for 50% duty cycle waveform
1101 = 0.700 V_{PK-PK}, measured for 50% duty cycle waveform
1110 = 0.940 V_{PK-PK}, measured for 50% duty cycle waveform
1111 = 1.250 V_{PK-PK}, measured for 50% duty cycle waveform

bit 3-0 **SLPS<3:0>:** Slope Compensation $\Delta V/\Delta t$ Configuration bits

6.7.1 SLPS<3:0> CONFIGURATION

The SLPS<3:0> bits directly control the $\Delta V/\Delta t$ of the added ramp. This byte should be set proportional to the switching frequency according to the following equation:

EQUATION 6-1:

Where:

F_{SW} = Device switching frequency
n = Decimal equivalent of SLPS<3:0>

6.7.2 SLPG<3:0> CONFIGURATION

The SLPG<3:0> bits control the amplitude of the added ramp. The values listed above correspond to a 50% duty cycle waveform and are true only if the SLPS<3:0> bits are set according to Equation 6-1. If less amplitude is required, the SLPS<3:0> bits can be adjusted to a lower switching frequency.

6.8 MASTER Error Signal Gain

When operating in a multi-phase system, the output of the MASTER's error amplifier is used by all SLAVE devices as their control signal. It is important to balance the current in all phases to maintain a uniform temperature across all phases. Component tolerances make this balancing difficult. Each SLAVE device has the ability to gain or attenuate the MASTER error signal depending upon the settings in the SLVGNCON register.

Note: The SLVGNCON register is configured in the multi-phase SLAVE device.

REGISTER 6-8: SLVGNCON: MASTER ERROR SIGNAL INPUT GAIN CONTROL REGISTER

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	—	SLVGN<4:0>				
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **SLVGN<4:0>:** MASTER Error Signal Gain bits

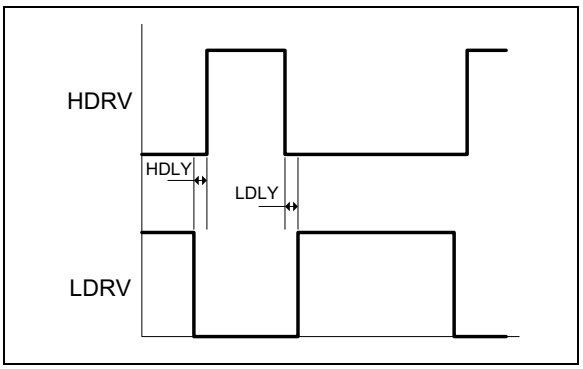
00000 = -3.3 dB
00001 = -3.1 dB
00010 = -2.9 dB
00011 = -2.7 dB
00100 = -2.5 dB
00101 = -2.3 dB
00110 = -2.1 dB
00111 = -1.9 dB
01000 = -1.7 dB
01001 = -1.4 dB
01010 = -1.2 dB
01011 = -1.0 dB
01100 = -0.8 dB
01101 = -0.6 dB
01110 = -0.4 dB
01111 = -0.2 dB
10000 = 0.0 dB
10001 = 0.2 dB
10010 = 0.4 dB
10011 = 0.7 dB
10100 = 0.9 dB
10101 = 1.1 dB
10110 = 1.3 dB
10111 = 1.5 dB
11000 = 1.7 dB
11001 = 1.9 dB
11010 = 2.1 dB
11011 = 2.3 dB
11100 = 2.6 dB
11101 = 2.8 dB
11110 = 3.0 dB
11111 = 3.2 dB

6.9 MOSFET Driver Programmable Dead Time

The turn-on delay of the high-side and low-side drive signals can be configured independently to allow different MOSFETs and circuit board layouts to be used to construct an optimized system. See Figure 6-2.

Setting the PE1<HDLYBY> and PE1<LDLYBY> bits enables the high-side and low-side delay, respectively. The amount of delay added is controlled in the DEADCON register. See Register 6-9 for more information.

FIGURE 6-2: MOSFET DRIVER DEAD TIME



REGISTER 6-9: DEADCON: DRIVER DEAD TIME CONTROL REGISTER

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
HDLY3	HDLY2	HDLY1	HDLY0	LDLY3	LDLY2	LDLY1	LDLY0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-4 **HDLY<3:0>:** High-Side Dead Time Configuration bits
0000 = 11 ns delay
0001 = 15 ns delay
0010 = 19 ns delay
0011 = 23 ns delay
0100 = 27 ns delay
0101 = 31 ns delay
0110 = 35 ns delay
0111 = 39 ns delay
1000 = 43 ns delay
1001 = 47 ns delay
1010 = 51 ns delay
1011 = 55 ns delay
1100 = 59 ns delay
1101 = 63 ns delay
1110 = 67 ns delay
1111 = 71 ns delay

bit 3-0 **LDLY<3:0>:** Low-Side Dead Time Configuration bits
0000 = 4 ns delay
0001 = 8 ns delay
0010 = 12 ns delay
0011 = 16 ns delay
0100 = 20 ns delay
0101 = 24 ns delay
0110 = 28 ns delay
0111 = 32 ns delay
1000 = 36 ns delay
1001 = 40 ns delay
1010 = 44 ns delay
1011 = 48 ns delay
1100 = 52 ns delay
1101 = 56 ns delay
1110 = 60 ns delay
1111 = 64 ns delay

6.10 Output Voltage Configuration

Two registers control the error amplifier reference voltage. The reference is coarsely set in 15 mV steps and then finely adjusted in 0.82 mV steps above the coarse setting (see Registers 6-10 and 6-11). Higher output voltages can be achieved by using a voltage divider connected between the output and the $+V_{SEN}$ pin. Care must be taken to ensure maximum voltage rating compliance on all pins.

Note: The OVFCON<VOUTEN> bit must be set to enable the output voltage setting registers.

REGISTER 6-10: OVCCON: OUTPUT VOLTAGE SET POINT COARSE CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
OVC<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **OVC<7:0>:** Output Voltage Set Point Coarse Configuration bits
OVC<7:0> = (V_{OUT}/0.0158) – 1(1)

Note 1: The units for the OVC<7:0> equation are volts.

REGISTER 6-11: OVFCON: OUTPUT VOLTAGE SET POINT FINE CONTROL REGISTER

R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
VOUTEN	—	—	OVF<4:0>				
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **VOUTEN:** Output Voltage DAC Enable bit
1 = Output Voltage DAC is enabled
0 = Output Voltage DAC is disabled

bit 6-5 **Unimplemented:** Read as '0'

bit 4-0 **OVF<4:0>:** Output Voltage Set Point Fine Configuration bits
OVF<4:0> = ($V_{OUT} – V_{OUT\_COARSE}$)/0.0008(1)

Note 1: The units for the OVF<4:0> equation are volts.

6.11 Output Undervoltage

The output voltage is monitored and, when it is below the output undervoltage threshold, the UVIF flag is set. This flag must be cleared in software. See **Section 15.3.1.4 "PIR2 Register"** for more information.

The output undervoltage threshold is controlled by the OUVCON register.

REGISTER 6-12: OUVCON: OUTPUT UNDERVOLTAGE DETECT LEVEL CONTROL REGISTER

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
OUV<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **OUV<7:0>:** Output Undervoltage Detect Level Configuration bits

$OUV<7:0> = (V_{OUT\_UV\_Detect\_Level})/0.015$ (1)

Note 1: The units for the OUV<7:0> equation are volts.

6.12 Output Overvoltage

The output voltage is monitored and, when it is above the output overvoltage threshold, the OVIF flag is set. This flag must be cleared in software. See **Section 15.3.1.4 "PIR2 Register"** for more information.

The output overvoltage threshold is controlled by the OOVCON register.

REGISTER 6-13: OOVCON: OUTPUT OVERVOLTAGE DETECT LEVEL CONTROL REGISTER

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
OOV<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **OOV<7:0>:** Output Overvoltage Detect Level Configuration bits

$OOV<7:0> = (V_{OUT\_OV\_Detect\_Level})/0.015$ (1)

Note 1: The units for the OOV<7:0> equation are volts.

6.13 Analog Peripheral Control

The MCP19118/19 has various analog peripherals. These peripherals can be configured to allow customizable operation. Refer to Register 6-14 for more information.

6.13.1 DIODE EMULATION MODE

The MCP19118/19 can operate in either Diode Emulation or Synchronous Rectification mode. When operating in Diode Emulation mode, the LDRV signal is terminated when the voltage across the low-side MOSFET is approximately 0V. This condition is true when the inductor current reaches approximately 0A. Both the HDRV and LDRV signals are low until the beginning of the next switching cycle. At that time, the HDRV signal is asserted high, turning on the high-side MOSFET.

When operating in Synchronous Rectification mode, the LDRV signal is held high until the beginning of the next switching cycle. At that time, the HDRV signal is asserted high, turning on the high-side MOSFET.

The PE1<DECON> bit controls the operating mode of the MCP19118/19.

6.13.2 HIGH-SIDE DRIVE STRENGTH

The peak source and sink current of the high-side driver can be configured to be either 1A source/sink or 2A source/sink. The PE1<DVRSTR> bit determines the high-side drive strength.

6.13.3 MOSFET DRIVER DEAD TIME

As described in **Section 6.9 "MOSFET Driver Programmable Dead Time"**, the MOSFET driver dead time can be adjusted. In order to enable dead time settings, the proper bypass bits must be cleared. PE1<HDLYBY> and PE1<LDLYBY> control the delay circuits. Clearing the respective bits allows the dead time programmed by the DEADCON register to be added to the appropriate turn-on edge.

6.13.4 OUTPUT VOLTAGE SENSE PULL-UP/PULL-DOWN

A high-impedance pull-up on the $+V_{SEN}$ pin can be configured by setting the PE1<PUEN> bit. When set, the $+V_{SEN}$ pin is internally pulled-up to V_{DD}.

A high-impedance pull-down on the $-V_{SEN}$ can be configured by setting the PE1<PDEN> bit. When set, the $-V_{SEN}$ pin is internally pulled-down to ground.

6.13.5 OUTPUT UNDERVOLTAGE ACCELERATOR

The MCP19118/19 has additional control circuitry to allow it to respond quickly to an output undervoltage condition. The enabling of this circuitry is handled by the PE1<UVTEE> bit. When this bit is set, the MCP19118/19 will respond to an output undervoltage condition by setting both the HDRV and LDRV signals low and turning off both the high-side and low-side MOSFETs.

6.13.6 OUTPUT OVERVOLTAGE ACCELERATOR

The MCP19118/19 has additional control circuitry to allow it to respond quickly to an output overvoltage condition. The enabling of this circuitry is handled by the PE1<OVTEE> bit. When this bit is set, the MCP19118/19 will respond to an output overvoltage condition by setting both the HDRV and LDRV signals low and turning off both the high-side and low-side MOSFETs.

REGISTER 6-14: PE1: ANALOG PERIPHERAL ENABLE 1 CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
DECON	DVRSTR	HDLYBY	LDLYBY	PDEN	PUEN	UVTEE	OVTEE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **DECON:** Diode Emulation Mode bit
1 = Diode Emulation mode enabled
0 = Synchronous Rectification mode enabled

bit 6 **DVRSTR:** High-Side Drive Strength Configuration bit
1 = High-side 1A source/sink drive strength
0 = High-side 2A source/sink drive strength

bit 5 **HDLYBY:** High-Side Dead Time Bypass bit
1 = High-side dead time bypass is enabled
0 = High-side dead time bypass is disabled

bit 4 **LDLYBY:** Low-Side Dead Time Bypass bit
1 = Low-side dead time bypass is enabled
0 = Low-side dead time bypass is disabled

bit 3 **PDEN:** $-V_{SEN}$ Weak Pull-Down Enable bit
1 = $-V_{SEN}$ weak pull-down is enabled
0 = $-V_{SEN}$ weak pull-down is disabled

bit 2 **PUEN:** $+V_{SEN}$ Weak Pull-Up Enable bit
1 = $+V_{SEN}$ weak pull-up is enabled
0 = $+V_{SEN}$ weak pull-up is disabled

bit 1 **UVTEE:** Output Undervoltage Accelerator Enable bit
1 = Output undervoltage accelerator is enabled
0 = Output undervoltage accelerator is disabled

bit 0 **OVTEE:** Output Overvoltage Accelerator Enable bit
1 = Output overvoltage accelerator is enabled
0 = Output overvoltage accelerator is disabled

6.14 Analog Blocks Enable Control

Various analog circuit blocks can be enabled or disabled, as shown in Register 6-15. Additional enable bits are located in the ATSTCON register.

6.14.1 OUTPUT OVERVOLTAGE ENABLE

The output overvoltage is enabled by setting the ABECON<OVDCEN> bit. Clearing this bit will disable the output overvoltage circuitry and cause the setting in the OOVCON register to be ignored.

6.14.2 OUTPUT UNDERVOLTAGE ENABLE

The output undervoltage is enabled by setting the ABECON<UVDCEN> bit. Clearing this bit will disable the output undervoltage circuitry and cause the setting in the OUVCON register to be ignored.

6.14.3 RELATIVE EFFICIENCY MEASUREMENT CONTROL

Section 10.0 "Relative Efficiency Measurement" describes the procedure used to measure the relative efficiency of the system. Setting the ABECON<MEASEN> bit initiates the relative measurement.

6.14.4 SLOPE COMPENSATION CONTROL

The slope compensation described in Register 6-7 can be bypassed by setting the ABECON<SLCPBY> bit. Under normal operation, this bit will always be set.

6.14.5 CURRENT MEASUREMENT CONTROL

The peak current measurement circuitry is controlled by the ABECON<CRTMEN> bit. Setting this bit enables the current measurement circuitry. Under normal operation, this bit will be set.

6.14.6 INTERNAL TEMPERATURE MEASUREMENT CONTROL

The internal temperature of the silicon can be measured with the ADC. To enable the internal temperature measurement circuitry, the ABECON<TMPSEN> bit must be set.

6.14.7 RELATIVE EFFICIENCY CIRCUITY CONTROL

Section 10.0 "Relative Efficiency Measurement" describes the procedure used to measure the relative efficiency of the system. Setting the ABECON<RECIREN> bit enables the relative efficiency measurement circuitry.

6.14.8 SIGNAL CHAIN CONTROL

Setting the ABECON<PATHEN> bit enables the voltage control path. Under normal operation, this bit is set.

REGISTER 6-15: ABECON: ANALOG BLOCK ENABLE CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
OVDCEN	UVDCEN	MEASEN	SLCPBY	CRTMEN	TMPSEN	RECIREN	PATHEN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **OVDCEN:** Output overvoltage DAC control bit
1 = Output overvoltage DAC is enabled
0 = Output overvoltage DAC is disabled

bit 6 **UVDCEN:** Output undervoltage DAC control bit
1 = Output undervoltage DAC is enabled
0 = Output undervoltage DAC is disabled

bit 5 **MEASEN:** Relative efficiency measurement control bit
1 = Initiate relative efficiency measurement
0 = Relative efficiency measurement not in progress

bit 4 **SLCPBY:** Slope compensation bypass control bit
1 = Slope compensation is disabled
0 = Slope compensation is enabled

bit 3 **CRTMEN:** Current measurement circuitry control bit
1 = Current measurement circuitry is enabled
0 = Current measurement circuitry is disabled

bit 2 **TMPSEN:** Internal temperature sensor control bit
1 = Internal temperature sensor circuitry is enabled
0 = Internal temperature sensor circuitry is disabled

bit 1 **RECIREN:** Relative efficiency circuitry control bit
1 = Relative efficiency measurement circuitry is enabled
0 = Relative efficiency measurement circuitry is disabled

bit 0 **PATHEN:** Signal chain circuitry control bit
1 = Signal chain circuitry is enabled
0 = Signal chain circuitry is disabled

7.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore, outside the warranted range.

Note: Unless otherwise indicated, V_{IN} = 12V, F_{SW} = 300 kHz, T_A = +25°C.

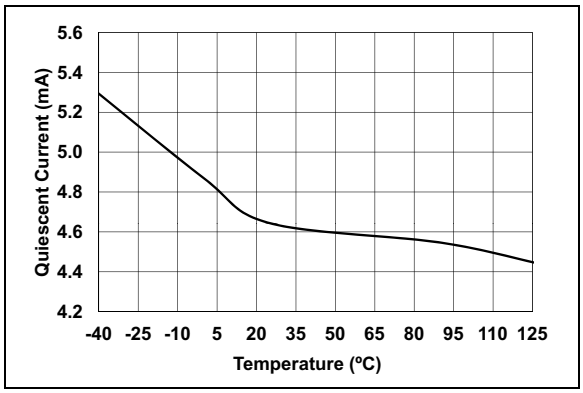


FIGURE 7-1: *I_Q vs. Temperature.*

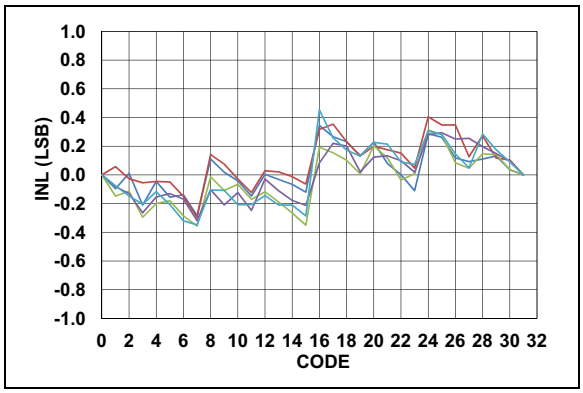


FIGURE 7-4: *OVFCON DAC INL vs. Code and Temperature (-40°C to +125°C).*

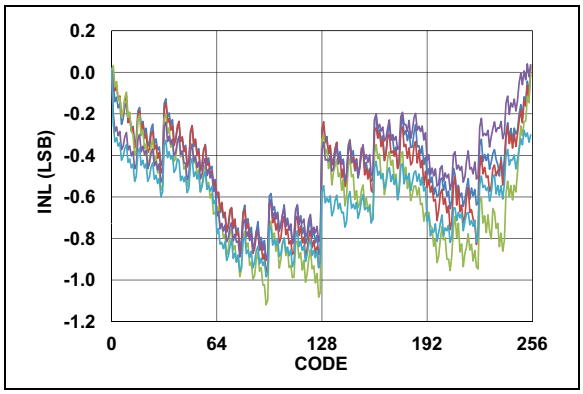


FIGURE 7-2: *OVCCON DAC INL vs. Code and Temperature (-40°C to +125°C).*

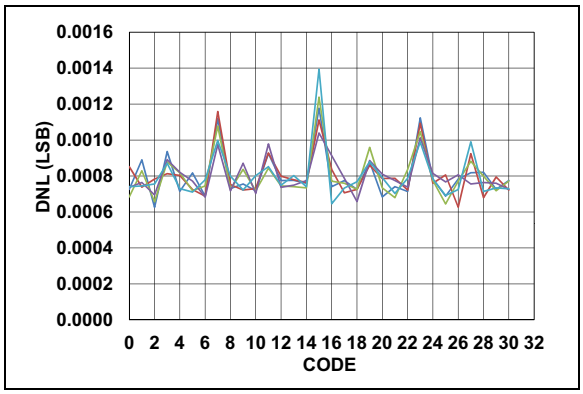


FIGURE 7-5: *OVFCON DAC DNL vs. Code and Temperature (-40°C to +125°C).*

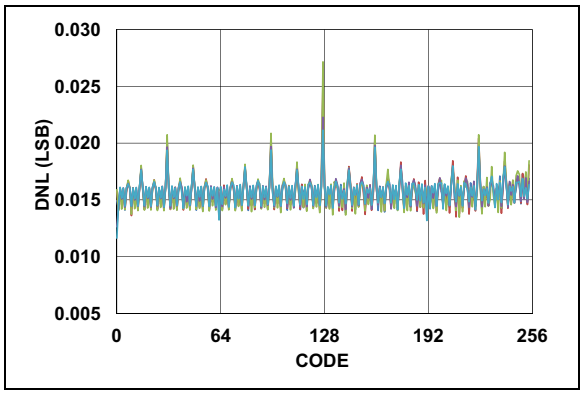


FIGURE 7-3: *OVCCON DAC DNL vs. Code and Temperature (-40°C to +125°C).*

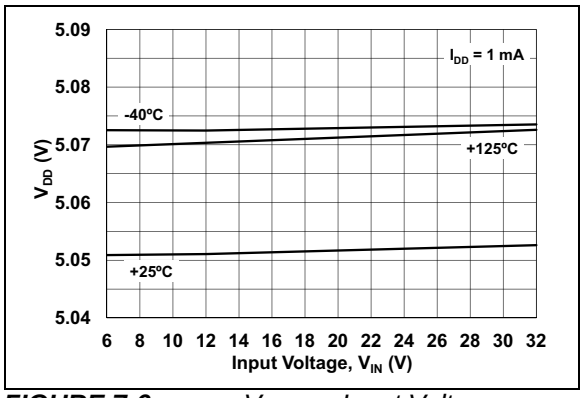


FIGURE 7-6: *V_{DD} vs. Input Voltage.*

Note: Unless otherwise indicated, V_{IN} = 12V, F_{SW} = 300 kHz, T_A = +25°C.

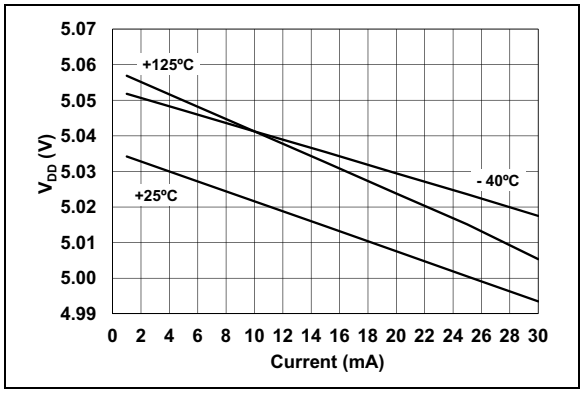


FIGURE 7-7: *V_{DD} vs. Output Current.*

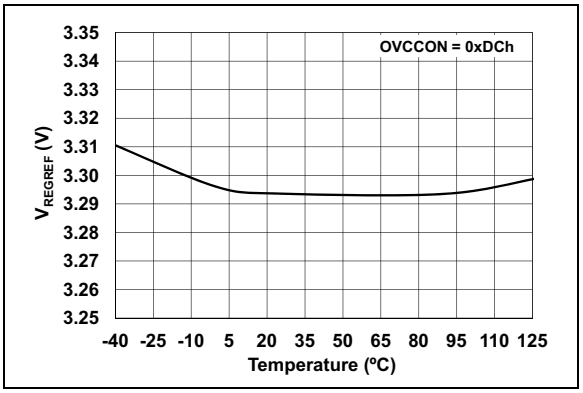


FIGURE 7-10: *V_{REGREF} vs. Temperature (V_{REGREF} = 3.3V).*

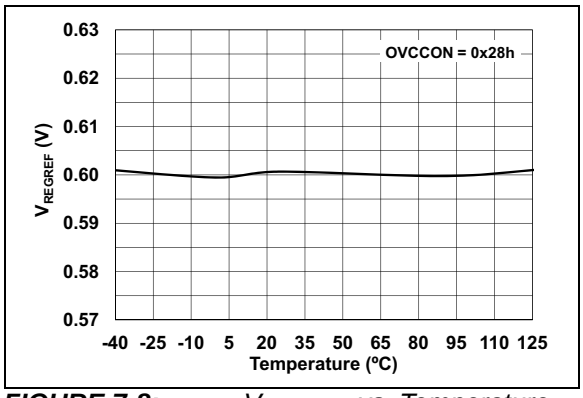


FIGURE 7-8: *V_{REGREF} vs. Temperature (V_{REGREF} = 0.6V).*

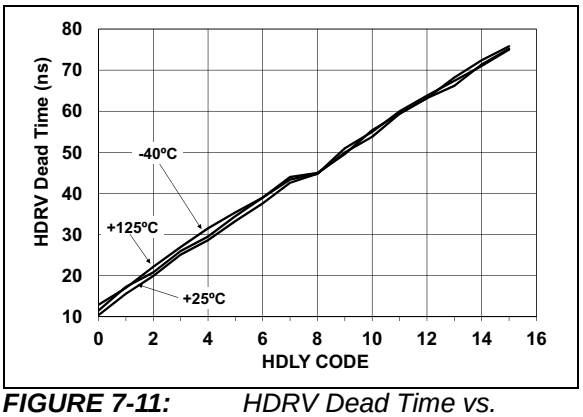


FIGURE 7-11: *HDRV Dead Time vs. HDLY Code.*

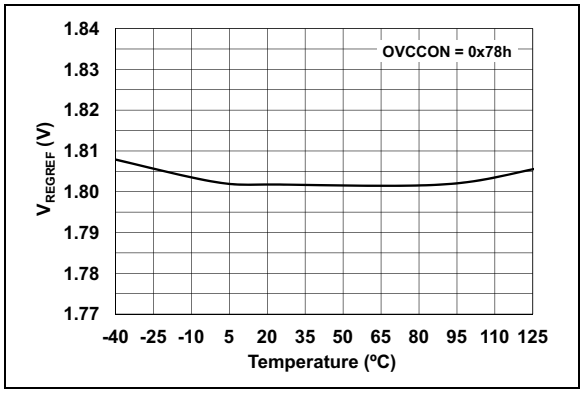


FIGURE 7-9: *V_{REGREF} vs. Temperature (V_{REGREF} = 1.8V).*

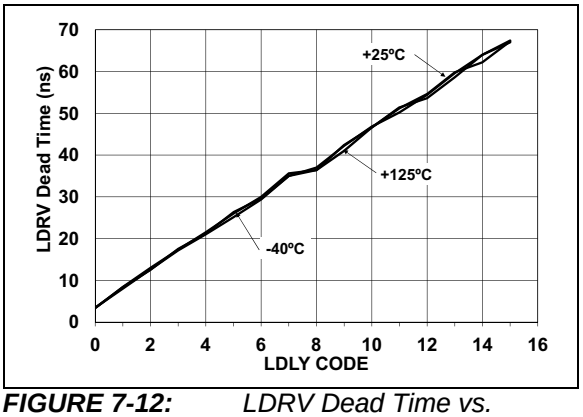


FIGURE 7-12: *LDRV Dead Time vs. LDLY Code.*

Note: Unless otherwise indicated, V_{IN} = 12V, F_{SW} = 300 kHz, T_A = +25°C.

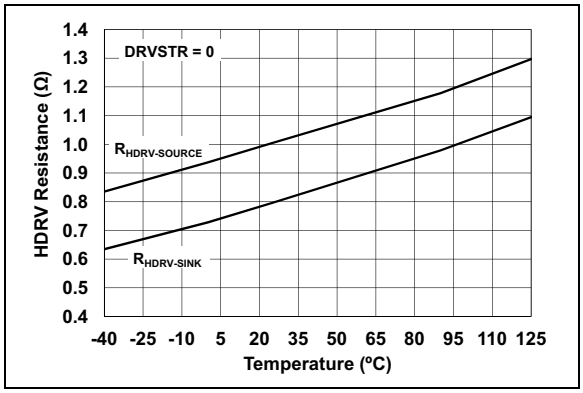


FIGURE 7-13: *HDRV R_{DSon} vs. Temperature.*

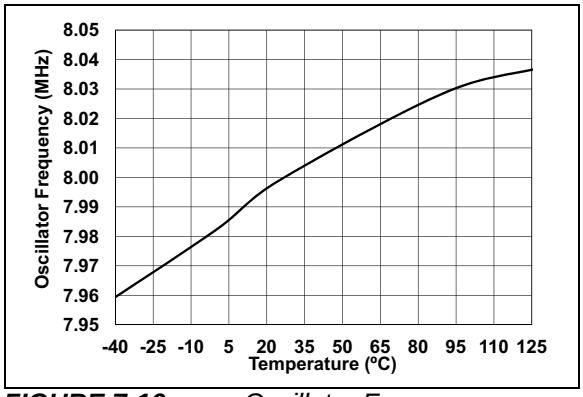


FIGURE 7-16: *Oscillator Frequency vs. Temperature.*

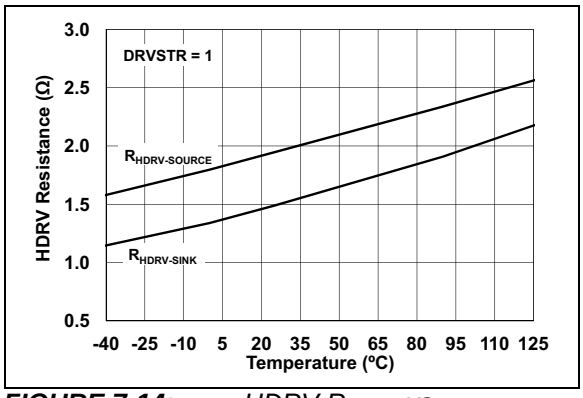


FIGURE 7-14: *HDRV R_{DSon} vs. Temperature.*

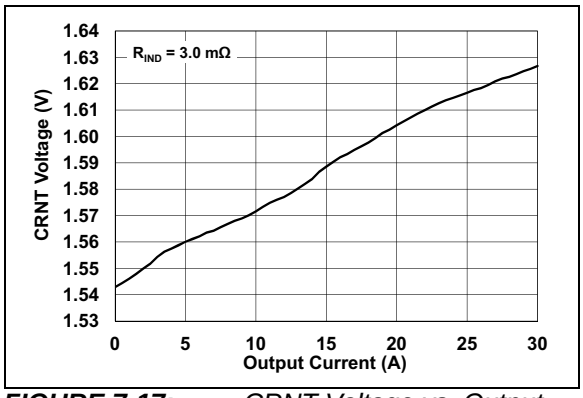


FIGURE 7-17: *CRNT Voltage vs. Output Current.*

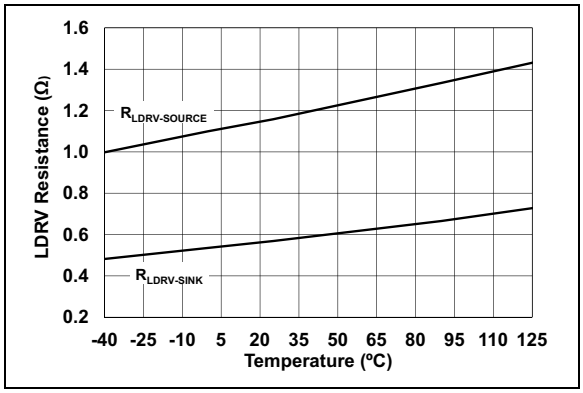


FIGURE 7-15: *LDRV R_{DSon} vs. Temperature.*

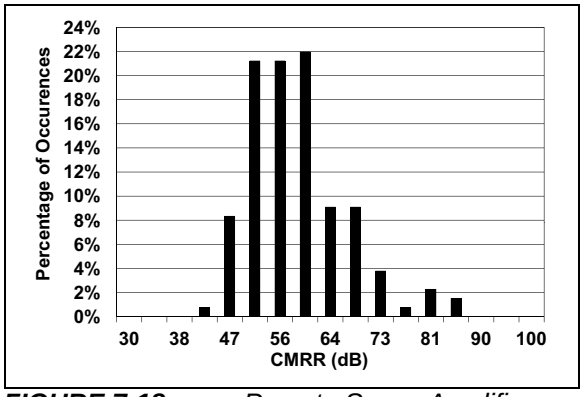


FIGURE 7-18: *Remote Sense Amplifier CMRR.*

NOTES:

8.0 SYSTEM BENCH TESTING

To allow for easier system design and bench testing, the MCP19118/19 family of devices features a multiplexer used to output various internal analog signals. These signals can be measured on the GPA0 pin through a unity gain buffer. The configuration control of the GPA0 pin is found in the ATSTCON register.

Control of the signals present at the output of the unity gain buffer is found in the BUFFCON register.

8.1 Analog Bench Test Control

8.1.1 ATSTCON REGISTER

The ATSTCON register contains the bits used to disable the MOSFET drivers and configure the GPA0 pin as the unity gain buffer out.

Note 1:	The DRVDIS bit is reset to '1' so the high-side and low-side drivers are in a known state after reset. This bit must be cleared by software for normal operation.
2:	For proper operation, bit 7 must always be set to '1'.

REGISTER 8-1: ATSTCON: ANALOG BENCH TEST CONTROL REGISTER

R/W-1	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-1
Reserved	—	—	Reserved	HIDIS	LODIS	BNCHEN	DRVDIS
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **Reserved:** Bit 7 must always be set to '1'.

bit 6-5 **Unimplemented:** Read as '0'

bit 4 **Reserved**

bit 3 **HIDIS:** High-side driver control bit
1 = High-side driver is disabled
0 = High-side driver is enabled

bit 2 **LODIS:** Low-side driver control bit
1 = Low-side driver is disabled
0 = Low-side driver is enabled

bit 1 **BNCHEN:** GPA0 bench test configuration control bit
1 = GPA0 is configured for analog bench test output
0 = GPA0 is configured for normal operation

bit 0 **DRVDIS:** MOSFET driver disable control bit
1 = High-side and low-side drivers are set low, PHASE pin is floating
0 = High-side and low-side drivers are set for normal operation

8.2 Unity Gain Buffer

The unity gain buffer module is used during a multi-phase application and while operating in Bench Test mode.

When the ATSTCON<BNCHEN> bit is set, the device is in Bench Test mode and the ASEL<4:0> bits in the BUFFCON register determine which internal analog signal can be measured on the GPA0 pin.

When measuring signals with the unity gain buffer, the buffer offset must be added to the measured signal. The factory-measured buffer offset can be read from memory location 2087h. Refer to **Section 11.1.1 "Reading Program Memory as Data"** for more information.

REGISTER 8-2: BUFFCON: UNITY GAIN BUFFER CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
MLTPH2	MLTPH1	MLTPH0	ASEL4	ASEL3	ASEL2	ASEL1	ASEL0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5 **MLTPH<2:0>:** System configuration bits
000 = Device set as stand-alone unit
001 = Device set as multiple output MASTER
010 = Device set as multiple output SLAVE
011 = Device set as multi-phase MASTER
100 = Device set as multi-phase SLAVE

bit 4-0 **ASEL<4:0>:** Multiplexer output control bit
00000 = Voltage proportional to current in the inductor
00001 = Error amplifier output plus slope compensation, input to PWM comparator
00010 = Input to slope compensation circuitry
00011 = Band gap reference
00100 = Output voltage reference
00101 = Output voltage after internal differential amplifier
00110 = Unimplemented
00111 = Voltage proportional to the internal temperature
01000 = Internal ground for current sense circuitry, see **Section 6.5 "Voltage for Zero Current"**
01001 = Output overvoltage comparator reference
01010 = Output undervoltage comparator reference
01011 = Error amplifier output
01100 = For a multi-phase SLAVE, error amplifier signal received from MASTER
01101 = For multi-phase SLAVE, error signal received from MASTER with gain, see **Section 6.8 "MASTER Error Signal Gain"**
01110 = V_{IN} divided down by 1/13
01111 = DC inductor valley current
10000 = Unimplemented
•
•
•
11100 = Unimplemented
11101 = Overcurrent reference
11110 = Unimplemented
11111 = Unimplemented

9.0 DEVICE CALIBRATION

Read-only memory locations 2080h through 208Fh contain factory calibration data. Refer to **Section 18.0 "Flash Program Memory Control"** for information on how to read from these memory locations.

9.1 Calibration Word 1

The DOV<3:0> bits at memory location 2080h set the offset calibration for the output voltage remote sense differential amplifier. Firmware must read these values and write them to the DOVCAL register for proper calibration.

The FCAL<6:0> bits at memory location 2080h set the internal oscillator calibration. Firmware must read these values and write them to the OSCCAL register for proper calibration.

REGISTER 9-1: CALWD1: CALIBRATION WORD 1 REGISTER

U-0	U-0	R/P-1	R/P-1	R/P-1	R/P-1
—	—	DOV<3:0>			
bit 13					bit 8

U-0	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
—	FCAL<6:0>						
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13-12 **Unimplemented:** Read as '0'

bit 11-8 **DOV<3:0>:** Output voltage remote sense differential amplifier offset calibration bits

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **FCAL<6:0>:** Internal oscillator calibration bits

9.2 Calibration Word 2

The VRO<3:0> bits at memory location 2081h calibrate the offset of the buffer amplifier of the output voltage regulation reference set point. This effectively changes the band gap reference. Firmware must read these values and write them to the VROCAL register for proper calibration.

The BGR<3:0> bits at memory location 2081h calibrate the internal band gap. Firmware must read these values and write them to the BGRCAL register for proper calibration.

REGISTER 9-2: CALWD2: CALIBRATION WORD 2 REGISTER

U-0	U-0	R/P-1	R/P-1	R/P-1	R/P-1
—	—	VRO<3:0>			
bit 13					bit 8

U-0	U-0	U-0	U-0	R/P-1	R/P-1	R/P-1	R/P-1
—	—	—	—	BGR<3:0>			
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 13-12 **Unimplemented:** Read as ‘0’

bit 11-8 **VRO<3:0>:** Reference voltage offset calibration bits

bit 7-4 **Unimplemented:** Read as ‘0’

bit 3-0 **BGR<3:0>:** Internal band gap calibration bits

9.3 Calibration Word 3

The TTA<3:0> bits at memory location 2082h calibrate the overtemperature shutdown threshold point. Firmware must read these values and write them to the TTACAL register for proper calibration.

The ZRO<3:0> bits at memory location 2082h calibrate the offset of the error amplifier. Firmware must read these values and write them to the ZROCAL register for proper calibration.

REGISTER 9-3: CALWD3: CALIBRATION WORD 3 REGISTER

U-0	U-0	R/P-1	R/P-1	R/P-1	R/P-1
—	—	TTA<3:0>			
bit 13					bit 8

U-0	U-0	U-0	U-0	R/P-1	R/P-1	R/P-1	R/P-1
—	—	—	—	ZRO<3:0>			
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 13-12 **Unimplemented:** Read as ‘0’

bit 11-8 **TTA<3:0>:** Overtemperature shutdown threshold calibration bits

bit 7-4 **Unimplemented:** Read as ‘0’

bit 3-0 **ZRO<3:0>:** Error amplifier offset voltage calibration bits

9.4 Calibration Word 4 and Calibration Word 5

The data stored in the CALWD4 and CALWD5 registers can be used by firmware to provide a more accurate internal temperature sensor ADC reading. The coefficients for a straight line equation can be generated by manipulation of the values stored in these calibration words. These calibration words contain all gains and offsets associated with reading the input voltage with the internal ADC.

9.4.1 CALWD4: INTERNAL TEMPERATURE READING GAIN TERM

The CALWD4 register is located at program memory location 2083h and represents the coefficient, Z, used in Equation 9-1. This coefficient is used to calculate the gain of the internal temperature reading by the ADC.

EQUATION 9-1: CALCULATING GAIN

$$m = Z \times 2^N$$

Where:

m = gain
Z = 14-bit integer
N = 12

9.4.2 CALWD5: INTERNAL TEMPERATURE READING OFFSET VOLTAGE TERM

The CALWD5 register is located at program memory location 2084h and represents the coefficient, W, used in Equation 9-2. This coefficient is used to calculate the offset voltage of the internal temperature reading by the ADC.

EQUATION 9-2: CALCULATING OFFSET VOLTAGE

$$b = W \times 2^N$$

Where:

b = offset voltage
W = 14-bit two's complement integer
N = 4

REGISTER 9-4: CALWD4: CALIBRATION WORD 4 REGISTER

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
TANAM<13:8>					
bit 13					bit 8

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
TANAM<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13-0 **TANAM<13:0>:** Coefficient used to find the gain when reading the internal temperature with the ADC

REGISTER 9-5: CALWD5: CALIBRATION WORD 5 REGISTER

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
TANAI<13:8>					
bit 13					bit 8

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
TANAI<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13-0 **TANAI<13:0>:** Coefficient used to find the offset voltage when reading the internal temperature with the ADC

9.5 Calibration Word 6 and Calibration Word 7

The MCP19118/19 has the ability to read and report the system input voltage. Firmware can be written that uses the data stored in the CALWD6 and CALWD7 registers to improve the accuracy of this voltage reading. These calibration words contain the gain and offset voltage associated with reading the input voltage with ADC.

9.5.1 CALWD6: INPUT VOLTAGE READING GAIN TERM

The data stored in the CALWD6 register at program memory location 2085h is an 8-bit number that represents the coefficient, Z, used in Equation 9-3. This coefficient is used to calculate the gain of the input voltage ADC reading circuitry.

EQUATION 9-3: CALCULATING INPUT VOLTAGE READING GAIN

$$m = \frac{1}{Z} \times 2^N$$

Where:

m = gain
Z = 8-bit integer
N = 11

9.5.2 CALWD7: INPUT VOLTAGE READING OFFSET VOLTAGE

The data stored in the CALWD7 register at program memory location 2086h is an 8-bit two's complement integer that represents the offset voltage of the input voltage reading circuitry.

REGISTER 9-6: CALWD6: CALIBRATION WORD 6 REGISTER

U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—
bit 13					bit 8

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
GIVAN<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13-8 **Unimplemented:** Read as '0'

bit 7-0 **GIVAN<7:0>:** Reading input voltage gain term

REGISTER 9-7: CALWD7: CALIBRATION WORD 7 REGISTER

U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—
bit 13					bit 8

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
VOIVAN<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13-8 **Unimplemented:** Read as '0'

bit 7-0 **VOIVAN<7:0>:** Reading input voltage offset voltage term

9.6 Calibration Word 8

The BUFF<7:0> bits at memory location 2087h represent the offset voltage of the unity gain buffer in millivolts. This is an 8-bit two's complement number. The MSB is the sign bit. If the MSB is set to 1, the resulting number is negative.

REGISTER 9-8: CALWD8: CALIBRATION WORD 8 REGISTER

U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—
bit 13					bit 8

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
BUFF<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13-8 **Unimplemented:** Read as '0'

bit 7-0 **BUFF<7:0>:** Unity gain buffer offset voltage calibration bits

9.7 Calibration Word 9 and Calibration Word 10

The information stored in the CALWD9 and CALWD10 registers can be used by firmware to remove the offset and gain of the output differential amplifier. The coefficients for a straight line equation can be generated by using the values stored in these calibration words.

9.7.1 CALWD9: DIFFERENTIAL AMPLIFIER GAIN TERM

The data stored in the CALWD9 register at program memory location 2088h represents the coefficient, Z, used in Equation 9-4. This coefficient is used to calculate the gain of the differential amplifier.

EQUATION 9-4: CALCULATING GAIN

$$G = Z \times 2^N$$

Where:

G = differential amplifier gain
Z = 14-bit integer
N = -12

9.7.2 CALWD10: DIFFERENTIAL AMPLIFIER OFFSET VOLTAGE TERM

The data stored in the CALWD10 register at program memory location 2089h represents the coefficient, V, used in Equation 9-5. This coefficient is used to calculate the offset voltage of the differential amplifier.

EQUATION 9-5: CALCULATING OFFSET VOLTAGE

$$VOS = V \times 2^N$$

Where:

VOS = differential amplifier offset
V = 14-bit integer
N = -12

REGISTER 9-9: CALWD9: CALIBRATION WORD 9 REGISTER

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
DAGN<13:8>					
bit 13					bit 8

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
DAGN<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13-0 **DAGN<13:0>:** Differential amplifier gain calibration bits

REGISTER 9-10: CALWD10: CALIBRATION WORD 10 REGISTER

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
DAI<13:8>					
bit 13					bit 8

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
DAI<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13-0 **DAI<13:0>:** Differential amplifier offset voltage calibration bits

9.8 Calibration Word 11 and Calibration Word 12

The information stored in the CALWD11 and CALWD12 registers can be used by firmware to remove the offset and gain of ADC measurements.

9.8.1 CALWD11: ADC GAIN TERM

The data stored in the CALWD11 register at program memory location 208Ah represents the gain of the ADC.

9.8.2 CALWD12: ADC OFFSET VOLTAGE TERM

The data stored in the CALWD12 register at program memory location 208Bh is a two's complement number that is used by Equation 9-6 to calculate the offset voltage of the ADC.

EQUATION 9-6: CALCULATING ADC OFFSET VOLTAGE

$$b = W \times 2^N$$

Where:

b = ADC offset
W = Two's complement 14-bit integer
N = 6

REGISTER 9-11: CALWD11: CALIBRATION WORD 11 REGISTER

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
GADC<13:8>					
bit 13					bit 8

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
GADC<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13-0 **GADC<13:0>:** ADC gain term

REGISTER 9-12: CALWD12: CALIBRATION WORD 12 REGISTER

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
VOADC<13:8>					
bit 13					bit 8

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
VOADC<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13-0 **VOADC<13:0>:** Two's complement ADC offset voltage term

10.0 RELATIVE EFFICIENCY MEASUREMENT

With a constant input voltage, output voltage and load current, any change in the high-side MOSFET on time represents a change in the system efficiency. The MCP19118/19 is capable of measuring the on time of the high-side MOSFET. Therefore, the relative efficiency of the system can be measured and optimized by changing the system parameters, such as switching frequency, driver dead time or high-side drive strength.

10.1 Relative Efficiency Measurement Procedure

To measure the relative efficiency, the RELEFF register, the ABECON<MEASEN> and ABECON<RECIREN> bits and the ADC RELEFF input are used. The following steps outline the measurement process:

1. Set the ABECON<RECIREN> bit to enable the measurement circuitry.
2. Clear the ABECON<MEASEN> bit.
3. With the ADC, read the RELEFF channel and store this reading as the High.
4. With the ADC, read the VZC channel and store this reading as the Low.
5. Set the ABECON<MEASEN> bit to initiate a measurement cycle.
6. Monitor the RELEFF<MSDONE> bit. When set, it indicates the measurement is complete.
7. When the measurement is complete, use the ADC to read the RELEFF channel. This value becomes the Fractional variable in Equation 10-1. This reading should be accomplished approximately 50 ms after the RELESS<MSDONE> bit is set.
8. Read the value of the RE<6:0> bits in the RELEFF register and store the reading as Whole.
9. Clear the ABECON<MEASEN> bit.
10. The relative efficiency is then calculated by the following equation:

EQUATION 10-1:

$$Duty\ Cycle = \frac{\left(Whole + \frac{(Fractional - Low)}{(High - Low)}\right)}{(PR2 + 1)}$$

Where:

Whole = Value obtained in Step 8 of the measurement procedure

Fractional = Value obtained in Step 7 of the measurement procedure

High = Value obtained in Step 3 of the measurement procedure

Low = Value obtained in Step 4 of the measurement procedure

Note 1: The RELEFF<MSDONE> bit is set and cleared automatically.

REGISTER 10-1: RELEFF: RELATIVE EFFICIENCY MEASUREMENT REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
MSDONE	RE6	RE5	RE4	RE3	RE2	RE1	RE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **MSDONE:** Relative efficiency measurement done bit
1 = Relative efficiency measurement is complete
0 = Relative efficiency measurement is not complete

bit 6-0 **RE<6:0>:** Whole clock counts for relative efficiency measurement result

NOTES:

11.0 MEMORY ORGANIZATION

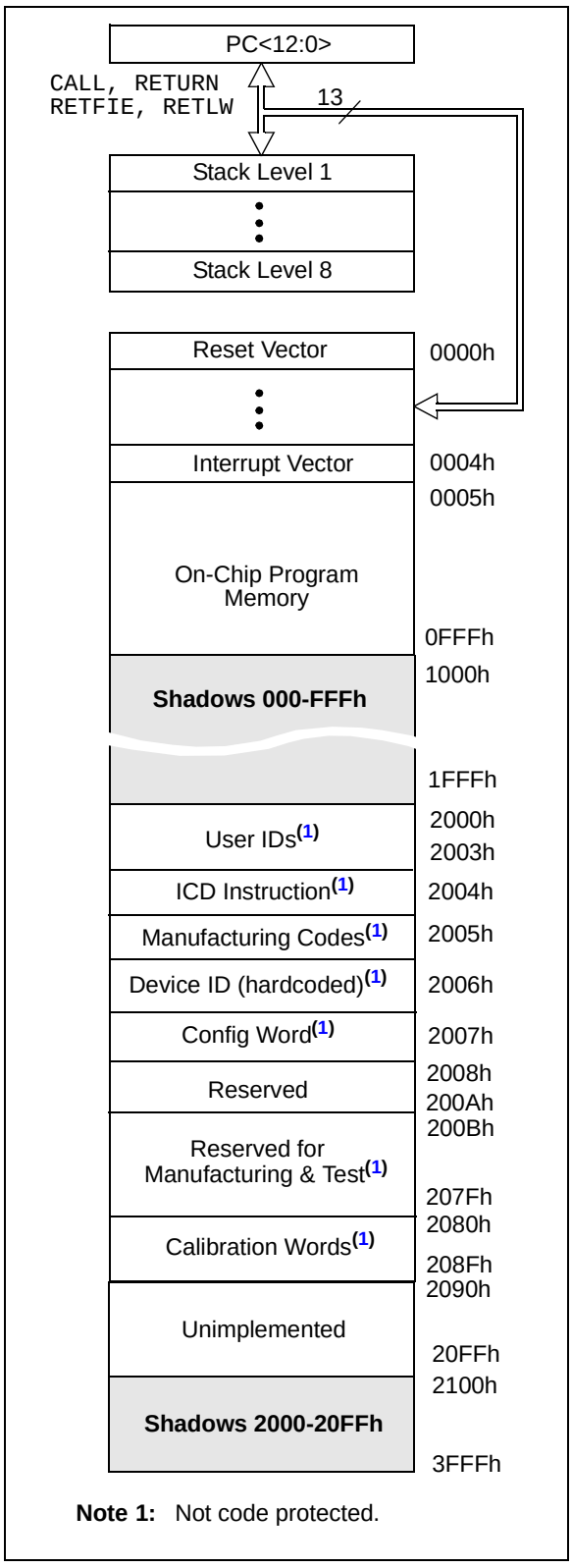
There are two types of memory in the MCP19118/19:

- Program Memory
- Data Memory
  - Special Function Registers (SFRs)
  - General Purpose RAM

11.1 Program Memory Organization

The MCP19118/19 has a 13-bit program counter capable of addressing an 8K x 14 program memory space. Only the first 4K x 14 (0000h-0FFFh) is physically implemented. Addressing a location above this boundary will cause a wrap-around within the first 4K x 14 space. The Reset vector is at 0000h and the interrupt vector is at 0004h (see Figure 11-1). The width of the program memory bus (instruction word) is 14 bits. Since all instructions are a single word, the MCP19118/19 has space for 4K of instructions.

FIGURE 11-1: PROGRAM MEMORY MAP AND STACK FOR MCP19118/19



Note 1: Not code protected.

11.1.1 READING PROGRAM MEMORY AS DATA

There are two methods of accessing constants in program memory. The first method is to use tables of RETLW instructions. The second method is to set a Files Select Register (FSR) to point to the program memory.

11.1.1.1 RETLW Instruction

The RETLW instruction can be used to provide access to tables of constants. The recommended way to create such a table is shown in Example 11-1.

EXAMPLE 11-1: RETLW INSTRUCTION

```
constants
    RETLW DATA0        ;Index0 data
    RETLW DATA1        ;Index1 data
    RETLW DATA2
    RETLW DATA3


my_function
    ;… LOTS OF CODE…
    MOVLW      DATA_INDEX
    call constants
    ;… THE CONSTANT IS IN W
```

11.2 Data Memory Organization

The data memory (see Table 11-1) is partitioned into four banks, which contain the General Purpose Registers (GPR) and the Special Function Registers (SFR). The Special Function Registers are located in the first 32 locations of each bank. Register locations 20h-7Fh in Bank 0, A0h-EFh in Bank 1 and 120h-16Fh in Bank 2 are General Purpose Registers, implemented as static RAM. All other RAM is unimplemented and returns '0' when read. The RP<1:0> bits in the STATUS register are the bank select bits.

RP1	RP0	
0	0	-> Bank 0 is selected
0	1	-> Bank 1 is selected
1	0	-> Bank 2 is selected
1	1	-> Bank 3 is selected

To move values from one register to another, the value must pass through the W register. This means that, for all register-to-register moves, two instruction cycles are required.

The STATUS register contains:

- the arithmetic status of the ALU (Arithmetic Logic Unit)
- the Reset status
- the bank select bits for data memory (RAM)

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the $\overline{TO}$ and $\overline{PD}$ bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, CLRF STATUS will clear the upper three bits and set the Z bit. This leaves the STATUS register as '000u u1uu' (where u = unchanged).

Therefore, it is recommended that only BCF, BSF, SWAPF and MOVWF instructions are used to alter the STATUS register, because these instructions do not affect any Status bits. For other instructions not affecting any Status bits, see **Section 29.0 "Instruction Set Summary"**.

Note 1: The C and DC bits operate as $\overline{Borrow}$ and $\overline{Digit\ Borrow}$ out bits, respectively, in subtraction.

REGISTER 11-1: STATUS: STATUS REGISTER

R/W-0	R/W-0	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x
IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC(1)	C(1)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **IRP:** Register Bank Select bit (used for Indirect addressing)
1 = Bank 2 & 3 (100h–1FFh)
0 = Bank 0 & 1 (00h–FFh)

bit 6-5 **RP<1:0>:** Register Bank Select bits (used for Direct addressing)
00 = Bank 0 (00h-7Fh)
01 = Bank 1 (80h-FFh)
10 = Bank 2 (100h-17Fh)
11 = Bank 3 (180h-1FFh)

bit 4 **$\overline{TO}$:** Time-out bit
1 = After power-up, CLRWDT instruction or SLEEP instruction
0 = A WDT time out occurred

bit 3 **$\overline{PD}$:** Power-down bit
1 = After power-up or by the CLRWDT instruction
0 = By execution of the SLEEP instruction

bit 2 **Z:** Zero bit
1 = The result of an arithmetic or logic operation is zero
0 = The result of an arithmetic or logic operation is not zero

bit 1 **DC:** Digit Carry/$\overline{\text{Digit Borrow}}$ bit(1) (ADDWF, ADDLW, SUBLW, SUBWF instructions)
1 = A carry-out from the 4th low-order bit of the result occurred
0 = No carry-out from the 4th low-order bit of the result

bit 0 **C:** Carry/$\overline{\text{Borrow}}$ bit(1) (ADDWF, ADDLW, SUBLW, SUBWF instructions)(1)
1 = A carry-out from the Most Significant bit of the result occurred
0 = No carry-out from the Most Significant bit of the result occurred

Note 1: For $\overline{\text{Borrow}}$, the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (RRF, RLF) instructions, this bit is loaded with either the high-order or low-order bit of the source register.

11.2.1 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and peripheral functions for controlling the desired operation of the device (see Table 11-1). These registers are static RAM.

The special registers can be classified into two sets: core and peripheral. The Special Function Registers associated with the microcontroller core are described in this section. Those related to the operation of the peripheral features are described in the associated section for that peripheral feature.

11.3 DATA MEMORY

TABLE 11-1: MCP19118/19 DATA MEMORY MAP

	File Address		File Address		File Address		File Address
Indirect addr.(1)	00h	Indirect addr. (1)	80h	Indirect addr.(1)	100h	Indirect addr. (1)	180h
TMR0	01h	OPTION_REG	81h	TMR0	101h	OPTION_REG	181h
PCL	02h	PCL	82h	PCL	102h	PCL	182h
STATUS	03h	STATUS	83h	STATUS	103h	STATUS	183h
FSR	04h	FSR	84h	FSR	104h	FSR	184h
PORTGPA	05h	TRISGPA	85h	WPUGPA	105h	IOCA	185h
PORTGPB	06h	TRISGPB	86h	WPUGPB	106h	IOCB	186h
PIR1	07h	PIE1	87h	PE1	107h	ANSELA	187h
PIR2	08h	PIE2	88h	BUFFCON	108h	ANSELB	188h
PCON	09h	APFCON	89h	ABECON	109h		189h
PCLATH	0Ah	PCLATH	8Ah	PCLATH	10Ah	PCLATH	18Ah
INTCON	0Bh	INTCON	8Bh	INTCON	10Bh	INTCON	18Bh
TMR1L	0Ch		8Ch		10Ch	PORTICD(2)	18Ch
TMR1H	0Dh		8Dh		10Dh	TRISICD(2)	18Dh
T1CON	0Eh		8Eh		10Eh	ICKBUG(2)	18Eh
TMR2	0Fh		8Fh		10Fh	BIGBUG(2)	18Fh
T2CON	10h	VINLVL	90h	SSPADD	110h	PMCON1	190h
PR2	11h	OCCON	91h	SSPBUF	111h	PMCON2	191h
	12h		92h	SSPCON1	112h	PMADRL	192h
PWMPHL	13h	CSGSCON	93h	SSPCON2	113h	PMADRH	193h
PWMPHH	14h		94h	SSPCON3	114h	PMDATL	194h
PWMRL	15h	CSDGCON	95h	SSPMSK	115h	PMDATH	195h
PWMRH	16h		96h	SSPSTAT	116h		196h
	17h	VZCCON	97h	SSPADD2	117h		197h
	18h	CMPZCON	98h	SSPMSK2	118h	OSCCAL	198h
OVCCON	19h	OUVCON	99h		119h	DOVCAL	199h
OVFCON	1Ah	OOVCON	9Ah		11Ah	TTACAL	19Ah
OSCTUNE	1Bh	DEADCON	9Bh		11Bh	BGRCAL	19Bh
ADRESL	1Ch	SLPCRCON	9Ch		11Ch	VROCAL	19Ch
ADRESH	1Dh	SLVGNCON	9Dh		11Dh	ZROCAL	19Dh
ADCON0	1Eh	RELEFF	9Eh		11Eh		19Eh
ADCON1	1Fh		9Fh		11Fh	ATSTCON	19Fh
General Purpose Register 96 Bytes	20h	General Purpose Register 80 Bytes	A0h	General Purpose Register 80 bytes	120h		1A0h
			EFh		16F		1EF
	7Fh	Accesses Bank 0	F0h FFh	Accesses Bank 0	170h 17Fh	Accesses Bank 0	1F0h 1FFh
Bank 0		Bank 1		Bank2		Bank3	

Unimplemented data memory locations, read as '0'.

Note 1: Not a physical register.

2: Only accessible when DBGEN = 0 and ICKBUG<INBUG> = 1.

TABLE 11-2: MCP19118/19 SPECIAL REGISTERS SUMMARY BANK 0

Adr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Value on all other resets(1)
Bank 0											
00h	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								xxxx xxxx	xxxx xxxx
01h	TMR0	Timer0 Module's Register								xxxx xxxx	uuuu uuuu
02h	PCL	Program Counter's (PC) Least Significant byte								0000 0000	0000 0000
03h	STATUS	IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	0001 1xxx	000q quuu
04h	FSR	Indirect data memory address pointer								xxxx xxxx	uuuu uuuu
05h	PORTGPA	GPA7	GPA6	GPA5	GPA4	GPA3	GPA2	GPA1	GPA0	xxxx xxxx	uuuu uuuu
06h	PORTGPB	GPB7	GPB6	GPB5	GPB4	—	GPB2	GPB1	GPB0	xxx- xxxx	uuu- uuuu
07h	PIR1	—	ADIF	BCLIF	SSPIF	—	—	TMR2IF	TMR1IF	-000 --00	-000 --00
08h	PIR2	UVIF	—	OCIF	OVIF	—	—	VINIF	—	0-00 --00	0-00 --00
09h	PCON	—	—	—	—	—	$\overline{OT}$	$\overline{POR}$	—	---- -qq-	---- -uu-
0Ah	PCLATH	—	—	—	Write buffer for upper 5 bits of program counter					---0 0000	---0 0000
0Bh	INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF(3)	0000 000x	0000 000u
0Ch	TMR1L	Holding register for the Least Significant byte of the 16-bit TMR1								xxxx xxxx	uuuu uuuu
0Dh	TMR1H	Holding register for the Most Significant byte of the 16-bit TMR1								xxxx xxxx	uuuu uuuu
0Eh	T1CON	—	—	T1CKPS1	T1CKPS0	—	—	TMR1CS	TMR1ON	--00 --00	--uu --uu
0Fh	TMR2	Timer2 Module Register								0000 0000	uuuu uuuu
10h	T2CON	—	—	—	—	—	TMR2ON	T2CKPS1	T2CKPS0	---- -000	---- -000
11h	PR2	Timer2 Module Period Register								1111 1111	1111 1111
12h	—	Unimplemented								_	_
13h	PWMPHL	SLAVE Phase Shift Register								xxxx xxxx	uuuu uuuu
14h	PWMPHH	SLAVE Phase Shift Register								xxxx xxxx	uuuu uuuu
15h	PWMRL	PWM Register Low Byte								xxxx xxxx	uuuu uuuu
16h	PWMRH	PWM Register High Byte								xxxx xxxx	uuuu uuuu
17h	—	Unimplemented								_	_
18h	—	Unimplemented								_	_
19h	OVCCON	OVC7	OVC6	OVC5	OVC4	OVC3	OVC2	OVC1	OVC0	0000 0000	0000 0000
1Ah	OVFCON	VOUTEN	—	—	OVF4	OVF3	OVF2	OVF1	OVF0	0--0 0000	0--0 0000
1Bh	OSCTUNE	—	—	—	TUN4	TUN3	TUN2	TUN1	TUN0	---0 0000	---0 0000
1Ch	ADRESL	Least significant 8 bits of the right-shifted result								xxxx xxxx	uuuu uuuu
1Dh	ADRESH	Most significant 2 bits of right-shifted result								---- --xx	uuuu uuuu
1Eh	ADCON0	—	CHS4	CHS3	CHS2	CHS1	CHS0	GO/$\overline{DONE}$	ADON	-000 0000	-000 0000
1Fh	ADCON1	—	ADCS2	ADCS1	ADCS0	—	—	—	—	-000 ----	-000 ----

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

Note 1: Other (non power-up) resets include $\overline{MCLR}$ Reset and Watchdog Timer Reset during normal operation.

2: IRP & RP1 bits are reserved, always maintain these bits clear.

3: $\overline{MCLR}$ and WDT reset does not affect the previous value data latch. The IOCF bit will be cleared upon reset but will set again if the mismatch exists.

TABLE 11-3: MCP19118/19 SPECIAL REGISTERS SUMMARY BANK 1

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Values on all other resets(1)
Bank 1											
80h	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								xxxx xxxx	uuuu uuuu
81h	OPTION_REG	$\overline{RAPU}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h	PCL	Program Counter's (PC) Least Significant byte								0000 0000	0000 0000
83h	STATUS	IRP(2)	RP1(2)	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	0001 1xxx	000q quuu
84h	FSR	Indirect data memory address pointer								xxxx xxxx	uuuu uuuu
85h	TRISGPA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1111 1111	1111 1111
86h	TRISGPB	TRISB7	TRISB6	TRISB5	TRISB4	—	TRISB2	TRISB1	TRISB0	1111 1111	1111 1111
87h	PIE1	—	ADIE	BCLIE	SSPIE	—	—	TMR2IE	TMR1IE	-000 --00	-000 --00
88h	PIE2	UVIE	—	OCIE	OVIE	—	—	VINIE	—	0-00 --00	0-00 --00
89h	APFCON	—	—	—	—	—	—	—	CLKSEL	---- ---0	---- ---0
8Ah	PCLATH	—	—	—	Write buffer for upper 5 bits of program counter					---0 0000	---0 0000
8Bh	INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF(4)	0000 000x	0000 000u
8Ch	—	Unimplemented								—	—
8Dh	—	Unimplemented								—	—
8Eh	—	Unimplemented								—	—
8Fh	—	Unimplemented								—	—
90h	VINLVL	UVLOEN	—	UVLO5	UVLO4	UVLO3	UVLO2	UVLO1	UVLO0	0-xx xxxx	0-uu uuuu
91h	OCCON	OCEN	OCLEB1	OCLEB0	OOC4	OOC3	OOC2	OOC1	OOC0	0xxx xxxx	0uuu uuuu
92h	—	—	—	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	--xx xxxx	--uu uuuu
93h	CSGSCON	—	Reserved	Reserved	Reserved	CSGS3	CSGS2	CSGS1	CSGS0	-xxx xxxx	-uuu uuuu
94h	—	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	xxxx xxxx	uuuu uuuu
95h	CSDGCON	CSDGEN	—	—	—	Reserved	CSDG2	CSDG1	CSDG0	0--- xxxx	0--- uuuu
96h	—	—	—	—	—	Reserved	Reserved	Reserved	Reserved	---- xxxx	---- uuuu
97h	VZCCON	VZC7	VZC6	VZC5	VZC4	VZC3	VZC2	VZC1	VZC0	xxxx xxxx	uuuu uuuu
98h	CMPZCON	CMPZF3	CMPZF2	CMPZF1	CMPZF0	CMPZG3	CMPZG2	CMPZG1	CMPZG0	xxxx xxxx	uuuu uuuu
99h	OUVCON	OUV7	OUV6	OUV5	OUV4	OUV3	OUV2	OUV1	OUV0	xxxx xxxx	uuuu uuuu
9Ah	OOVCON	OOV7	OOV6	OOV5	OOV4	OOV3	OOV2	OOV1	OOV0	xxxx xxxx	uuuu uuuu
9Bh	DEADCON	HDLY3	HDLY2	HDLY1	HDLY0	LDLY3	LDLY2	LDLY1	LDLY0	xxxx xxxx	uuuu uuuu
9Ch	SLPCRCON	SLPG3	SLPG2	SLPG1	SLPG0	SLPS3	SLPS2	SLPS1	SLPS0	xxxx xxxx	uuuu uuuu
9Dh	SLVGNCON	—	—	—	SLVGN4	SLVGN3	SLVGN2	SLVGN1	SLVGN0	---x xxxx	---u uuuu
9Eh	RELEFF	MSDONE	RE6	RE5	RE4	RE3	RE2	RE1	RE0	0000 0000	0000 0000
9Fh	—	Unimplemented								—	—

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

Note 1: Other (non power-up) resets include $\overline{MCLR}$ Reset and Watchdog Timer Reset during normal operation.

2: IRP & RP1 bits are reserved, always maintain these bits clear.

3: RA3 pull-up is enabled when pin is configured as $\overline{MCLR}$ in Configuration Word.

4: $\overline{MCLR}$ and WDT Reset does not affect the previous value data latch. The IOCF bit will be cleared upon reset but will set again if the mismatch exists.

TABLE 11-4: MCP19118/19 SPECIAL REGISTERS SUMMARY BANK 2

Adr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Value on all other resets(1)
Bank 2											
100h	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								xxxx xxxx	xxxx xxxx
101h	TMR0	Timer0 Module's Register								xxxx xxxx	uuuu uuuu
102h	PCL	Program Counter's (PC) Least Significant byte								0000 0000	0000 0000
103h	STATUS	IRP(2)	RP1(2)	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	0001 1xxx	000q quuu
104h	FSR	Indirect data memory address pointer								xxxx xxxx	uuuu uuuu
105h	WPUGPA	—	—	WPUA5	—	WPUA3	WPUA2	WPUA1	WPUA0	--1- 1111	--u- uuuu
106h	WPUGPB	WPUB7	WPUB6	WPUB5	WPUB4	—	WPUB2	WPUB1	—	1111 -11-	uuuu -uu-
107h	PE1	DECON	DVRSTR	HDLYBY	LDLYBY	PDEN	PUEN	UVTEE	OVTEE	0000 1100	0000 1100
108h	BUFFCON	MLTPH2	MLTPH1	MLTPH0	ASEL4	ASEL3	ASEL2	ASEL1	ASEL0	0000 0000	0000 0000
109h	ABECON	OVDCEN	UVDCEN	MEASEN	SLCPBY	CRTMEN	TMPSEN	RECIREN	PATHEN	0000 0000	0000 0000
10Ah	PCLATH	—	—	—	Write buffer for upper 5 bits of program counter					---0 0000	---0 0000
10Bh	INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF(3)	0000 000x	0000 000u
10Ch	—	Unimplemented								—	—
10Dh	—	Unimplemented								—	—
10Eh	—	Unimplemented								—	—
10Fh	—	Unimplemented								—	—
110h	SSPADD	ADD<7:0>								0000 0000	0000 0000
111h	SSPBUF	Synchronous Serial Port Receive Buffer/Transmit Register								xxxx xxxx	uuuu uuuu
112h	SSPCON1	WCOL	SSPOV	SSPEN	CKP	SSPM>3:0>				0000 0000	0000 0000
113h	SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	0000 0000
114h	SSPCON3	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	0000 0000	0000 0000
115h	SSPMSK	MSK<7:0>								1111 1111	1111 1111
116h	SSPSTAT	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	—	—
117h	SSPADD2	ADD2<7:0>								0000 0000	0000 0000
118h	SSPMSK2	MSK2<7:0>								1111 1111	1111 1111
119h	—	Unimplemented								—	—
11Ah	—	Unimplemented								—	—
11Bh	—	Unimplemented								—	—
11Ch	—	Unimplemented								—	—
11Dh	—	Unimplemented								—	—
11Eh	—	Unimplemented								—	—
11Fh	—	Unimplemented								—	—

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

Note 1: Other (non power-up) resets include $\overline{MCLR}$ Reset and Watchdog Timer Reset during normal operation.

2: IRP & RP1 bits are reserved, always maintain these bits clear.

3: $\overline{MCLR}$ and WDT reset does not affect the previous value data latch. The IOCF bit will be cleared upon reset but will set again if the mismatch exists.

TABLE 11-5: MCP19118/19 SPECIAL REGISTERS SUMMARY BANK 3

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Values on all other resets(1)
Bank 3											
180h	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								xxxx xxxx	uuuu uuuu
181h	OPTION_REG	$\overline{RAPU}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
182h	PCL	Program Counter's (PC) Least Significant byte								0000 0000	0000 0000
183h	STATUS	IRP(2)	RP1(2)	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	0001 1xxx	000q quuu
184h	FSR	Indirect data memory address pointer								xxxx xxxx	uuuu uuuu
185h	IOCA	IOCA7	IOCA6	IOCA5	IOCA4	IOCA3	IOCA2	IOCA1	IOCA0	0000 0000	0000 0000
186h	IOCB	IOCB7	IOCB6	IOCB5	IOCB4	—	IOCB2	IOCB1	IOCB0	0000 -000	0000 -000
187h	ANSELA	—	—	—	—	ANSA3	ANSA2	ANSA1	ANSA0	---- 1111	---- 1111
188h	ANSELB	—	—	ANSB5	ANSB4	—	ANSB2	ANSB1	—	--11 -11-	--11 -11-
189h	—	Unimplemented								—	—
18Ah	PCLATH	—	—	—	Write buffer for upper 5 bits of program counter					---0 0000	---0 0000
18Bh	INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF(4)	0000 000x	0000 000u
18Ch	PORTICD(5)	In-Circuit Debug Port Register									
18Dh	TRISICD(5)	In-Circuit Debug TRIS Register									
18Eh	ICKBUG(5)	In-Circuit Debug Register								0--- ----	0--- ----
18Fh	BIGBUG(5)	In-Circuit Debug Breakpoint Register								---- ----	---- ----
190h	PMCON1	—	CALSEL	—	—	—	WREN	WR	RD	-0-- -000	-0-- -000
191h	PMCON2	Program Memory Control Register 2 (not a physical register)								---- ----	---- ----
192h	PMADRL	PMADRL7	PMADRL6	PMADRL5	PMADRL4	PMADRL3	PMADRL2	PMADRL1	PMADRL0	0000 0000	0000 0000
193h	PMADRH	—	—	—	—	PMADRH3	PMADRH2	PMADRH1	PMADRH0	---- 0000	---- 0000
194h	PMDATL	PMDATL7	PMDATL6	PMDATL5	PMDATL4	PMDATL3	PMDATL2	PMDATL1	PMDATL0	0000 0000	0000 0000
195h	PMDATH	—	—	PMDATH5	PMDATH4	PMDATH3	PMDATH2	PMDATH1	PMDATH0	--00 0000	--00 0000
196h	—	Unimplemented								—	—
197h	—	Unimplemented								—	—
198h	OSCCAL	—	FCALT6	FCALT5	FCALT4	FCALT3	FCALT2	FCALT1	FCALT0	xxxx xxxx	uuuu uuuu
199h	DOVCAL	—	—	—	—	DOVT3	DOVT2	DOVT1	DOVT0	xxxx xxxx	uuuu uuuu
19Ah	TTACAL	—	—	—	—	TTA3	TTA2	TTA1	TTA0	xxxx xxxx	uuuu uuuu
19Bh	BGRCAL	Reserved	Reserved	Reserved	Reserved	BGRT3	BGRT2	BGRT1	BGRT0	xxxx xxxx	uuuu uuuu
19Ch	VROCAL	—	—	—	—	VROT3	VROT2	VROT1	VROT0	xxxx xxxx	uuuu uuuu
19Dh	ZROCAL	—	—	—	—	ZROT3	ZROT2	ZROT1	ZROT0	xxxx xxxx	uuuu uuuu
19Eh	—	Unimplemented								—	—
19Fh	ATSTCON	Reserved	—	—	Reserved	HIDIS	LODIS	BNCHEN	DRVDIS	1--0 0001	1--0 0001

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

Note 1: Other (non power-up) resets include $\overline{MCLR}$ Reset and Watchdog Timer Reset during normal operation.

2: IRP & RP1 bits are reserved, always maintain these bits clear.

3: RA3 pull-up is enabled when pin is configured as $\overline{MCLR}$ in Configuration Word.

4: $\overline{MCLR}$ and WDT Reset does not affect the previous value data latch. The IOCF bit will be cleared upon reset but will set again if the mismatch exists.

5: Only accessible when $\overline{DBGEN}$ = 0 and ICKBUG<INBUG> = 1.

11.3.1 OPTION_REG REGISTER

The OPTION_REG register is a readable and writable register, which contains various control bits to configure:

- Timer0/WDT prescaler
- External GPA2/INT interrupt
- Timer0
- Weak pull-ups on PORTGPA and PORTGPB

Note 1: To achieve a 1:1 prescaler assignment for Timer0, assign the prescaler to the WDT by setting PSA bit in the OPTION_REG register to '1'. See **Section 23.1.3 "Software-Programmable Prescaler"**.

REGISTER 11-2: OPTION_REG: OPTION REGISTER (Note 1)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
$\overline{\text{RAPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **$\overline{\text{RAPU}}$:** Port GPx Pull-Up Enable bit
1 = Port GPx pull-ups are disabled
0 = Port GPx pull-ups are enabled

bit 6 **INTEDG:** Interrupt Edge Select bit
0 = Interrupt on rising edge of INT pin
1 = Interrupt on falling edge of INT pin

bit 5 **T0CS:** TMR0 Clock Source Select bit
1 = Transition on T0CKI pin
0 = Internal instruction cycle clock

bit 4 **T0SE:** TMR0 Source Edge Select bit
1 = Increment on high-to-low transition on T0CKI pin
0 = Increment on low-to-high transition on T0CKI pin

bit 3 **PSA:** Prescaler Assignment bit
1 = Prescaler is assigned to WDT
0 = Prescaler is assigned to the Timer0 module

bit 2-0 **PS<2:0>:** Prescaler Rate Select bits

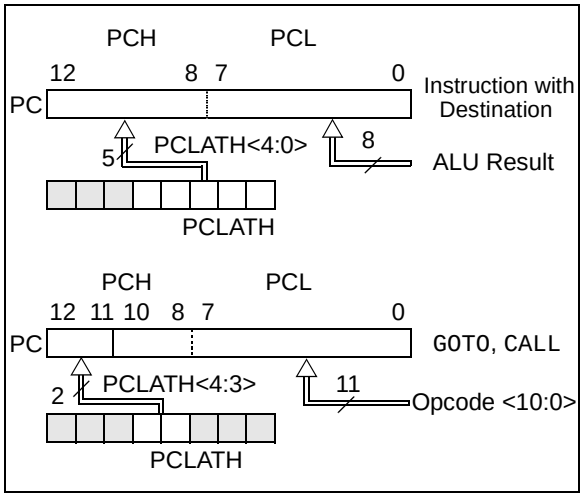
Bit Value	TMR0 Rate	WDT Rate
000	1: 2	1: 1
001	1: 4	1: 2
010	1: 8	1: 4
011	1: 16	1: 8
100	1: 32	1: 16
101	1: 64	1: 32
110	1: 128	1: 64
111	1: 256	1: 128

Note 1: Individual WPUx bit must also be enabled.

11.4 PCL and PCLATH

The Program Counter (PC) is 13-bit wide. The low byte comes from the PCL register, which is a readable and writable register. The high byte (PC<12:8>) is not directly readable or writable and comes from PCLATH. On any Reset, the PC is cleared. Figure 11-2 shows the two situations for loading the PC. The upper example in Figure 11-2 shows how the PC is loaded on a write to PCL (PCLATH<4:0> → PCH). The lower example in Figure 11-2 shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> → PCH).

FIGURE 11-2: LOADING OF PC IN DIFFERENT SITUATIONS



11.4.1 MODIFYING PCL

Executing any instruction with the PCL register as the destination simultaneously causes the Program Counter PC<12:8> bits (PCH) to be replaced by the contents of the PCLATH register. This allows the entire content of the program counter to be changed by writing the desired upper five bits to the PCLATH register. When the lower eight bits are written to the PCL register, all 13 bits of the program counter will change to the values contained in the PCLATH register and those being written to the PCL register.

11.4.2 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). Care should be exercised when jumping into a look-up table or program branch table (computed GOTO) by modifying the PCL register. Assuming that PCLATH is set to the table start address, if the table length is greater than 255 instructions or if the lower eight bits of the memory address rolls over from 0xFFh to 0X00h in the middle of the table, then PCLATH must be incremented for each address rollover that occurs between the table beginning and the table location within the table.

For more information, refer to Application Note AN556 – *"Implementing a Table Read"* (DS00556).

11.4.3 COMPUTED FUNCTION CALLS

A computed function CALL allows programs to maintain tables of functions and provides another way to execute state machines or look-up tables. When performing a table read using a computed function CALL, care should be exercised if the table location crosses a PCL memory boundary (each 256-byte block).

If using the CALL instruction, the PCH<2:0> and PCL registers are loaded with the operand of the CALL instruction. PCH<6:3> is loaded with PCLATH<6:3>.

11.4.4 STACK

The MCP19118/19 has an 8-level x 13-bit wide hardware stack (refer to Figure 11-1). The stack space is not part of either program or data space and the Stack Pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on).

Note 1:	There are no Status bits to indicate Stack Overflow or Stack Underflow conditions.
2:	There are no instructions/mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW and RETFIE instructions or the vectoring to an interrupt address.

11.5 Indirect Addressing, INDF and FSR Registers

The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

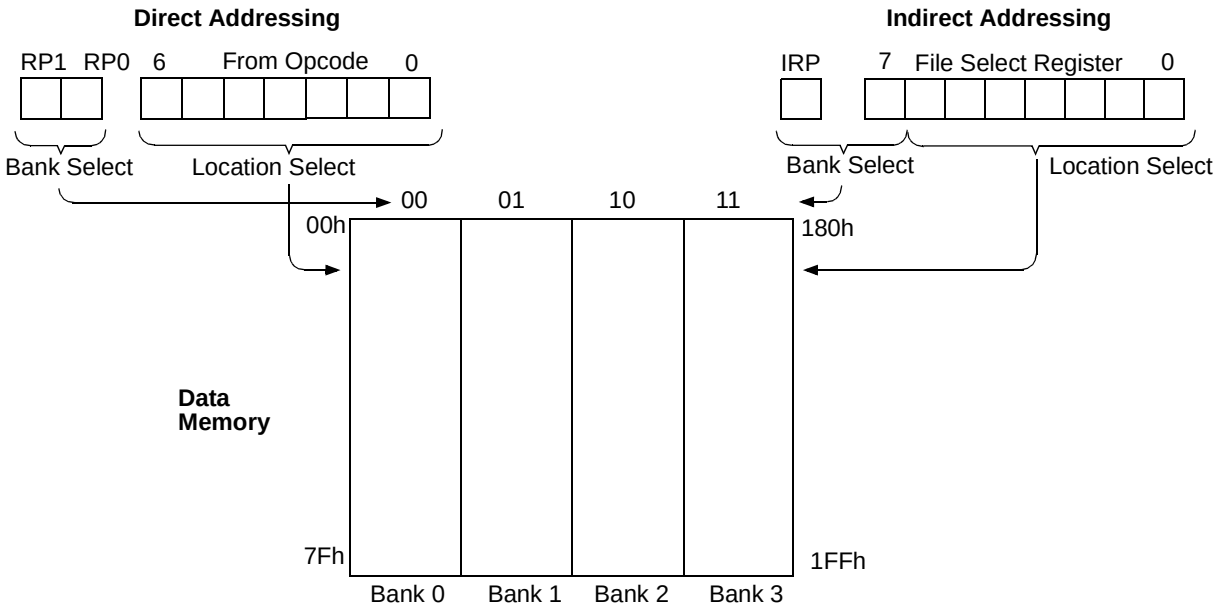
Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses data pointed to by the File Select Register (FSR). Reading INDF itself indirectly will produce 00h. Writing to the INDF register directly results in no operation being performed (although Status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR and the IRP bit in the STATUS register, as shown in Figure 11-3.

A simple program to clear RAM location 40h-7Fh using indirect addressing is shown in Example 11-2.

EXAMPLE 11-2: INDIRECT ADDRESSING

```
        MOVLW   0x40    ;initialize pointer
        MOVWF   FSR     ;to RAM
NEXT    CLRF    INDF    ;clear INDF register
        INCF    FSR     ;inc pointer
        BTFSS   FSR,7   ;all done?
        GOTO    NEXT    ;no clear next
CONTINUE                ;yes continue
```

FIGURE 11-3: DIRECT/INDIRECT ADDRESSING



Note: For memory map detail, see Figure 11-2.

NOTES:

12.0 DEVICE CONFIGURATION

Device Configuration consists of Configuration Word and Code Protection.

12.1 Configuration Word

There are several Configuration Word bits that allow different timers to be enabled and memory protection options. These are implemented as Configuration Word at 2007h.

Note: The $\overline{\text{DBGEN}}$ bit in Configuration Word is managed automatically by device development tools, including debuggers and programmers. For normal device operation, this bit should be maintained as a '1'.

REGISTER 12-1: CONFIG: CONFIGURATION WORD REGISTER

R/P-1	U-1	R/P-1	R/P-1	U-1	U-1
$\overline{\text{DBGEN}}$	—	WRT1	WRT0	—	—
bit 13					bit 8

U-1	R/P-1	R/P-1	R/P-1	R/P-1	U-1	U-1	U-1
—	$\overline{\text{CP}}$	MCLRE	$\overline{\text{PWRTE}}$	WDTE	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 13 **$\overline{\text{DBGEN}}$**: ICD Debug bit
1 = ICD debug mode disabled
0 = ICD debug mode enabled

bit 12 **Unimplemented:** Read as '1'

bit 11-10 **WRT<1:0>:** Flash Program Memory Self Write Enable bit
11 = Write protection off
10 = 000h to 3FFh write protected, 400h to FFFh may be modified by PMCON1 control
01 = 000h to 7FFh write protected, 800h to FFFh may be modified by PMCON1 control
00 = 000h to FFFh write protected, entire program memory is write protected

bit 9-7 **Unimplemented:** Read as '1'

bit 6 **$\overline{\text{CP}}$:** Code Protection
1 = Program memory code protection is disabled
0 = Program memory code protection is enabled

bit 5 **MCLRE:** $\overline{\text{MCLR}}$ Pin Function Select
1 = $\overline{\text{MCLR}}$ pin is $\overline{\text{MCLR}}$ function and weak internal pull-up is enabled
0 = $\overline{\text{MCLR}}$ pin is alternate function, $\overline{\text{MCLR}}$ function is internally disabled

bit 4 **$\overline{\text{PWRTE}}$:** Power-Up Timer Enable bit
1 = PWRT disabled
0 = PWRT enabled

bit 3 **WDTE:** Watchdog Timer Enable bit
1 = WDT enabled
0 = WDT disabled

bit 2-0 **Unimplemented:** Read as '1'

12.2 Code Protection

Code protection allows the device to be protected from unauthorized access. Internal access to the program memory is unaffected by any code protection setting.

12.2.1 PROGRAM MEMORY PROTECTION

The entire program memory space is protected from external reads and writes by the $\overline{CP}$ bit in the Configuration Word. When $\overline{CP}$ = 0, external reads and writes of the program memory are inhibited and a read will return all '0's. The CPU can continue to read program memory, regardless of the protection bit settings. Writing the program memory is dependent upon the write protection setting. See **Section 12.3 "Write Protection"** for more information.

12.3 Write Protection

Write protection allows the device to be protected from unintended self-writes. Applications, such as bootloader software, can be protected while allowing other regions of the program memory to be modified.

The WRT<1:0> bits in the Configuration Word define the size of the program memory block that is protected.

12.4 ID Locations

Four memory locations (2000h-2003h) are designated as ID locations where the user can store checksum or other code identification numbers. These locations are not accessible during normal execution but are readable and writable during Program/Verify mode. Only the Least Significant seven bits of the ID locations are reported when using MPLAB Integrated Development Environment (IDE).

13.0 OSCILLATOR MODES

The MCP19118/19 has one oscillator configuration which is an 8 MHz internal oscillator.

13.1 Internal Oscillator (INTOSC)

The Internal Oscillator module provides a system clock source of 8 MHz. The frequency of the internal oscillator can be trimmed with a calibration value in the OSCTUNE register.

13.2 Oscillator Calibration

The 8 MHz internal oscillator is factory-calibrated. The factory calibration values reside in the read-only Calibration Word 1 register. These values must be read from the Calibration Word 1 register and stored in the OSCCAL register. Refer to **Section 18.0 "Flash Program Memory Control"** for the procedure on reading from program memory.

Note 1:	The FCAL<6:0> bits from the Calibration Word 1 register must be written into the OSCCAL register to calibrate the internal oscillator.

13.3 Frequency Tuning in User Mode

In addition to the factory calibration, the base frequency can be tuned in the user's application. This frequency tuning capability allows the user to deviate from the factory-calibrated frequency. The user can tune the frequency by writing to the OSCTUNE register (Register 13-1).

REGISTER 13-1: OSCTUNE: OSCILLATOR TUNING REGISTER

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	TUN<4:0>				
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **TUN<4:0>:** Frequency Tuning bits

01111 = Maximum frequency
01110 =
•
•
•
00001 =
00000 = Center frequency. Oscillator Module is running at the calibrated frequency.
11111 =
•
•
•
10000 = Minimum frequency

13.3.1 OSCILLATOR DELAY UPON POWER-UP, WAKE-UP AND BASE FREQUENCY CHANGE

In applications where the OSCTUNE register is used to shift the frequency of the internal oscillator, the application should not expect the frequency of the internal oscillator to stabilize immediately. In this case, the frequency may shift gradually toward the new value. The time for this frequency shift is less than eight cycles of the base frequency.

On power-up, the device is held in reset by the power-up time, if the power-up timer is enabled.

Following a wake-up from Sleep mode or POR, an internal delay of ~10 µs is invoked to allow the memory bias to stabilize before program execution can begin.

TABLE 13-1: SUMMARY OF REGISTERS ASSOCIATED WITH CLOCK SOURCES

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OSCTUNE	—	—	—	TUN4	TUN3	TUN2	TUN1	TUN0	83

Legend: — = unimplemented locations read as '0'. Shaded cells are not used by clock sources.

TABLE 13-2: SUMMARY OF CALIBRATION WORD ASSOCIATED WITH CLOCK SOURCES

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CALWD1	13:8	—	—	—	—	DOV3	DOV2	DOV1	DOV0	59
	7:0	—	FCAL6	FCAL5	FCAL4	FCAL3	FCAL2	FCAL1	FCAL0	

Legend: — = unimplemented locations read as '0'. Shaded cells are not used by clock sources.

14.0 RESETS

The reset logic is used to place the MCP19118/19 into a known state. The source of the reset can be determined by using the device status bits.

There are multiple ways to reset this device:

- Power-On Reset (POR)
- Overtemperature Reset (OT)
- $\overline{\text{MCLR}}$ Reset
- WDT Reset

To allow V_{DD} to stabilize, an optional power-up timer can be enabled to extend the Reset time after a POR event.

Some registers are not affected in any Reset condition; their status is unknown on POR and unchanged in any other Reset. Most other registers are reset to a Reset state on:

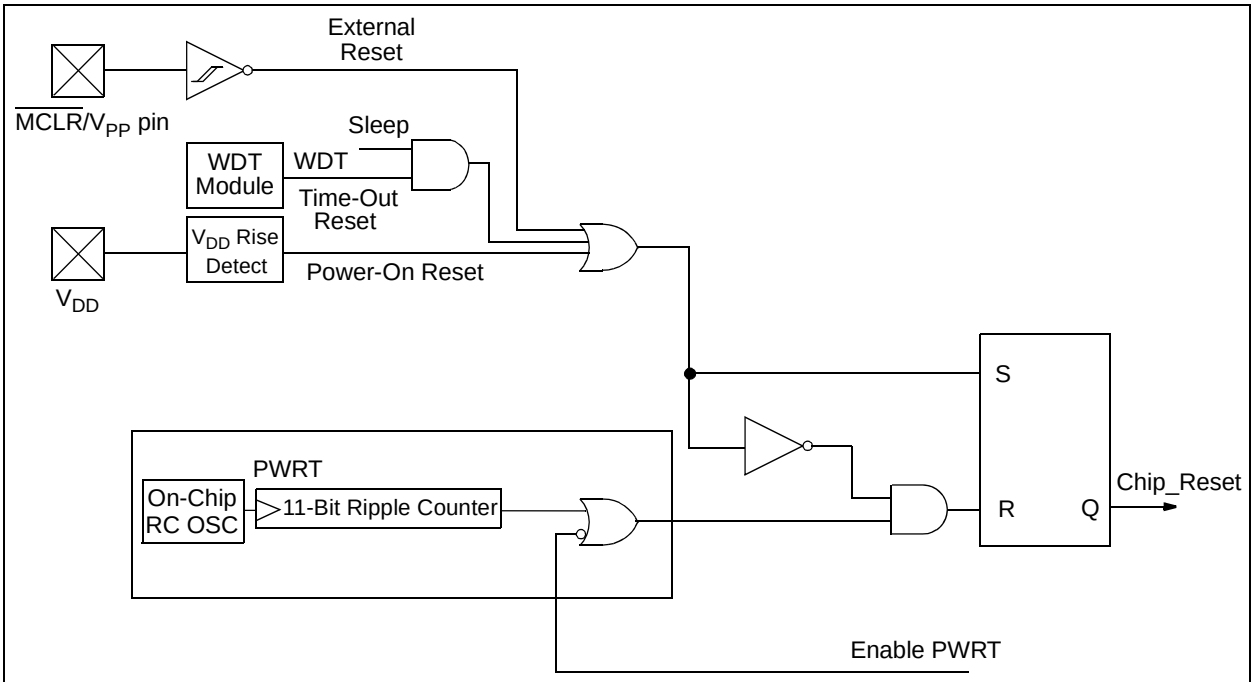
- Power-On Reset
- $\overline{\text{MCLR}}$ Reset
- $\overline{\text{MCLR}}$ Reset during Sleep
- WDT Reset

WDT wake-up does not cause register resets in the same manner as a WDT Reset, since wake-up is viewed as the resumption of normal operation. $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits are set or cleared differently in different Reset situations, as indicated in Table 14-1. Software can use these bits to determine the nature of the Reset. See Table 14-2 for a full description of Reset states of all registers.

A simplified block diagram of the On-Chip Reset Circuit is shown in Figure 14-1.

The $\overline{\text{MCLR}}$ Reset path has a noise filter to detect and ignore small pulses. See **Section 5.0 "Digital Electrical Characteristics"** for pulse width specifications.

FIGURE 14-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



Note 1: Refer to the Configuration Word register (Register 12-1).

TABLE 14-1: TIME OUT IN VARIOUS SITUATIONS

Power-Up		Wake-Up from Sleep
$\overline{\text{PWRTE}}$ = 0	$\overline{\text{PWRTE}}$ = 1	
T_{PWRT}	—	—

TABLE 14-2: STATUS/PCON BITS AND THEIR SIGNIFICANCE

$\overline{POR}$	$\overline{TO}$	$\overline{PD}$	Condition
0	1	1	Power-On Reset
u	0	u	WDT Reset
u	0	0	WDT Wake-Up
u	u	u	$\overline{MCLR}$ Reset during normal operation
u	1	0	$\overline{MCLR}$ Reset during Sleep

Legend: u = unchanged, x = unknown

14.1 Power-On Reset (POR)

The on-chip POR circuit holds the chip in Reset until V_{DD} has reached a high enough level for proper operation. To take advantage of the POR, simply connect the $\overline{MCLR}$ pin through a resistor to V_{DD}. This will eliminate external RC components usually needed to create Power-On Reset.

Note:	The POR circuit does not produce an internal Reset when V_{DD} declines. To re-enable the POR, V_{DD} must reach V_{SS} for a minimum of 100 µs.

When the device starts normal operation (exits the Reset condition), device operating parameters (i.e., voltage, frequency, temperature, etc.) must be met to ensure proper operation. If these conditions are not met, the device must be held in Reset until the operating conditions are met.

14.2 $\overline{MCLR}$

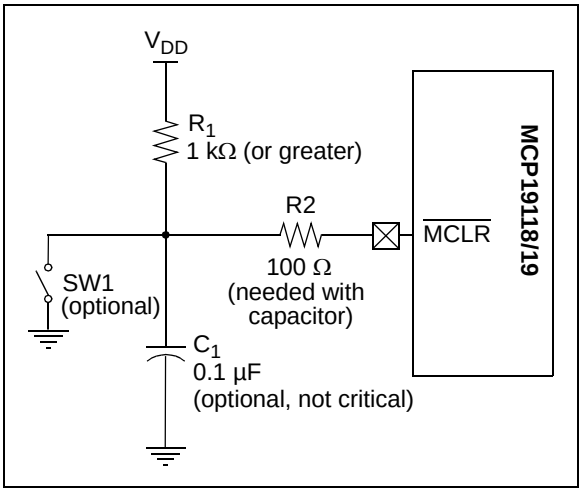
MCP19118/19 has a noise filter in the $\overline{MCLR}$ Reset path. The filter will detect and ignore small pulses.

It should be noted that a WDT Reset does not drive $\overline{MCLR}$ pin low.

Voltages applied to the $\overline{MCLR}$ pin that exceed its specification can result in both $\overline{MCLR}$ Resets and excessive current beyond the device specification during the ESD event. For this reason, Microchip recommends that the $\overline{MCLR}$ pin no longer be tied directly to V_{DD}. The use of an RC network, as shown in Figure 14-2, is suggested.

An internal $\overline{MCLR}$ option is enabled by clearing the MCLRE bit in the Configuration Word register. When MCLRE = 0, the Reset signal to the chip is generated internally. When MCLRE = 1, the $\overline{MCLR}$ pin becomes an external Reset input. In this mode, the $\overline{MCLR}$ pin has a weak pull-up to V_{DD}.

FIGURE 14-2: RECOMMENDED $\overline{MCLR}$ CIRCUIT



14.3 Power-Up Timer (PWRT)

The Power-Up Timer provides a fixed 64 ms (nominal) time out on power-up only, from POR Reset. The Power-Up Timer operates from an internal RC oscillator. The chip is kept in Reset as long as PWRT is active. The PWRT delay allows the V_{DD} to rise to an acceptable level. A Configuration bit, $\overline{PWRTE}$, can disable (if set) or enable (if cleared or programmed) the Power-Up Timer.

The Power-Up Timer delay will vary from chip to chip due to:

- V_{DD} variation
- Temperature variation
- Process variation

Note:	Voltage spikes below V_{SS} at the $\overline{MCLR}$ pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the $\overline{MCLR}$ pin, rather than pulling this pin directly to V_{SS}.

14.4 Watchdog Timer (WDT) Reset

The Watchdog Timer generates a Reset if the firmware does not issue a `CLRWDT` instruction within the time-out period. The $\overline{TO}$ and $\overline{PD}$ bits in the STATUS register are changed to indicate the WDT Reset. See **Section 17.0 "Watchdog Timer (WDT)"** for more information.

14.5 Power-Up Timer

The Power-Up Timer optionally delays device execution after a POR event. This timer is typically used to allow V_{DD} to stabilize before allowing the device to start running.

The Power-Up Timer is controlled by the $\overline{PWRTE}$ bit of Configuration Word.

14.6 Start-Up Sequence

Upon the release of a POR, the following must occur before the device begins executing:

- Power-Up Timer runs to completion (if enabled)
- Oscillator start-up timer runs to completion
- $\overline{MCLR}$ must be released (if enabled)

The total time out will vary based on the $\overline{PWRTE}$ bit status. For example, with $\overline{PWRTE}$ bit erased (PWRT disabled), there will be no time out at all. Figures 14-3, 14-4 and 14-5 depict time-out sequences.

Since the time outs occur from the POR pulse, if $\overline{MCLR}$ is kept low long enough, the time outs will expire. Then, bringing $\overline{MCLR}$ high will begin execution immediately (see Figure 14-4). This is useful for testing purposes or to synchronize more than one MCP19118/19 device operating in parallel.

14.6.1 POWER CONTROL (PCON) REGISTER

The Power Control (PCON) register (address 8Eh) has two Status bits to indicate what type of Reset occurred last.

FIGURE 14-3: TIME-OUT SEQUENCE ON POWER-UP (DELAYED $\overline{MCLR}$): CASE 1

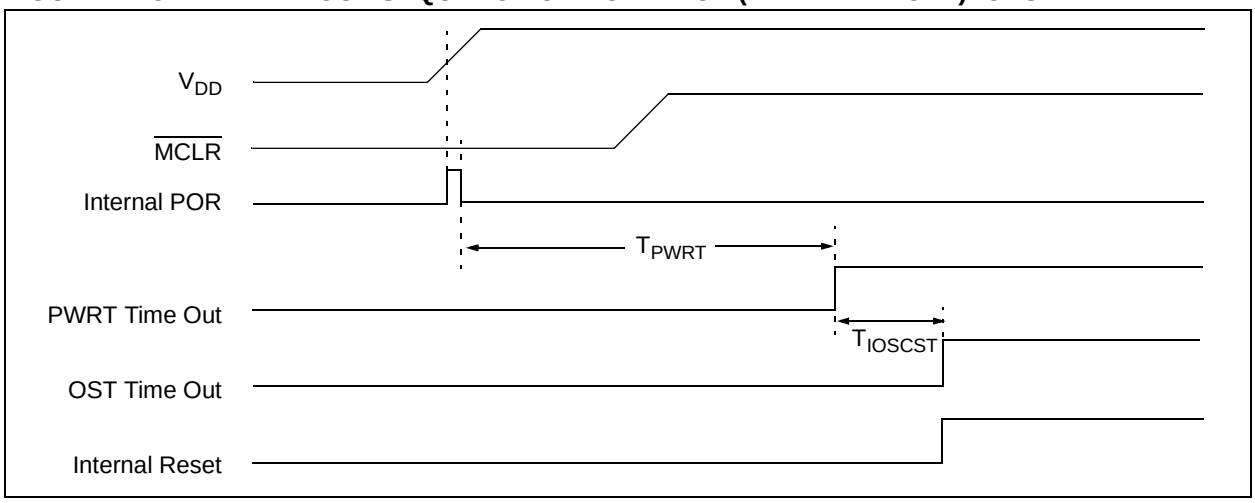


FIGURE 14-4: TIME-OUT SEQUENCE ON POWER-UP (DELAYED $\overline{MCLR}$): CASE 2

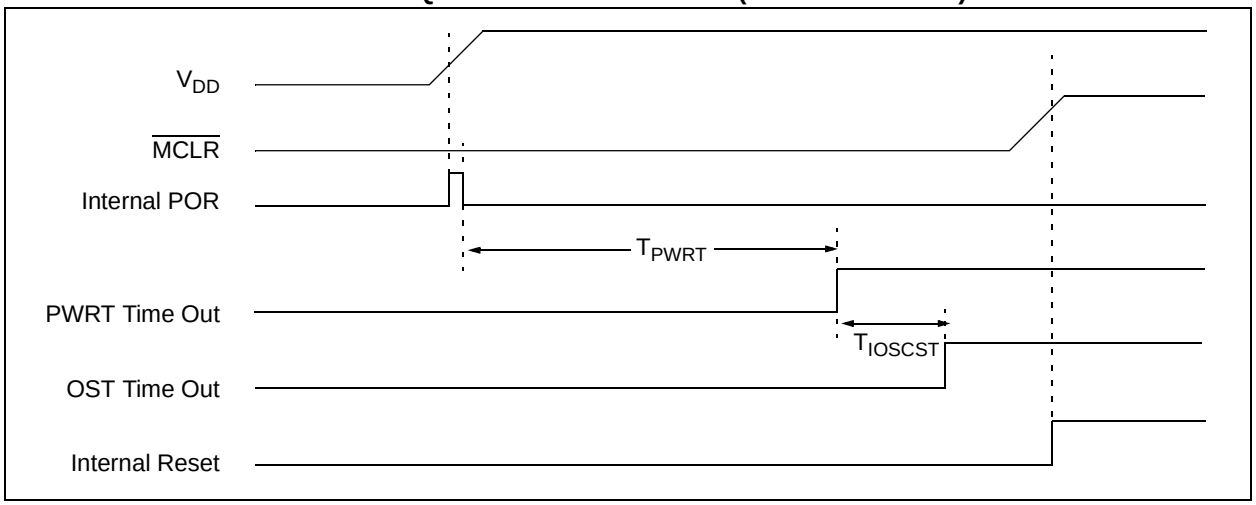


FIGURE 14-5: TIME-OUT SEQUENCE ON POWER-UP ($\overline{MCLR}$ WITH V_{DD})

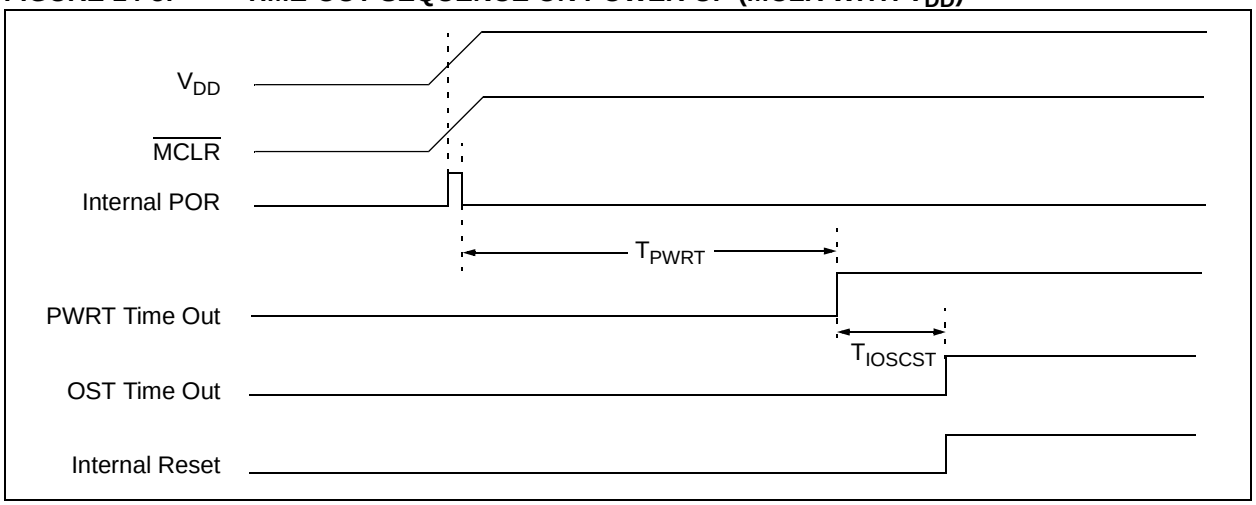


TABLE 14-3: INITIALIZATION CONDITION FOR REGISTERS

Register	Address	Power-On Reset	$\overline{\text{MCLR}}$ Reset WDT Reset	Wake-Up from Sleep through Interrupt Wake-Up from Sleep through WDT Time Out
W	—	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF	00h/80h/ 100h/180h	xxxx xxxx	xxxx xxxx	uuuu uuuu
TMR0	01h/101h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	02h/82h/ 102h/182h	0000 0000	0000 0000	PC + 1(3)
STATUS	03h/83h/ 103h/183h	0001 1xxx	000q quuu(4)	uuuq quuu(4)
FSR	04h/84h/ 104h/184h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTGPA	05h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTGPB	06h	xxx- xxxx	uuu- uuuu	uuu- uuuu
PIR1	07h	-000 --00	-000 --00	-uuu --uu
PIR2	08h	0-00 --00	0-00 --00	u-uu --uu
PCON	09h	---- -qq-	---- -uu-	---- -uu-
PCLATH	0Ah/8Ah/ 10Ah/18Ah	---0 0000	---0 0000	---u uuuu
INTCON	0Bh/8Bh/ 10Bh/18Bh	0000 000x	0000 000u	uuuu uuuu(2)
TMR1L	0Ch	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR1H	0Dh	xxxx xxxx	uuuu uuuu	uuuu uuuu
T1CON	0Eh	--00 --00	--uu --uu	--uu --uu
TMR2	0Fh	0000 0000	uuuu uuuu	uuuu uuuu
T2CON	10h	---- -000	---- -000	---- -uuu
PR2	11h	1111 1111	1111 1111	uuuu uuuu
PWMPHL	13h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PWMPHH	14h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PWMRL	15h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PWMRH	16h	xxxx xxxx	uuuu uuuu	uuuu uuuu
OVCCON	19h	0000 0000	0000 0000	uuuu uuuu
OVFCON	1Ah	0--0 0000	0--0 0000	u--u uuuu
OSCTUNE	1Bh	---0 0000	---0 0000	---u uuuu
ADRESL(1)	1Ch	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADRESH(1)	1Dh	---- --xx	---- --uu	---- ---uu
ADCON0(1)	1Eh	-000 0000	-000 0000	-uuu uuuu
ADCON1(1)	1Fh	-000 ----	-000 ----	-uuu ----
OPTION_REG	81h/181h	1111 1111	1111 1111	uuuu uuuu
TRISGPA	85h	1111 1111	1111 1111	uuuu uuuu
TRISGPB	86h	1111 1111	1111 1111	uuuu uuuu

Legend: u = unchanged, x = unknown, – = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: If V_{DD} goes too low, Power-On Reset will be activated and registers will be affected differently.

2: One or more bits in the INTCON and/or PIRx registers will be affected (to cause wake-up).

3: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

4: See Table 14-5 for Reset value for specific condition.

TABLE 14-3: INITIALIZATION CONDITION FOR REGISTERS (CONTINUED)

Register	Address	Power-On Reset	$\overline{\text{MCLR}}$ Reset WDT Reset	Wake-Up from Sleep through Interrupt Wake-Up from Sleep through WDT Time Out
PIE1	87h	-000 --00	-000 --00	-uuu --uu
PIE2	88h	0-00 --00	0-00 --00	u-uu --uu
APFCON	89h	---- ---0	---- ---0	---- ---u
VINLVL	90h	0-xx xxxx	0-uu uuuu	u-uu uuuu
OCCON	91h	0xxx xxxx	0uuu uuuu	uuuu uuuu
CSGSCON	93h	-xxx xxxx	-uuu uuuu	-uuu uuuu
CSDGCON	95h	0--- xxxx	0--- uuuu	u--- uuuu
VZCCON	97h	xxxx xxxx	uuuu uuuu	uuuu uuuu
CMPZCON	98h	xxxx xxxx	uuuu uuuu	uuuu uuuu
OUVCON	99h	xxxx xxxx	uuuu uuuu	uuuu uuuu
OOVCON	9Ah	xxxx xxxx	uuuu uuuu	uuuu uuuu
DEADCON	9Bh	xxxx xxxx	uuuu uuuu	uuuu uuuu
SLPCRCON	9Ch	xxxx xxxx	uuuu uuuu	uuuu uuuu
SLVGNCON	9Dh	---x xxxx	---u uuuu	---u uuuu
RELEFF	9Eh	0000 0000	0000 0000	uuuu uuuu
WPUGPA	105h	--1- 1111	--u- uuuu	--u- uuuu
WPUGPB	106h	1111 -11-	uuuu -uu-	uuuu -uu-
PE1	107h	0000 1100	0000 1100	uuuu uuuu
BUFFCON	108h	000- 0000	000- 0000	uuu- uuuu
ABECON	109h	0000 0000	0000 0000	uuuu uuuu
SSPADD	110h	0000 0000	0000 0000	uuuu uuuu
SSPBUF	111h	xxxx xxxx	uuuu uuuu	uuuu uuuu
SSPCON1	112h	0000 0000	0000 0000	uuuu uuuu
SSPCON2	113h	0000 0000	0000 0000	uuuu uuuu
SSPCON3	114h	0000 0000	0000 0000	uuuu uuuu
SSPMSK	115h	1111 1111	1111 1111	uuuu uuuu
SSPSTAT	116h			
SSPADD2	117h	0000 0000	0000 0000	uuuu uuuu
SSPMSK2	118h	1111 1111	1111 1111	uuuu uuuu
IOCA	185h	0000 0000	0000 0000	uuuu uuuu
IOCB	186h	0000 -000	0000 -000	uuuu -uuu
ANSELA	187h	---- 1111	---- 1111	---- uuuu
ANSELB	188h	--11 -11-	--11 -11-	--uu -uu-
PMCON1	190h	-0-- -000	-0-- -000	-u-- -uuu
PMCON2	191h	---- ----	---- ----	---- ----
PMADRL	192h	0000 0000	0000 0000	uuuu uuuu
PMADRH	193h	---- -000	---- -000	---- -uuu
PMDATL	194h	0000 0000	0000 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, – = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: If V_{DD} goes too low, Power-On Reset will be activated and registers will be affected differently.

2: One or more bits in the INTCON and/or PIRx registers will be affected (to cause wake-up).

3: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

4: See Table 14-5 for Reset value for specific condition.

TABLE 14-3: INITIALIZATION CONDITION FOR REGISTERS (CONTINUED)

Register	Address	Power-On Reset	$\overline{\text{MCLR}}$ Reset WDT Reset	Wake-Up from Sleep through Interrupt Wake-Up from Sleep through WDT Time Out
PMDATH	195h	--00 0000	--00 0000	--uu uuuu
OSCCAL	198h	-xxx xxxx	-uuu uuuu	-uuu uuuu
DOVCAL	199h	---- xxxx	---- uuuu	---- uuuu
TTACAL	19Ah	---- xxxx	---- uuuu	---- uuuu
BGRCAL	19Bh	---- xxxx	---- uuuu	---- uuuu
VROCAL	19Ch	---- xxxx	---- uuuu	---- uuuu
ZROCAL	19Dh	---- xxxx	---- uuuu	---- uuuu
ATSTCON	19F	1--- 0001	1--- 0001	u--- uuuu

Legend: u = unchanged, x = unknown, – = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: If V_{DD} goes too low, Power-On Reset will be activated and registers will be affected differently.

2: One or more bits in the INTCON and/or PIRx registers will be affected (to cause wake-up).

3: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

4: See Table 14-5 for Reset value for specific condition.

14.7 Determining the Cause of a Reset

Upon any Reset, multiple bits in the STATUS and PCON registers are updated to indicate the cause of the Reset. Tables 14-4 and 14-5 show the Reset conditions of these registers.

TABLE 14-4: RESET STATUS BITS AND THEIR SIGNIFICANCE

$\overline{\text{POR}}$	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Condition
0	1	1	Power-On Reset
u	0	u	WDT Reset
u	0	0	WDT Wake-Up from Sleep
u	1	0	Interrupt Wake-Up from Sleep
u	u	u	$\overline{\text{MCLR}}$ Reset during normal operation
u	1	0	$\overline{\text{MCLR}}$ Reset during Sleep
0	0	x	Not allowed. $\overline{\text{TO}}$ is set on POR
0	x	0	Not allowed. $\overline{\text{PD}}$ is set on POR

TABLE 14-5: RESET CONDITION FOR SPECIAL REGISTERS (Note 2)

Condition	Program Counter	STATUS Register	PCON Register
Power-On Reset	0000h	0001 1xxx	---- -u0-
$\overline{\text{MCLR}}$ Reset during normal operation	0000h	000u uuuu	---- -uu-
$\overline{\text{MCLR}}$ Reset during Sleep	0000h	0001 0uuu	---- -uu-
WDT Reset	0000h	0000 uuuu	---- -uu-
WDT Wake-Up from Sleep	PC + 1	uuu0 0uuu	---- -uu-
Interrupt Wake-Up from Sleep	PC + 1(1)	uuu1 0uuu	---- -uu-

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0'.

Note 1: When the wake-up is due to an interrupt and the Global Interrupt Enable (GIE) bit is set, the return address is pushed on the stack and PC is loaded with the interrupt vector (0004h) after execution of PC + 1.

2: If a Status bit is not implemented, that bit will be read as '0'.

14.8 Power Control (PCON) Register

The Power Control (PCON) register contains flag bits to differentiate between a:

- Power-On Reset ($\overline{POR}$)
- Overtemperature ($\overline{OT}$)

The PCON register bits are shown in Register 14-1.

REGISTER 14-1: PCON: POWER CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0
—	—	—	—	—	$\overline{OT}$	$\overline{POR}$	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-3 **Unimplemented:** Read as '0'

bit 2 **$\overline{OT}$:** Overtemperature Reset Status bit
1 = No Overtemperature Reset occurred
0 = An Overtemperature Reset occurred (must be set in software after an Overtemperature occurs)

bit 1 **$\overline{POR}$:** Power-On Reset Status bit
1 = No Power-On Reset occurred
0 = A Power-On Reset occurred (must be set in software after a Power-On Reset occurs)

bit 0 **Unimplemented:** Read as '0'

TABLE 14-6: SUMMARY OF REGISTERS ASSOCIATED WITH RESETS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
PCON	—	—	—	—	—	$\overline{OT}$	$\overline{POR}$	—	92
STATUS	IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	71

Legend: — = unimplemented bit, reads as '0'. Shaded cells are not used by Resets.

Note 1: Other (non Power-Up) Resets include $\overline{MCLR}$ Reset and Watchdog Timer Reset during normal operation.

15.0 INTERRUPTS

The MCP19118/19 has multiple sources of interrupt:

- External Interrupt (INT pin)
- Interrupt-On-Change (IOC) Interrupts
- Timer0 Overflow Interrupt
- Timer1 Overflow Interrupt
- Timer2 Match Interrupt
- ADC Interrupt
- System Overvoltage Error
- System Undervoltage Error
- System Overcurrent Error
- SSP
- BCL
- System Input Undervoltage Error

The Interrupt Control (INTCON) register and Peripheral Interrupt Request (PIRx) registers record individual interrupt requests in flag bits. The INTCON register also has individual and global interrupt enable bits.

The Global Interrupt Enable (GIE) bit in the INTCON register enables (if set) all unmasked interrupts or disables (if cleared) all interrupts. Individual interrupts can be disabled through their corresponding enable bits in the INTCON register and PIEx registers. GIE is cleared on Reset.

When an interrupt is serviced, the following actions occur automatically:

- The GIE is cleared to disable any further interrupt.
- The return address is pushed onto the stack.
- The PC is loaded with 0004h.

The firmware within the Interrupt Service Routine (ISR) should determine the source of the interrupt by polling the interrupt flag bits. The interrupt flag bits must be cleared before exiting the ISR, to avoid repeated interrupts. Because the GIE bit is cleared, any interrupt that occurs while executing the ISR will be recorded through its interrupt flag, but will not cause the processor to redirect to the interrupt vector.

Note 1:	Individual interrupt flag bits are set, regardless of the status of their corresponding mask bit or the GIE bit.
2:	When an instruction that clears the GIE bit is executed, any interrupts that were pending for execution in the next cycle are ignored. The interrupts which were ignored are still pending to be serviced when the GIE bit is set again.

The `RETFIE` instruction exits the ISR by popping the previous address from the stack, restoring the saved context from the shadow registers and setting the GIE bit.

For additional information on a specific Interrupt's operation, refer to its Peripheral chapter.

15.1 Interrupt Latency

For external interrupt events, such as the INT pin or PORTGPx change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends upon when the interrupt event occurs (see Figure 15-2). The latency is the same for one or two-cycle instructions.

15.2 GPA2/INT Interrupt

The external interrupt on the GPA2/INT pin is edge-triggered either on the rising edge, if the INTEDG bit in the OPTION_REG register is set or on the falling edge, if the INTEDG bit is cleared. When a valid edge appears on the GPA2/INT pin, the INTF bit in the INTCON register is set. This interrupt can be disabled by clearing the INTE control bit in the INTCON register. The INTF bit must be cleared by software in the Interrupt Service Routine before re-enabling this interrupt. The GPA2/INT interrupt can wake-up the processor from Sleep, if the INTE bit was set prior to going into Sleep. See **Section 16.0 "Power-Down Mode (Sleep)"** for details on Sleep and **Section 16.1 "Wake-Up from Sleep"** for timing of wake-up from Sleep through GPA2/INT interrupt.

Note:	The ANSELx registers must be initialized to configure an analog channel as a digital input. Pins configured as analog inputs will read '0' and cannot generate an interrupt.

FIGURE 15-1: INTERRUPT LOGIC

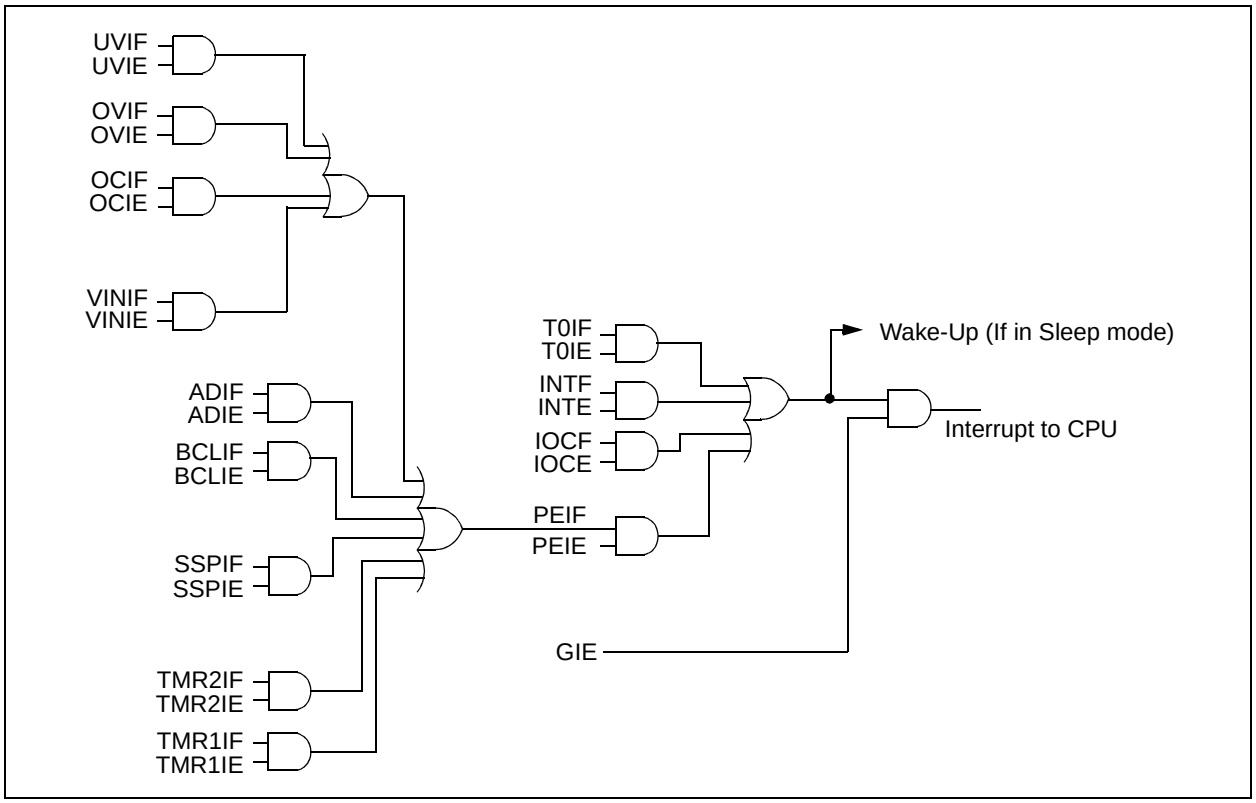
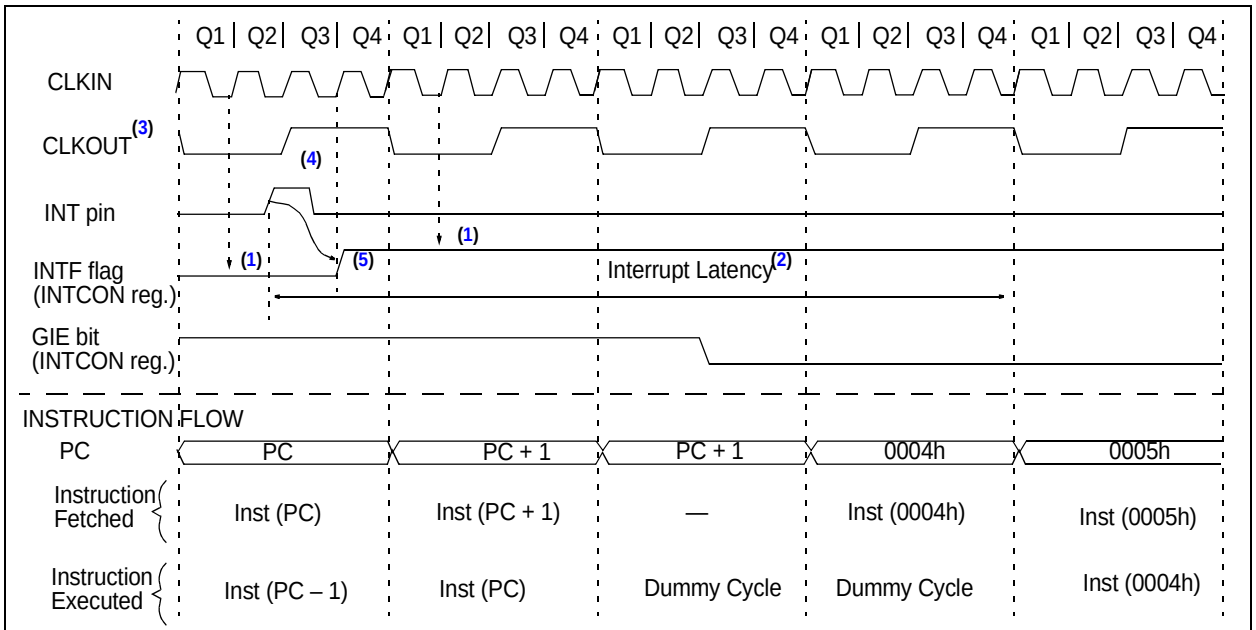


FIGURE 15-2: INT PIN INTERRUPT TIMING



Note 1: INTF flag is sampled here (every Q1).

2: Asynchronous interrupt latency = 3-4 T_{CY}. Synchronous latency = 3 T_{CY}, where T_{CY} = instruction cycle time. Latency is the same whether Inst (PC) is a single cycle or a two-cycle instruction.

3: CLKOUT is available only in INTOSC and RC Oscillator modes.

4: For minimum width of INT pulse, refer to the AC specifications in **Section 5.0 "Digital Electrical Characteristics"**.

5: INTF is enabled to be set any time during the Q4–Q1 cycles.

15.3 Interrupt Control Registers

15.3.1 INTCON REGISTER

The INTCON register is a readable and writable register that contains the various enable and flag bits for the TMR0 register overflow, interrupt-on-change and external INT pin interrupts.

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable (GIE) bit in the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 15-1: INTCON: INTERRUPT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **GIE:** Global Interrupt Enable bit
1 = Enables all unmasked interrupts
0 = Disables all interrupts

bit 6 **PEIE:** Peripheral Interrupt Enable bit
1 = Enables all unmasked peripheral interrupts
0 = Disables all peripheral interrupts

bit 5 **T0IE:** TMR0 Overflow Interrupt Enable bit
1 = Enables the TMR0 interrupt
0 = Disables the TMR0 interrupt

bit 4 **INTE:** INT External Interrupt Enable bit
1 = Enables the INT external interrupt
0 = Disables the INT external interrupt

bit 3 **IOCE:** Interrupt-on-Change Enable bit(1)
1 = Enables the interrupt-on-change
0 = Disables the interrupt-on-change

bit 2 **T0IF:** TMR0 Overflow Interrupt Flag bit(2)
1 = TMR0 register overflowed (must be cleared in software)
0 = TMR0 register did not overflow

bit 1 **INTF:** External Interrupt Flag bit
1 = The external interrupt occurred (must be cleared in software)
0 = The external interrupt did not occur

bit 0 **IOCF:** Interrupt-on-Change Interrupt Flag bit
1 = When at least one of the interrupt-on-change pins changed state
0 = None of the interrupt-on-change pins changed state

Note 1: The IOCx registers must also be enabled.
2: T0IF bit is set when TMR0 rolls over. TMR0 is unchanged on Reset and should be initialized before clearing T0IF bit.

15.3.1.1 PIE1 Register

The PIE1 register (Register 15-2) contains the Peripheral Interrupt Enable bits.

Note 1:	The PEIE bit in the INTCON register must be set to enable any peripheral interrupt.

REGISTER 15-2: PIE1: PERIPHERAL INTERRUPT ENABLE REGISTER 1

U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0
—	ADIE	BCLIE	SSPIE	—	—	TMR2IE	TMR1IE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6 **ADIE:** ADC Interrupt Enable bit
1 = Enables the ADC interrupt
0 = Disables the ADC interrupt

bit 5 **BCLIE:** MSSP Bus Collision Interrupt Enable bit
1 = Enables the MSSP Bus Collision Interrupt
0 = Disables the MSSP Bus Collision Interrupt

bit 4 **SSPIE:** Synchronous Serial Port (MSSP) Interrupt Enable bit
1 = Enables the MSSP interrupt
0 = Disables the MSSP interrupt

bit 3-2 **Unimplemented:** Read as '0'

bit 1 **TMR2IE:** Timer2 Interrupt Enable
1 = Enables the Timer2 interrupt
0 = Disables the Timer2 interrupt

bit 0 **TMR1IE:** Timer1 Interrupt Enable
1 = Enables the Timer1 interrupt
0 = Disables the Timer1 interrupt

15.3.1.2 PIE2 Register

The PIE2 register (Register 15-3) contains the Peripheral Interrupt Enable bits.

Note 1:	The PEIE bit in the INTCON register must be set to enable any peripheral interrupt.

REGISTER 15-3: PIE2: PERIPHERAL INTERRUPT ENABLE REGISTER 2

U-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0	U-0
UVIE	—	OCIE	OVIE	—	—	VINIE	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **UVIE:** Output Undervoltage Interrupt enable bit
1 = Enables the UV interrupt
0 = Disables the UV interrupt

bit 6 **Unimplemented:** Read as '0'

bit 5 **OCIE:** Output Overcurrent Interrupt enable bit
1 = Enables the OC interrupt
0 = Disables the OC interrupt

bit 4 **OVIE:** Output Overvoltage Interrupt enable bit
1 = Enables the OV interrupt
0 = Disables the OV interrupt

bit 3-2 **Unimplemented:** Read as '0'

bit 1 **VINIE:** V_{IN} UVLO Interrupt Enable
1 = Enables the V_{IN} UVLO interrupt
0 = Disables the V_{IN} UVLO interrupt

bit 0 **Unimplemented:** Read as '0'

15.3.1.3 PIR1 Register

The PIR1 register (Register 15-4) contains the Peripheral Interrupt Flag bits.

Note 1:	Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable (GIE) bit in the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 15-4: PIR1: PERIPHERAL INTERRUPT FLAG REGISTER 1

U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0
—	ADIF	BCLIF	SSPIF	—	—	TMR2IF	TMR1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6 **ADIF:** ADC Interrupt Flag bit
1 = ADC conversion complete
0 = ADC conversion has not completed or has not been started

bit 5 **BCLIF:** MSSP Bus Collision Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

bit 4 **SSPIF:** Synchronous Serial Port (MSSP) Interrupt Flag bit
1 = Interrupt is pending
0 = Interrupt is not pending

bit 3-2 **Unimplemented:** Read as '0'

bit 1 **TMR2IF:** Timer2 to PR2 Match Interrupt Flag
1 = Timer2 to PR2 match occurred (must be cleared in software)
0 = Timer2 to PR2 match did not occur

bit 0 **TMR1IF:** Timer1 Interrupt Flag
1 = Timer1 rolled over (must be cleared in software)
0 = Timer1 did not roll over

15.3.1.4 PIR2 Register

The PIR2 register (Register 15-5) contains the Peripheral Interrupt Flag bits.

Note 1:	Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable (GIE) bit in the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 15-5: PIR2: PERIPHERAL INTERRUPT FLAG REGISTER 2

R/W-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0	U-0
UVIF	—	OCIF	OVIF	—	—	VINIF	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **UVIF:** Output undervoltage error interrupt flag bit
1 = Output undervoltage error has occurred
0 = Output undervoltage error has not occurred

bit 6 **Unimplemented:** Read as '0'

bit 5 **OCIF:** Output overcurrent error interrupt flag bit
1 = Output overcurrent error has occurred
0 = Output overcurrent error has not occurred

bit 4 **OVIF:** Output overvoltage error interrupt flag bit
1 = Output overvoltage error has occurred
0 = Output overvoltage error has not occurred

bit 3-2 **Unimplemented:** Read as '0'

bit 1 **VINIF:** V_{IN} Status bit
1 = V_{IN} is below acceptable level
0 = V_{IN} is at acceptable level

bit 0 **Unimplemented:** Read as '0'

TABLE 15-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPTS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF	95
OPTION_REG	$\overline{\text{RAPU}}$	INTEDG	T0CE	T0SE	PSA	PS2	PS1	PS0	77
PIE1	—	ADIE	BCLIE	SSPIE	—	—	TMR2IE	TMR1IE	96
PIE2	UVIE	—	OCIE	OVIE	—	—	VINIE	—	97
PIR1	—	ADIF	BCLIF	SSPIF	—	—	TMR2IF	TMR1IF	98
PIR2	UVIF	—	OCIF	OVIF	—	—	VINIF	—	99

Legend: — = unimplemented locations read as '0'. Shaded cells are not used by Interrupts.

15.4 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt (e.g., W and STATUS registers). This must be implemented in software.

Temporary holding registers W_TEMP and STATUS_TEMP should be placed in the last 16 bytes of GPR (see Figure 11-2). These 16 locations are common to all banks and do not require banking. This makes context save and restore operations simpler. The code shown in Example 15-1 can be used to:

- Store the W register
- Store the STATUS register
- Execute the ISR code
- Restore the Status (and Bank Select Bit) register
- Restore the W register

Note:	The MCP19118/19 device does not require saving the PCLATH. However, if computed GOTOs are used in both the ISR and the main code, the PCLATH must be saved and restored in the ISR.

EXAMPLE 15-1: SAVING STATUS AND W REGISTERS IN RAM

```
    MOVWF   W_TEMP              ;Copy W to TEMP register
    SWAPF   STATUS,W            ;Swap status to be saved into W
                                ;Swaps are used because they do not affect the status bits
    MOVWF   STATUS_TEMP         ;Save status to bank zero STATUS_TEMP register
    :
    :(ISR)                      ;Insert user code here
    :
    SWAPF   STATUS_TEMP,W       ;Swap STATUS_TEMP register into W
                                ;(sets bank to original state)
    MOVWF   STATUS              ;Move W into STATUS register
    SWAPF   W_TEMP,F            ;Swap W_TEMP
    SWAPF   W_TEMP,W            ;Swap W_TEMP into W
```

16.0 POWER-DOWN MODE (SLEEP)

The Power-Down mode is entered by executing a SLEEP instruction.

Upon entering Sleep mode, the following conditions exist:

1. WDT will be cleared but keeps running, if enabled for operation during Sleep.
2. The $\overline{PD}$ bit in the STATUS register is cleared.
3. The $\overline{TO}$ bit in the STATUS register is set.
4. CPU clock is not disabled.
5. The Timer1 oscillator is unaffected and peripherals that operate from it may continue operation in Sleep.
6. The ADC is unaffected.
7. The I/O ports maintain the status they had before SLEEP was executed (driving high, low or high-impedance).
8. Resets other than WDT are not affected by Sleep mode.
9. Analog circuitry is unaffected by execution of SLEEP instruction.

Refer to individual chapters for more details on peripheral operation during Sleep.

To minimize current consumption, the following conditions should be considered:

- I/O pins should not be floating
- External circuitry sinking current from I/O pins
- Internal circuitry sourcing current from I/O pins
- Current draw from pins with internal weak pull-ups
- Modules using Timer1 oscillator

I/O pins that are high-impedance inputs should be pulled to V_{DD} or GND externally to avoid switching currents caused by floating inputs.

The SLEEP instruction does not affect the analog circuitry. The enable state of the analog circuitry does not change with the execution of the SLEEP instruction.

Examples of internal circuitry that might be sourcing current include modules, such as the DAC. See **Section 22.0 "Analog-to-Digital Converter (ADC) Module"** for more information on this module.

16.1 Wake-Up from Sleep

The device can wake-up from Sleep through one of the following events:

1. External Reset input on $\overline{MCLR}$ pin, if enabled
2. POR Reset
3. Watchdog Timer, if enabled
4. Any external interrupt
5. Interrupts by peripherals capable of running during Sleep (see individual peripheral for more information)

The first two events will cause a device Reset. The last three events are considered a continuation of program execution. To determine whether a device Reset or Wake-Up event occurred, refer to **Section 14.7 "Determining the Cause of a Reset"**.

The following peripheral interrupts can wake the device from Sleep:

1. Timer1 interrupt. Timer1 must be operating as an asynchronous counter.
2. A/D conversion
3. Interrupt-on-change
4. External Interrupt from the INT pin

When the SLEEP instruction is being executed, the next instruction (PC + 1) is prefetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be enabled. Wake-up will occur regardless of the state of the GIE bit. If the GIE bit is disabled, the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is enabled, the device executes the instruction after the SLEEP instruction, the device will then call the Interrupt Service Routine. In cases where the execution of the instruction following SLEEP is not desirable, the user should have an NOP after the SLEEP instruction.

The WDT is cleared when the device wakes up from Sleep, regardless of the source of wake-up.

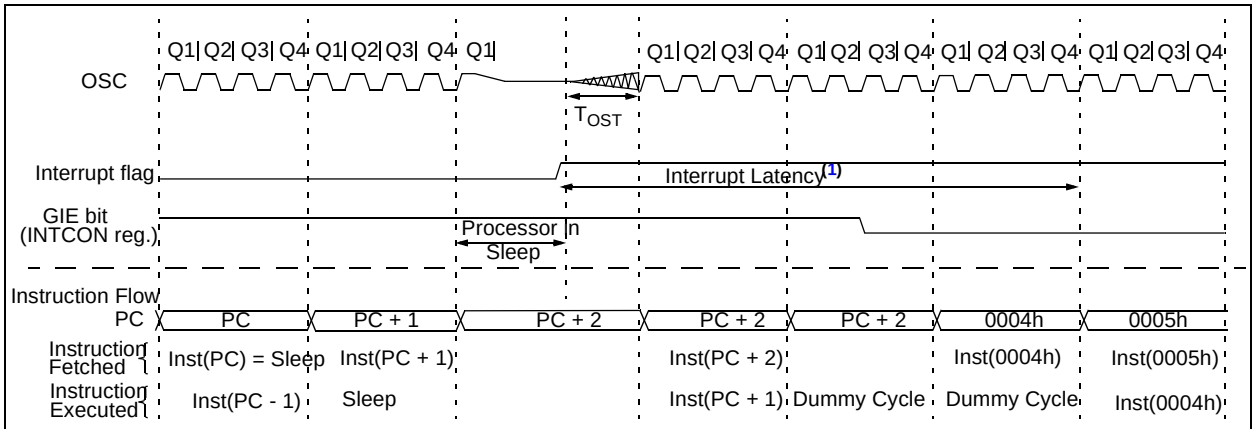
16.1.1 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs **before** the execution of a SLEEP instruction:
  - SLEEP instruction will execute as an NOP
  - WDT and WDT prescaler will not be cleared
  - The $\overline{TO}$ bit in the STATUS register will not be set
  - The $\overline{PD}$ bit in the STATUS register will not be cleared
- If the interrupt occurs **during or after** the execution of a SLEEP instruction:
  - SLEEP instruction will be completely executed
  - The device will immediately wake-up from Sleep
  - WDT and WDT prescaler will be cleared
  - The $\overline{TO}$ bit in the STATUS register will be set
  - The $\overline{PD}$ bit in the STATUS register will be cleared

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the $\overline{PD}$ bit. If the $\overline{PD}$ bit is set, the SLEEP instruction was executed as an NOP.

FIGURE 16-1: WAKE-UP FROM SLEEP THROUGH INTERRUPT



Note 1: GIE = 1 assumed. In this case, after wake-up, the processor calls the ISR at 0004h. If GIE = 0, execution will continue in-line.

TABLE 16-1: SUMMARY OF REGISTERS ASSOCIATED WITH POWER-DOWN MODE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF	95
IOCA	IOCA7	IOCA6	IOCA5	IOCA4	IOCA3	IOCA2	IOCA1	IOCA0	122
IOCB	IOCB7	IOCB6	IOCB5	IOCB4	—	IOCB2	IOCB1	IOCB0	122
PIE1	—	ADIE	BCLIE	SSPIE	—	—	TMR2IE	TMR1IE	96
PIE2	UVIE	—	OCIE	OVIE	—	—	VINIE	—	97
PIR1	—	ADIF	BCLIF	SSPIF	—	—	TMR2IF	TMR1IF	98
PIR2	UVIF	—	OCIF	OVIF	—	—	VINIF	—	99
STATUS	IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C	71

Legend: — = unimplemented, read as '0'. Shaded cells are not used in Power-Down mode.

17.0 WATCHDOG TIMER (WDT)

The Watchdog Timer is a free-running timer. The WDT is enabled by setting the WDTE bit in the Configuration Word (default setting).

During normal operation, a WDT time out generates a device Reset. If the device is in Sleep mode, a WDT time out causes the device to wake-up and continue with normal operation.

The WDT can be permanently disabled by clearing the WDTE bit in the Configuration Word register. See **Section 12.1 "Configuration Word"** for more information.

17.1 Watchdog Timer (WDT) Operation

During normal operation, a WDT time out generates a device Reset. If the device is in Sleep mode, a WDT time out causes the device to wake-up and continue with normal operation; this is known as a WDT wake-up. The WDT can be permanently disabled by clearing the WDTE configuration bit.

The postscaler assignment is fully under software control and can be changed during program execution.

17.2 WDT Period

The WDT has a nominal time-out period of 18 ms (with no prescaler). The time-out periods vary with temperature, V_{DD} and process variations from part to part (see Table 5-4). If longer time-out periods are desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT under software control by writing to the OPTION_REG register. Thus, time-out periods up to 2.3 seconds can be realized.

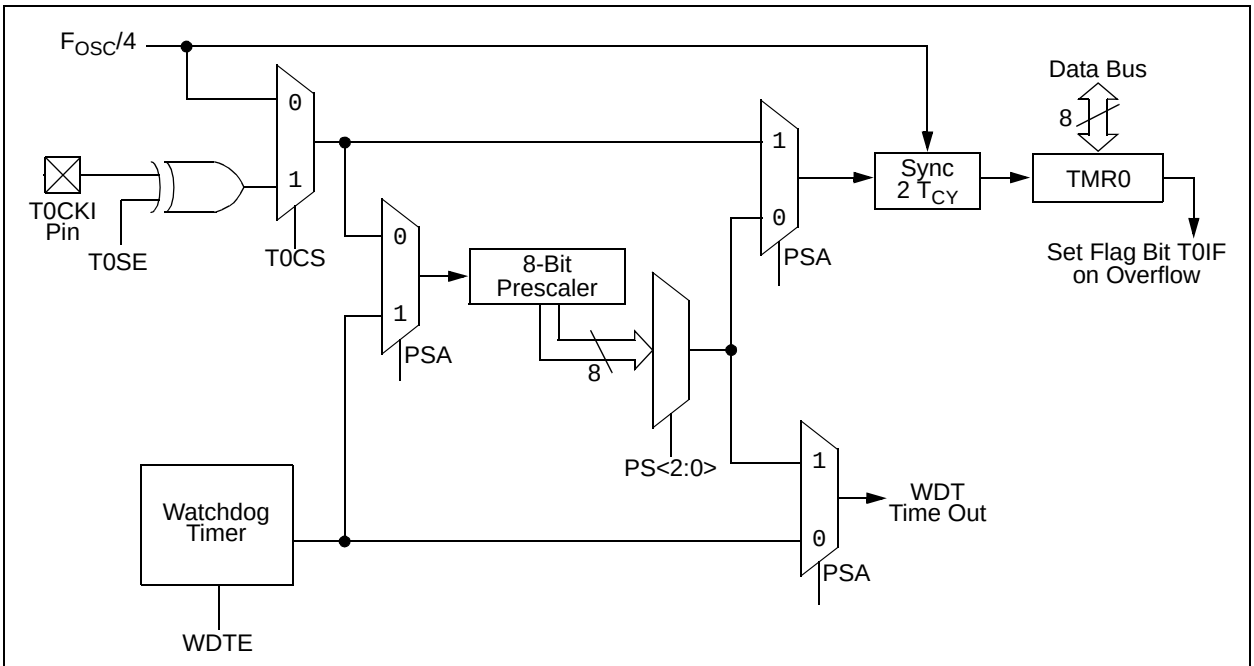
The `CLRWDT` and `SLEEP` instructions clear the WDT and the prescaler, if assigned to the WDT, and prevent it from timing out and generating a device Reset.

The $\overline{TO}$ bit in the STATUS register will be cleared upon a Watchdog Timer time out.

17.3 WDT Programming Considerations

Under worst-case conditions (i.e., V_{DD} = Minimum, Temperature = Maximum, Maximum WDT prescaler), it may take several seconds before a WDT time out occurs.

FIGURE 17-1: WATCHDOG TIMER WITH SHARED PRESCALER BLOCK DIAGRAM



Note 1: T0SE, T0CS, PSA, PS<2:0> are bits in the OPTION_REG register.

2: The WDTE bit is in the Configuration Word register.

TABLE 17-1: WDT STATUS

Conditions	WDT
WDTE = 0	Cleared
CLRWDT Command	
Exit Sleep	

TABLE 17-2: SUMMARY OF REGISTERS ASSOCIATED WITH WATCHDOG TIMER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OPTION_REG	$\overline{\text{RAPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	77

Legend: Shaded cells are not used by the Watchdog Timer.

TABLE 17-3: SUMMARY OF CONFIGURATION WORD ASSOCIATED WITH WATCHDOG TIMER

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CONFIG	13:8	—	—	$\overline{\text{DBGEN}}$	—	WRT1	WRT0	—	—	81
	7:0	—	$\overline{\text{CP}}$	MCLRE	$\overline{\text{PWRTE}}$	WDTE	—	—	—	

Legend: — = unimplemented location, read as '1'. Shaded cells are not used by Watchdog Timer.

18.0 FLASH PROGRAM MEMORY CONTROL

The Flash program memory is readable and writable during normal operation (full V_{IN} range). This memory is not directly mapped in the register file space. Instead, it is indirectly addressed through the Special Function Registers (SFR) (see Registers 18-1 to 18-5). There are six SFRs used to read and write this memory:

- PMCON1
- PMCON2
- PMDATL
- PMDATH
- PMADRL
- PMADRH

When interfacing the program memory block, the PMDATL and PMDATH registers form a two-byte word, which holds the 14-bit data for read/write, while the PMADRL and PMADRH registers form a two-byte word, which holds the 13-bit address of the FLASH location being accessed. These devices have 4K words of program Flash with an address range from 0000h to 0FFFh.

The program memory allows single-word read and a four-word write. A four-word write automatically erases the row of the location and writes the new data (erase before write).

The write time is controlled by an on-chip timer. The write/erase voltages are generated by an on-chip charge pump rated to operate over the voltage range of the device for byte or word operations.

When the device is code-protected, the CPU may continue to read and write the Flash program memory.

Depending on the settings of the Flash Program Memory Enable (WRT<1:0>) bits, the device may or may not be able to write certain blocks of the program memory. However, reads of the program memory are allowed.

When the Flash Program Memory Code Protection ($\overline{CP}$) bit is enabled, the program memory is code-protected and the device programmer (ICSP) cannot access data or program memory.

18.1 PMADRH and PMADRL Registers

The PMADRH and PMADRL registers can address up to a maximum of 4K words of program memory.

When selecting a program address value, the Most Significant Byte (MSB) of the address is written to the PMADRH register and the Least Significant Byte (LSB) is written to the PMADRL register.

18.2 PMCON1 and PMCON2 Registers

PMCON1 is the control register for the data program memory accesses.

Control bits RD and WR initiate read and write, respectively. These bits cannot be cleared, only set in software. They are cleared in hardware at completion of the read or write operation. The inability to clear the WR bit in software prevents the accidental premature termination of a write operation.

The WREN bit, when set, will allow a write operation. On power-up, the WREN bit is clear.

The CALSEL bit allows the user to read locations in test memory in case there are calibration bits stored in the calibration word locations that need to be transferred to SFR trim registers. The CALSEL bit is only for reads and, if a write operation is attempted with CALSEL = 1, no write will occur.

PMCON2 is not a physical register. Reading PMCON2 will read all '0's. The PMCON2 register is used exclusively in the flash memory write sequence.

18.3 Flash Program Memory Control Registers

REGISTER 18-1: PMDATL: PROGRAM MEMORY DATA LOW BYTE REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PMDATL<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-0 **PMDATL<7:0>**: 8 Least Significant Data Bits Read from Program Memory

REGISTER 18-2: PMADRL: PROGRAM MEMORY ADDRESS LOW BYTE REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PMADRL<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-0 **PMADRL<7:0>**: 8 Least Significant Address Bits for Program Memory Read/Write Operation

REGISTER 18-3: PMDATH: PROGRAM MEMORY DATA HIGH BYTE REGISTER

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	PMDATH<5:0>					
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **PMDATH<5:0>**: 6 Most Significant Data Bits Read from Program Memory

REGISTER 18-4: PMADRH: PROGRAM MEMORY ADDRESS HIGH BYTE REGISTER

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	—	PMADRH<3:0>			
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-4 **Unimplemented:** Read as ‘0’

bit 3-0 **PMADRH<3:0>**: Specifies the 4 Most Significant Address bits or High bits for Program Memory Reads.

REGISTER 18-5: PMCON1: PROGRAM MEMORY CONTROL REGISTER 1

U-1	R/W-0	U-0	U-0	U-0	R/W-0	R/S-0	R/S-0
—	CALSEL	—	—	—	WREN	WR	RD
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown
S = Bit can only be set			

bit 7 **Unimplemented:** Read as '1'

bit 6 **CALSEL:** Program Memory calibration space select bit
1 = Select test memory area for reads only (for loading calibration trim registers)
0 = Select user area for reads

bit 5-3 **Unimplemented:** Read as '0'

bit 2 **WREN:** Program Memory Write Enable bit
1 = Allows write cycles
0 = Inhibits write to the Flash Program Memory

bit 1 **WR:** Write Control bit
1 = Initiates a write cycle to program memory. (The bit is cleared by hardware when write is complete. The WR bit can only be set (not cleared) in software.)
0 = Write cycle to the Flash memory is complete

bit 0 **RD:** Read Control bit
1 = Initiates a program memory read. (The read takes one cycle. The RD is cleared in hardware; the RD bit can only be set (not cleared) in software).
0 = Does not initiate a Flash memory read

18.3.1 READING THE FLASH PROGRAM MEMORY

To read a program memory location, the user must write two bytes of the address to the PMADRL and PMADRH registers and then set control bit RD (PMCON1<0>). Once the read control bit is set, the program memory Flash controller will use the second instruction cycle after setting the control bit to read the data. This causes the second instruction immediately following the "BSF PMCON1,RD" instruction to be ignored. The data is available, in the very next cycle, in the PMDATL and PMDATH registers; it can be read as two bytes in the following instructions. PMDATL and PMDATH registers will hold this value until another read or until it is written to by the user (during a write operation).

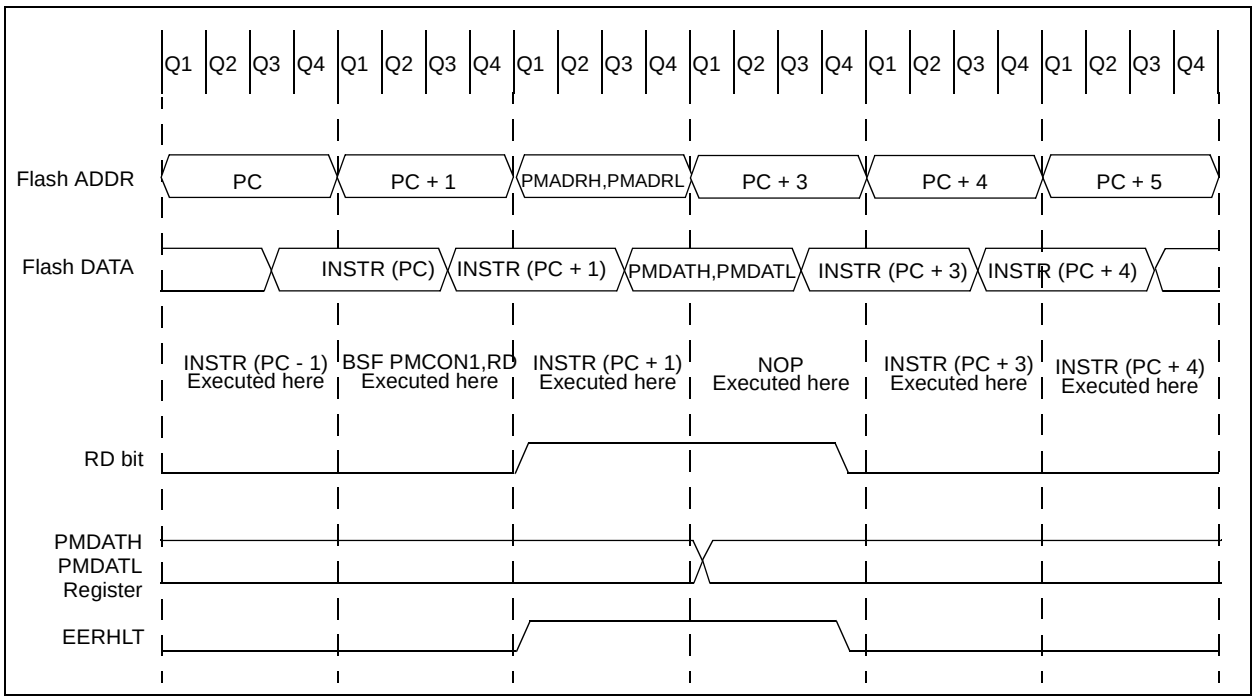
EXAMPLE 18-1: FLASH PROGRAM READ

```
    BANKSELPM_ADR; Change STATUS bits RP1:0 to select bank with PMADR
    MOVLWMS_PROG_PM_ADDR;
    MOVWFPMADRH; MS Byte of Program Address to read
    MOVLWLS_PROG_PM_ADDR;
    MOVWFPMADRL; LS Byte of Program Address to read
    BANKSELPMCON1; Bank to containing PMCON1
    BSF PMCON1, RD; EE Read

    NOP     ; First instruction after BSF PMCON1,RD executes normally

    NOP     ; Any instructions here are ignored as program
            ; memory is read in second cycle after BSF PMCON1,RD
            ;
    BANKSELPMDATL; Bank to containing PMADRL
    MOVFPMDATL, W; W = LS Byte of Program PMDATL
    MOVFPMDATH, W; W = MS Byte of Program PMDATL
```

FIGURE 18-1: FLASH PROGRAM MEMORY READ CYCLE EXECUTION – NORMAL MODE



18.3.2 WRITING TO THE FLASH PROGRAM MEMORY

A word of the Flash program memory may only be written to if the word is in an unprotected segment of memory, as defined in **Section 12.1 "Configuration Word"** (bits WRT<1:0>).

> **Note:** The write-protect bits are used to protect the users' program from modification by the user's code. They have no effect when programming is performed by ICSP. The code-protect bits, when programmed for code protection, will prevent the program memory from being written via the ICSP interface.

Flash program memory must be written in four-word blocks. See Figures 18-2 and 18-3 for more details. A block consists of four words with sequential addresses, with a lower boundary defined by an address, where PMADRL<1:0> = 00. All block writes to program memory are done as 16-word erase by four-word write operations. The write operation is edge-aligned and cannot occur across boundaries.

To write program data, the WREN bit must be set and the data must first be loaded into the buffer registers (see Figure 18-2). This is accomplished by first writing the destination address to PMADRL and PMADRH and then writing the data to PMDATL and PMDATH. After the address and data have been set, the following sequence of events must be executed:

1. Write 55h, then AAh, to PMCON2 (Flash programming sequence).
2. Set the WR control bit in the PMCON1 register.

All four buffer register locations should be written to with correct data. If less than four words are being written to in the block of four words, then a read from the program memory location(s) not being written to must be performed. This takes the data from the program memory location(s) not being written and loads it into the PMDATL and PMDATH registers. Then the sequence of events to transfer data to the buffer registers must be executed.

To transfer data from the buffer registers to the program memory, the PMADRL and PMADRH registers must point to the last location in the four-word block (PMADRL<1:0> = 11). Then the following sequence of events must be executed:

1. Write 55h, then AAh, to PMCON2 (Flash programming sequence).
2. Set the WR control bit in the PMCON1 register to begin the write operation.

The user must follow the same specific sequence to initiate the write for each word in the program block, writing each program word in sequence (000, 001, 010, 011). When the write is performed on the last word (PMADRL<1:0> = 11), a block of sixteen words is automatically erased and the content of the four-word buffer registers are written into the program memory.

After the "BSF PMCON1,WR" instruction, the processor requires two cycles to set up the erase/write operation. The user must place two NOP instructions after the WR bit is set. Since data is being written to buffer registers, the writing of the first three words of the block appears to occur immediately. The processor will halt internal operations for the typical 4 ms, only during the cycle in which the erase takes place (i.e., the last word of the sixteen-word block erase). This is not Sleep mode, as the clocks and peripherals will continue to run. After the four-word write cycle, the processor will resume operation with the third instruction after the PMCON1 write instruction. The above sequence must be repeated for the higher 12 words.

> **Note:** An erase is only initiated for the write of four words, just after a row boundary; or PMCON1<WR> set with PMADRL<3:0> = xxxx0011.

Refer to Figure 18-2 for a block diagram of the buffer registers and the control signals for test mode.

18.3.3 PROTECTION AGAINST SPURIOUS WRITE

There are conditions when the device should not write to the program memory. To protect against spurious writes, various mechanisms have been built in. On power-up, WREN is cleared. Also, the Power-Up Timer (72 ms duration) prevents program memory writes.

The write initiate sequence and the WREN bit help prevent an accidental write during a power glitch or software malfunction.

18.3.4 OPERATION DURING CODE PROTECT

When the device is code-protected, the CPU is able to read and write unscrambled data to the program memory. The test mode access is disabled.

18.3.5 OPERATION DURING WRITE PROTECT

When the program memory is write-protected, the CPU can read and execute from the program memory. The portions of program memory that are write-protected cannot be modified by the CPU using the PMCON registers. The write protection has no effect in ICSP mode.

FIGURE 18-2: BLOCK WRITES TO 4K FLASH PROGRAM MEMORY

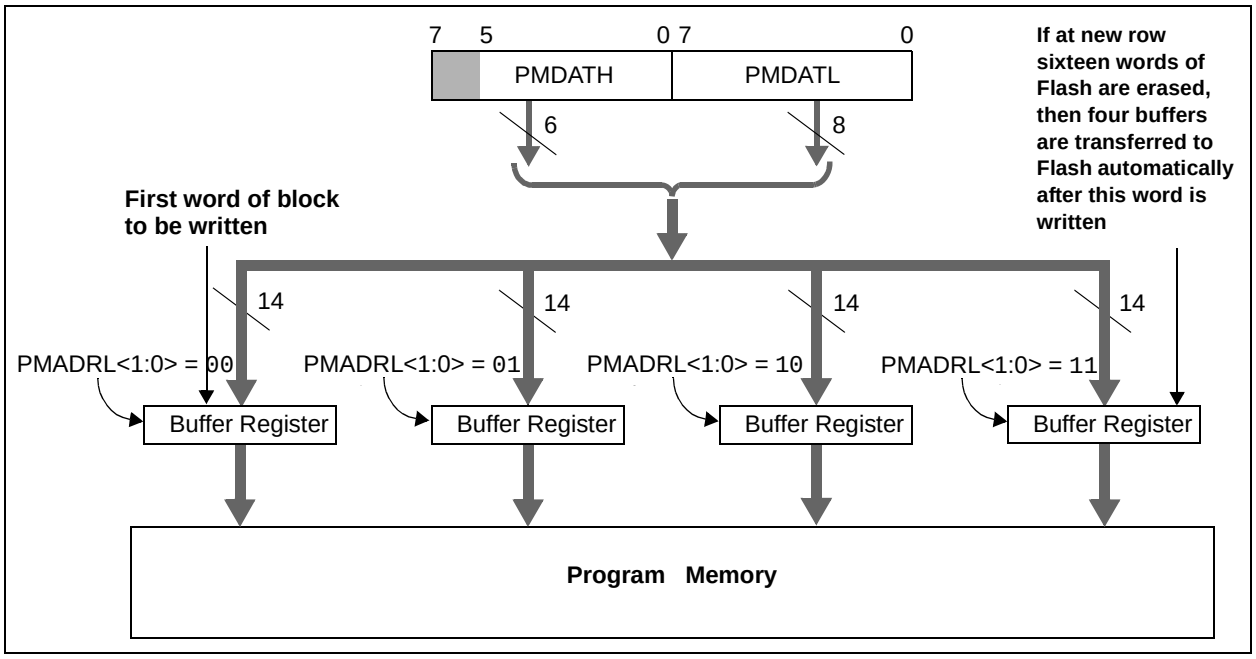
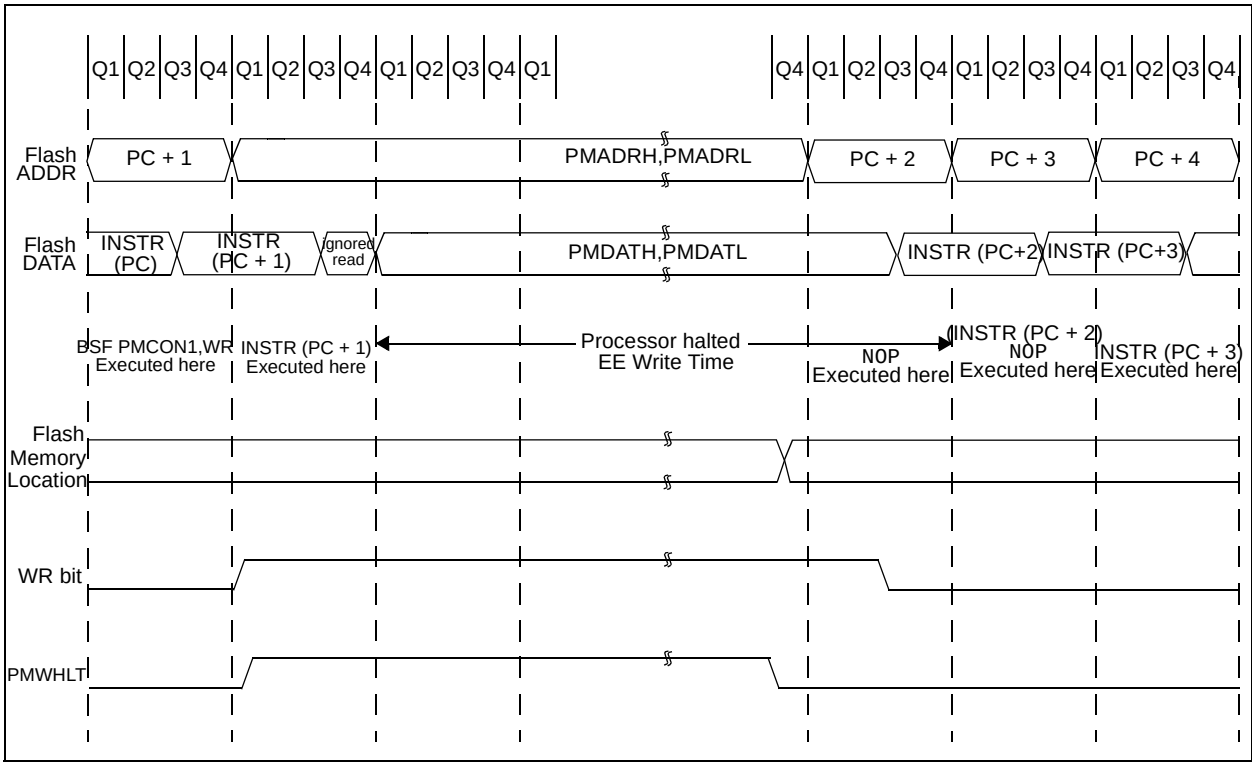


FIGURE 18-3: FLASH PROGRAM MEMORY LONG WRITE CYCLE EXECUTION



19.0 I/O PORTS

In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

Each port has two registers for its operation. These registers are:

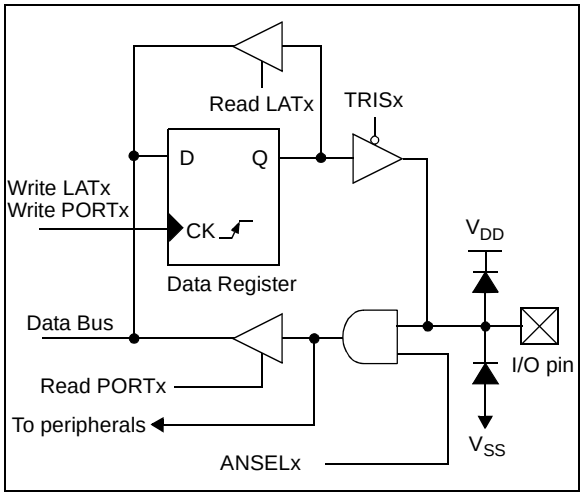
- TRISGPx registers (data direction register)
- PORTGPx registers (read the levels on the pins of the device)

Some ports may have one or more of the following additional registers. These registers are:

- ANSELx (analog select)
- WPUx (weak pull-up)

Ports with analog functions also have an ANSELx register, which can disable the digital input and save power. A simplified model of a generic I/O port, without the interfaces to other peripherals, is shown in Figure 19-1.

FIGURE 19-1: GENERIC I/O PORTGPX OPERATION



EXAMPLE 19-1: INITIALIZING PORTA

```
; This code example illustrates
; initializing the PORTGPA register. The
; other ports are initialized in the same
; manner.

BANKSEL PORTGPA;
CLRF    PORTGPA;Init PORTA
BANKSEL ANSELA;
CLRF    ANSELA;digital I/O
BANKSEL TRISGPA;
MOVLW   B'00011111';Set GPA<4:0> as
            ;inputs
MOVWF   TRISGPA;and set GPA<7:6> as
            ;outputs
```

19.1 Alternate Pin Function

The Alternate Pin Function Control (APFCON) register is used to steer specific peripheral input and output functions between different pins. The APFCON register is shown in Register 19-1. For the MCP19119 device, the following function can be moved between different pins:

- Frequency Synchronization Clock Input/Output

This bit has no effect on the values of any TRIS register. PORT and TRIS overrides will be routed to the correct pin. The unselected pin will be unaffected.

REGISTER 19-1: APFCON: ALTERNATE PIN FUNCTION CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	CLKSEL
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-1 **Unimplemented:** Read as '0'

bit 0 **CLKSEL:** Pin Selection bit
1 = Multi-phase or multiple output clock function is on GPB5
0 = Multi-phase or multiple output clock function is on GPA1

19.2 PORTGPA and TRISGPA Registers

PORTGPA is an 8-bit wide, bidirectional port consisting of five CMOS I/O, two open-drain I/O and one open-drain input-only pin. The corresponding data direction register is TRISGPA (Register 19-3). Setting a TRISGPA bit (= 1) will make the corresponding PORTGPA pin an input (i.e., disable the output driver). Clearing a TRISGPA bit (= 0) will make the corresponding PORTGPA pin an output (i.e., enables output driver). The exception is GPA5, which is input only and its TRISGPA bit will always read as '1'. Example 19-1 shows how to initialize an I/O port.

Reading the PORTGPA register (Register 19-2) reads the status of the pins, whereas writing to it will write to the PORT latch. All write operations are read-modify-write operations.

The TRISGPA register (Register 19-3) controls the PORTGPA pin output drivers, even when they are being used as analog inputs. The user must ensure the bits in the TRISGPA register are maintained set when using them as analog inputs. I/O pins configured as analog input always read '0'. If the pin is configured for a digital output (either port or alternate function), the TRISGPA bit must be cleared in order for the pin to drive the signal and a read will reflect the state of the pin.

19.2.1 INTERRUPT-ON-CHANGE

Each PORTGPA pin is individually configurable as an interrupt-on-change pin. Control bits IOCA<7:0> enable or disable the interrupt function for each pin. The interrupt-on-change feature is disabled on a Power-On Reset. Refer to **Section 20.0 "Interrupt-on-Change"** for more information.

19.2.2 WEAK PULL-UPS

PORTGPA <3:0> and PORTGPA5 have an internal weak pull-up. PORTGPA<7:6> are special ports for the SSP module and do not have weak pull-ups. Individual control bits can enable or disable the internal weak pull-ups (see Register 19-4). The weak pull-up is automatically turned off when the port pin is configured as an output, an alternative function or on a Power-On Reset setting the RAPU bit in the OPTION_REG register. The weak pull-up on GPA5 is enabled when configured as MCLR pin by setting bit 5 in the Configuration Word register and disabled when GPA5 is an I/O. There is no software control of the MCLR pull-up.

19.2.3 ANSELA REGISTER

The ANSELA register (Register 19-5) is used to configure the Input mode of an I/O pin to analog. Setting the appropriate ANSELA bit high will cause all digital reads on the pin to be read as '0' and allows analog functions on the pin to operate correctly.

The state of the ANSELA bits has no effect on the digital output functions. A pin with TRISGPA clear and ANSELA set will still operate as a digital output, but the Input mode will be analog. This can cause unexpected behavior when executing read-modify-write instructions on the affected port.

Note:	The ANSELA bits default to the Analog mode after Reset. To use any pins as digital general purpose or peripheral inputs, the corresponding ANSELA bits must be initialized to '0' by user software.

19.2.4 PORTGPA FUNCTIONS AND OUTPUT PRIORITIES

Each PORTGPA pin is multiplexed with other functions. The pins, their combined functions and their output priorities are shown in Table 19-1. For additional information, refer to the appropriate section in this data sheet.

PORTGPA pins GPA7 and GPA4 are true open-drain pins with no connection back to V_{DD}.

When multiple outputs are enabled, the actual pin control goes to the peripheral with the highest priority.

Analog input functions, such as ADC, are not shown in the priority lists. These inputs are active when the I/O pin is set for Analog mode using the ANSELA register. Digital output functions may control the pin when it is in Analog mode with the priority shown in Table 19-1.

TABLE 19-1: PORTGPA OUTPUT PRIORITY

Pin Name	Function Priority(1)
GPA0	GPA0 AN0 ANALOG_TEST
GPA1	GPA1 AN1 CLKPIN
GPA2	GPA2 AN2 T0CKI INT
GPA3	GPA3 AN3
GPA4	GPA4 (open-drain input/output)
GPA5	GPA5 (open-drain data input only)
GPA6	GPA6 ICSPDAT (**MCP19118 Only**)
GPA7	GPA7 (open-drain output) SCL ICSPCLK (**MCP19118 Only**)

Note 1: Priority listed from highest to lowest.

REGISTER 19-2: PORTGPA: PORTGPA REGISTER

R/W-x	R/W-x	R-x	R-x	R/W-x	R/W-x	R/W-x	R/W-x
GPA7	GPA6	GPA5	GPA4	GPA3	GPA2	GPA1	GPA0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **GPA7**: General Purpose Open-Drain I/O pin.

bit 6 **GPA6**: General Purpose I/O pin.
1 = Port pin is > V_{IH}
0 = Port pin is < V_{IL}

bit 5 **GPA5/MCLR**: General Purpose Open-Drain I/O pin.

bit 4 **GPA4**: General Purpose Open-Drain I/O pin.

bit 3-0 **GPA<3:0>**: General Purpose I/O pin.
1 = Port pin is > V_{IH}
0 = Port pin is < V_{IL}

REGISTER 19-3: TRISGPA: PORTGPA TRI-STATE REGISTER

R/W-1	R/W-1	R-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **TRISA<7:6>:** PORTGPA Tri-State Control bit
1 = PORTGPA pin configured as an input (tri-stated)
0 = PORTGPA pin configured as an output

bit 5 **TRISA5:** GPA5 Port Tri-State Control bit
This bit is always '1' as GPA5 is an input only

bit 4-0 **TRISA<4:0>:** PORTGPA Tri-State Control bit
1 = PORTGPA pin configured as an input (tri-stated)
0 = PORTGPA pin configured as an output

REGISTER 19-4: WPUGPA: WEAK PULL-UP PORTGPA REGISTER

U-0	U-0	R/W-1	U-0	R/W-1	R/W-1	R/W-1	R/W-1
—	—	WPUA5	—	WPUA3	WPUA2	WPUA1	WPUA0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **Unimplemented:** Read as '0'

bit 5 **WPUA5:** Weak Pull-Up Register bit
1 = Pull-up enabled.
0 = Pull-up disabled.

bit 4 **Unimplemented:** Read as '0'

bit 3-0 **WPUA<3:0>:** Weak Pull-Up Register bit
1 = Pull-up enabled.
0 = Pull-up disabled.

Note 1: The weak pull-up device is enabled only when the global $\overline{\text{RAPU}}$ bit is enabled, the pin is in input mode (TRISGPA = 1), the individual WPUA bit is enabled (WPUA = 1) and the pin is not configured as an analog input.

2: GPA5 weak pull-up is also enabled when the pin is configured as $\overline{\text{MCLR}}$ in the Configuration Word register.

REGISTER 19-5: ANSELA: ANALOG SELECT PORTGPA REGISTER

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	—	ANSA<3:0>			
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-4 **Unimplemented:** Read as '0'

bit 3-0 **ANSA<3:0>**: Analog Select PORTGPA Register bit
1 = Analog input. Pin is assigned as analog input.(1)
0 = Digital I/O. Pin is assigned to port or special function.

Note 1: Setting a pin to an analog input automatically disables the digital input circuitry, weak pull-ups and interrupt-on-change, if available. The corresponding TRIS bit must be set to Input mode in order to allow external control of the voltage on the pin.

TABLE 19-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTGPA

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA	—	—	—	—	ANSA3	ANSA2	ANSA1	ANSA0	115
APFCON	—	—	—	—	—	—	—	CLKSEL	112
OPTION_REG	$\overline{\text{RAPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	77
PORTGPA	GPA7	GPA6	GPA5	GPA4	GPA3	GPA2	GPA1	GPA0	113
TRISGPA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	114
WPUGPA	—	—	WPUA5	—	WPUA3	WPUA2	WPUA1	WPUA0	114

Legend: — = unimplemented locations read as '0'. Shaded cells are not used by PORTGPA.

19.3 PORTGPB and TRISGPB Registers

PORTGPB is an 8-bit wide, bidirectional port consisting of seven general purpose I/O ports. The corresponding data direction register is TRISGPB (Register 19-7). Setting a TRISGPB bit (= 1) will make the corresponding PORTGPB pin an input (i.e., disable the output driver). Clearing a TRISGPB bit (= 0) will make the corresponding PORTGPB pin an output (i.e., enable the output driver). Example 19-1 shows how to initialize an I/O port.

Some pins for PORTGPB are multiplexed with an alternate function for the peripheral or a clock function. In general, when a peripheral or clock function is enabled, that pin may not be used as a general purpose I/O pin.

Reading the PORTGPB register (Register 19-6) reads the status of the pins, whereas writing to it will write to the PORT latch. All write operations are read-modify-write operations.

The TRISGPB register (Register 19-7) controls the PORTGPB pin output drivers, even when they are being used as analog inputs. The user should ensure the bits in the TRISGPB register are maintained set when using them as analog inputs. I/O pins configured as analog input always read '0'. If the pin is configured for a digital output (either port or alternate function), the TRISGPB bit must be cleared in order for the pin to drive the signal and a read will reflect the state of the pin.

19.3.1 INTERRUPT-ON-CHANGE

Each PORTGPB pin is individually configurable as an interrupt-on-change pin. Control bits IOCB<7:4> and IOCB<2:0> enable or disable the interrupt function for each pin. The interrupt-on-change feature is disabled on a Power-On Reset. Refer to **Section 20.0 "Interrupt-on-Change"** for more information.

19.3.2 WEAK PULL-UPS

Each of the PORTGPB pins has an individually configurable internal weak pull-up. Control bits WPUB<7:4> and WPUB<2:1> enable or disable each pull-up (see Register 19-8). Each weak pull-up is automatically turned off when the port pin is configured as an output. All pull-ups are disabled on a Power-On Reset by the RAPU bit in the OPTION_REG register.

19.3.3 ANSELB REGISTER

The ANSELB register (Register 19-9) is used to configure the Input mode of an I/O pin to analog. Setting the appropriate ANSELB bit high will cause all digital reads on the pin to be read as '0' and allows analog functions on the pin to operate correctly.

The state of the ANSELB bits has no effect on the digital output functions. A pin with TRISGPB clear and ANSELB set will still operate as a digital output, but the Input mode will be analog. This can cause unexpected behavior when executing read-modify-write instructions on the affected port.

Note:	The ANSELB bits default to the Analog mode after Reset. To use any pins as digital general purpose or peripheral inputs, the corresponding ANSELB bits must be initialized to '0' by the user's software.

19.3.4 PORTGPB FUNCTIONS AND OUTPUT PRIORITIES

Each PORTGPB pin is multiplexed with other functions. The pins, their combined functions and their output priorities are shown in Table 19-3. For additional information, refer to the appropriate section in this data sheet.

PORTGPB pin GPB0 is a true open-drain pin with no connection back to V_{DD}.

When multiple outputs are enabled, the actual pin control goes to the peripheral with the highest priority.

Analog input functions, such as ADC, and some digital input functions are not included in the list below. These inputs are active when the I/O pin is set for Analog mode using the ANSELB registers. Digital output functions may control the pin when it is in Analog mode, with the priority shown in Table 19-3.

TABLE 19-3: PORTGPB OUTPUT PRIORITY

Pin Name	Function Priority(1)
GPB0	GPB0 (open-drain input/output) SDA
GPB1	GPB1 AN4 EAPIN
GPB2	GPB2 AN5
GPB4	GPB4 AN6 ICSPDAT/ICDDAT (**MCP19119 Only**)
GPB5	GPB5 AN7 ICSPCLK/ICDCLK (**MCP19119 Only**) ALT_CLKPIN (**MCP19119 Only**)
GPB6	GPB6
GPB7	GPB7

Note 1: Priority listed from highest to lowest.

REGISTER 19-6: PORTGPB: PORTGPB REGISTER

R/W-x	R/W-x	R/W-x	R/W-x	U-x	R/W-x	R/W-x	R/W-x
GPB7(1)	GPB6(1)	GPB5(1)	GPB4(1)	—	GPB2	GPB1	GPB0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-4 **GPB<7:4>**: General Purpose I/O Pin bit
1 = Port pin is > V_{IH}
0 = Port pin is < V_{IL}

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **GPB<2:0>**: General Purpose I/O Pin bit
1 = Port pin is > V_{IH}
0 = Port pin is < V_{IL}

Note 1: Not implemented on MCP19118.

REGISTER 19-7: TRISGPB: PORTGPB TRI-STATE REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	U-1	R/W-1	R/W-1	R/W-1
TRISB7(1)	TRISB6(1)	TRISB5(1)	TRISB4(1)	—	TRISB2	TRISB1	TRISB0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-4 **TRISB<7:4>:** PORTGPB Tri-State Control bit
1 = PORTGPB pin configured as an input (tri-stated)
0 = PORTGPB pin configured as an output

bit 3 **Unimplemented:** Read as '1'

bit 2-0 **TRISB<2:0>:** PORTGPB Tri-State Control bit
1 = PORTGPB pin configured as an input (tri-stated)
0 = PORTGPB pin configured as an output

Note 1: Not implemented on MCP19118.

REGISTER 19-8: WPUGPB: WEAK PULL-UP PORTGPB REGISTER

R/W-1	R/W-1	R/W-1	R/W-1	U-0	R/W-1	R/W-1	U-0
WPUB7(2)	WPUB6(2)	WPUB5(2)	WPUB4(2)	—	WPUB2	WPUB1	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-4 **WPUB<7:4>**: Weak Pull-Up Register bit
1 = Pull-up enabled
0 = Pull-up disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-1 **WPUB<2:1>**: Weak Pull-Up Register bit
1 = Pull-up enabled
0 = Pull-up disabled

bit 0 **Unimplemented:** Read as '0'

Note 1: The weak pull-up device is enabled only when the global $\overline{\text{RAPU}}$ bit is enabled, the pin is in Input mode (TRISGPA = 1), the individual WPUB bit is enabled (WPUB = 1) and the pin is not configured as an analog input.

2: Not implemented on MCP19118.

REGISTER 19-9: ANSELB: ANALOG SELECT PORTGPB REGISTER

U-0	U-0	R/W-1	R/W-1	U-0	R/W-1	R/W-1	U-0
—	—	ANSB5(2)	ANSB4(2)	—	ANSB2	ANSB1	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **Unimplemented:** Read as '0'

bit 5-4 **ANSB<5:4>**: Analog Select PORTGPB Register bit
1 = Analog input. Pin is assigned as analog input(1).
0 = Digital I/O. Pin is assigned to port or special function.

bit 3 **Unimplemented:** Read as '0'

bit 2-1 **ANSB<2:1>**: Analog Select PORTGPB Register bit
1 = Analog input. Pin is assigned as analog input(1).
0 = Digital I/O. Pin is assigned to port or special function.

bit 0 **Unimplemented:** Read as '0'

Note 1: Setting a pin to an analog input automatically disables the digital input circuitry, weak pull-ups and interrupt-on-change if available. The corresponding TRIS bit must be set to Input mode in order to allow external control of the voltage on the pin.

2: Not implemented on MCP19118.

TABLE 19-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTGPB

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELB	—	—	ANSB5	ANSB4	—	ANSB2	ANSB1	—	118
APFCON	—	—	—	—	—	—	—	CLKSEL	112
OPTION_REG	$\overline{\text{RAPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	77
PORTGPB	GPB7	GPB6	GPB5	GPB4	—	GPB2	GPB1	GPB0	117
TRISGPB	TRISB7	TRISB6	TRISB5	TRISB4	—	TRISB2	TRISB1	TRISB0	117
WPUGPB	WPUB7	WPUB6	WPUB5	WPUB4	—	WPUB2	WPUB1	—	118

Legend: — = unimplemented locations read as '0'. Shaded cells are not used by PORTGPB.

NOTES:

20.0 INTERRUPT-ON-CHANGE

Each PORTGPA and PORTGPB pin is individually configurable as an interrupt-on-change pin. Control bits IOCA and IOCB enable or disable the interrupt function for each pin. Refer to Registers 20-1 and 20-2. The interrupt-on-change is disabled on a Power-On Reset.

The interrupt-on-change on GPA5 is disabled when configured as $\overline{\text{MCLR}}$ pin in the Configuration Word register.

For enabled interrupt-on-change pins, the values are compared with the old value latched on the last read of PORTGPA or PORTGPB. The mismatched outputs of the last read of all the PORTGPA and PORTGPB pins are OR'ed together to set the Interrupt-on-Change Interrupt Flag bit (IOCF) in the INTCON register.

20.1 Enabling the Module

To allow individual port pins to generate an interrupt, the IOCIE bit in the INTCON register must be set. If the IOCIE bit is disabled, the edge detection on the pin will still occur, but an interrupt will not be generated.

20.2 Individual Pin Configuration

To enable a pin to detect an interrupt-on-change, the associated IOCAx or IOCBx bit in the IOCA or IOCB register is set.

20.3 Clearing Interrupt Flags

The user, in the Interrupt Service Routine, clears the interrupt by:

a) Any read of PORTGPA or PORTGPB AND Clear flag bit IOCF. This will end the mismatch condition;

   OR

b) Any write of PORTGPA or PORTGPB AND Clear flag bit IOCF will end the mismatch condition.

A mismatch condition will continue to set flag bit IOCF. Reading PORTGPA or PORTGPB will end the mismatch condition and allow flag bit IOCF to be cleared. The latch holding the last read value is not affected by a $\overline{\text{MCLR}}$ Reset. After this Reset, the IOCF flag will continue to be set if a mismatch is present.

Note:	If a change on the I/O pin should occur when any PORTGPA or PORTGPB operation is being executed, then the IOCF interrupt flag may not get set.

20.4 Operation in Sleep

The interrupt-on-change interrupt sequence will wake the device from Sleep mode, if the IOCE bit is set.

20.5 Interrupt-on-Change Registers

REGISTER 20-1: IOCA: INTERRUPT-ON-CHANGE PORTGPA REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
IOCA7	IOCA6	IOCA5	IOCA4	IOCA3	IOCA2	IOCA1	IOCA0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **IOCA<7:6>**: Interrupt-on-Change PORTGPA Register bits.
1 = Interrupt-on-change enabled on the pin.
0 = Interrupt-on-change disabled on the pin.

bit 5 **IOCA<5>**: Interrupt-on-Change PORTGPA Register bits(1).
1 = Interrupt-on-change enabled on the pin.
0 = Interrupt-on-change disabled on the pin.

bit 4-0 **IOCA<4:0>**: Interrupt-on-Change PORTGPA Register bits.
1 = Interrupt-on-change enabled on the pin.
0 = Interrupt-on-change disabled on the pin.

Note 1: The Interrupt-on-change on GPA5 is disabled if GPA5 is configured as $\overline{\text{MCLR}}$.

REGISTER 20-2: IOCB: INTERRUPT-ON-CHANGE PORTGPB REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
IOCB7(1)	IOCB6(1)	IOCB5(1)	IOCB4(1)	—	IOCB2	IOCB1	IOCB0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-4 **IOCB<7:4>**: Interrupt-on-Change PORTGPB Register bits.
1 = Interrupt-on-change enabled on the pin.
0 = Interrupt-on-change disabled on the pin.

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **IOCB<2:0>**: Interrupt-on-Change PORTGPB Register bits.
1 = Interrupt-on-change enabled on the pin.
0 = Interrupt-on-change disabled on the pin.

Note 1: Not implemented on MCP19119.

TABLE 20-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPT-ON-CHANGE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA	—	—	—	—	ANSA3	ANSA2	ANSA1	ANSA0	115
ANSELB	—	—	ANSB5	ANSB4	—	ANSB2	ANSB1	—	118
INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF	96
IOCA	IOCA7	IOCA6	IOCA5	IOCA4	IOCA3	IOCA2	IOCA1	IOCA0	122
IOCB	IOCB7	IOCB6	IOCB5	IOCB4	—	IOCB2	IOCB1	IOCB0	122
TRISGPA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	114
TRISGPB	TRISB7	TRISB6	TRISB5	TRISB4	—	TRISB2	TRISB1	TRISB0	117

Legend: — = unimplemented locations read as '0'. Shaded cells are not used by interrupt-on-change.

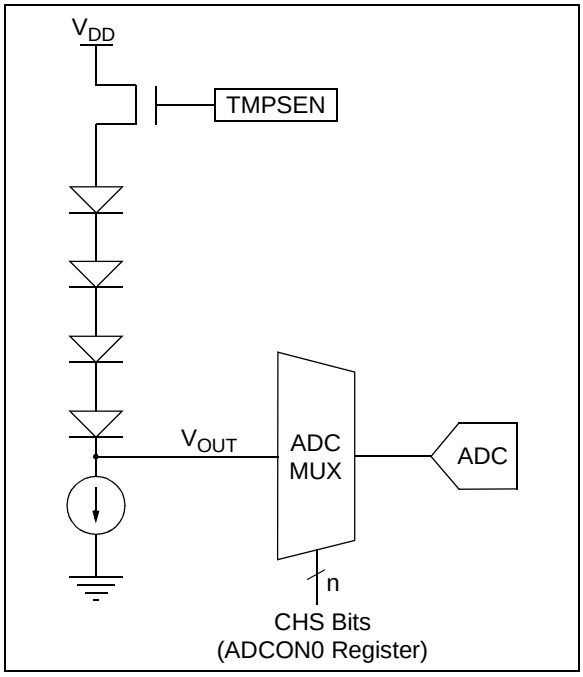
21.0 INTERNAL TEMPERATURE INDICATOR MODULE

The MCP19118/19 is equipped with a temperature circuit designed to measure the operating temperature of the silicon die. The circuit's operating temperature rangeis -40°C to +125°C. The output is a voltage that is proportional to the device temperature. The output of the temperature indicator is internally connected to the device ADC.

21.1 Circuit Operation

The TMPSEN bit in the ABECON register (Register 6-15) is set to enable the internal temperature measurement circuit. The MCP19118/19 overtemperature shutdown feature is NOT controlled by this bit.

FIGURE 21-1: TEMPERATURE CIRCUIT DIAGRAM



21.2 Temperature Output

The output of the circuit is measured using the internal analog-to-digital converter. Channel 10 is reserved for the temperature circuit output. Refer to **Section 22.0 "Analog-to-Digital Converter (ADC) Module"** for detailed information.

The temperature of the silicon die can be calculated by the ADC measurement by using Equation 21-1.

EQUATION 21-1: SILICON DIE TEMPERATURE

$$TEMP\_DIE = \frac{ADC\ READING - 1.75}{13.3mV/^{\circ}C}$$

NOTES:

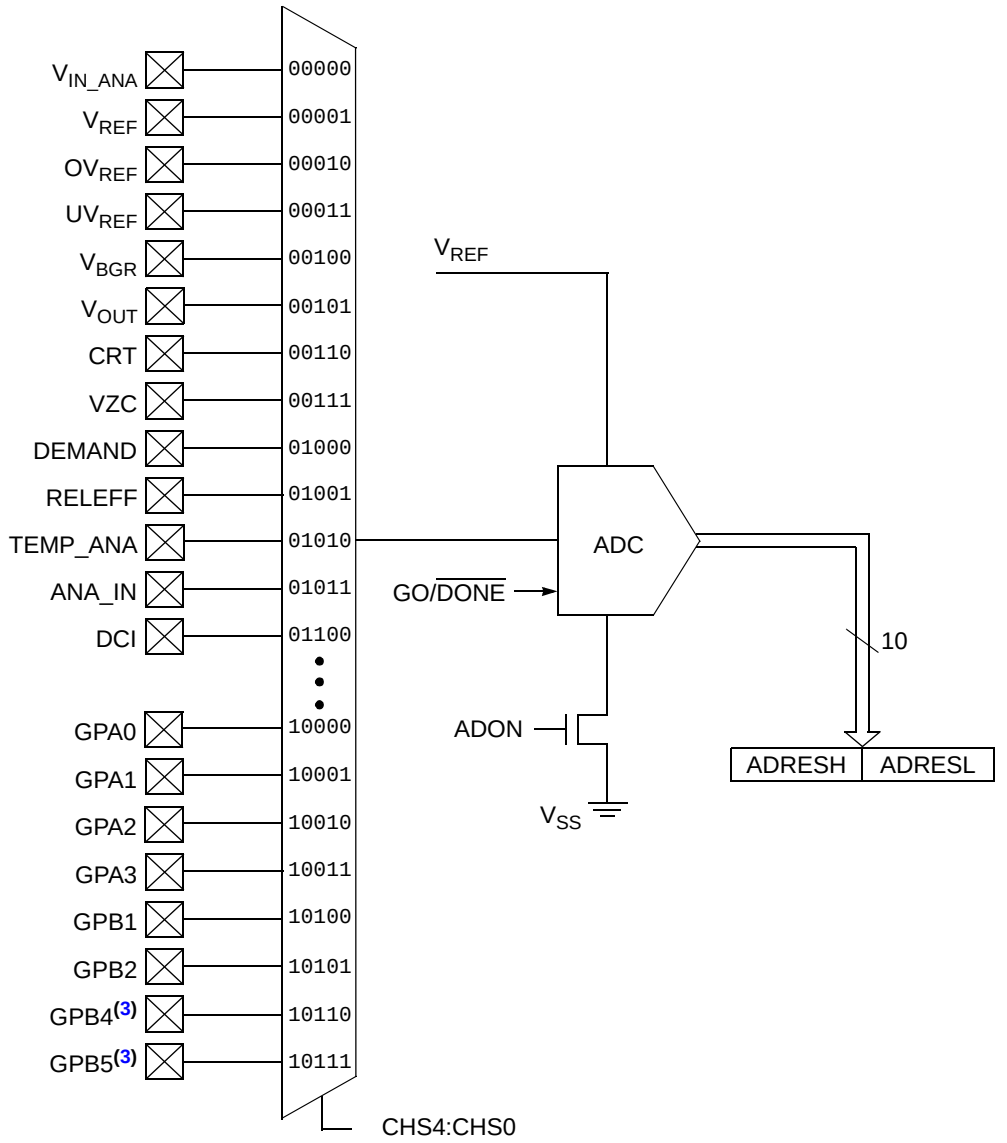
22.0 ANALOG-TO-DIGITAL CONVERTER (ADC) MODULE

The Analog-to-Digital Converter (ADC) allows conversion of an analog input signal to a 10-bit binary representation of that signal. This device uses analog inputs, which are multiplexed into a single sample and hold circuit. The output of the sample and hold is connected to the input of the converter. The converter generates a 10-bit binary result via successive approximation and stores the right justified conversion result into the ADC result registers (ADRESH:ADRESL register pair). Figure 22-1 shows the block diagram of the ADC.

The internal band gap supplies the voltage reference to the ADC.

The ADC can generate an interrupt upon completion of a conversion. This interrupt can be used to wake-up the device from Sleep.

FIGURE 22-1: ADC BLOCK DIAGRAM



Note 1: When ADON = 0, all multiplexer inputs are disconnected.

2: See the ADCON0 register (Register 22-1) for detailed analog channel selection per device.

3: Not implemented on MCP19118.

22.1 ADC Configuration

When configuring and using the ADC, the following functions must be considered:

- Port configuration
- Channel selection
- ADC conversion clock source
- Interrupt control
- Result formatting

22.1.1 PORT CONFIGURATION

The ADC can be used to convert both analog and digital signals. When converting analog signals, the I/O pin should be configured for analog by setting the associated TRIS and ANSEL bits. Refer to **Section 19.0 "I/O Ports"** for more information.

Note:	Analog voltages on any pin that is defined as a digital input may cause the input buffer to conduct excess current.

22.1.2 CHANNEL SELECTION

There are up to 19 channel selections available on the MCP19118 and 21 channel selections available on the MCP19119:

- AN<6:0> pins
- VIN_ANA: 1/13 of the input voltage (V_{IN})
- VREGREF: V_{OUT} reference voltage
- OV_REF: reference for OV comparator
- UV_REF: reference for UV comparator
- VBGR: band gap reference
- VOUT: output voltage
- CRT: voltage proportional to the AC inductor current
- VZC: an internal ground, Voltage for Zero Current
- DEMAND: input to slope compensation circuitry
- RELEFF: relative efficient measurement channel
- TMP_ANA: voltage proportional to silicon die temperature
- ANA_IN: for a multi-phase slave, error amplifier signal received from master
- DCI: DC inductor valley current

The CHS<4:0> bits in the ADCON0 register determine which channel is connected to the sample and hold circuit.

When changing channels, a delay is required before starting the next conversion. Refer to **Section 22.2 "ADC Operation"** for more information.

22.1.3 ADC CONVERSION CLOCK

The source of the conversion clock is software-selectable via the ADCON1<ADCS> bits. There are five possible clock options:

- $F_{OSC}/8$
- $F_{OSC}/16$
- $F_{OSC}/32$
- $F_{OSC}/64$
- F_{RC} (clock derived from internal oscillator with a divisor of 16)

The time to complete one bit conversion is defined as T_{AD}. One full 10-bit conversion requires 11 T_{AD} periods, as shown in Figure 22-2.

For a correct conversion, the appropriate T_{AD} specification must be met. Refer to the A/D conversion requirements in **Section 5.0 "Digital Electrical Characteristics"** for more information. Table 22-1 gives examples of appropriate ADC clock selections.

Note:	Unless using the F_{RC}, any changes in the system clock frequency will change the ADC clock frequency, which may adversely affect the ADC result.

TABLE 22-1: ADC CLOCK PERIOD (T_{AD}) vs. DEVICE OPERATING FREQUENCIES

ADC Clock Period (T_{AD})		Device Frequency (F_{OSC})
ADC Clock Source	**ADCS<2:0>**	**8 MHz**
$F_{OSC}/8$	001	1.0 µs(2)
$F_{OSC}/16$	101	2.0 µs
$F_{OSC}/32$	010	4.0 µs
$F_{OSC}/64$	110	8.0 µs(3)
F_{RC}	x11	2.0-6.0 µs(1,4)

Legend: Shaded cells are outside of recommended range.

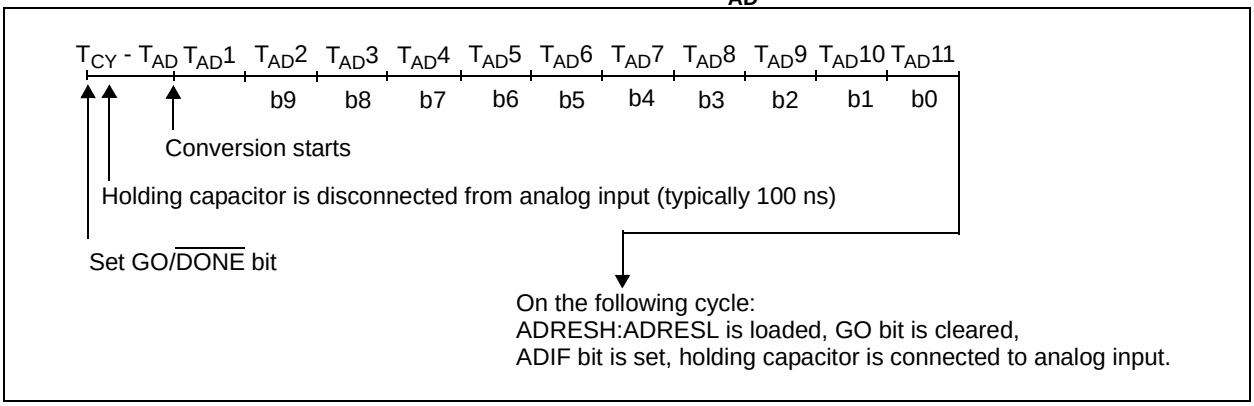
Note 1: The F_{RC} source has a typical T_{AD} time of 4 µs for V_{DD} > 3.0V.

2: These values violate the minimum required T_{AD} time.

3: For faster conversion times, the selection of another clock source is recommended.

4: The F_{RC} clock source is only recommended if the conversion will be performed during Sleep.

FIGURE 22-2: ANALOG-TO-DIGITAL CONVERSION T_{AD} CYCLES



22.1.4 INTERRUPTS

The ADC module allows for the ability to generate an interrupt upon completion of an Analog-to-Digital conversion. The ADC Interrupt Flag is the PIR1<ADIF> bit. The ADC Interrupt Enable is the PIE1<ADIE> bit. The ADIF bit must be cleared in software.

Note 1:	The ADIF bit is set at the completion of every conversion, regardless of whether or not the ADC interrupt is enabled.
2:	The ADC operates during Sleep only when the F_{RC} oscillator is selected.

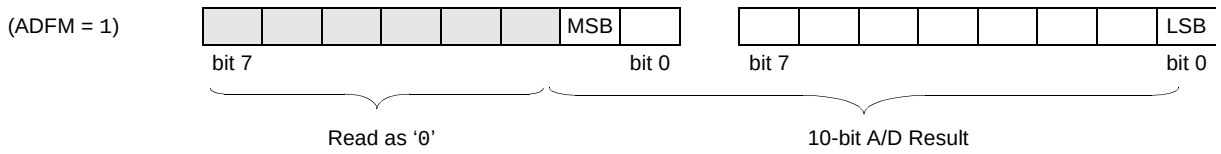
This interrupt can be generated while the device is operating or while in Sleep. If the device is in Sleep, the interrupt will wake-up the device. Upon waking from Sleep, the next instruction following the SLEEP instruction is always executed. If the user is attempting to wake-up from Sleep and resume in-line code execution, the INTCON<GIE> and INTCON<PEIE> bits must be disabled. If the INTCON<GIE> and INTCON<PEIE> bits are enabled, execution will switch to the Interrupt Service Routine.

22.1.5 RESULT FORMATTING

The 10-bit A/D conversion result is supplied in right justified format only.

Figure 22-3 shows the output format.

FIGURE 22-3: 10-BIT A/D RESULT FORMAT



22.2 ADC Operation

22.2.1 STARTING A CONVERSION

To enable the ADC module, the ADCON0<ADON> bit must be set to a '1'. Setting the ADCON0<GO/DONE> bit to a '1' will start the Analog-to-Digital conversion.

Note:	The GO/DONE bit should not be set in the same instruction that turns on the ADC. Refer to **Section 22.2.5 "A/D Conversion Procedure"**.

22.2.2 COMPLETION OF A CONVERSION

When the conversion is complete, the ADC module will:

- Clear the GO/DONE bit
- Set the ADIF Interrupt Flag bit
- Update the ADRESH:ADRESL registers with new conversion result

22.2.3 TERMINATING A CONVERSION

If a conversion must be terminated before completion, the GO/DONE bit can be cleared in software. The ADRESH:ADRESL registers will not be updated with the partially complete Analog-to-Digital conversion sample. Instead, the ADRESH:ADRESL register pair will retain the value of the previous conversion. Additionally, a two T_{AD} delay is required before another acquisition can be initiated. Following the delay, an input acquisition is automatically started on the selected channel.

Note:	A device Reset forces all registers to their Reset state. Thus, the ADC module is turned off and any pending conversion is terminated.

22.2.4 ADC OPERATION DURING SLEEP

The ADC module can operate during Sleep. This requires the ADC clock source to be set to the F_{RC} option. When the F_{RC} clock source is selected, the ADC waits one additional instruction before starting the conversion. This allows the SLEEP instruction to be executed, which can reduce system noise during the conversion. If the ADC interrupt is enabled, the device will wake-up from Sleep when the conversion completes. If the ADC interrupt is disabled, the ADC module is turned off after the conversion completes, although the ADON bit remains set.

When the ADC clock source is something other than F_{RC}, a SLEEP instruction causes the present conversion to be aborted and the ADC module is turned off, although the ADON bit remains set.

22.2.5 A/D CONVERSION PROCEDURE

This is an example procedure for using the ADC to perform an Analog-to-Digital conversion:

1. Configure Port:
   - Disable pin output driver (Refer to the TRIS register)
   - Configure pin as analog (Refer to the ANSEL register)
2. Configure the ADC module:
   - Select ADC conversion clock
   - Select ADC input channel
   - Turn on ADC module
3. Configure ADC interrupt (optional):
   - Clear ADC interrupt flag
   - Enable ADC interrupt
   - Enable peripheral interrupt
   - Enable global interrupt(1)
4. Wait the required acquisition time(2).
5. Start conversion by setting the GO/DONE bit.
6. Wait for ADC conversion to complete by one of the following:
   - Polling the GO/DONE bit
   - Waiting for the ADC interrupt (interrupts enabled)
7. Read ADC Result.
8. Clear the ADC interrupt flag (required if interrupt is enabled).

Note 1:	The global interrupt can be disabled if the user is attempting to wake-up from Sleep and resume in-line code execution.
2:	Refer to **Section 22.4 "A/D Acquisition Requirements"**.

EXAMPLE 22-1: A/D CONVERSION

```
;This code block configures the ADC
;for polling, Frc clock and AN0 input.
;
;Conversion start & polling for completion ;
are included.
;
BANKSEL   ADCON1          ;
MOVLW     B'01110000'     ;Frc clock
MOVWF     ADCON1          ;
BANKSEL   TRISGPA         ;
BSF       TRISGPA,0       ;Set GPA0 to input
BANKSEL   ANSELA          ;
BSF       ANSELA,0        ;Set GPA0 to analog
BANKSEL   ADCON0          ;
MOVLW     B'01000001'     ;Select channel AN0
MOVWF     ADCON0          ;Turn ADC On
CALL      SampleTime      ;Acquisiton delay
BSF       ADCON0,1        ;Start conversion
BTFSC     ADCON0,1        ;Is conversion done?
GOTO      $-1             ;No, test again
BANKSEL   ADRESH          ;
MOVF      ADRESH,W        ;Read upper 2 bits
MOVWF     RESULTHI        ;store in GPR space
BANKSEL   ADRESL          ;
MOVF      ADRESL,W        ;Read lower 8 bits
MOVWF     RESULTLO        ;Store in GPR space
```

22.3 ADC Register Definitions

The following registers are used to control the operation of the ADC:

REGISTER 22-1: ADCON0: A/D CONTROL REGISTER 0

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	CHS4	CHS3	CHS2	CHS1	CHS0	GO/$\overline{\text{DONE}}$	ADON
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6-2 **CHS<4:0>:** Analog Channel Select bits

00000 = VIN_ANA (analog voltage proportional to 1/13 of V_{IN})
00001 = VREGREF (reference voltage for V_{REG} output)
00010 = OV_REF (reference for overvoltage comparator)
00011 = UV_REF (reference for undervoltage comparator)
00100 = VBGR (band gap reference)
00101 = INT_VREG (internal version of the V_{REG} load voltage)
00110 = CRT (voltage proportional to the current in the inductor)
00111 = VZC (an internal ground, Voltage for Zero Current)
01000 = DEMAND (input to current loop, output of demand mux)
01001 = RELEFF (analog voltage proportional to duty cycle)
01010 = TMP_ANA (analog voltage proportional to temperature)
01011 = ANA_IN (demanded current from the remote master)
01100 = DCI (dc inductor valley current)
01101 = Unimplemented
01110 = Unimplemented
01111 = Unimplemented
10000 = GPA0 (i.e. ADDR1)
10001 = GPA1 (i.e. ADDR0)
10010 = GPA2 (i.e. Temperature Sensor Input)
10011 = GPA3 (i.e. Tracking Voltage)
10100 = GPB1
10101 = GPB2
10110 = GPB4(1)
10111 = GPB5(1)
11000 = Unimplemented
11001 = Unimplemented
11011 = Unimplemented
11100 = Unimplemented
11101 = Unimplemented
11110 = Unimplemented
11111 = Unimplemented

bit 1 **GO/$\overline{\text{DONE}}$:** A/D Conversion Status bit

1 = A/D conversion cycle in progress. Setting this bit starts an A/D conversion cycle.
This bit is automatically cleared by hardware when the A/D conversion has completed.
0 = A/D conversion completed/not in progress

bit 0 **ADON:** ADC Enable bit

1 = ADC is enabled
0 = ADC is disabled and consumes no operating current

Note 1: Not implemented on MCP19118.

REGISTER 22-2: ADCON1: A/D CONTROL REGISTER 1

U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	ADCS<2:0>			—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **ADCS<2:0>:** A/D Conversion Clock Select bits
- 000 = Reserved
- 001 = $F_{OSC}/8$
- 010 = $F_{OSC}/32$
- x11 = F_{RC} (clock derived from internal oscillator with a divisor of 16)
- 100 = Reserved
- 101 = $F_{OSC}/16$
- 110 = $F_{OSC}/64$

bit 3-0 **Unimplemented:** Read as '0'

REGISTER 22-3: ADRESH: ADC RESULT REGISTER HIGH (ADRESH)

U-0	U-0	U-0	U-0	U-0	U-0	R-x	R-x
—	—	—	—	—	—	ADRES9	ADRES8
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-2 **Unimplemented:** Read as '0'

bit 1-0 **ADRES<9:8>**: Most Significant A/D Results

REGISTER 22-4: ADRESL: ADC RESULT REGISTER LOW (ADRESL)

R-x	R-x	R-x	R-x	R-x	R-x	R-x	R-x
ADRES<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **ADRES<7:0>**: Least Significant A/D results

22.4 A/D Acquisition Requirements

For the ADC to meet its specified accuracy, the charge holding capacitor (C_{HOLD}) must be allowed to fully charge to the input channel voltage level. The Analog Input model is shown in Figure 22-4. The source impedance (R_S) and the internal sampling switch (R_{SS}) impedance directly affect the time required to charge the capacitor C_{HOLD}. The sampling switch (R_{SS}) impedance varies over the device voltage (V_{DD}); refer to Figure 22-4.

The maximum recommended impedance for analog sources is 10 kΩ. As the source impedance is decreased, the acquisition time may be decreased. After the analog input channel is selected (or changed), an A/D acquisition must be done before the conversion can be started. To calculate the minimum acquisition time, Equation 22-1 may be used. This equation assumes that 1/2 LSb error is used (1,024 steps for the ADC). The 1/2 LSb error is the maximum error allowed for the ADC to meet its specified resolution.

EQUATION 22-1: ACQUISITION TIME EXAMPLE

Assumptions: *Temperature = +50°C and external impedance of 10 kΩ 5.0V* V_{DD}

$$T_{ACQ} = \text{Amplifier Settling Time} + \text{Hold Capacitor Charging Time} + \text{Temperature Coefficient}$$
$$= T_{AMP} + T_C + T_{COFF}$$
$$= 2\ \mu s + T_C + [(\text{Temperature} - 25°C)(0.05\ \mu s/°C)]$$

The value for T_C *can be approximated with the following equations:*

$$V_{APPLIED}\left(1 - \frac{1}{(2^{n+1}) - 1}\right) = V_{CHOLD} \quad ;[1]\ V_{CHOLD} \text{ charged to within 1/2 lsb}$$

$$V_{APPLIED}\left(1 - e^{\frac{-T_C}{RC}}\right) = V_{CHOLD} \quad ;[2]\ V_{CHOLD} \text{ charge response to } V_{APPLIED}$$

$$V_{APPLIED}\left(1 - e^{\frac{-T_C}{RC}}\right) = V_{APPLIED}\left(1 - \frac{1}{(2^{n+1}) - 1}\right) \quad ;\text{combining [1] and [2]}$$

Note: *Where n = number of bits of the ADC.*

Solving for T_C*:*

$$T_C = -C_{HOLD}(R_{IC} + R_{SS} + R_S)\ ln(1/2047)$$
$$= -10\ pF(1\ k\Omega + 7\ k\Omega + 10\ k\Omega)\ ln(0.0004885)$$
$$= 1.37\mu s$$

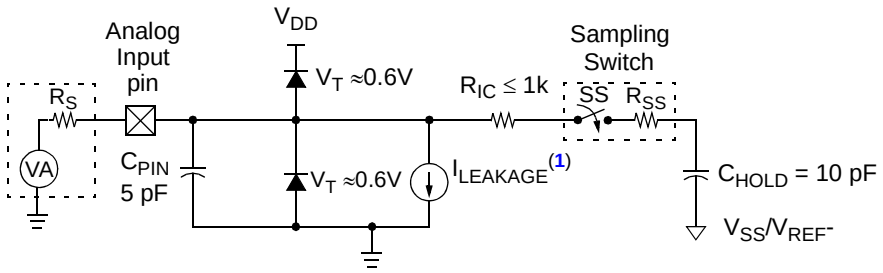
Therefore:

$$T_{ACQ} = 2\ \mu s + 1.37\mu s + [(50°C - 25°C)(0.05\mu s/°C)]$$
$$= 4.67\ \mu s$$

Note 1: The charge holding capacitor (C_{HOLD}) is not discharged after each conversion.

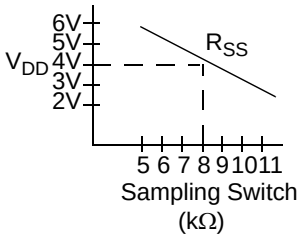
2: The maximum recommended impedance for analog sources is 10 kΩ . This is required to meet the pin leakage specification.

FIGURE 22-4: ANALOG INPUT MODEL



Legend:

C_{HOLD} = Sample/Hold Capacitance
C_{PIN} = Input Capacitance
$I_{LEAKAGE}$ = Leakage current at the pin due to various junctions
R_{IC} = Interconnect Resistance
R_{SS} = Resistance of Sampling Switch
SS = Sampling Switch
V_T = Threshold Voltage



Note 1: Refer to **Section 5.0 "Digital Electrical Characteristics"**.

FIGURE 22-5: ADC TRANSFER FUNCTION

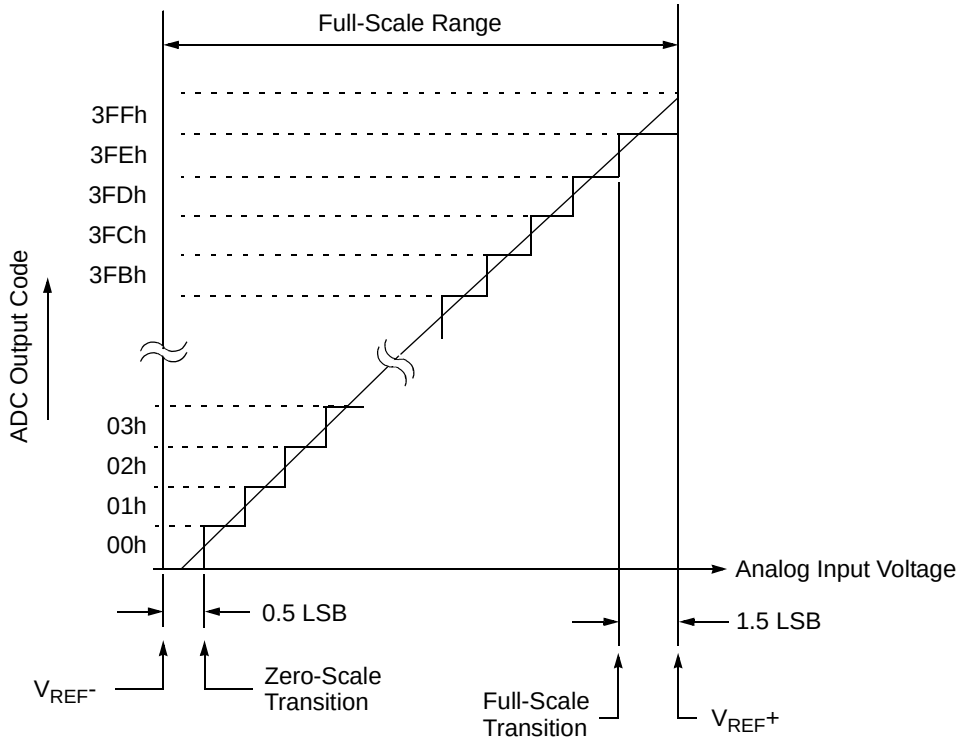


TABLE 22-2: SUMMARY OF REGISTERS ASSOCIATED WITH ADC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ADCON0	—	CHS4	CHS3	CHS2	CHS1	CHS0	GO/$\overline{\text{DONE}}$	ADON	129
ADCON1	—	ADCS2	ADCS1	ADCS0	—	—	—	—	130
ADRESH	—	—	—	—	—	—	ADRES9	ADRES8	130
ADRESL	ADRES7	ADRES6	ADRES5	ADRES4	ADRES3	ADRES2	ADRES1	ADRES0	130
ANSELA	—	—	—	—	ANSA3	ANSA2	ANSA1	ANSA0	115
ANSELB	—	—	ANSB5	ANSB4	—	ANSB2	ANSB1	—	118
INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF	95
PIE1	—	ADIE	BCLIE	SSPIE	—	—	TMR2IE	TMR1IE	96
PIR1	—	ADIF	BCLIF	SSPIF	—	—	TMR2IF	TMR1IF	98
TRISGPA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	114
TRISGPB	TRISB7	TRISB6	TRISB5	TRISB4	—	TRISB2	TRISB1	TRISB0	117

Legend: — = unimplemented read as '0'. Shaded cells are not used for ADC module.

NOTES:

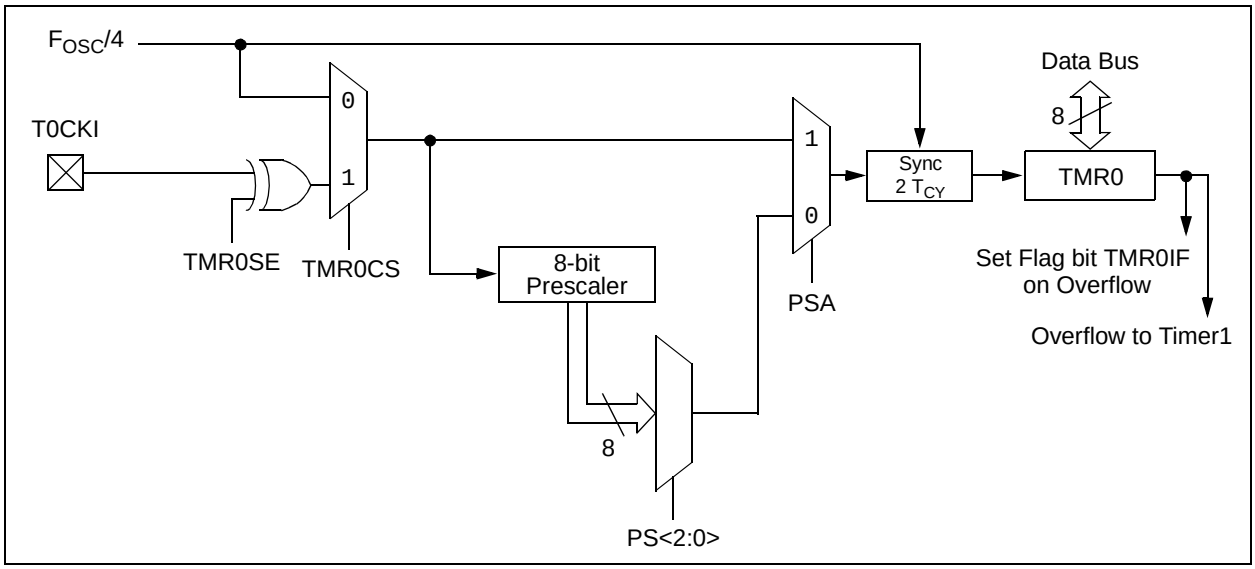
23.0 TIMER0 MODULE

The Timer0 module is an 8-bit timer/counter with the following features:

- 8-bit timer/counter register (TMR0)
- 8-bit prescaler (independent of Watchdog Timer)
- Programmable internal or external clock source
- Programmable external clock edge selection
- Interrupt on overflow

Figure 23-1 is a block diagram of the Timer0 module.

FIGURE 23-1: BLOCK DIAGRAM OF TIMER0



23.1 Timer0 Operation

The Timer0 module can be used as either an 8-bit timer or an 8-bit counter.

23.1.1 8-BIT TIMER MODE

The Timer0 module will increment every instruction cycle, if used without a prescaler. 8-Bit Timer mode is selected by clearing the T0CS bit in the OPTION_REG register.

When TMR0 is written, the increment is inhibited for two instruction cycles immediately following the write.

Note:	The value written to the TMR0 register can be adjusted, in order to account for the two-instruction cycle delay when TMR0 is written.

23.1.2 8-BIT COUNTER MODE

In 8-Bit Counter mode, the Timer0 module will increment on every rising or falling edge of the T0CKI pin. The incrementing edge is determined by the OPTION_REG<T0SE> bit.

8-Bit Counter mode using the T0CKI pin is selected by setting the OPTION_REG<T0CS> bit to '1'.

23.1.3 SOFTWARE-PROGRAMMABLE PRESCALER

A single software-programmable prescaler is available for use with either Timer0 or the Watchdog Timer (WDT), but not both simultaneously. The prescaler assignment is controlled by the OPTION_REG<PSA> bit. To assign the prescaler to Timer0, the PSA bit must be cleared to '0'.

There are eight prescaler options for the Timer0 module ranging from 1:2 to 1:256. The prescale values are selectable via the PS<2:0> bits in the OPTION_REG register. In order to have a 1:1 prescaler value for the Timer0 module, the prescaler must be disabled by setting the OPTION_REG<PSA> bit.

The prescaler is not readable or writable. When assigned to the Timer0 module, all instructions writing to the TMR0 register will clear the prescaler.

23.1.4 SWITCHING PRESCALER BETWEEN TIMER0 AND WDT MODULES

As a result of having the prescaler assigned to either Timer0 or the WDT, it is possible to generate an unintended device Reset when switching prescaler values. When changing the prescaler assignment from Timer0 to the WDT module, the instruction sequence shown in Example 23-1 must be executed.

EXAMPLE 23-1: CHANGING PRESCALER (TIMER0 → WDT)

```
BANKSEL TMR0            ;
CLRWDT                  ;Clear WDT
CLRF    TMR0            ;Clear TMR0 and
                        ;prescaler
BANKSEL OPTION_REG      ;
BSF     OPTION_REG,PSA  ;Select WDT
CLRWDT                  ;
                        ;
MOVLW   b'11111000'     ;Mask prescaler
ANDWF   OPTION_REG,W    ;bits
IORLW   b'00000101'     ;Set WDT prescaler
MOVWF   OPTION_REG      ;to 1:32
```

When changing the prescaler assignment from the WDT to the Timer0 module, the following instruction sequence must be executed (see Example 23-2).

EXAMPLE 23-2: CHANGING PRESCALER (WDT → TIMER0)

```
CLRWDT              ;Clear WDT and
                    ;prescaler
BANKSEL OPTION_REG  ;
MOVLW   b'11110000' ;Mask TMR0 select and
ANDWF   OPTION_REG,W ;prescaler bits
IORLW   b'00000011' ;Set prescale to 1:16
MOVWF   OPTION_REG  ;
```

23.1.5 TIMER0 INTERRUPT

Timer0 will generate an interrupt when the TMR0 register overflows from FFh to 00h. The INTCON<T0IF> interrupt flag bit is set every time the TMR0 register overflows, regardless of whether or not the Timer0 interrupt is enabled. The T0IF bit can only be cleared in software. The Timer0 interrupt enable is the INTCON<T0IE> bit.

Note:	The Timer0 interrupt cannot wake the processor from Sleep since the timer is frozen during Sleep.

23.1.6 USING TIMER0 WITH AN EXTERNAL CLOCK

When Timer0 is in Counter mode, the synchronization of the T0CKI input and the Timer0 register is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, the high and low periods of the external clock source must meet the timing requirements, as shown in **Section 5.0 "Digital Electrical Characteristics"**.

23.1.7 OPERATION DURING SLEEP

Timer0 cannot operate while the processor is in Sleep mode. The contents of the TMR0 register will remain unchanged while the processor is in Sleep mode.

TABLE 23-1: SUMMARY OF REGISTERS ASSOCIATED WITH TIMER0

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	T0IE	INTE	IOCIE	T0IF	INTF	IOCIF	96
OPTION_REG	$\overline{\text{RAPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	77
TMR0	Timer0 Module Register								135*
TRISGPA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	114

Legend: — = Unimplemented locations, read as '0'. Shaded cells are not used by the Timer0 module.

* Page provides register information.

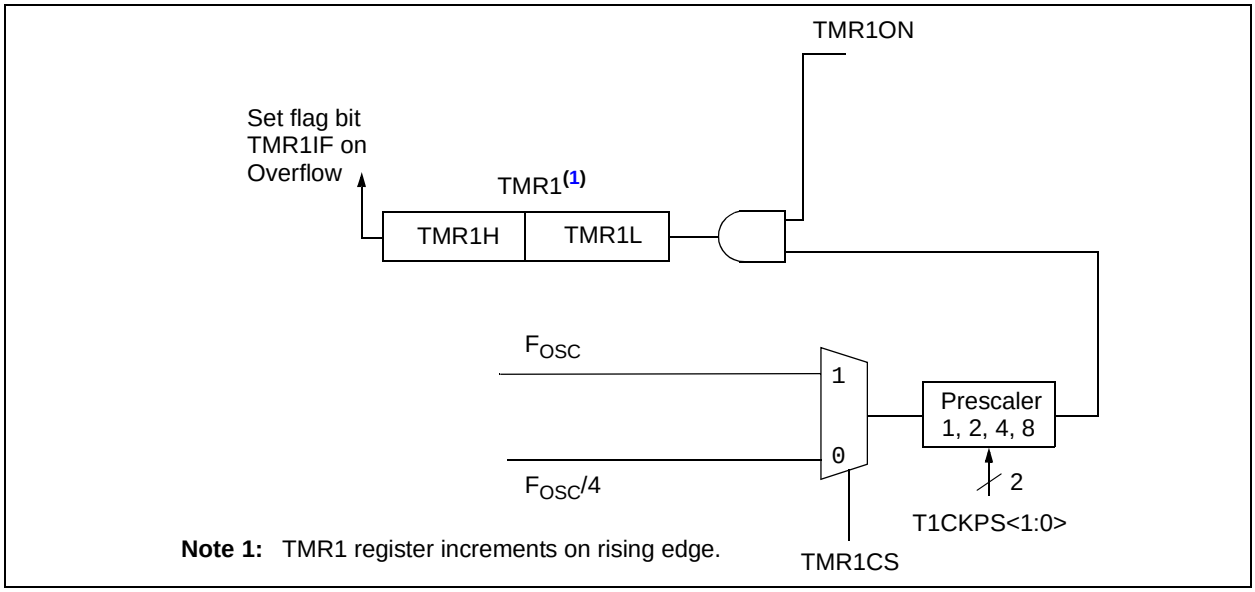
24.0 TIMER1 MODULE WITH GATE CONTROL

The Timer1 module is a 16-bit timer with the following features:

- 16-bit timer register pair (TMR1H:TMR1L)
- Readable and Writable (both registers)
- Selectable internal clock source
- 2-bit prescaler
- Interrupt on overflow

Figure 24-1 is a block diagram of the Timer1 module.

FIGURE 24-1: TIMER1 BLOCK DIAGRAM



Note 1: TMR1 register increments on rising edge.

24.1 Timer1 Operation

The Timer1 module is a 16-bit incrementing timer which is accessed through the TMR1H:TMR1L register pair. Writes to TMR1H or TMR1L directly update the counter. The timer is incremented on every instruction cycle.

Timer1 is enabled by configuring the T1CON<TMR1ON> bit. Table 24-1 displays the Timer1 enable selections.

24.2 Clock Source Selection

The T1CON<TMR1CS> bit is used to select the clock source for Timer1. Table 24-1 displays the clock source selections.

24.2.1 INTERNAL CLOCK SOURCE

The TMR1H:TMR1L register pair will increment on multiples of F_{OSC} or $F_{OSC}/4$ as determined by the Timer1 prescaler.

As an example, when the F_{OSC} internal clock source is selected, the Timer1 register value will increment by four counts every instruction clock cycle.

TABLE 24-1: CLOCK SOURCE SELECTIONS

TMR1CS	Clock Source
1	8 MHz system clock (F_{OSC})
0	2 MHz instruction clock ($F_{OSC}/4$)

24.3 Timer1 Prescaler

Timer1 has four prescaler options allowing 1, 2, 4 or 8 divisions of the clock input. The T1CON<T1CKPS> bits control the prescale counter. The prescale counter is not directly readable or writable; however, the prescaler counter is cleared upon a write to TMR1H or TMR1L.

24.4 Timer1 Interrupt

The Timer1 register pair (TMR1H:TMR1L) increments to FFFFh and rolls over to 0000h. When Timer1 rolls over, the Timer1 interrupt flag bit in the PIR1 register is set. To enable the interrupt on rollover, you must set these bits:

- T1CON<TMR1ON> bit
- PIE1<TMR1IE> bit
- INTCON<PEIE> bit
- INTCON<GIE> bit

The interrupt is cleared by clearing the TMR1IF bit in the Interrupt Service Routine.

Note:	The TMR1H:TMR1L register pair and the TMR1IF bit should be cleared before enabling interrupts.

24.5 Timer1 in Sleep

Unlike other standard mid-range Timer1 modules, the MCP19118/19 Timer1 module only clocks from an internal system clock and thus does not run during Sleep mode, nor can it be used to wake the device from this mode.

24.6 Timer1 Control Register

The Timer1 Control (T1CON) register is used to control Timer1 and select the various features of the Timer1 module.

REGISTER 24-1: T1CON: TIMER1 CONTROL REGISTER

U-0	U-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0
—	—	T1CKPS1	T1CKPS0	—	—	TMR1CS	TMR1ON
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-4 **T1CKPS<1:0>:** Timer1 Input Clock Prescale Select bits
- 11 = 1:8 Prescale value
- 10 = 1:4 Prescale value
- 01 = 1:2 Prescale value
- 00 = 1:1 Prescale value

bit 3-2 **Unimplemented:** Read as ‘0’

bit 1 **TMR1CS:** Timer1 Clock Source Control bit
- 1 = 8 MHz system clock (F_{OSC})
- 0 = 2 MHz instruction clock (F_{OSC})

bit 0 **TMR1ON:** Timer1 On bit
- 1 = Enables Timer1
- 0 = Stops Timer1, Clears Timer1 gate flip-flop

TABLE 24-2: SUMMARY OF REGISTERS ASSOCIATED WITH TIMER1

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF	95
PIE1	—	ADIE	BCLIE	SSPIE	—	—	TMR2IE	TMR1IE	95
PIR1	—	ADIF	BCLIF	SSPIF	—	—	TMR2IF	TMR1IF	98
TMR1H	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register								137*
TMR1L	Holding Register for the Least Significant Byte of the 16-bit TMR1 Register								137*
T1CON	—	—	T1CKPS1	T1CKPS0	—	—	TMR1CS	TMR1ON	138

Legend: — = unimplemented, read as '0'. Shaded cells are not used by the Timer1 module.

* Page provides register information.

25.0 TIMER2 MODULE

The Timer2 module is an 8-bit timer with the following features:

- 8-bit timer register (TMR2)
- 8-bit period register (PR2)
- Interrupt on TMR2 match with PR2
- Software-programmable prescaler (1:1, 1:4, 1:16)

See Figure 25-1 for a block diagram of Timer2.

25.1 Timer2 Operation

The clock input to the Timer2 module is the system clock (F_{OSC}). The clock is fed into the Timer2 prescaler, which has prescaler options of 1:1, 1:4 or 1:16. The output of the prescaler is then used to increment the TMR2 register.

The values of TMR2 and PR2 are constantly compared to determine when they match. TMR2 will increment from 00h until it matches the value in PR2. When a match occurs, TMR2 is reset to 00h on the next increment cycle.

The match output of the Timer2/PR2 comparator is used to set the PIR1<TMR2IF>.

The TMR2 and PR2 registers are both fully readable and writable. On any Reset, the TMR2 register is set to 00h and the PR2 register is set to FFh.

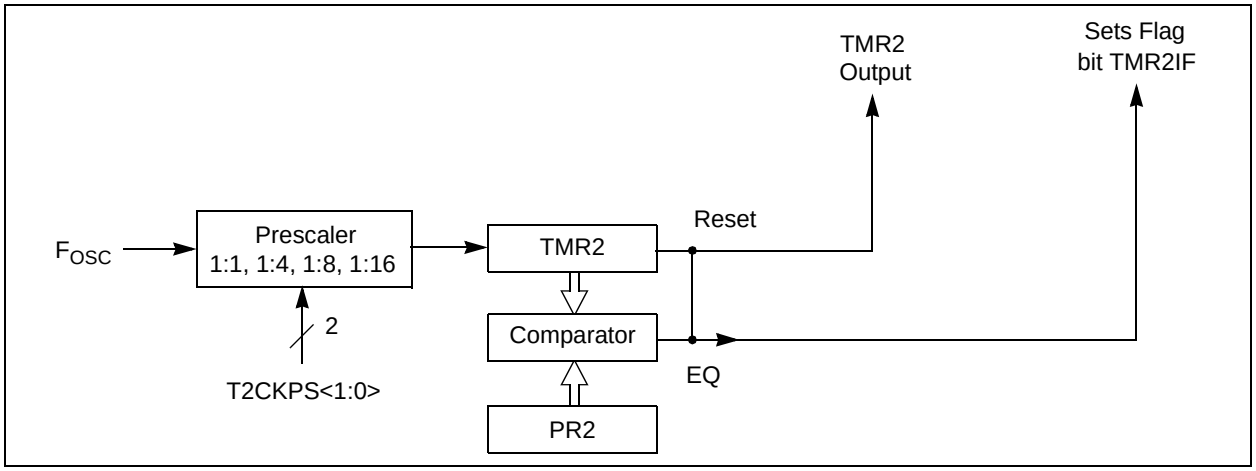
Timer2 is turned on by setting the T2CON<TMR2ON> bit to a '1'. Timer2 is turned off by clearing the TMR2ON bit to a '0'.

The Timer2 prescaler is controlled by the T2CON<T2CKPS> bits. The prescaler counter is cleared when:

- A write to TMR2 occurs
- A write to T2CON occurs
- Any device Reset occurs (Power-On Reset, MCLR Reset, Watchdog Timer Reset or Brown-Out Reset)

Note:	TMR2 is not cleared when T2CON is written.

FIGURE 25-1: TIMER2 BLOCK DIAGRAM



25.2 Timer2 Control Register

REGISTER 25-1: T2CON: TIMER2 CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-3 **Unimplemented:** Read as '0'

bit 2 **TMR2ON:** Timer2 On bit
1 = Timer2 is on
0 = Timer2 is off

bit 1-0 **T2CKPS<1:0>:** Timer2 Clock Prescale Select bits
00 =Prescaler is 1
01 =Prescaler is 4
10 =Prescaler is 8
11 =Prescaler is 16

TABLE 25-1: SUMMARY OF REGISTERS ASSOCIATED WITH TIMER2

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF	95
PIE1	—	ADIE	BCLIE	SSPIE	—	—	TMR2IE	TMR1IE	96
PIR1	—	ADIF	BCLIF	SSPIF	—	—	TMR2IF	TMR1IF	98
PR2	Timer2 Module Period Register								140*
T2CON	—	—	—	—	—	TMR2ON	T2CKPS1	T2CKPS0	141
TMR2	Holding Register for the 8-bit TMR2 Time Base								140*

Legend: — = unimplemented read as '0'. Shaded cells are not used for Timer2 module.
* Page provides register information.

NOTES:

26.0 PWM MODULE

The CCP module implemented on the MCP19118/19 is a modified version of the CCP module found in standard mid-range microcontrollers. In the MCP19118/19, the PWM module is used to generate the system clock or system oscillator. This system clock will control the MCP19118/19 switching frequency, as well as set the maximum allowable duty cycle. The PWM module does not continuously adjust the duty cycle to control the output voltage. This is accomplished by the analog control loop and associated circuitry.

26.1 Standard Pulse-Width Modulation (PWM) Mode

The PWM module output signal is used to set the operating switching frequency and maximum allowable duty cycle of the MCP19118/19. The actual duty cycle on the HDRV and LDRV is controlled by the analog PWM control loop. However, this duty cycle cannot be greater than the value in the PWMRL register.

There are two modes of operation that concern the system clock PWM signal. These modes are stand-alone (nonfrequency synchronization) and frequency synchronization.

26.1.1 STAND-ALONE (NONFREQUENCY SYNCHRONIZATION) MODE

When the MCP19118/19 is running stand-alone, the PWM signal functions as the system clock. It is operating at the programmed switching frequency with a programmed maximum duty cycle (D_{CLOCK}). The programmed maximum duty cycle is not adjusted on a cycle-by-cycle basis to control the MCP19118/19 system output. The required duty cycle (D_{BUCK}) to control the output is adjusted by the MCP19118/19 analog control loop and associated circuitry. D_{CLOCK} does, however, set the maximum allowable D_{BUCK}.

EQUATION 26-1:

$$D_{BUCK} < 1 - D_{CLOCK}$$

26.1.2 SWITCHING FREQUENCY SYNCHRONIZATION MODE

The MCP19118/19 can be programmed to be a switching frequency MASTER or SLAVE device. The MASTER device functions as described in **Section 26.1.1 "Stand-Alone (NonFrequency Synchronization) Mode"** with the exception of the system clock also being applied to GPA1.

A SLAVE device will receive the MASTER system clock on GPA1. This MASTER system clock will be OR'ed with the output of the TIMER2 module. This OR'ed signal will latch PWMRL into PWMRH and PWMPHL into PWMPHH.

Figure 26-1 shows a simplified block diagram of the CCP module in PWM mode.

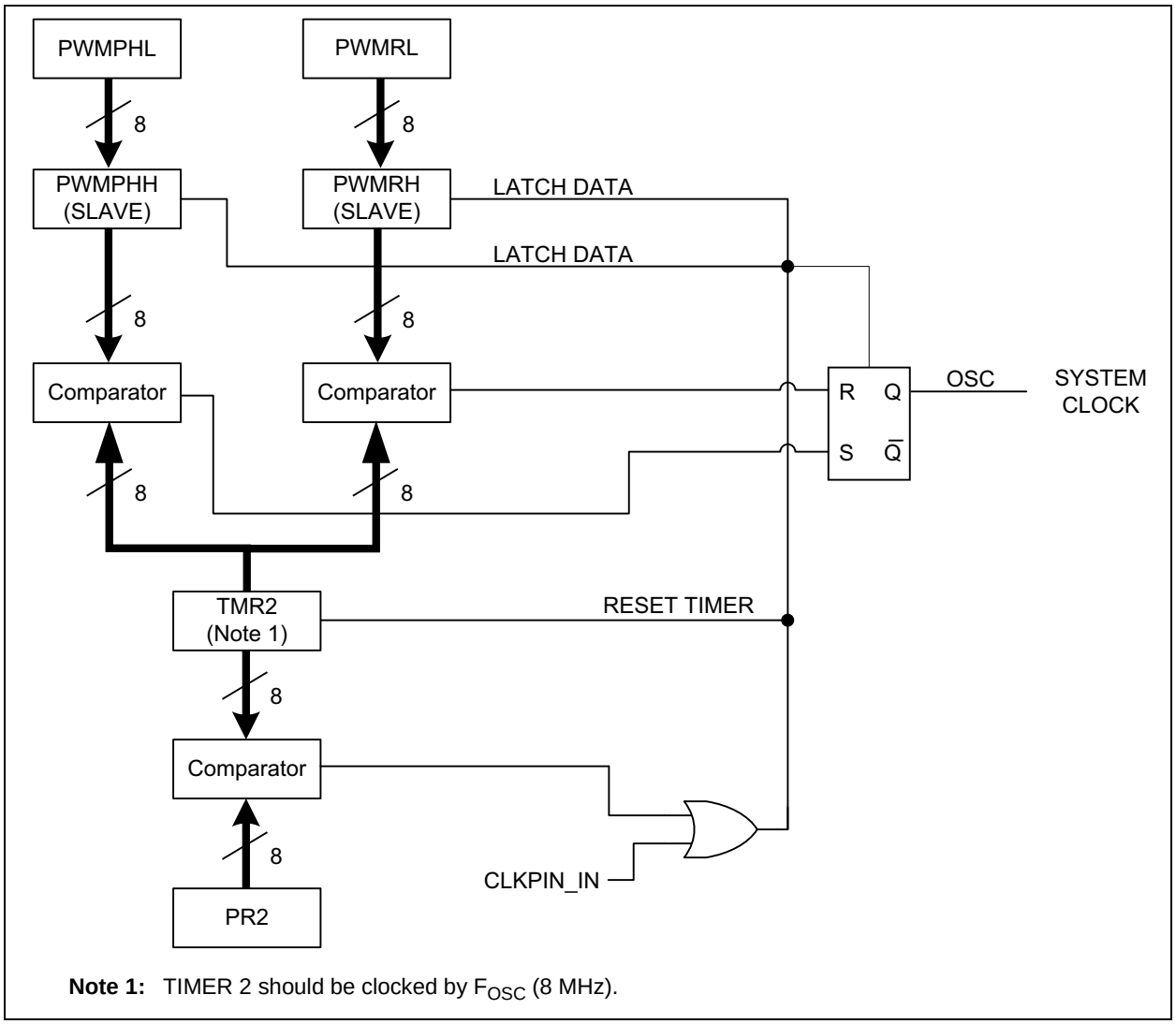
The PWMPHL register allows for a phase shift to be added to the SLAVE system clock.

It is desired to have the MCP19118/19 SLAVE device's system clock start point shifted by a programmed amount from the MASTER system clock. This SLAVE phase shift is specified by writing to the PWMPHL register. The SLAVE phase shift can be calculated by using the following equation.

EQUATION 26-2:

$$SLAVE\ PHASE\ SHIFT = PWMPHL \cdot T_{OSC} \cdot (T2\ PRESCALE\ VALUE)$$

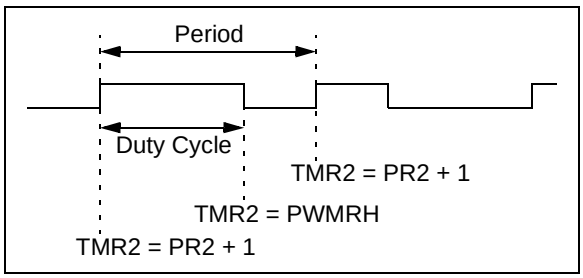
FIGURE 26-1: SIMPLIFIED PWM BLOCK DIAGRAM



Note 1: TIMER 2 should be clocked by F_{OSC} (8 MHz).

A PWM output (Figure 26-2) has a time base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 26-2: PWM OUTPUT



26.1.3 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following equation:

EQUATION 26-3:

$$PWM\ PERIOD=[(PR2)+1]\ x\ T_{OSC}\ x\ (T2\ PRESCALE\ VALUE)$$

When TMR2 is equal to PR2, the following two events occur on the next increment cycle:

- TMR2 is cleared
- The PWM duty cycle is latched from PWMRL into PWMRH

26.1.4 PWM DUTY CYCLE (D_{CLOCK})

The PWM duty cycle (D_{CLOCK}) is specified by writing to the PWMRL register. Up to 8-bit resolution is available. The following equation is used to calculate the PWM duty cycle (D_{CLOCK}):

EQUATION 26-4:

$$PWM\ DUTY\ CYCLE = PWMRL \times T_{OSC} \times (T2\ PRESCALE\ VALUE)$$

The PWMRL bits can be written to at any time, but the duty cycle value is not latched into PWMRH until after a match between PR2 and TMR2 occurs.

26.2 Operation during Sleep

When the device is placed in Sleep, the allocated timer will not increment and the state of the module will not change. If the CLKPIN pin is driving a value, it will continue to drive that value. When the device wakes up, it will continue from this state.

TABLE 26-1: SUMMARY OF REGISTERS ASSOCIATED WITH PWM MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
APFCON	—	—	—	—	—	—	—	CLKSEL	112
T2CON	—	—	—	—	—	TMR2ON	T2CKPS1	T2CKPS0	141
PR2	Timer2 Module Period Register								140*
PWMRL	PWM Register Low Byte								143*
PWMPHL	SLAVE Phase Shift Byte								143*
BUFFCON	MLTPH2	MLTPH1	MLTPH0	ASEL4	ASEL3	ASEL2	ASEL1	ASEL0	58

Legend: — = Unimplemented locations, read as '0'. Shaded cells are not used by Capture mode.

* Page provides register information.

NOTES:

27.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

27.1 Master SSP (MSSP) Module Overview

The Master Synchronous Serial Port (MSSP) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be Serial EEPROMs, shift registers, display drivers, A/D converters, etc. The MSSP module only operates in Inter-Integrated Circuit (I^2C) mode.

The I^2C interface supports the following modes and features:

- Master mode
- Slave mode
- Byte NACKing (Slave mode)
- Limited Multi-Master support
- 7-bit and 10-bit addressing
- Start and Stop interrupts
- Interrupt masking
- Clock stretching
- Bus collision detection
- General call address matching
- Dual Address masking
- Address Hold and Data Hold modes
- Selectable SDA hold times

Figure 27-1 is a block diagram of the I^2C interface module in Master mode. Figure 27-2 is a diagram of the I^2C interface module in Slave mode.

FIGURE 27-1: MSSP BLOCK DIAGRAM (I^2C MASTER MODE)

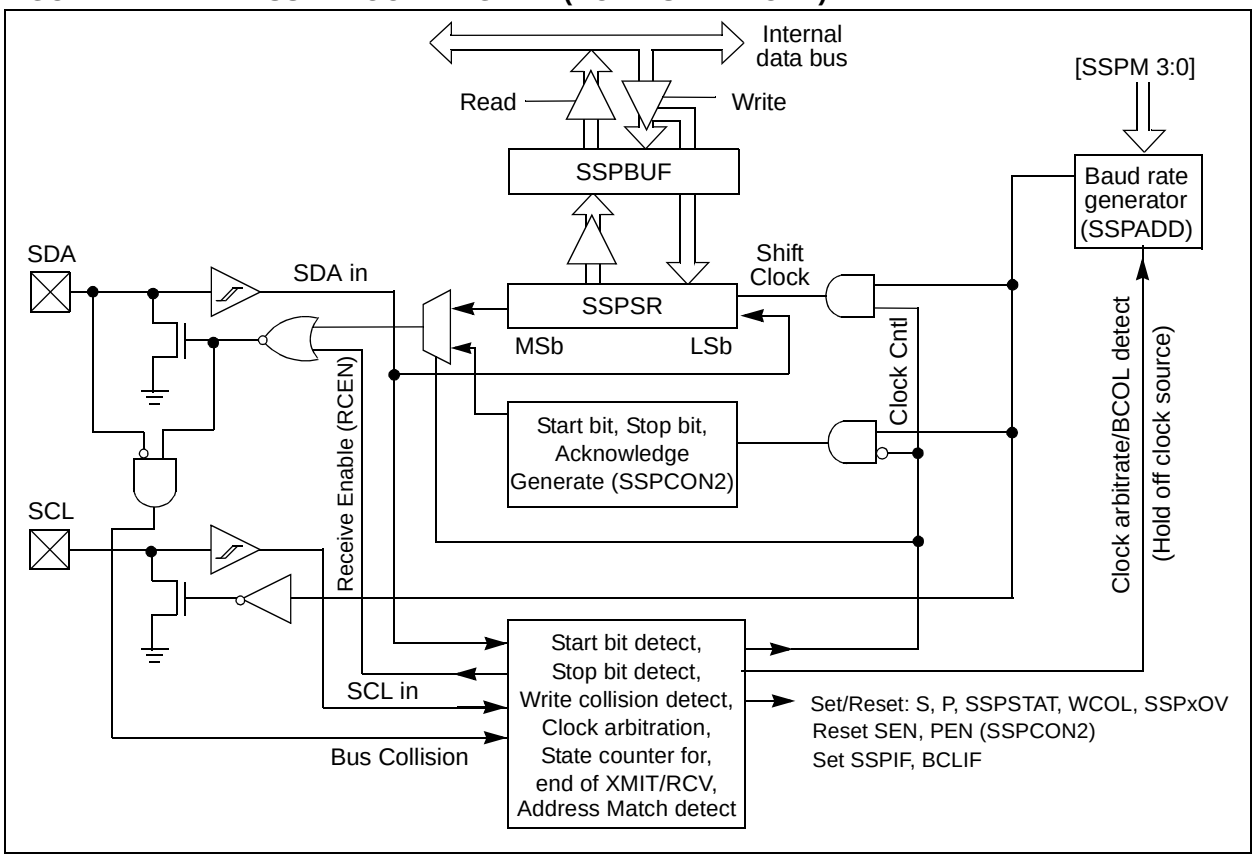
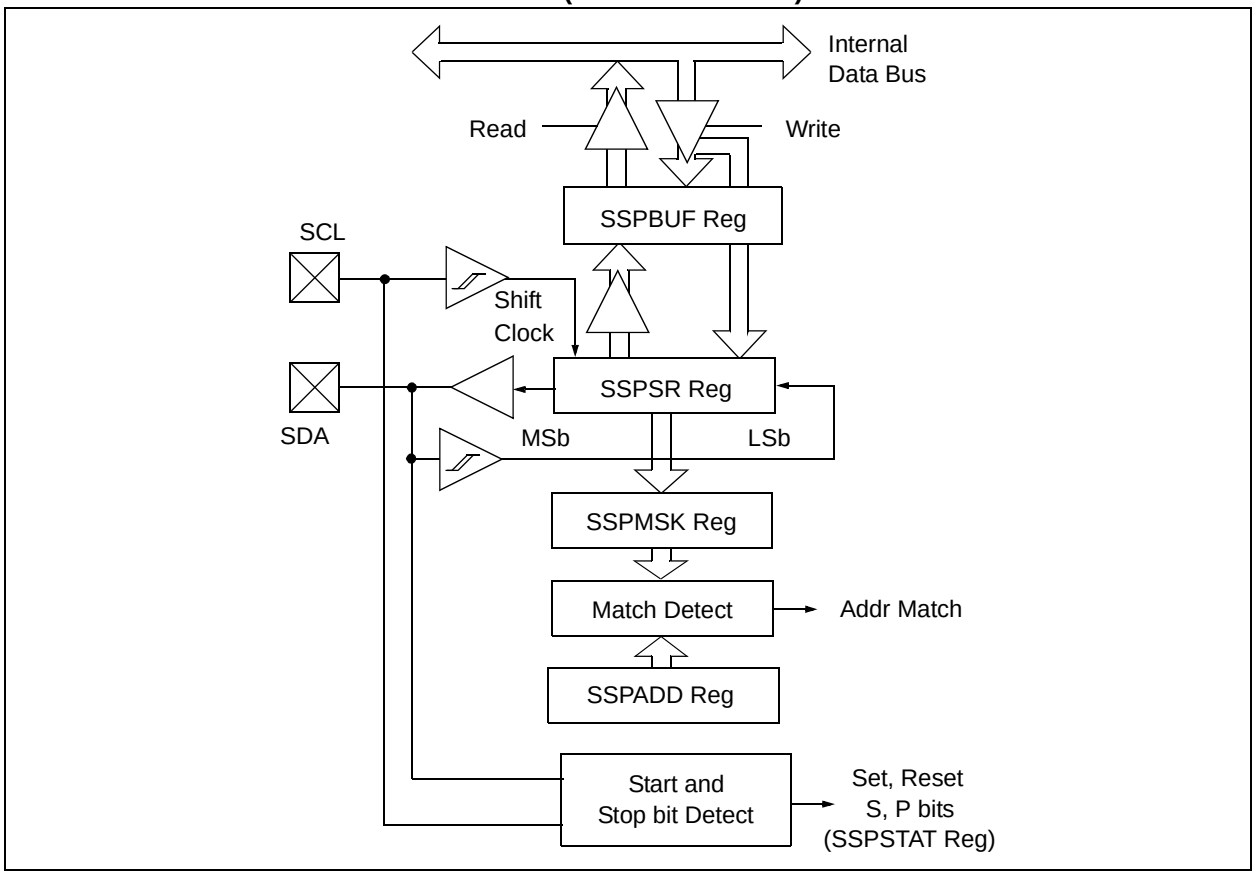


FIGURE 27-2: MSSP BLOCK DIAGRAM (I^2C SLAVE MODE)



27.2 I^2C MODE OVERVIEW

The Inter-Integrated Circuit Bus (I^2C) is a multi-master serial data communication bus. Devices communicate in a master/slave environment, where the master devices initiate the communication. A slave device is controlled through addressing.

The MSSP module has eight registers for I^2C operation. They are the:

- MSSP Status Register (SSPSTAT)
- MSSP Control Register1 (SSPCON1)
- MSSP Control Register2 (SSPCON2)
- MSSP Control Register3 (SSPCON3)
- Serial Receive/Transmit Buffer (SSPBUF)
- MSSP Shift Register (SSPSR) – Not directly accessible
- MSSP Address Register (SSPADD)
- MSSP Address Register2 (SSPADD2)
- MSSP Address Mask Register1 (SSPMSK)
- MSSP Address Mask Register2 (SSPMSK2)

The SSPCON1 register is used to define the I^2C mode. Four selection bits (SSPCON1<3:0>) allow one of the following I^2C modes to be selected:

- I^2C Slave mode (7-bit address)
- I^2C Slave mode (10-bit address)
- I^2C Master mode, clock = OSC/4 (SSPADD +1)
- I^2C firmware controlled Master mode (Slave idle)

The SSPSTAT register gives the status of the data transfer. This information includes detection of a START or STOP bit, specifies if the data received byte was data or address, if the next byte is completion of the 10-bit address and if this will be a read or write data transfer.

The SSPBUF is the register to which transfer data is written to or read from. The SSPSR register shifts the data in or out of the device. In receive operation, the SSPBUF and SSPSR create a double buffer receiver. This allows reception of the next byte to begin before reading the last byte of received data. When the complete byte is received before the SSPBUF register is read, a receiver overflow has occurred, the SSPOV bit (SSPCON1<6>) is set and the byte in the SSPSR is lost.

The I²C bus specifies two signal connections:

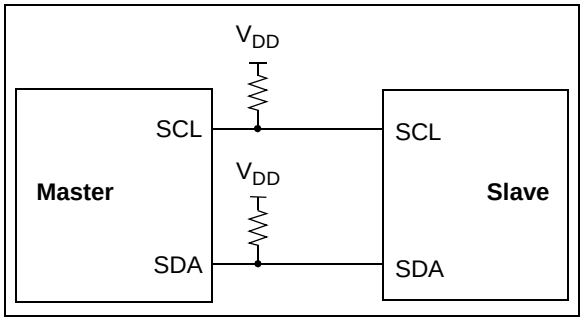
- Serial Clock (SCL)
- Serial Data (SDA)

Both the SCL and SDA connections are bidirectional open-drain lines, each requiring pull-up resistors for the supply voltage. Pulling the line to ground is considered a logical zero; letting the line float is considered a logical one.

Before selecting any I²C mode, the SCL and SDA pins must be programmed to inputs by setting the appropriate TRIS bits. Selecting I²C mode, by setting the SSPEN bit, enables the SCL and SDA pins to be used as clock and data lines in I²C mode.

Figure 27-3 shows a typical connection between two devices configured as master and slave.

FIGURE 27-3: I²C MASTER/SLAVE CONNECTION



The I²C bus can operate with one or more master devices and one or more slave devices.

There are four potential modes of operation for a given device:

- Master Transmit mode
  (master is transmitting data to a slave)
- Master Receive mode
  (master is receiving data from a slave)
- Slave Transmit mode
  (slave is transmitting data to a master)
- Slave Receive mode
  (slave is receiving data from the master)

To begin communication, a master device starts out in Master Transmit mode. The master device sends out a Start bit followed by the address byte of the slave it intends to communicate with. This is followed by a single Read/Write bit, which determines whether the master intends to transmit to or receive data from the slave device.

If the requested slave exists on the bus, it will respond with an Acknowledge bit, otherwise known as an ACK. The master then continues in either Transmit mode or Receive mode and the slave continues in the complement, either in Receive mode or Transmit mode, respectively.

A Start bit is indicated by a high-to-low transition of the SDA line while the SCL line is held high. Address and data bytes are sent out, Most Significant bit (MSb) first. The Read/Write bit is sent out as a logical one when the master intends to read data from the slave and is sent out as a logical zero when it intends to write data to the slave.

The Acknowledge ($\overline{ACK}$) bit is an active-low signal, which holds the SDA line low to indicate to the transmitter that the slave device has received the transmitted data and is ready to receive more.

The transition of a data bit is always performed while the SCL line is held low. Transitions that occur while the SCL line is held high are used to indicate Start and Stop bits.

If the master intends to write to the slave, then it repeatedly sends out a byte of data, with the slave responding after each byte with an $\overline{ACK}$ bit. In this example, the master device is in Master Transmit mode and the slave is in Slave Receive mode.

If the master intends to read from the slave, then it repeatedly receives a byte of data from the slave and responds after each byte with an $\overline{ACK}$ bit. In this example, the master device is in Master Receive mode and the slave is Slave Transmit mode.

On the last byte of data communicated, the master device may end the transmission by sending a Stop bit. If the master device is in Receive mode, it sends the Stop bit in place of the last $\overline{ACK}$ bit. A Stop bit is indicated by a low-to-high transition of the SDA line, while the SCL line is held high.

In some cases, the master may want to maintain control of the bus and reinitiate another transmission. If so, the master device may send another Start bit in place of the Stop bit or last $\overline{ACK}$ bit when it is in Receive mode.

The I²C bus specifies three message protocols:

- Single message where a master writes data to a slave
- Single message where a master reads data from a slave
- Combined message where a master initiates a minimum of two writes, or two reads, or a combination of writes and reads, to one or more slaves

When one device is transmitting a logical one or letting the line float and a second device is transmitting a logical zero or holding the line low, the first device can detect that the line is not a logical one. This detection, when used on the SCL line, is called clock stretching. Clock stretching gives slave devices a mechanism to control the flow of data. When this detection is used on the SDA line, it is called arbitration. Arbitration ensures that there is only one master device communicating at any single time.

27.2.1 CLOCK STRETCHING

When a slave device has not completed processing data, it can delay the transfer of more data through the process of Clock Stretching. An addressed slave device may hold the SCL clock line low after receiving or sending a bit, indicating that it is not yet ready to continue. The master that is communicating with the slave will attempt to raise the SCL line in order to transfer the next bit, but will detect that the clock line has not yet been released. Because the SCL connection is open-drain, the slave has the ability to hold that line low until it is ready to continue communicating.

Clock stretching allows receivers that cannot keep up with a transmitter to control the flow of incoming data.

27.2.2 ARBITRATION

Each master device must monitor the bus for Start and Stop bits. If the device detects that the bus is busy, it cannot begin a new message until the bus returns to an Idle state.

However, two master devices may try to initiate a transmission on or about the same time. When this occurs, the process of arbitration begins. Each transmitter checks the level of the SDA data line and compares it to the level that it expects to find. The first transmitter to observe that the two levels don't match loses arbitration and must stop transmitting on the SDA line.

For example, if one transmitter holds the SDA line to a logical one (lets it float) and a second transmitter holds it to a logical zero (pulls it low), the result is that the SDA line will be low. The first transmitter then observes that the level of the line is different than expected and concludes that another transmitter is communicating.

The first transmitter to notice this difference is the one that loses arbitration and must stop driving the SDA line. If this transmitter is also a master device, it also must stop driving the SCL line. It then can monitor the lines for a Stop condition before trying to reissue its transmission. In the meantime, the other device that has not noticed any difference between the expected and actual levels on the SDA line continues with its original transmission. It can do so without any complications, because so far, the transmission appears exactly as expected with no other transmitter disturbing the message.

Slave Transmit mode can also be arbitrated, when a master addresses multiple slaves, but this is less common.

If two master devices are sending a message to two different slave devices at the address stage, the master sending the lower slave address always wins arbitration. When two master devices send messages to the same slave address and addresses can sometimes refer to multiple slaves, the arbitration process must continue into the data stage.

Arbitration usually occurs very rarely, but it is a necessary process for proper multi-master support.

27.3 I²C MODE OPERATION

All MSSP I²C communication is byte-oriented and shifted out MSb first. Six SFR registers and two interrupt flags interface the module with the PIC microcontroller and user software. Two pins, SDA and SCL, are exercised by the module to communicate with other external I²C devices.

27.3.1 BYTE FORMAT

All communication in I²C is done in 9-bit segments. A byte is sent from a master to a slave or vice-versa, followed by an Acknowledge bit sent back. After the 8th falling edge of the SCL line, the device outputting data on the SDA changes that pin to an input and reads in an acknowledge value on the next clock pulse.

The clock signal, SCL, is provided by the master. Data is valid to change while the SCL signal is low and sampled on the rising edge of the clock. Changes on the SDA line while the SCL line is high define special conditions on the bus, explained below.

27.3.2 DEFINITION OF I²C TERMINOLOGY

There is language and terminology in the description of I²C communication that have definitions specific to I²C. That word usage is defined below and may be used in the rest of this document without explanation. This table was adapted from the Philips I²C specification.

27.3.3 SDA AND SCL PINS

On the MCP19118/19, the SCL and SDA pins are always open-drain. These pins should be set by the user to inputs by setting the appropriate TRIS bits.

Note: Data is tied to output zero when an I²C mode is enabled.

27.3.4 SDA HOLD TIME

The hold time of the SDA pin is selected by the SSPCON3<SDAHT> bit. Hold time is the time SDA is held valid after the falling edge of SCL. Setting the SDAHT bit selects a longer 300 ns minimum hold time and may help on buses with large capacitance.

TABLE 27-1: I²C BUS TERMS

TERM	Description
Transmitter	The device which shifts data out onto the bus.
Receiver	The device which shifts data in from the bus.
Master	The device that initiates a transfer, generates clock signals and terminates a transfer.
Slave	The device addressed by the master.
Multi-Master	A bus with more than one device that can initiate data transfers.
Arbitration	Procedure to ensure that only one master at a time controls the bus. Winning arbitration ensures that the message is not corrupted.
Synchronization	Procedure to synchronize the clocks of two or more devices on the bus.
Idle	No master is controlling the bus and both SDA and SCL lines are high.
Active	Any time one or more master devices are controlling the bus.
Addressed Slave	Slave device that has received a matching address and is actively being clocked by a master.
Matching Address	Address byte that is clocked into a slave that matches the value stored in SSPADDx.
Write Request	Slave receives a matching address with R/$\overline{W}$ bit clear and is ready to clock in data.
Read Request	Master sends an address byte with the R/$\overline{W}$ bit set, indicating that it wishes to clock data out of the slave. This data is the next and all following bytes until a Restart or Stop.
Clock Stretching	When a device on the bus holds SCL low to stall communication.
Bus Collision	Any time the SDA line is sampled low by the module while it is outputting and expected high state.

27.3.5 START CONDITION

The I²C specification defines a Start condition as a transition of SDA from a high to a low state, while SCL line is high. A Start condition is always generated by the master and signifies the transition of the bus from an Idle to an Active state. Figure 27-4 shows the wave forms for Start and Stop conditions.

A bus collision can occur on a Start condition if the module samples the SDA line low before asserting it low. This does not conform to the I²C Specification that states no bus collision can occur on a Start.

27.3.6 STOP CONDITION

A Stop condition is a transition of the SDA line from a low state to a high state while the SCL line is high.

Note: At least one SCL low time must appear before a Stop is valid. Therefore, if the SDA line goes low then high again while the SCL line stays high, only the Start condition is detected.

27.3.7 RESTART CONDITION

A Restart is valid any time that a Stop would be valid. A master can issue a Restart if it wishes to hold the bus after terminating the current transfer. A Restart has the same effect on the slave that a Start would, resetting all slave logic and preparing it to clock in an address. The master may want to address the same or another slave.

In 10-bit Addressing Slave mode, a Restart is required for the master to clock data out of the addressed slave. Once a slave has been fully addressed, matching both high and low address bytes, the master can issue a Restart and the high address byte with the R/$\overline{W}$ bit set. The slave logic will then hold the clock and prepare to clock out data.

After a full match with R/$\overline{W}$ clear in 10-bit mode, a prior match flag is set and maintained. Until a Stop condition, a high address with R/$\overline{W}$ clear or a high address match fails.

27.3.8 START/STOP CONDITION INTERRUPT MASKING

The SSPCON3<SCIE> and SSPCON3<PCIE> bits can enable the generation of an interrupt in slave modes that do not typically support this function. These bits will have no effect on slave modes where interrupt on Start and Stop detect are already enabled.

FIGURE 27-4: I²C START AND STOP CONDITIONS

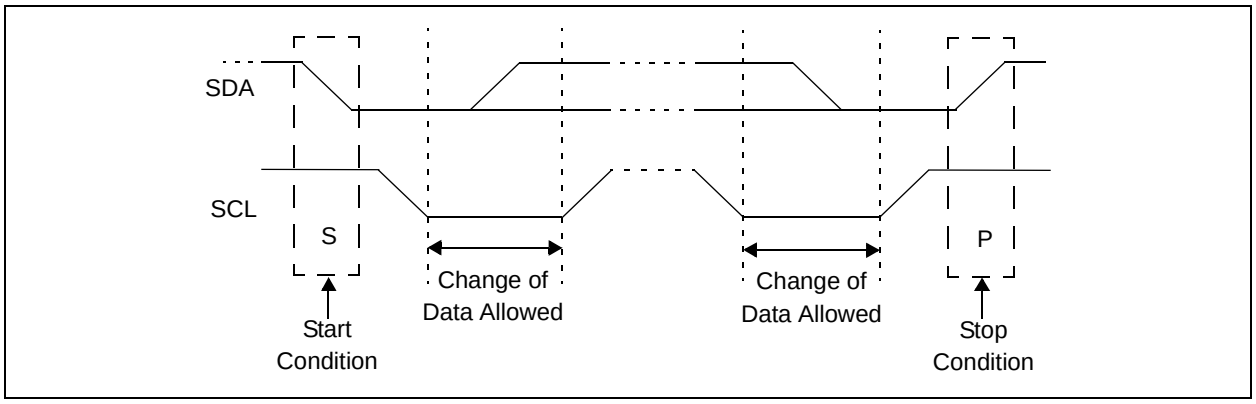
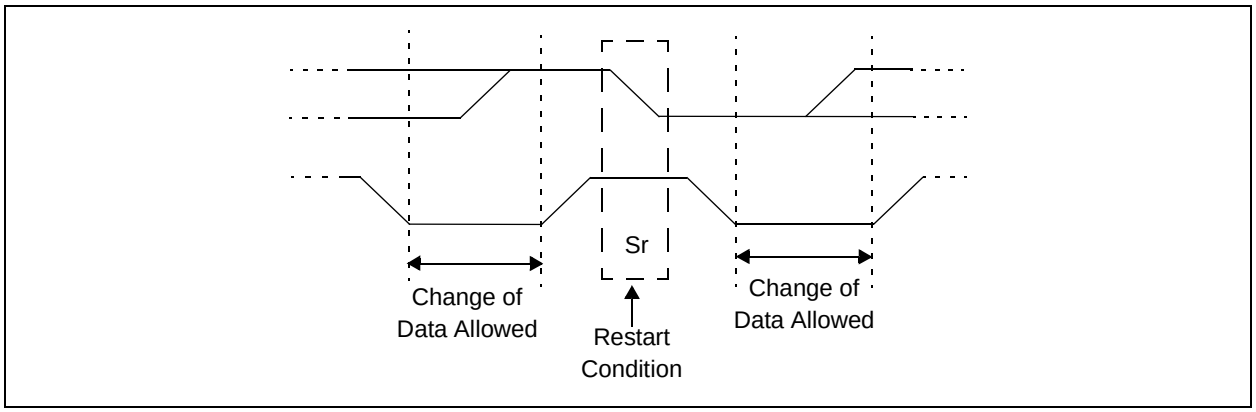


FIGURE 27-5: I²C RESTART CONDITION



27.3.9 ACKNOWLEDGE SEQUENCE

The 9th SCL pulse for any transferred byte in I²C is dedicated as an Acknowledge. It allows receiving devices to respond back to the transmitter by pulling the SDA line low. The transmitter must release control of the line during this time to shift in the response. The Acknowledge ($\overline{ACK}$) is an active-low signal, pulling the SDA line low indicates to the transmitter that the device has received the transmitted data and is ready to receive more.

The result of an $\overline{ACK}$ is placed in the SSPCON2<ACKSTAT> bit.

Slave software, when the AHEN and DHEN bits are set, allows the user to set the $\overline{ACK}$ value sent back to the transmitter. The SSPCON2<ACKDT> bit is set/cleared to determine the response.

Slave hardware will generate an $\overline{ACK}$ response if the SSPCON3<AHEN> and SSPCON3<DHEN> bits are clear.

There are certain conditions where an $\overline{ACK}$ will not be sent by the slave. If the SSPSTAT<BF> bit or the SSPCON1<SSPOV> bit are set when a byte is received, an $\overline{ACK}$ will not be sent.

When the module is addressed, after the 8th falling edge of SCL on the bus, the SSPCON3<ACKTIM> bit is set. The ACKTIM bit indicates the acknowledge time of the active bus. The ACKTIM Status bit is only active when the AHEN bit or DHEN bit is enabled.

27.4 I²C SLAVE MODE OPERATION

The MSSP Slave mode operates in one of the four modes selected in the SSPCON1<SSPM> bits. The modes can be divided into 7-bit and 10-bit Addressing mode. 10-bit Addressing mode operates the same as 7-bit, with some additional overhead for handling the larger addresses.

Modes with Start and Stop bit interrupts operate the same as the other modes. The exception is the SSPIF bit getting set upon detection of a Start, Restart or Stop condition.

27.4.1 SLAVE MODE ADDRESSES, SSPADD

The SSPADD register contains the Slave mode address. The first byte received after a Start or Restart condition is compared against the value stored in this register. If the byte matches, the value is loaded into the SSPBUF register and an interrupt is generated. If the value does not match, the module goes idle and no indication is given to the software that anything happened.

The SSPMSK register affects the address matching process. See **Section 27.4.10 "SSPMSKx Register"** for more information.

27.4.2 SECOND SLAVE MODE ADDRESS, SSPADD2

The SSPADD2 register contains a second Slave mode address. To enable the use of this second Slave mode address, bit 0 must be set. The first byte received after a Start or Restart condition is compared against the value stored in this register. If the byte matches, the value is loaded into the SSPBUF register and an interrupt is generated. If the value does not match, the module goes Idle and no indication is given to the software that anything happened.

The SSPMSK2 register affects the address matching process. See **Section 27.4.10 "SSPMSKx Register"** for more information.

27.4.2.1 I²C Slave 7-Bit Addressing Mode

In 7-bit Addressing mode, the LSb of the received data byte is ignored when determining if there is an address match.

27.4.2.2 I²C Slave 10-Bit Addressing Mode

In 10-bit Addressing mode, the first received byte is compared to the binary value of '1 1 1 1 0 A9 A8 0'. A9 and A8 are the two MSb of the 10-bit address and stored in bits 2 and 1 in the SSPADDx register.

After the acknowledge of the high byte, the UA bit is set and SCL is held low until the user updates SSPADDx with the low address. The low address byte is clocked in and all eight bits are compared to the low address value in SSPADDx. Even if there is no address match, SSPIF and UA are set and SCL is held low until SSPADDx is updated to receive a high byte again. When SSPADDx is updated, the UA bit is cleared. This ensures the module is ready to receive the high address byte on the next communication.

A high and low address match as a write request is required at the start of all 10-bit addressing communication. A transmission can be initiated by issuing a Restart once the slave is addressed and clocking in the high address with the R/$\overline{W}$ bit set. The slave hardware will then acknowledge the read request and prepare to clock out data. This is only valid for a slave after it has received a complete high and low address byte match.

27.4.3 SLAVE RECEPTION

When the R/$\overline{W}$ bit of a matching received address byte is clear, the SSPSTAT<R/$\overline{W}$> bit is cleared. The received address is loaded into the SSPBUF register and acknowledged.

When an overflow condition exists for a received address, then a Not Acknowledge is given. An overflow condition is defined as either SSPSTAT<BF> bit or bit SSPCON1<SSPOV> bit is set. The SSPCON3<BOEN> bit modifies this operation. For more information, see Register 27-5.

An MSSP interrupt is generated for each transferred data byte. Flag bit, SSPIF, must be cleared by software.

When the SSPCON2<SEN> bit is set, SCL will be held low (clock stretch) following each received byte. The clock must be released by setting the SSPCON1<CKP> bit, except sometimes in 10-bit mode.

27.4.3.1 7-Bit Addressing Reception

This section describes a standard sequence of events for the MSSP module configured as an I^2C slave in 7-bit Addressing mode, all decisions made by hardware or software and their effect on reception. Figures 27-6 and 27-7 are used as a visual reference for this description.

This is a step-by-step process of what typically must be done to accomplish I^2C communication.

1. Start bit detected.
2. SSPSTAT<S> bit is set; SSPIF is set if Interrupt-on-Start detect is enabled.
3. Matching address with R/$\overline{W}$ bit clear is received.
4. The slave pulls SDA low, sending an $\overline{ACK}$ to the master, and sets SSPIF bit.
5. Software clears the SSPIF bit.
6. Software reads received address from SSPBUF, clearing the BF flag.
7. If SEN = 1, slave software sets CKP bit to release the SCL line.
8. The master clocks out a data byte.
9. Slave drives SDA low, sending an $\overline{ACK}$ to the master, and sets SSPIF bit.
10. Software clears SSPIF.
11. Software reads the received byte from SSPBUF, clearing BF.
12. Steps 8–12 are repeated for all received bytes from the master.
13. Master sends Stop condition, setting SSPSTAT<P> bit, and the bus goes Idle.

27.4.3.2 7-Bit Reception with AHEN and DHEN

Slave device reception with AHEN and DHEN set operates the same as without these options, with extra interrupts and clock stretching added after the 8th falling edge of SCL. These additional interrupts allow the slave software to decide whether it wants to $\overline{ACK}$ the receive address or data byte, rather than the hardware. This functionality adds support for PMBus that was not present on previous versions of this module.

This list describes the steps that need to be taken by slave software to use these options for I^2C communication. Figure 27-8 displays a module using both address and data holding. Figure 27-9 includes the operation with the SSPCON2<SEN> bit set.

1. SSPSTAT<S> bit is set; SSPIF is set if interrupt on Start detect is enabled.
2. Matching address with R/$\overline{W}$ bit clear is clocked in. SSPIF is set and CKP cleared after the 8th falling edge of SCL.
3. Slave clears the SSPIF.
4. Slave can look at the SSPCON3<ACKTIM> bit to determine if the SSPIF was after or before the $\overline{ACK}$.
5. Slave reads the address value from SSPBUF, clearing the BF flag.
6. Slave sets $\overline{ACK}$ value clocked out to the master by setting ACKDT.
7. Slave releases the clock by setting CKP.
8. SSPxIF is set after an $\overline{ACK}$, not after a $\overline{NACK}$.
9. If SEN = 1 the slave hardware will stretch the clock after the $\overline{ACK}$.
10. Slave clears SSPIF.

Note: SSPIF is still set after the 9th falling edge of SCL even if there is no clock stretching and BF has been cleared. Only if $\overline{NACK}$ is sent to master is SSPIF not set.

11. SSPIF set and CKP cleared after 8th falling edge of SCL for a received data byte.
12. Slave looks at SSPCON3<ACKTIM> bit to determine the source of the interrupt.
13. Slave reads the received data from SSPBUF clearing BF.
14. Steps 7–14 are the same for each received data byte.
15. Communication is ended by either the slave sending an $\overline{ACK}$ = 1 or the master sending a Stop condition. If a Stop is sent and Interrupt on Stop Detect is disabled, the slave will only know by polling the SSTSTAT<P> bit.

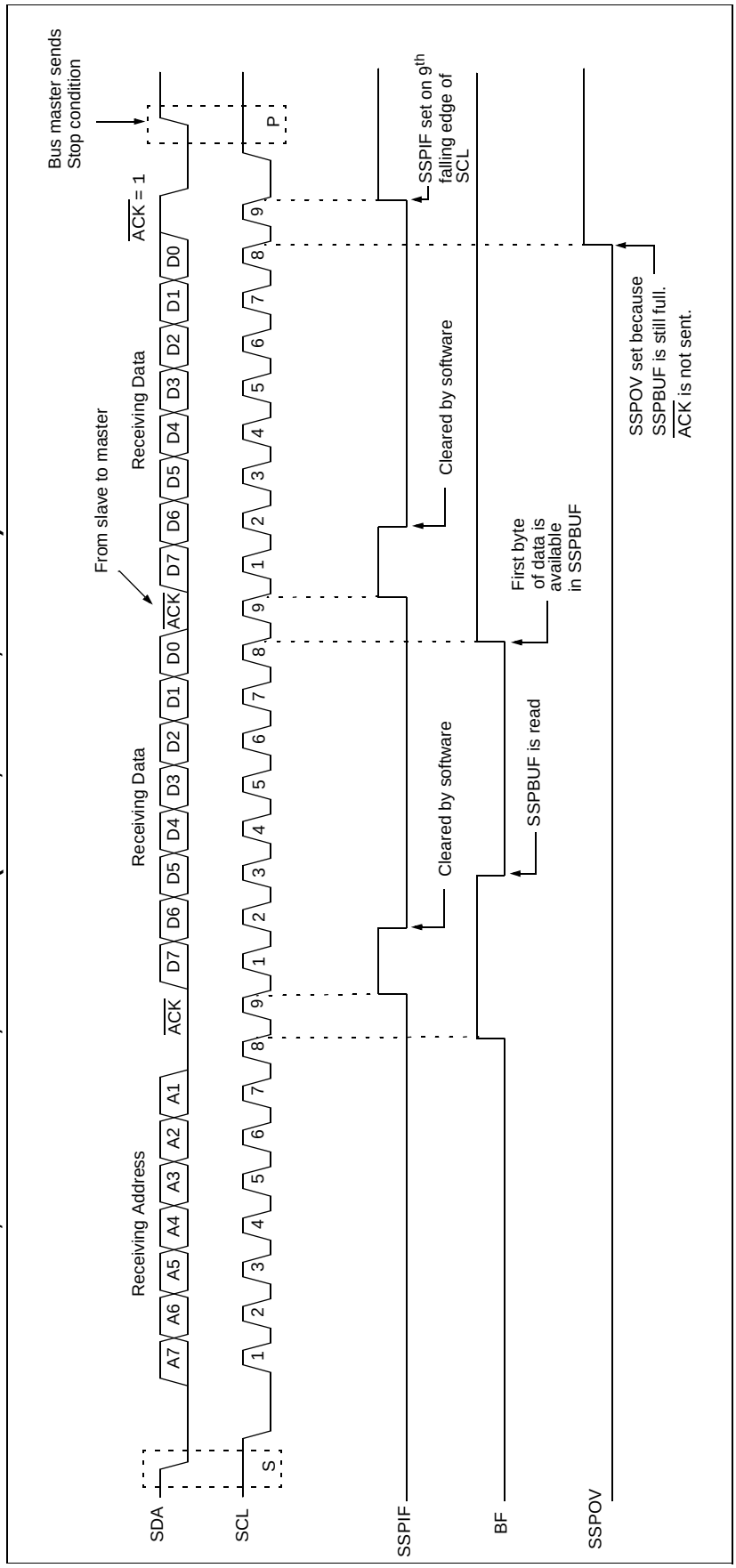


FIGURE 27-6: I²C SLAVE, 7-BIT ADDRESS, RECEPTION (SEN = 0, AHEN = 0, DHEN = 0)

FIGURE 27-7: I²C SLAVE, 7-BIT ADDRESS, RECEPTION (SEN = 1, AHEN = 0, DHEN = 0)

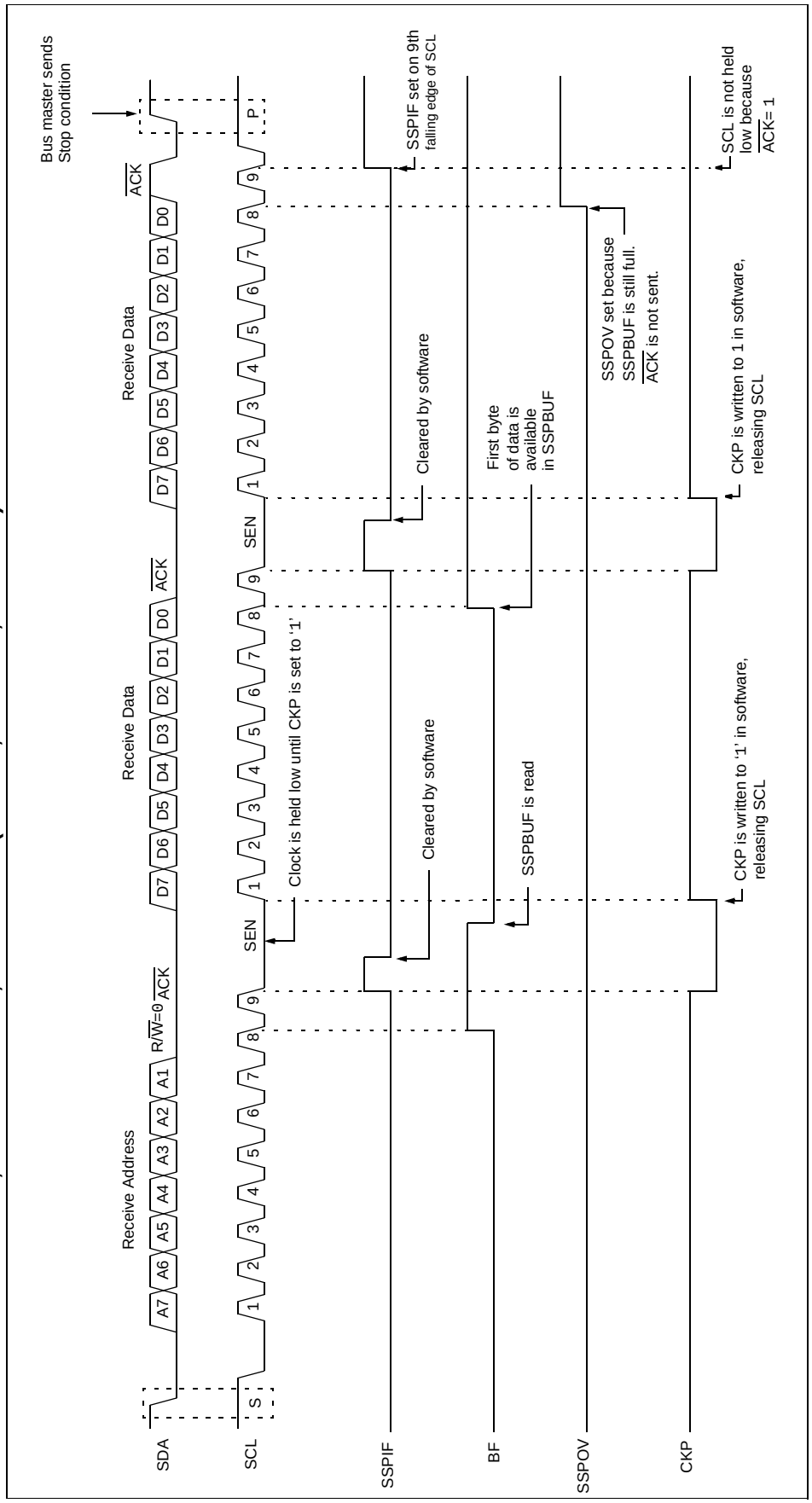


FIGURE 27-8: I²C SLAVE, 7-BIT ADDRESS, RECEPTION (SEN = 0, AHEN = 1, DHEN = 1)

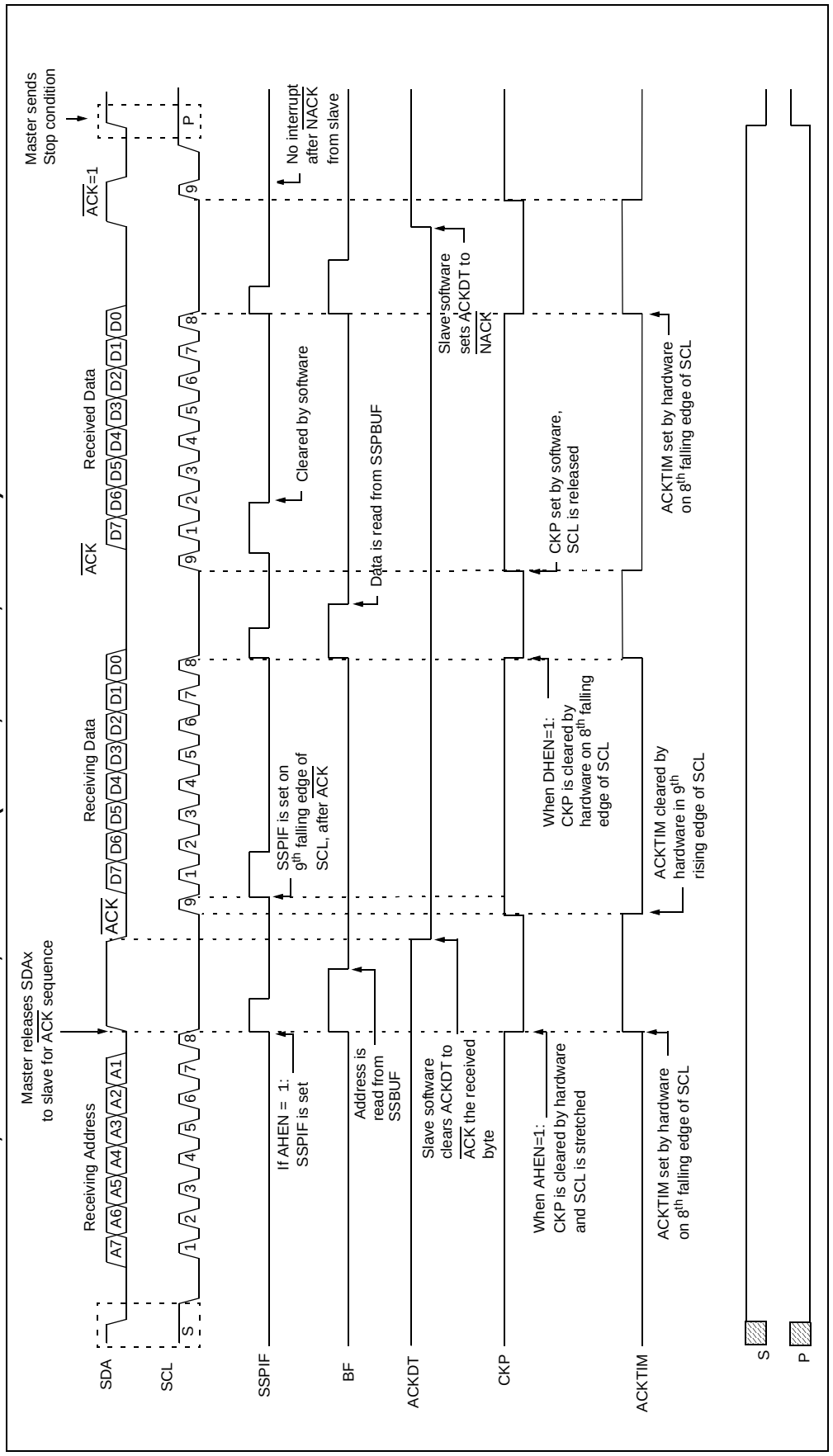
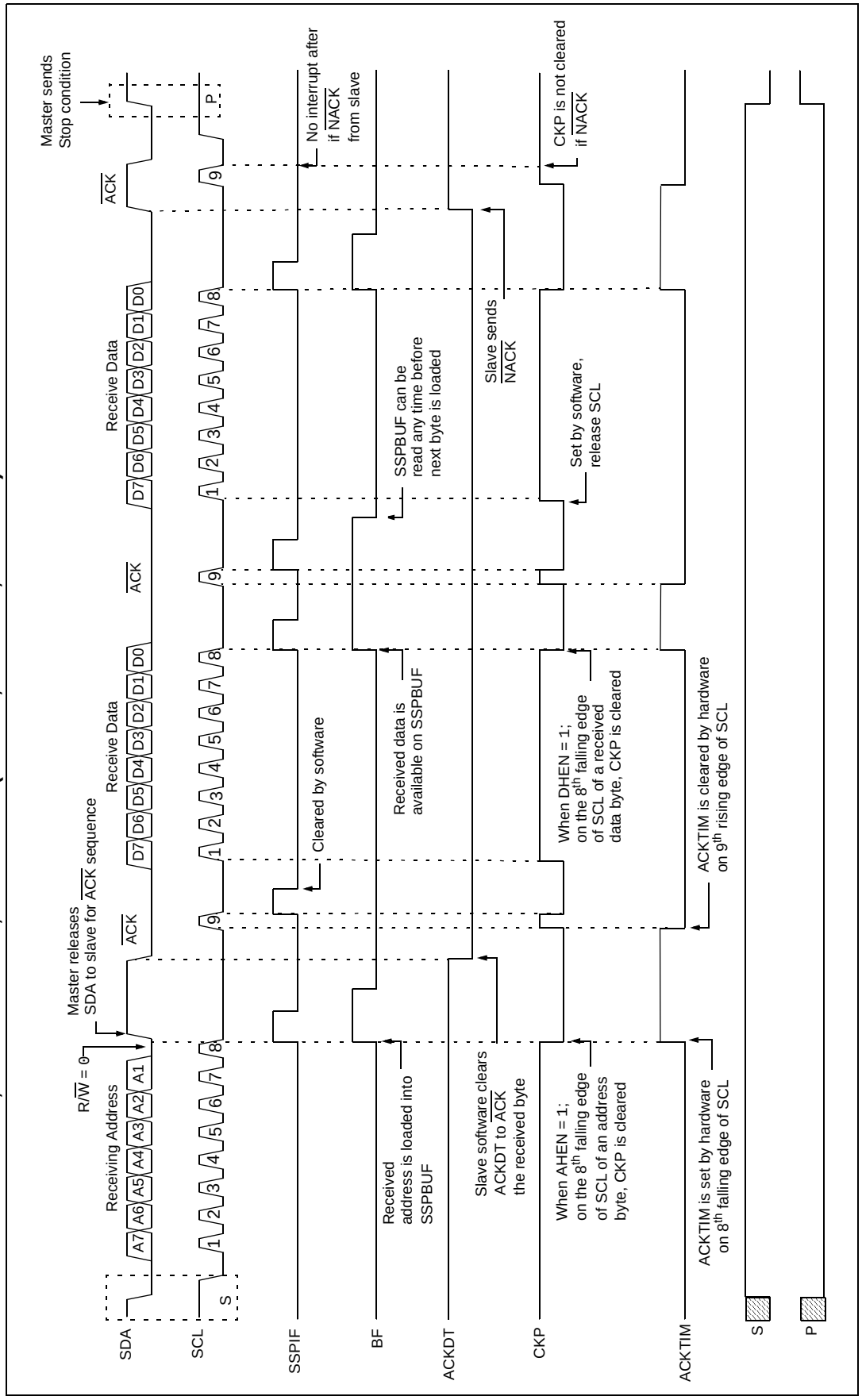


FIGURE 27-9: I²C SLAVE, 7-BIT ADDRESS, RECEPTION (SEN = 1, AHEN = 1, DHEN = 1)



27.4.4 SLAVE TRANSMISSION

When the R/$\overline{W}$ bit of the incoming address byte is set and an address match occurs, the SSPSTAT<R/$\overline{W}$> bit is set. The received address is loaded into the SSPBUF register and an $\overline{ACK}$ pulse is sent by the slave on the 9th bit.

Following the $\overline{ACK}$, slave hardware clears the CKP bit and the SCL pin is held low (see **Section 27.4.7 "Clock Stretching"** for more details). By stretching the clock, the master will be unable to assert another clock pulse until the slave is done preparing the transmit data.

The transmit data must be loaded into the SSPBUF register which also loads the SSPSR register. Then the SCL pin should be released by setting the SSPCON1<CKP> bit. The eight data bits are shifted out on the falling edge of the SCL input. This ensures that the SDA signal is valid during the SCL high time.

The $\overline{ACK}$ pulse from the master-receiver is latched on the rising edge of the 9th SCL input pulse. This $\overline{ACK}$ value is copied to the SSPCON2<ACKSTAT> bit. If ACKSTAT is set ($\overline{NACK}$), then the data transfer is complete. In this case, when the $\overline{NACK}$ is latched by the slave, the slave goes Idle and waits for another occurrence of the Start bit. If the SDA line was low ($\overline{ACK}$), the next transmit data must be loaded into the SSPBUF register. Again, the SCL pin must be released by setting the CKP bit.

An MSSP interrupt is generated for each data transfer byte. The SSPIF bit must be cleared by software and the SSPSTAT register is used to determine the status of the byte. The SSPIF bit is set on the falling edge of the 9th clock pulse.

27.4.4.1 Slave Mode Bus Collision

A slave receives a Read request and begins shifting data out on the SDA line. If a bus collision is detected and the SSPCON3<SBCDE> bit is set, the PIR<BCLIF> bit is set. Once a bus collision is detected, the slave goes Idle and waits to be addressed again. User software can use the BCLIF bit to handle a slave bus collision.

27.4.4.2 7-Bit Transmission

A master device can transmit a read request to a slave and then clock data out of the slave. The list below outlines what software for a slave will need to do to accomplish a standard transmission. Figure 27-10 can be used as a reference to this list.

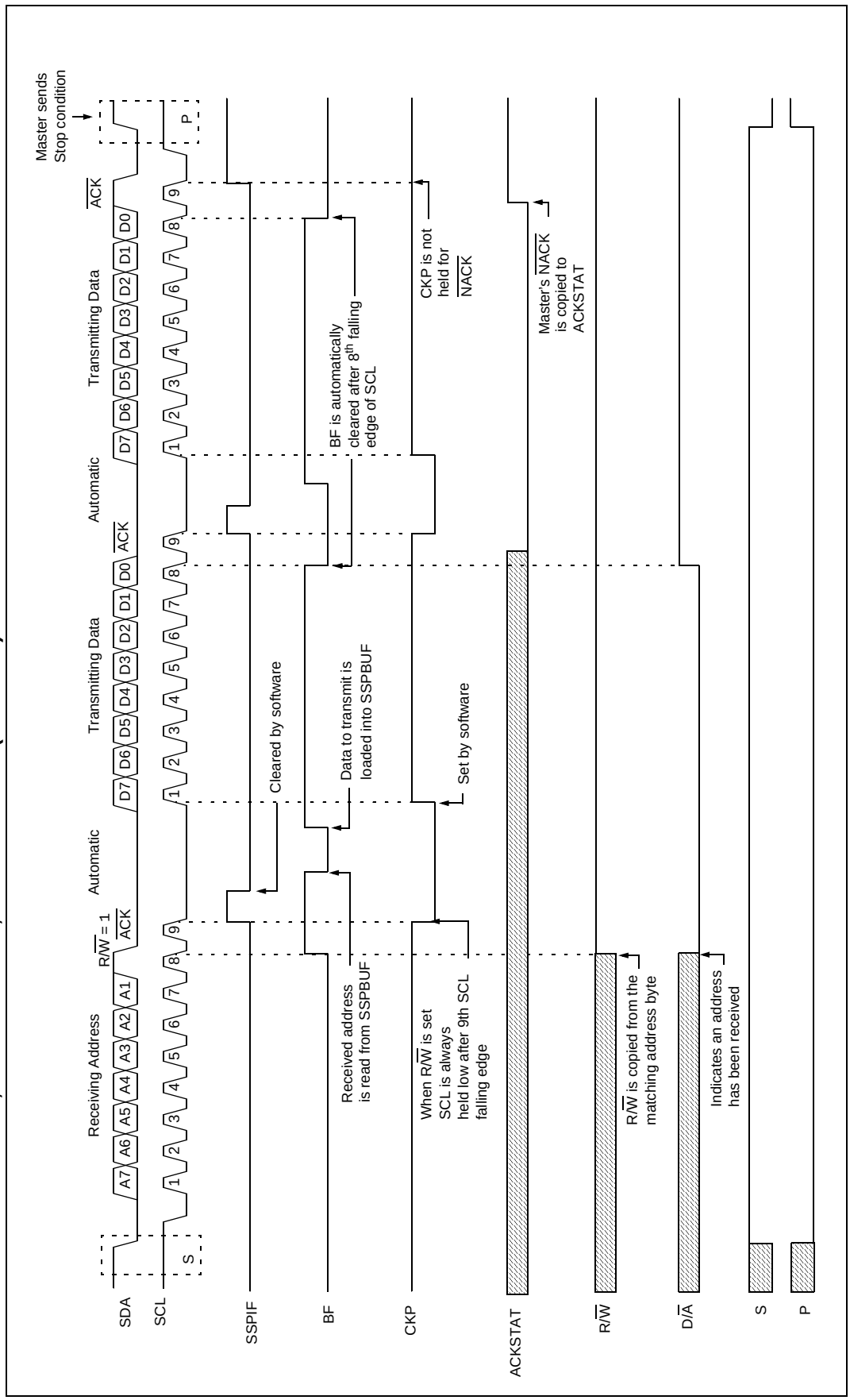
1. Master sends a Start condition on SDA and SCL.
2. SSPSTAT<S> bit is set; SSPIF is set if Interrupt-on-Start detect is enabled.
3. Matching address with R/$\overline{W}$ bit set is received by the slave setting SSPIF bit.
4. Slave hardware generates an $\overline{ACK}$ and sets SSPIF.
5. SSPIF bit is cleared by user.
6. Software reads the received address from SSPBUF, clearing BF.
7. R/$\overline{W}$ is set so CKP was automatically cleared after the $\overline{ACK}$.
8. The slave software loads the transmit data into SSPBUF.
9. CKP bit is set releasing SCL, allowing the master to clock the data out of the slave.
10. SSPIF is set after the $\overline{ACK}$ response from the master is loaded into the ACKSTAT register.
11. SSPIF bit is cleared.
12. The slave software checks the ACKSTAT bit to see if the master wants to clock out more data.

Note 1: If the master $\overline{ACK}$s, the clock will be stretched.

2: ACKSTAT is the only bit updated on the rising edge of SCL (9th) rather than the falling.

13. Steps 9-13 are repeated for each transmitted byte.
14. If the master sends a $\overline{NACK}$, the clock is not held, but SSPIF is still set.
15. The master sends a Restart condition or a Stop.
16. The slave is no longer addressed.

FIGURE 27-10: I²C SLAVE, 7-BIT ADDRESS, TRANSMISSION (AHEN = 0)



27.4.4.3 7-Bit Transmission with Address Hold Enabled

Setting the SSPCON3<AHEN> bit enables additional clock stretching and interrupt generation after the 8th falling edge of a received matching address. Once a matching address has been clocked in, CKP is cleared and the SSPIF interrupt is set.

Figure 27-11 displays a standard waveform of a 7-bit Address Slave Transmission with AHEN enabled.

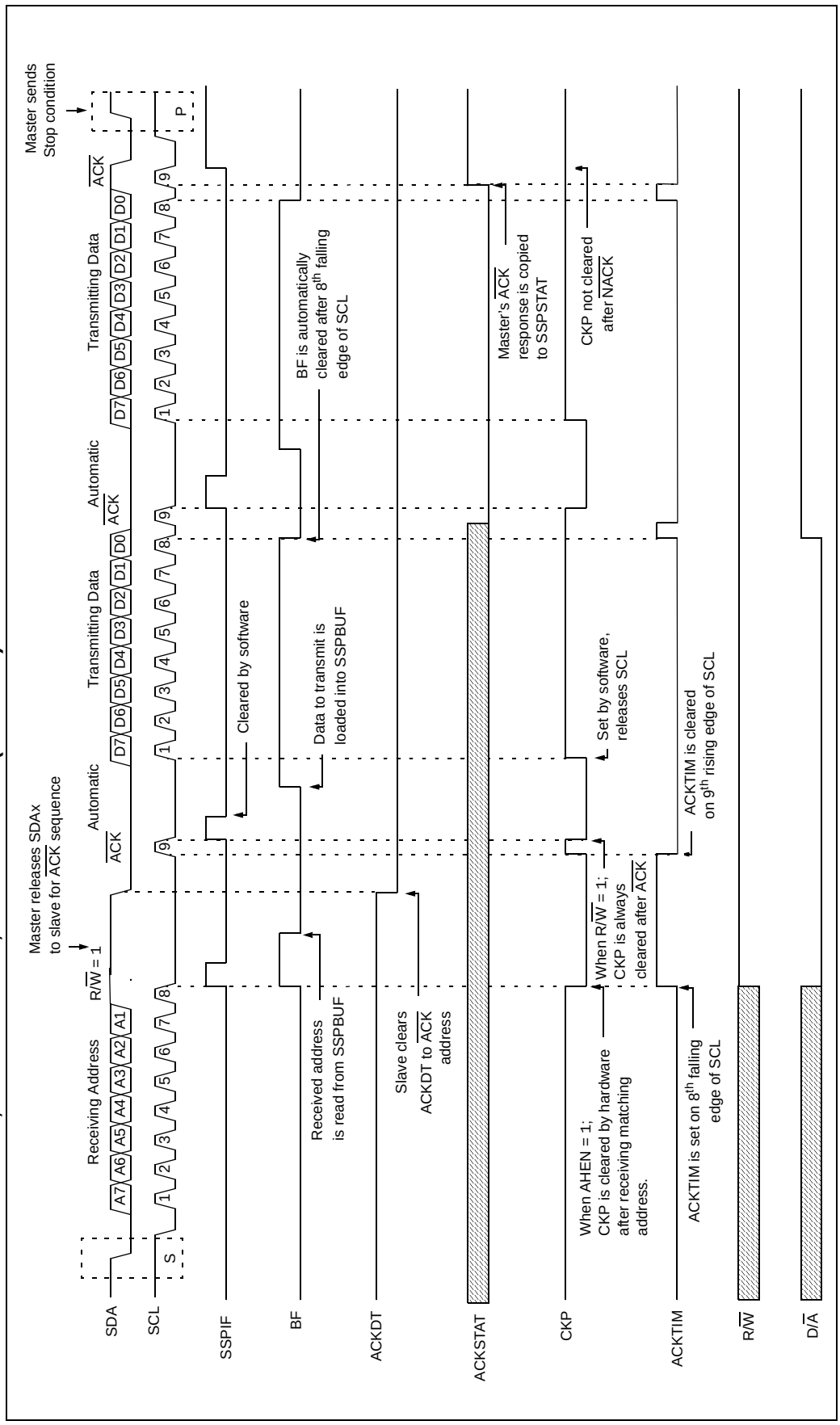
1. Bus starts Idle.
2. Master sends Start condition; the SSPSTAT<S> bit is set; SSPIF is set if Interrupt-on-Start detect is enabled.
3. Master sends matching address with R/$\overline{W}$ bit set. After the 8th falling edge of the SCL line, the CKP bit is cleared and SSPIF interrupt is generated.
4. Slave software clears SSPIF.
5. Slave software reads SSPCON3<ACKTIM> bit and SSPSTAT<R/$\overline{W}$> and SSPSTAT<D/$\overline{A}$> bits to determine the source of the interrupt.
6. Slave reads the address value from the SSPBUF register clearing the BF bit.
7. Slave software decides from this information if it wishes to $\overline{ACK}$ or $\overline{NACK}$ and sets SSPCON2<ACKDT> bit accordingly.
8. Slave sets the CKP bit releasing SCL.
9. Master clocks in the $\overline{ACK}$ value from the slave.
10. Slave hardware automatically clears the CKP bit and sets SSPIF after the $\overline{ACK}$ if the R/$\overline{W}$ bit is set.
11. Slave software clears SSPIF.
12. Slave loads value to transmit to the master into SSPBUF setting the BF bit.

Note: SSPBUF cannot be loaded until after the $\overline{ACK}$.

13. Slave sets CKP bit releasing the clock.
14. Master clocks out the data from the slave and sends an $\overline{ACK}$ value on the 9th SCL pulse.
15. Slave hardware copies the $\overline{ACK}$ value into the SSPCON2<ACKSTAT> bit.
16. Steps 10–15 are repeated for each byte transmitted to the master from the slave.
17. If the master sends a $\overline{NACK}$, the slave releases the bus, allowing the master to send a Stop and end the communication.

Note: Master must send a $\overline{NACK}$ on the last byte to ensure that the slave releases the SCL line to receive a Stop.

FIGURE 27-11: I²C SLAVE, 7-BIT ADDRESS, TRANSMISSION (AHEN = 1)



27.4.5 SLAVE MODE 10-BIT ADDRESS RECEPTION

This section describes a standard sequence of events for the MSSP module configured as an I^2C slave in 10-bit Addressing mode.

Figure 27-12 is used as a visual reference for this description.

This is a step-by-step process of what must be done by slave software to accomplish I^2C communication.

1. Bus starts Idle.
2. Master sends Start condition; SSPSTAT<S> bit is set; SSPIF is set if Interrupt-on-Start detect is enabled.
3. Master sends matching high address with R/$\overline{W}$ bit clear; SSPSTAT<UA> bit is set.
4. Slave sends $\overline{ACK}$ and SSPIF is set.
5. Software clears the SSPIF bit.
6. Software reads received address from SSPBUF, clearing the BF flag.
7. Slave loads low address into SSPADDx, releasing SCL.
8. Master sends matching low-address byte to the slave; UA bit is set.

Note:	Updates to the SSPADDx register are not allowed until after the $\overline{ACK}$ sequence.

9. Slave sends $\overline{ACK}$ and SSPIF is set.

Note:	If the low address does not match, SSPIF and UA are still set so that the slave software can set SSPADDx back to the high address. BF is not set because there is no match. CKP is unaffected.

10. Slave clears SSPIF.
11. Slave reads the received matching address from SSPBUF clearing BF.
12. Slave loads high address into SSPADD.
13. Master clocks a data byte to the slave and clocks out the slave's $\overline{ACK}$ on the 9th SCL pulse; SSPIF is set.
14. If SSPCON2<SEN> bit is set, CKP is cleared by hardware and the clock is stretched.
15. Slave clears SSPIF.
16. Slave reads the received byte from SSPBUF clearing BF.
17. If SEN is set, the slave sets CKP to release the SCL.
18. Steps 13–17 repeat for each received byte.
19. Master sends Stop to end the transmission.

27.4.6 10-BIT ADDRESSING WITH ADDRESS OR DATA HOLD

Reception using 10-bit addressing with AHEN or DHEN set is the same as with 7-bit modes. The only difference is the need to update the SSPADDx register using the UA bit. All functionality, specifically when the CKP bit is cleared and the SCL line is held low, are the same. Figure 27-13 can be used as a reference of a slave in 10-bit addressing with AHEN set.

Figure 27-14 shows a standard waveform for a slave transmitter in 10-bit Addressing mode.

FIGURE 27-12: I²C SLAVE, 10-BIT ADDRESS, RECEPTION (SEN = 1, AHEN = 0, DHEN = 0)

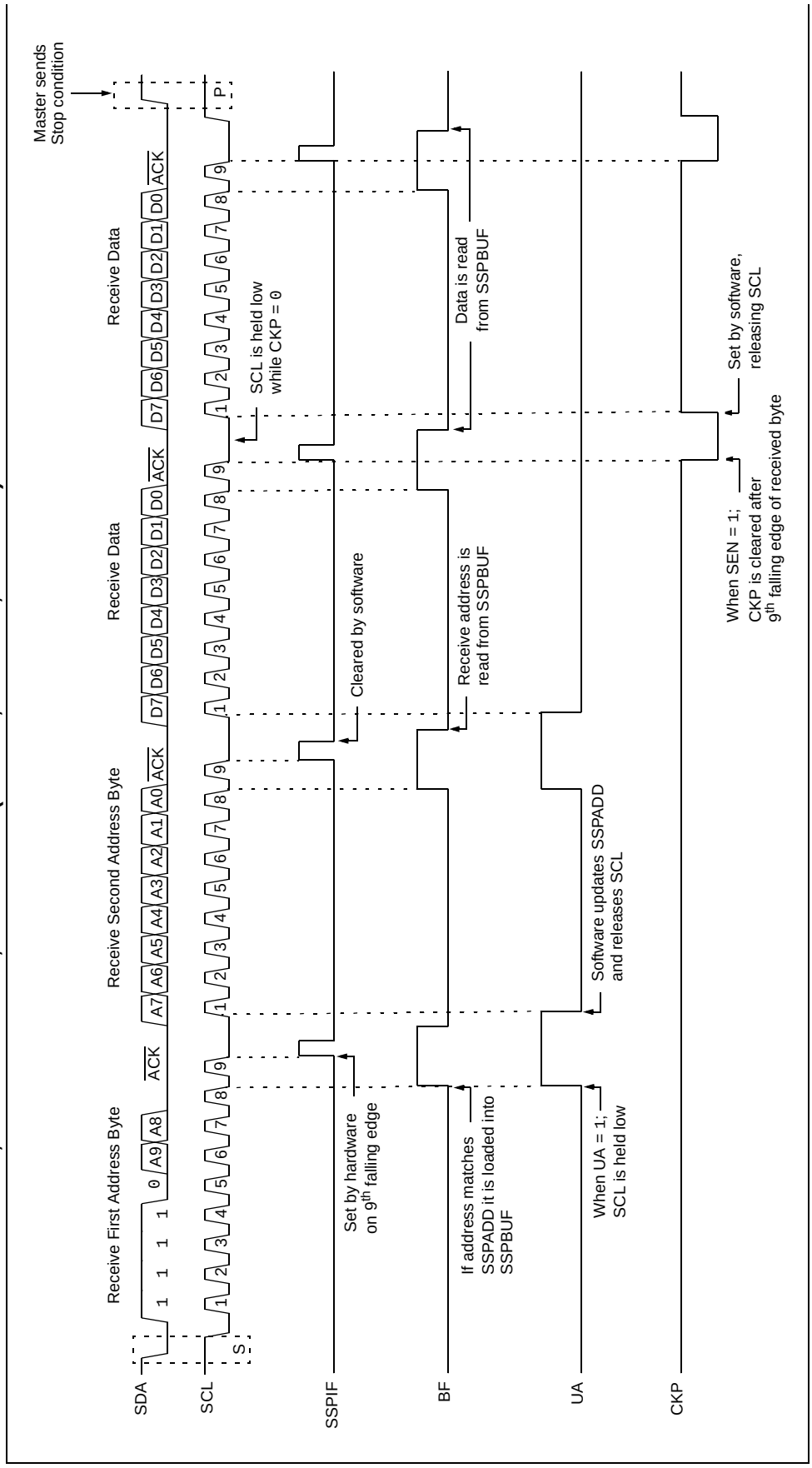


FIGURE 27-13: I²C SLAVE, 10-BIT ADDRESS, RECEPTION (SEN = 0, AHEN = 1, DHEN = 0)

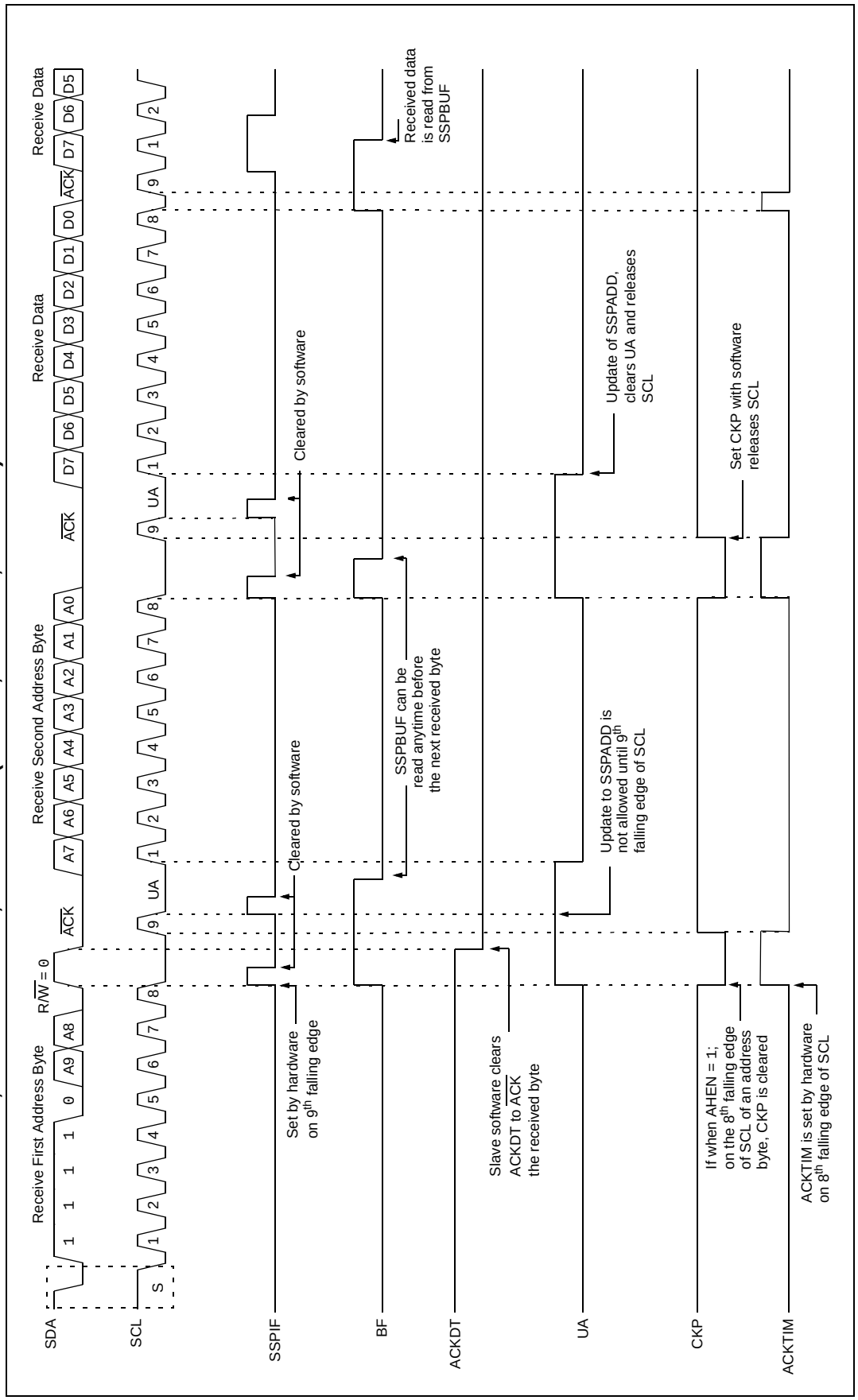
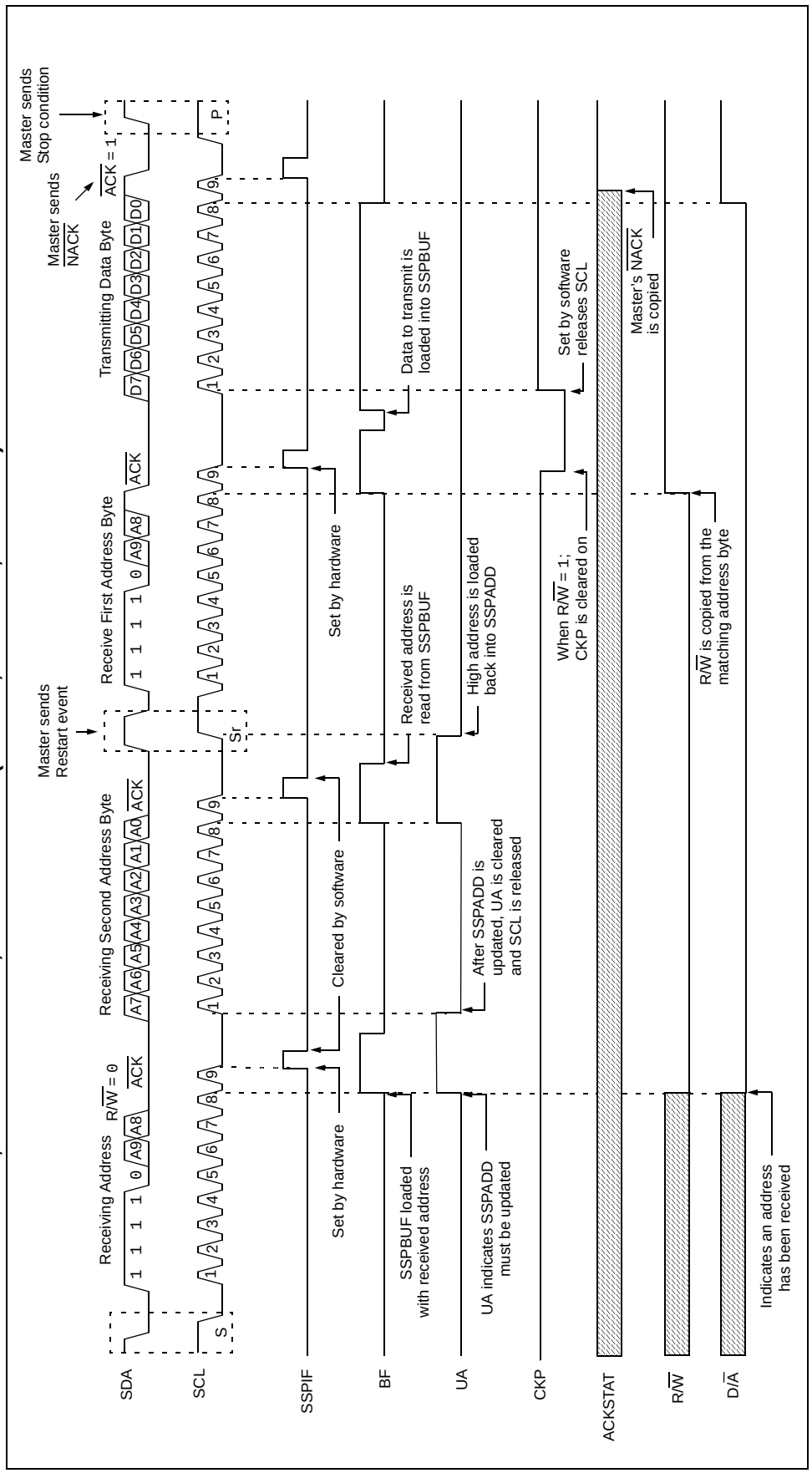


FIGURE 27-14: I²C SLAVE, 10-BIT ADDRESS, TRANSMISSION (SEN = 0, AHEN = 0, DHEN = 0)



27.4.7 CLOCK STRETCHING

Clock stretching occurs when a device on the bus holds the SCL line low, effectively pausing communication. The slave may stretch the clock to allow more time to handle data or prepare a response for the master device. A master device is not concerned with stretching, as anytime it is active on the bus and not transferring data it is stretching. Any stretching done by a slave is invisible to the master software and handled by the hardware that generates SCL.

The SSPCON1<CKP> bit is used to control stretching in software. Any time the CKP bit is cleared, the module will wait for the SCL line to go low and then hold it. Setting CKP will release SCL and allow more communication.

27.4.7.1 Normal Clock Stretching

Following an $\overline{ACK}$, if the SSPSTAT<R/$\overline{W}$> bit is set, causing a read request, the slave hardware will clear CKP. This allows the slave time to update SSPBUF with data to transfer to the master. If the SSPCON2<SEN> bit is set, the slave hardware will always stretch the clock after the $\overline{ACK}$ sequence. Once the slave is ready, CKP is set by software and communication resumes.

Note 1: The BF bit has no effect on whether the clock will be stretched or not. This is different than previous versions of the module that would not stretch the clock or clear CKP, if SSPBUF was read before the 9th falling edge of SCL.

2: Previous versions of the module did not stretch the clock for a transmission if SSPBUF was loaded before the 9th falling edge of SCL. It is now always cleared for read requests.

27.4.7.2 10-Bit Addressing Mode

In 10-bit Addressing mode, when the UA bit is set, the clock is always stretched. This is the only time the SCL is stretched without CKP being cleared. SCL is released immediately after a write to SSPADDx.

Note: Previous versions of the module did not stretch the clock if the second address byte did not match.

27.4.7.3 Byte NACKing

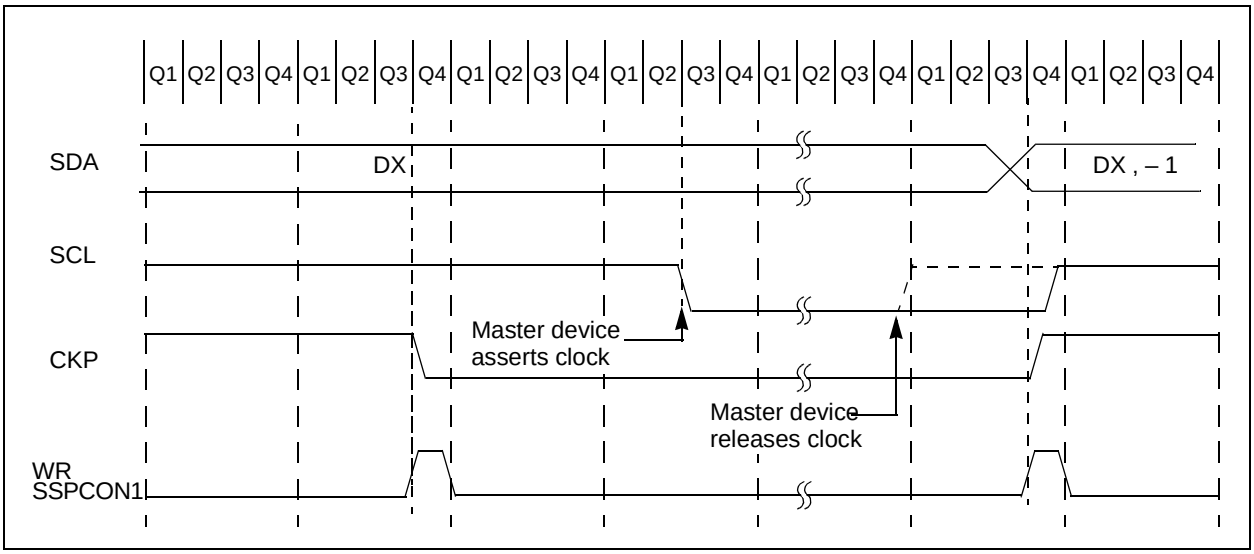
When SSPCON3<AHEN> bit is set, CKP is cleared by the hardware after the 8th falling edge of SCL for a received matching address byte. When SSPCON3<DHEN> bit is set, CKP is cleared after the 8th falling edge of SCL for received data.

Stretching after the 8th falling edge of SCL allows the slave to look at the received address or data and decide if it wants to ACK the received data.

27.4.8 CLOCK SYNCHRONIZATION AND THE CKP BIT

Any time the CKP bit is cleared, the module will wait for the SCL line to go low and then hold it. However, clearing the CKP bit will not assert the SCL output low until the SCL output is already sampled low. Therefore, the CKP bit will not assert the SCL line until an external I^2C master device has already asserted the SCL line. The SCL output will remain low until the CKP bit is set and all other devices on the I^2C bus have released SCL. This ensures that a write to the CKP bit will not violate the minimum high time requirement for SCL (see Figure 27-15).

FIGURE 27-15: CLOCK SYNCHRONIZATION TIMING



27.4.9 GENERAL CALL ADDRESS SUPPORT

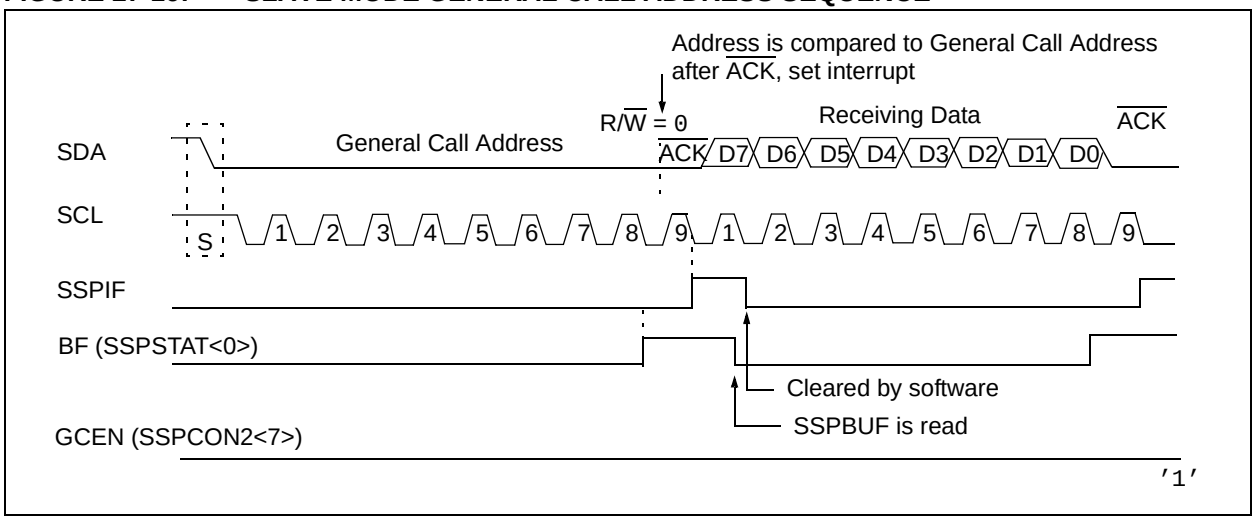
The addressing procedure for the I²C bus is such that the first byte after the Start condition usually determines which device will be the slave addressed by the master device. The exception is the general call address, which can address all devices. When this address is used, all devices will, in theory, respond with an acknowledge.

The general call address is a reserved address in the I²C protocol, defined as address 0x00. When the SSPCON2<GCEN> bit is set, the slave module will automatically ACK the reception of this address, regardless of the value stored in SSPADDx. After the slave clocks in an address of all zeros with the R/W bit clear, an interrupt is generated and slave software can read SSPBUF and respond. Figure 27-16 shows a general call reception sequence.

In 10-bit Address mode, the UA bit will not be set on the reception of the general call address. The slave will prepare to receive the second byte as data, just as it would in the 7-bit mode.

If the SSPCON3<AHEN> bit register is set, just as with any other address reception, the slave hardware will stretch the clock after the 8th falling edge of SCL. The slave must then set its ACKDT value and release the clock with communication progressing as it would normally.

FIGURE 27-16: SLAVE MODE GENERAL CALL ADDRESS SEQUENCE



27.4.10 SSPMSKX REGISTER

An SSP Mask (SSPMSKx) register (Registers 27-6 and 27-8) is available in I²C Slave mode as a mask for the value held in the SSPSRx register during an address comparison operation. A zero ('0') bit in the SSPMSKx register has the effect of making the corresponding bit of the received address a "don't care".

This register is reset to all '1's upon any Reset condition and, therefore, has no effect on standard SSP operation until written with a mask value.

The SSP Mask register is active during:

- 7-bit Address mode: address compare of A<7:1>
- 10-bit Address mode: address compare of A<7:0> only. The SSP mask has no effect during the reception of the first (high) byte of the address

27.5 I²C Master Mode

Master mode is enabled by setting and clearing the appropriate SSPCON1<SSPM> bits and by setting the SSPEN bit. In Master mode, the SDA and SCK pins must be configured as inputs. The MSSP peripheral hardware will override the output driver TRIS controls when necessary, to drive the pins low.

Master mode of operation is supported by interrupt generation on the detection of the Start and Stop conditions. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit is set or the bus is Idle.

In Firmware Controlled Master mode, user code conducts all I²C bus operations based on Start and Stop bit condition detection. Start and Stop condition detection is the only active circuitry in this mode. All other communication is done by the user software directly manipulating the SDA and SCL lines.

The following events will cause the SSP Interrupt Flag bit, SSPIF, to be set (SSP interrupt, if enabled):

- Start condition detected
- Stop condition detected
- Data transfer byte transmitted/received
- Acknowledge transmitted/received
- Repeated Start generated

Note 1: The MSSP module, when configured in I²C Master mode, does not allow queuing of events. For instance, the user is not allowed to initiate a Start condition and immediately write the SSPBUF register to initiate transmission before the Start condition is complete. In this case, the SSPBUF will not be written to and the WCOL bit will be set, indicating that a write to the SSPBUF did not occur.

2: When in Master mode, Start/Stop detection is masked and an interrupt is generated when the SEN/PEN bit is cleared and the generation is complete.

27.5.1 I²C MASTER MODE OPERATION

The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I²C bus will not be released.

In Master Transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the Read/Write (R/$\overline{W}$) bit. In this case, the R/$\overline{W}$ bit will be logic '0'. Serial data is transmitted eight bits at a time. After each byte is transmitted, an Acknowledge bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

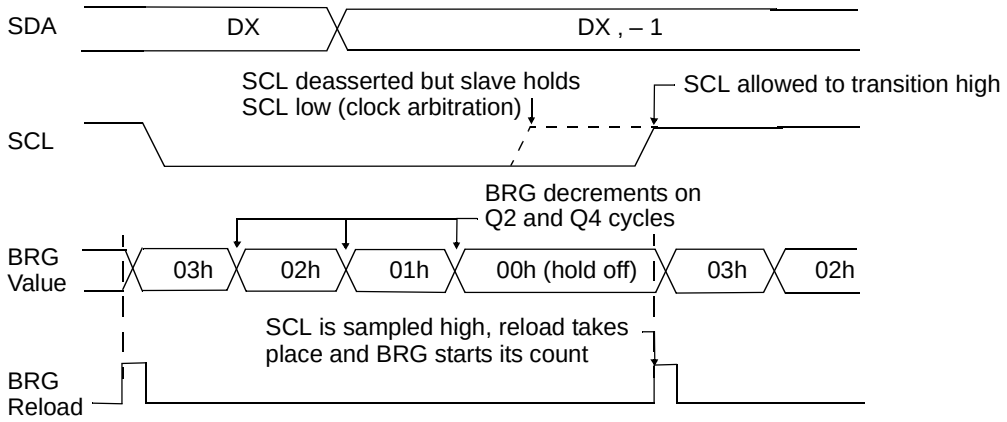
In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/$\overline{W}$ bit. In this case, the R/$\overline{W}$ bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address followed by a '1' to indicate the receive bit. Serial data is received via SDA, while SCL outputs the serial clock. Serial data is received eight bits at a time. After each byte is received, an Acknowledge bit is transmitted. Start and Stop conditions indicate the beginning and the end of transmission.

A Baud Rate Generator is used to set the clock frequency output on SCL. See **Section 27.6 "Baud Rate Generator"** for more details.

27.5.2 CLOCK ARBITRATION

Clock arbitration occurs when the master, during any receive, transmit or Repeated Start/Stop condition, releases the SCL pin (SCL allowed to float high). When the SCL pin is allowed to float high, the Baud Rate Generator (BRG) is suspended from counting until the SCL pin is actually sampled high. When the SCL pin is sampled high, the Baud Rate Generator is reloaded with the contents of SSPADD<7:0> and begins counting. This ensures that the SCL high time will always be at least one BRG rollover count in the event that the clock is held low by an external device (Figure 27-17).

FIGURE 27-17: BAUD RATE GENERATOR TIMING WITH CLOCK ARBITRATION



27.5.3 WCOL STATUS FLAG

If the user writes the SSPBUF when a Start, Restart, Stop, Receive or Transmit sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write does not occur). Any time the WCOL bit is set, it indicates that an action on SSPBUF was attempted while the module was not Idle.

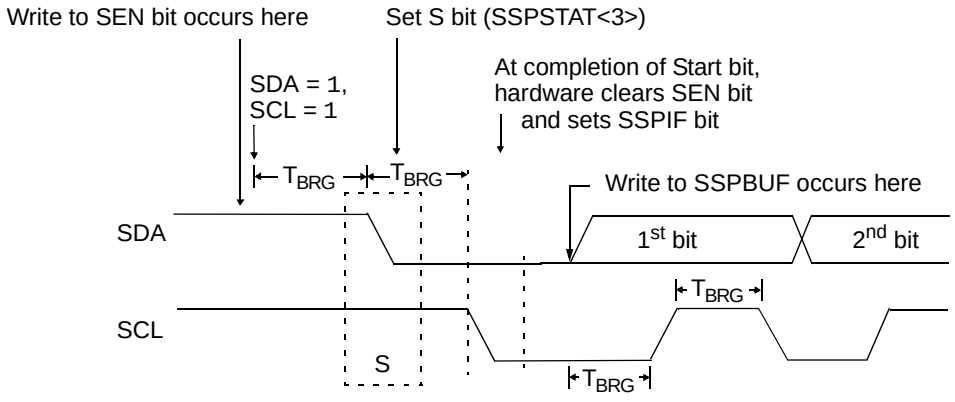
Note:	Because queuing of events is not allowed, writing to the lower five bits in the SSPCON2 register is disabled until the Start condition is complete.

27.5.4 I^2C MASTER MODE START CONDITION TIMING

To initiate a Start condition, the user sets the Start Enable (SEN) bit in the SSPCON2 register. If the SDA and SCL pins are sampled high, the Baud Rate Generator is reloaded with the contents of SSPADD<7:0> and starts its count. If SCL and SDA are both sampled high when the Baud Rate Generator times out (T_{BRG}), the SDA pin is driven low. The action of the SDA being driven low while SCL is high is the Start condition and causes the SSPSTAT<S> bit to be set. Following this, the Baud Rate Generator is reloaded with the contents of SSPADD<7:0> and resumes its count. When the Baud Rate Generator times out (T_{BRG}), the SSPCON2<SEN> bit will be automatically cleared by hardware; the Baud Rate Generator is suspended, leaving the SDA line held low and the Start condition is complete.

Note 1:	If at the beginning of the Start condition the SDA and SCL pins are already sampled low, or if during the Start condition the SCL line is sampled low before the SDA line is driven low, a bus collision occurs, the Bus Collision Interrupt Flag, BCLIF, is set, the Start condition is aborted and the I^2C module is reset into its Idle state.
2:	The Philips I^2C Specification states that a bus collision cannot occur on a Start.

FIGURE 27-18: FIRST START BIT TIMING



27.5.5 I²C MASTER MODE REPEATED START CONDITION TIMING

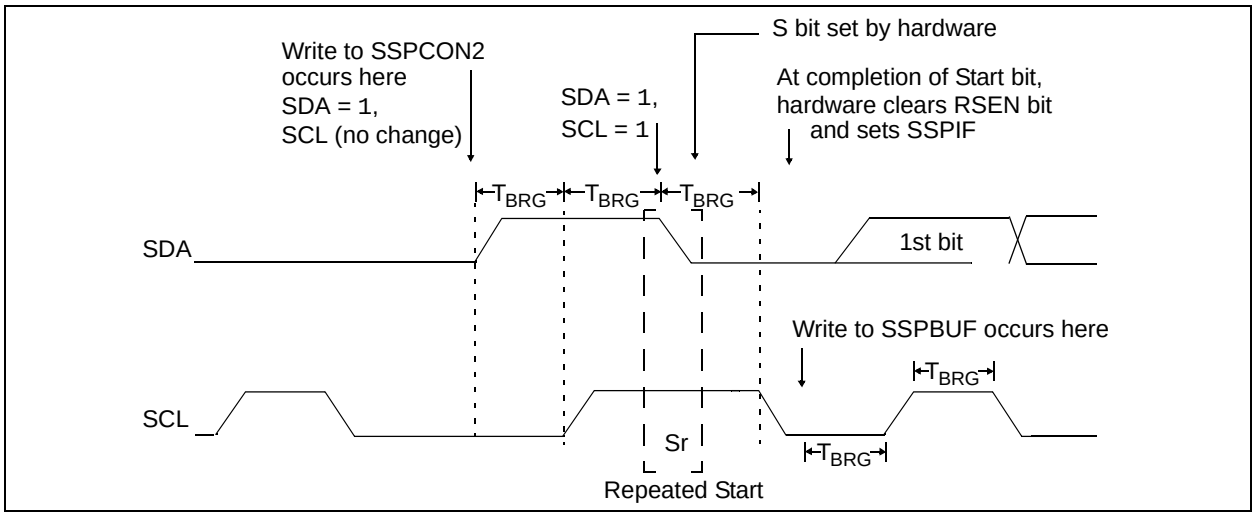
A Repeated Start condition occurs when the SSPCON2<RSEN> bit is programmed high and the master state machine is no longer active. When the RSEN bit is set, the SCL pin is asserted low. When the SCL pin is sampled low, the Baud Rate Generator is loaded and begins counting. The SDA pin is released (brought high) for one Baud Rate Generator count (T_{BRG}). When the Baud Rate Generator times out, if SDA is sampled high, the SCL pin will be deasserted (brought high). When SCL is sampled high, the Baud Rate Generator is reloaded and begins counting. SDA and SCL must be sampled high for one T_{BRG}. This action is then followed by the assertion of the SDA pin (SDA = 0) for one T_{BRG} while SCL is high. SCL is asserted low. Following this, the SSPCON2<RSEN> bit will be automatically cleared and the Baud Rate Generator will not be reloaded, leaving the SDA pin held low. As soon as a Start condition is detected on the SDA and SCL pins, the SSPSTAT<S> bit will be set. The SSPIF bit will not be set until the Baud Rate Generator has timed out.

Note 1: If RSEN is programmed while any other event is in progress, it will not take effect.

2: A bus collision during the Repeated Start condition occurs if:

- SDA is sampled low when SCL goes from low-to-high.
- SCL goes low before SDA is asserted low. This may indicate that another master is attempting to transmit a data '1'.

FIGURE 27-19: REPEAT START CONDITION WAVEFORM



27.5.6 I²C MASTER MODE TRANSMISSION

Transmission of a data byte, a 7-bit address or the other half of a 10-bit address is accomplished by simply writing a value to the SSPBUF register. This action will set the Buffer Full (BF) flag bit and will allow the Baud Rate Generator to begin counting and start the next transmission. Each bit of address/data will be shifted out onto the SDA pin after the falling edge of SCL is asserted. SCL is held low for one Baud Rate Generator rollover count (T_{BRG}). Data should be valid before SCL is released high. When the SCL pin is released high, it is held that way for T_{BRG}. The data on the SDA pin must remain stable for that duration and some hold time after the next falling edge of SCL. After the 8th bit is shifted out (the falling edge of the 8th clock), the BF flag is cleared and the master releases the SDA. This allows the slave device being addressed to respond with an $\overline{ACK}$ bit during the 9th bit time if an address match occurred or if data was received properly. The status of $\overline{ACK}$ is written into the ACKSTAT bit on the rising edge of the 9th clock. If the master receives an Acknowledge, the Acknowledge Status (ACKSTAT) bit is cleared. If not, the bit is set. After the 9th clock, the SSPIF bit is set and the master clock (Baud Rate Generator) is suspended until the next data byte is loaded into the SSPBUF, leaving SCL low and SDA unchanged (Figure 27-20).

After the write to the SSPBUF, each bit of the address will be shifted out on the falling edge of SCL until all seven address bits and the R/$\overline{W}$ bit are completed. On the falling edge of the 8th clock, the master will release the SDA pin, allowing the slave to respond with an Acknowledge. On the falling edge of the 9th clock, the master will sample the SDA pin to see if the address was recognized by a slave. The status of the $\overline{ACK}$ bit is loaded into the SSPCON2<ACKSTAT> bit. Following the falling edge of the 9th clock transmission of the address, the SSPIF is set, the BF flag is cleared and the Baud Rate Generator is turned off until another write to the SSPBUF takes place, holding SCL low and allowing SDA to float.

27.5.6.1 BF Status Flag

In Transmit mode, the SSPSTAT<BF> bit is set when the CPU writes to SSPBUF and is cleared when all eight bits are shifted out.

27.5.6.2 WCOL Status Flag

If the user writes the SSPBUF when a transmit is already in progress (i.e., SSPSR is still shifting out a data byte), the WCOL is set and the contents of the buffer are unchanged (the write does not occur).

WCOL must be cleared by software before the next transmission.

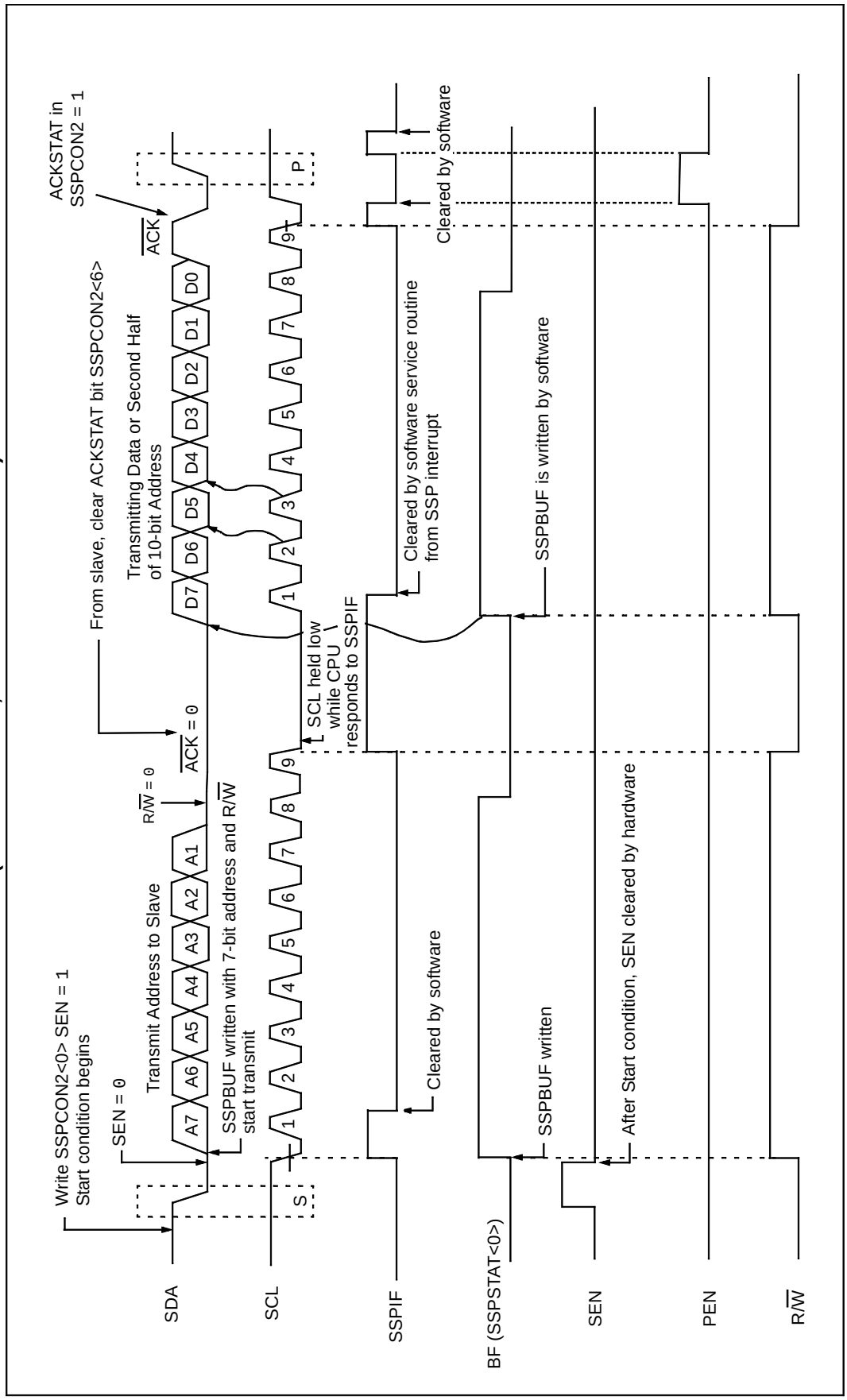
27.5.6.3 ACKSTAT Status Flag

In Transmit mode, the SSPCON2<ACKSTAT> bit is cleared when the slave has sent an Acknowledge ($\overline{ACK}$ = 0) and is set when the slave does Not Acknowledge ($\overline{ACK}$ = 1). A slave sends an Acknowledge when it has recognized its address (including a general call) or when the slave has properly received its data.

27.5.6.4 Typical Transmit Sequence

1. The user generates a Start condition by setting the SSPCON2<SEN> bit.
2. SSPIF is set by hardware on completion of the Start.
3. SSPIF is cleared by software.
4. The MSSP module will wait the required start time before any other operation takes place.
5. The user loads the SSPBUF with the slave address to transmit.
6. Address is shifted out the SDA pin until all eight bits are transmitted. Transmission begins as soon as SSPBUF is written to.
7. The MSSP module shifts in the $\overline{ACK}$ bit from the slave device and writes its value into the SSPCON2<ACKSTAT> bit.
8. The MSSP module generates an interrupt at the end of the 9th clock cycle by setting the SSPIF bit.
9. The user loads the SSPBUF with eight bits of data.
10. Data is shifted out the SDA pin until all eight bits are transmitted.
11. The MSSP module shifts in the $\overline{ACK}$ bit from the slave device and writes its value into the SSPCON2<ACKSTAT> bit.
12. Steps 8-11 are repeated for all transmitted data bytes.
13. The user generates a Stop or Restart condition by setting the SSPCON2<PEN> or SSPCON2<RSEN> bits. Interrupt is generated once the Stop/Restart condition is complete.

FIGURE 27-20: I²C MASTER MODE WAVEFORM (TRANSMISSION, 7 OR 10-BIT ADDRESS)



27.5.7 I²C MASTER MODE RECEPTION

Master mode reception is enabled by programming the Receive Enable (RCEN) bit in the SSPCON2 register.

Note: The MSSP module must be in an Idle state before the RCEN bit is set or the RCEN bit will be disregarded.

The Baud Rate Generator begins counting and on each rollover the state of the SCL pin changes (high-to-low/low-to-high) and data is shifted into the SSPSR. After the falling edge of the 8th clock, the receive enable flag is automatically cleared, the contents of the SSPSR are loaded into the SSPBUF, the BF flag bit is set, the SSPIF flag bit is set and the Baud Rate Generator is suspended from counting, holding SCL low. The MSSP is now in Idle state awaiting the next command. When the buffer is read by the CPU, the BF flag bit is automatically cleared. The user can then send an Acknowledge bit at the end of reception by setting the Acknowledge Sequence Enable (ACKEN) bit in the SSPCON2 register.

27.5.7.1 BF Status Flag

In receive operation, the BF bit is set when an address or data byte is loaded into SSPBUF from SSPSR. It is cleared when the SSPBUF register is read.

27.5.7.2 SSPOV Status Flag

In receive operation, the SSPOV bit is set when eight bits are received into the SSPSR and the BF flag bit is already set from a previous reception.

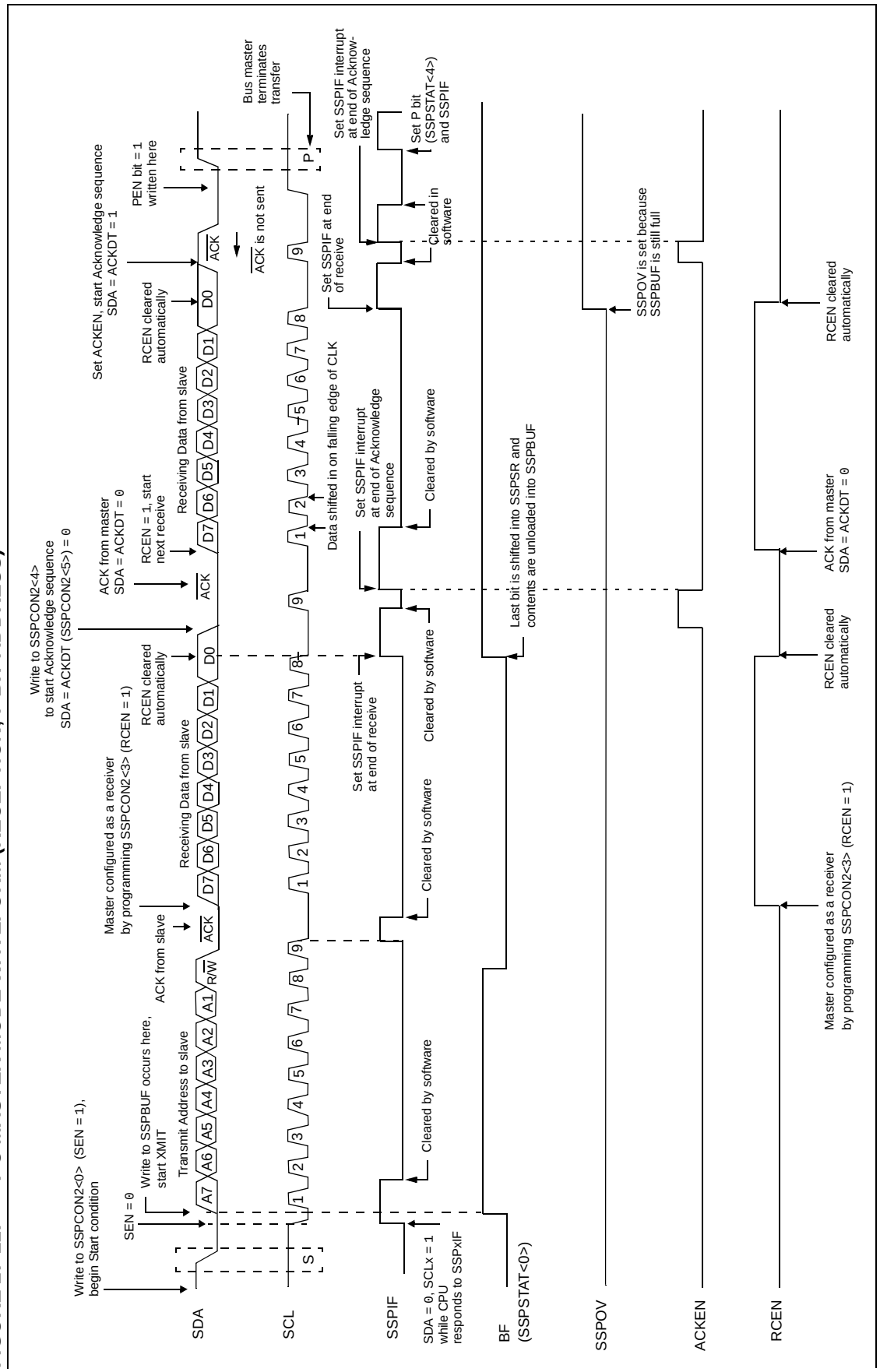
27.5.7.3 WCOL Status Flag

If the user writes the SSPBUF when a receive is already in progress (i.e., SSPSR is still shifting in a data byte), the WCOL bit is set and the contents of the buffer are unchanged (the write does not occur).

27.5.7.4 Typical Receive Sequence

1. The user generates a Start condition by setting the SSPCON2<SEN> bit.
2. SSPIF is set by hardware on completion of the Start.
3. SSPIF is cleared by software.
4. The user writes SSPBUF with the slave address to transmit and the R/$\overline{W}$ bit set.
5. Address is shifted out the SDA pin until all eight bits are transmitted. Transmission begins as soon as SSPBUF is written to.
6. The MSSP module shifts in the $\overline{ACK}$ bit from the slave device and writes its value into the SSPCON2<ACKSTAT> bit.
7. The MSSP module generates an interrupt at the end of the 9th clock cycle by setting the SSPIF bit.
8. User sets the SSPCON2<RCEN> bit and the master clocks in a byte from the slave.
9. After the 8th falling edge of SCL, SSPIF and BF are set.
10. Master clears SSPIF and reads the received byte from SSPBUF, clears BF.
11. Master sets $\overline{ACK}$ value sent to slave in SSPCON2<ACKDT> bit and initiates the $\overline{ACK}$ by setting the ACKEN bit.
12. Master's $\overline{ACK}$ is clocked out to the slave and SSPIF is set.
13. The user clears SSPIF.
14. Steps 8–13 are repeated for each received byte from the slave.
15. Master sends a $\overline{NACK}$ or Stop to end communication.

FIGURE 27-21: I²C MASTER MODE WAVEFORM (RECEPTION, 7-BIT ADDRESS)



27.5.8 ACKNOWLEDGE SEQUENCE TIMING

An Acknowledge sequence is enabled by setting the Acknowledge Sequence Enable (ACKEN) bit in the SSPCON2 register. When this bit is set, the SCL pin is pulled low and the contents of the Acknowledge data bit are presented on the SDA pin. If the user wishes to generate an Acknowledge, then the ACKDT bit should be cleared. If not, the user should set the ACKDT bit before starting an Acknowledge sequence. The Baud Rate Generator then counts for one rollover period (T_{BRG}) and the SCL pin is deasserted (pulled high). When the SCL pin is sampled high (clock arbitration), the Baud Rate Generator counts for T_{BRG}. The SCL pin is then pulled low. Following this, the ACKEN bit is automatically cleared, the Baud Rate Generator is turned off and the MSSP module then goes into Idle mode (Figure 27-22).

27.5.8.1 WCOL Status Flag

If the user writes the SSPBUF when an Acknowledge sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write does not occur).

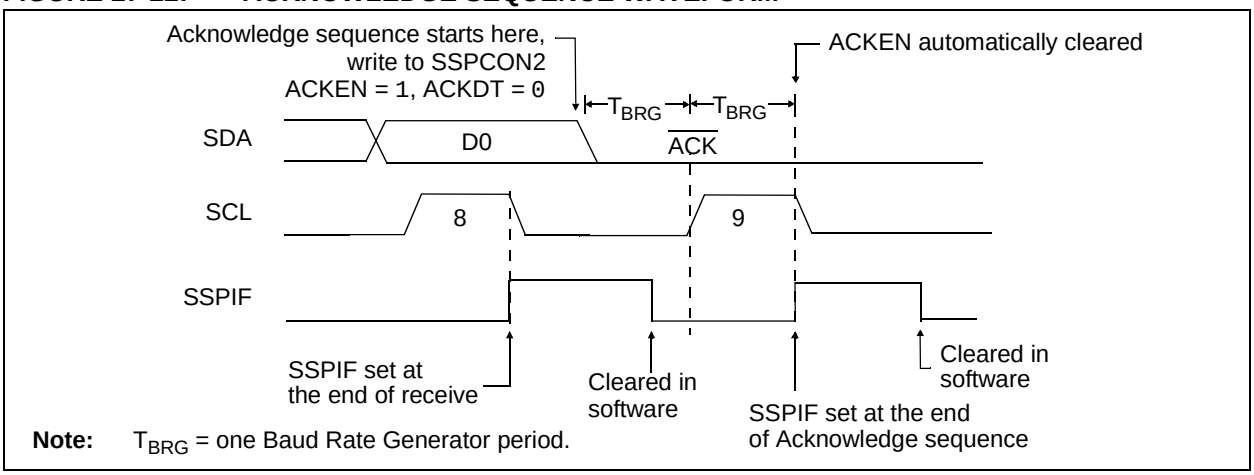
27.5.9 STOP CONDITION TIMING

A Stop bit is asserted on the SDA pin at the end of a receive/transmit by setting the Stop Sequence Enable (PEN) in the SSPCON2 register. At the end of a receive/transmit, the SCL line is held low after the falling edge of the 9th clock. When the PEN bit is set, the master will assert the SDA line low. When the SDA line is sampled low, the Baud Rate Generator is reloaded and counts down to '0'. When the Baud Rate Generator times out, the SCL pin will be brought high and, one T_{BRG} (Baud Rate Generator rollover count) later, the SDA pin will be deasserted. When the SDA pin is sampled high while SCL is high, the SSPSTAT<P> bit is set. A T_{BRG} later, the PEN bit is cleared and the SSPIF bit is set (Figure 27-23).

27.5.9.1 WCOL Status Flag

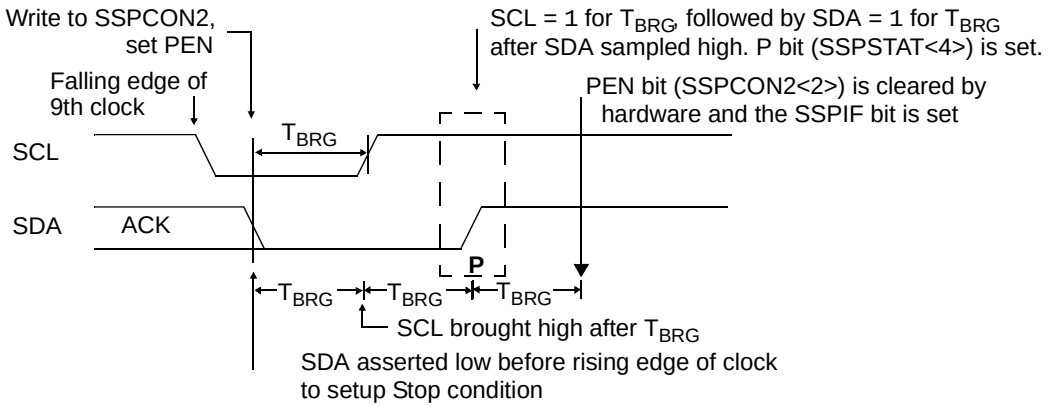
If the user writes the SSPBUF when a Stop sequence is in progress, then the WCOL bit is set and the contents of the buffer are unchanged (the write does not occur).

FIGURE 27-22: ACKNOWLEDGE SEQUENCE WAVEFORM



Note: T_{BRG} = one Baud Rate Generator period.

FIGURE 27-23: STOP CONDITION RECEIVE OR TRANSMIT MODE



Note: T_{BRG} = one Baud Rate Generator period.

27.5.10 SLEEP OPERATION

While in Sleep mode, the I²C slave module can receive addresses or data and, when an address match or complete byte transfer occurs, wakes the processor from Sleep (if the MSSP interrupt is enabled).

27.5.11 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

27.5.12 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit in the SSPSTAT register is set or the bus is Idle, with both the S and P bits clear. When the bus is busy, enabling the SSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDA line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed by hardware with the result placed in the BCLIF bit.

The states where arbitration can be lost are:

- Address Transfer
- Data Transfer
- A Start Condition
- A Repeated Start Condition
- An Acknowledge Condition

27.5.13 MULTI-MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDA pin, arbitration takes place when the master outputs a '1' on SDA, by letting SDA float high and another master asserts a '0'. When the SCL pin floats high, data should be stable. If the expected data on SDA is a '1' and the data sampled on the SDA pin is '0', then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag (BCLIF) and reset the I²C port to its Idle state (Figure 27-24).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDA and SCL lines are deasserted and the SSPBUF can be written to. When the user services the bus collision Interrupt Service Routine and if the I²C bus is free, the user can resume communication by asserting a Start condition.

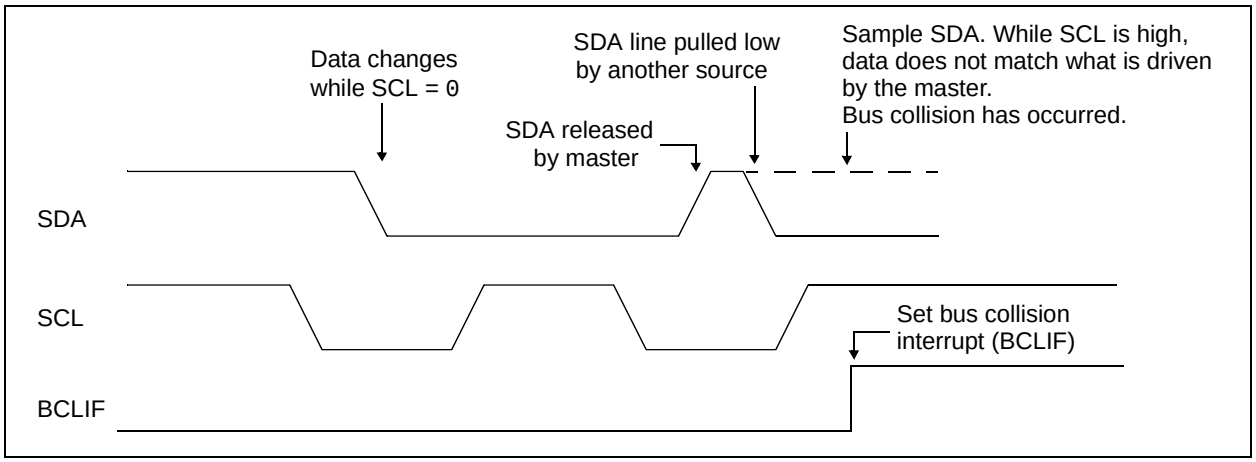
If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDA and SCL lines are deasserted and the respective control bits in the SSPCON2 register are cleared. When the user services the bus collision Interrupt Service Routine and if the I²C bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDA and SCL pins. If a Stop condition occurs, the SSPIF bit will be set.

A write to the SSPBUF will start the transmission of data at the first data bit, regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the I²C bus can be taken when the P bit is set in the SSPSTAT register or the bus is Idle and the S and P bits are cleared.

FIGURE 27-24: BUS COLLISION TIMING FOR TRANSMIT AND ACKNOWLEDGE



27.5.13.1 Bus Collision During a Start Condition

During a Start condition, a bus collision occurs if:

a) SDA or SCL are sampled low at the beginning of the Start condition (Figure 27-25).

b) SCL is sampled low before SDA is asserted low (Figure 27-26).

During a Start condition, both the SDA and the SCL pins are monitored.

If the SDA pin is already low or the SCL pin is already low, then all of the following occur:

- the Start condition is aborted
- the BCLIF flag is set
- the MSSP module is reset to its Idle state (Figure 27-25)

The Start condition begins with the SDA and SCL pins deasserted. When the SDA pin is sampled high, the Baud Rate Generator is loaded and counts down. If the SCL pin is sampled low while SDA is high, a bus collision occurs because it is assumed that another master is attempting to drive a data '1' during the Start condition.

If the SDA pin is sampled low during this count, the BRG is reset and the SDA line is asserted early (Figure 27-27). If, however, a '1' is sampled on the SDA pin, the SDA pin is asserted low at the end of the BRG count. The Baud Rate Generator is then reloaded and counts down to zero; if the SCL pin is sampled as '0' during this time, a bus collision does not occur. At the end of the BRG count, the SCL pin is asserted low.

Note: The reason that bus collision is not a factor during a Start condition is that no two bus masters can assert a Start condition at the exact same time. Therefore, one master will always assert SDA before the other. This condition does not cause a bus collision because the two masters must be allowed to arbitrate the first address following the Start condition. If the address is the same, arbitration must be allowed to continue into the data portion, Repeated Start or Stop conditions.

FIGURE 27-25: BUS COLLISION DURING START CONDITION (SDA ONLY)

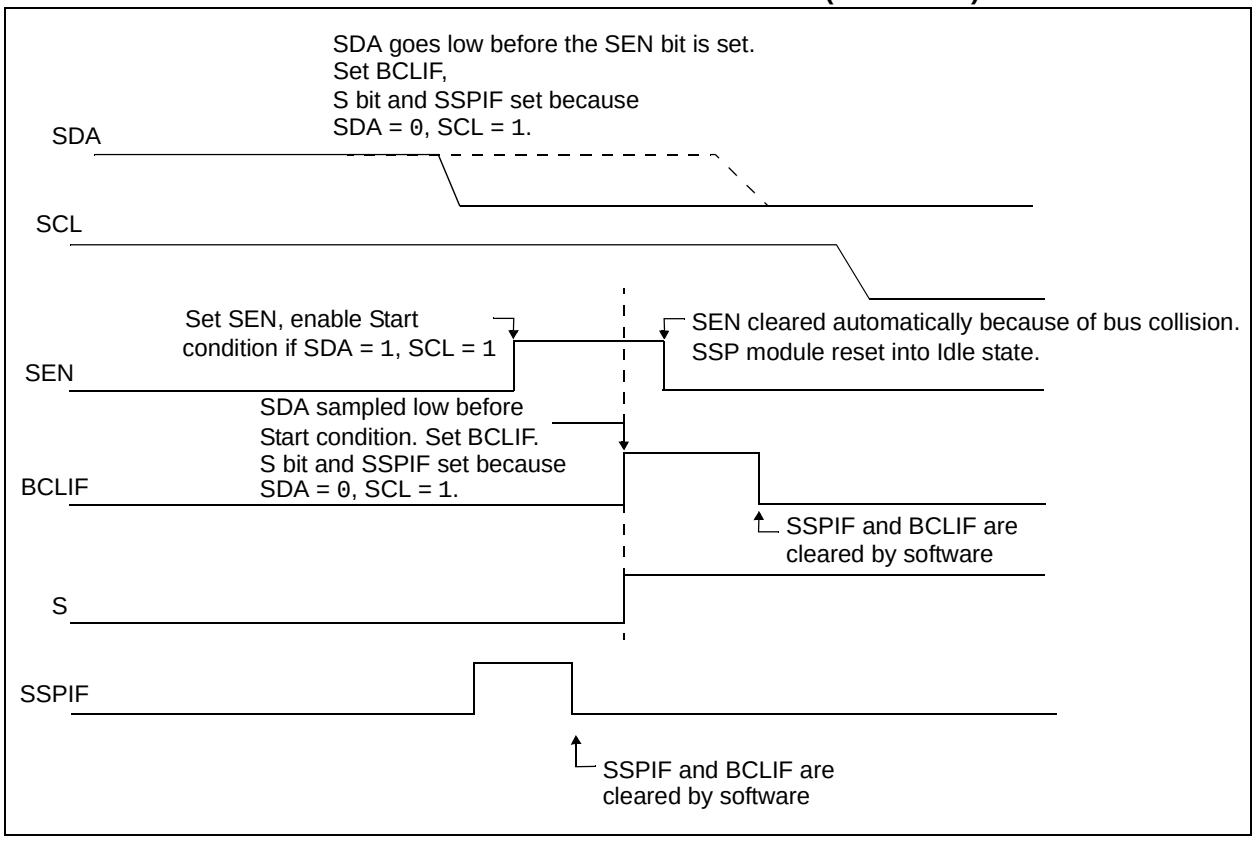


FIGURE 27-26: BUS COLLISION DURING START CONDITION (SCL = 0)

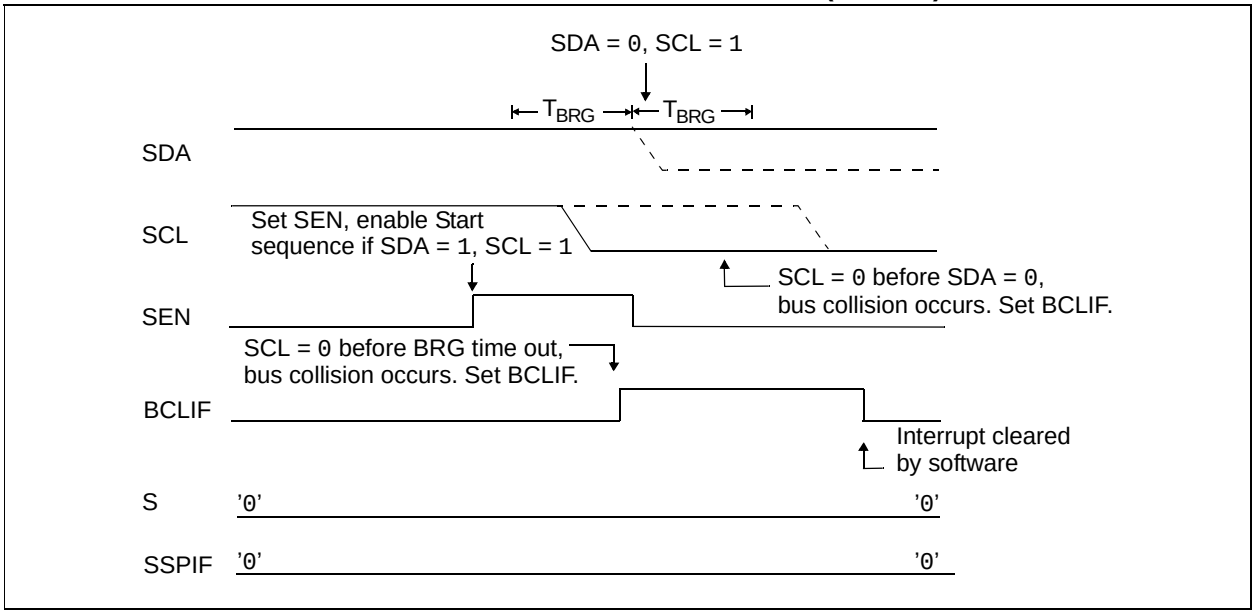
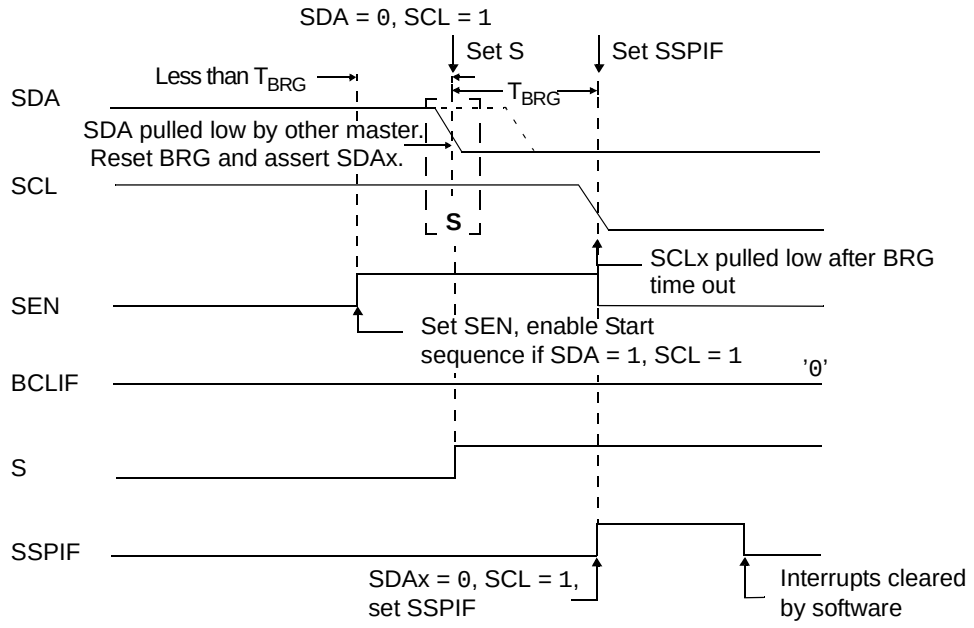


FIGURE 27-27: BRG RESET DUE TO SDA ARBITRATION DURING START CONDITION



27.5.13.2 Bus Collision during a Repeated Start Condition

During a Repeated Start condition, a bus collision occurs if:

a) A low level is sampled on SDA when SCL goes from low level to high level.

b) SCL goes low before SDA is asserted low, indicating that another master is attempting to transmit a data '1'.

When the user releases SDA and the pin is allowed to float high, the BRG is loaded with SSPADD and counts down to zero. The SCL pin is then deasserted and, when sampled high, the SDA pin is sampled.

If SDA is low, a bus collision has occurred (i.e., another master is attempting to transmit a data '0', Figure 27-28). If SDA is sampled high, the BRG is reloaded and begins counting. If SDA goes from high-to-low before the BRG times out, no bus collision occurs because no two masters can assert SDA at exactly the same time.

If SCL goes from high-to-low before the BRG times out and SDA has not already been asserted, a bus collision occurs. In this case, another master is attempting to transmit a data '1' during the Repeated Start condition (see Figure 27-29.)

If, at the end of the BRG time out, both SCL and SDA are still high, the SDA pin is driven low and the BRG is reloaded and begins counting. At the end of the count, regardless of the status of the SCL pin, the SCL pin is driven low and the Repeated Start condition is complete.

FIGURE 27-28: BUS COLLISION DURING A REPEATED START CONDITION (CASE 1)

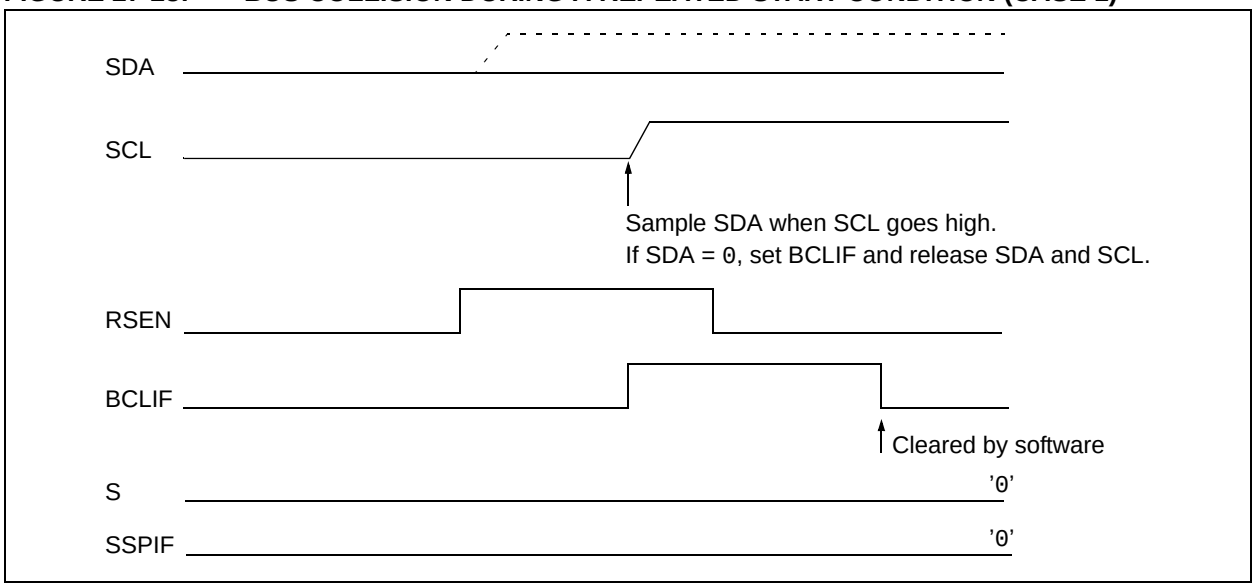
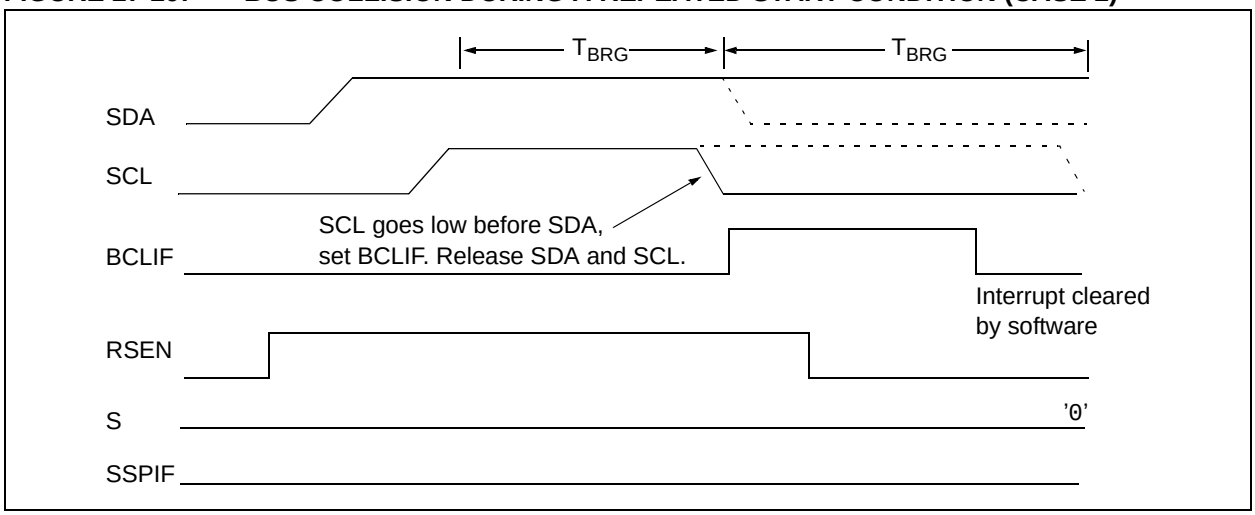


FIGURE 27-29: BUS COLLISION DURING A REPEATED START CONDITION (CASE 2)



27.5.13.3 Bus Collision During a Stop Condition

Bus collision occurs during a Stop condition if:

a) After the SDA pin has been deasserted and allowed to float high, SDA is sampled low after the BRG has timed out.

b) After the SCL pin is deasserted, SCL is sampled low before SDA goes high.

The Stop condition begins with SDA asserted low. When SDA is sampled low, the SCL pin is allowed to float. When the pin is sampled high (clock arbitration), the Baud Rate Generator is loaded with SSPADD and counts down to 0. After the BRG times out, SDA is sampled. If SDA is sampled low, a bus collision has occurred. This is due to another master attempting to drive a data '0' (Figure 27-30). If the SCL pin is sampled low before SDA is allowed to float high, a bus collision occurs. This is another case of another master attempting to drive a data '0' (Figure 27-31).

FIGURE 27-30: BUS COLLISION DURING A STOP CONDITION (CASE 1)

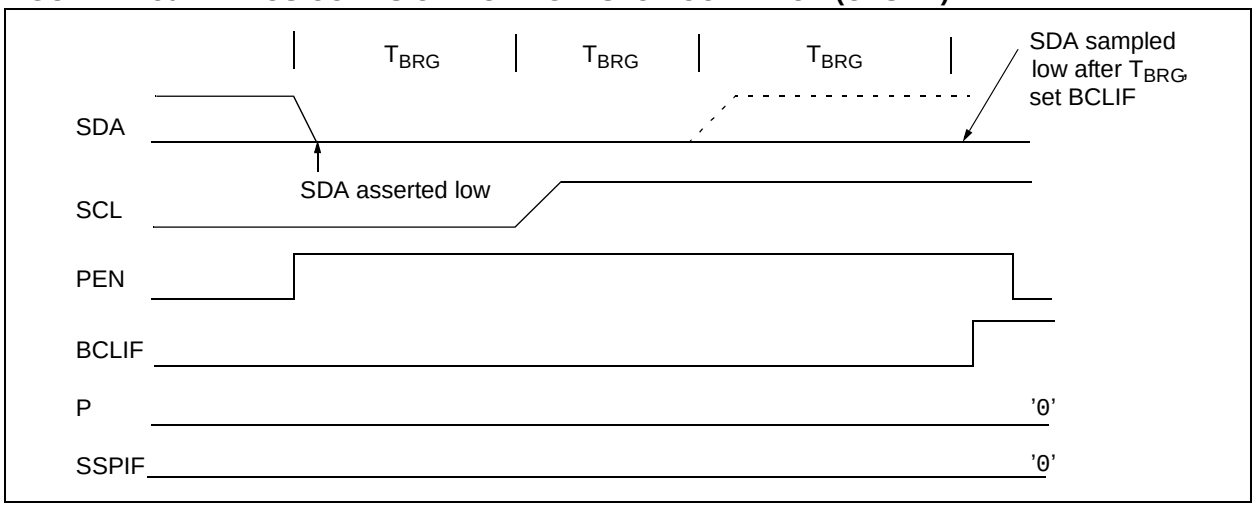


FIGURE 27-31: BUS COLLISION DURING A STOP CONDITION (CASE 2)

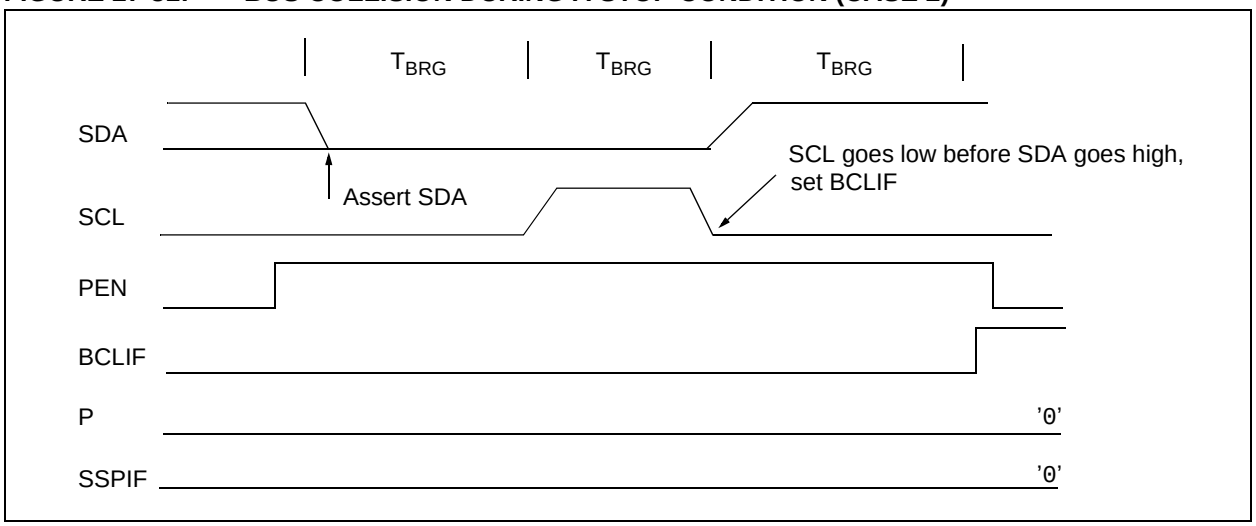


TABLE 27-1: SUMMARY OF REGISTERS ASSOCIATED WITH I²C OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE	PEIE	T0IE	INTE	IOCE	T0IF	INTF	IOCF	95
PIE1	—	ADIE	BCLIE	SSPIE	—	—	TMR2IE	TMR1IE	96
PIR1	—	ADIF	BCLIF	SSPIF	—	—	TMR2IF	TMR1IF	98
TRISGPA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	114
TRISGPB	TRISB7	TRISB6	TRISB5	TRISB4	—	TRISB2	TRISB1	TRISB0	117
SSPADD	ADD7	ADD6	ADD5	ADD4	ADD3	ADD2	ADD1	ADD0	189
SSPBUF	Synchronous Serial Port Receive Buffer/Transmit Register								148*
SSPCON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	186
SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	187
SSPCON3	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	188
SSPMSK	MSK7	MSK6	MSK5	MSK4	MSK3	MSK2	MSK1	MSK0	189
SSPSTAT	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	185
SSPMSK2	MSK27	MSK26	MSK25	MSK24	MSK23	MSK22	MSK21	MSK20	190
SSPADD2	ADD27	ADD26	ADD25	ADD24	ADD23	ADD22	ADD21	ADD20	190

Legend: – = unimplemented, read as '0'. Shaded cells are not used by the MSSP module in I²C mode.

* Page provides register information.

27.6 BAUD RATE GENERATOR

The MSSP module has a Baud Rate Generator available for clock generation in I^2C Master mode. The Baud Rate Generator (BRG) reload value is placed in the SSPADD register. When a write occurs to SSPBUF, the Baud Rate Generator will automatically begin counting down.

Once the given operation is complete, the internal clock will automatically stop counting and the clock pin will remain in its last state.

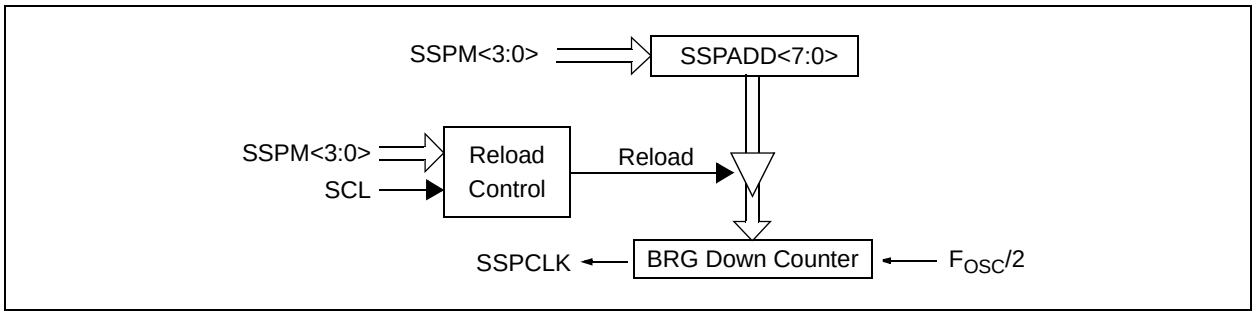
An internal signal “Reload” in Figure 27-32 triggers the value from SSPADD to be loaded into the BRG counter. This occurs twice for each oscillation of the module clock line. The logic dictating when the reload signal is asserted depends on the mode the MSSP is being operated in.

Table 27-2 demonstrates clock rates based on instruction cycles and the BRG value loaded into SSPADD.

EQUATION 27-1:

$$F_{CLOCK} = \frac{F_{OSC}}{(SSPADD + 1)(4)}$$

FIGURE 27-32: BAUD RATE GENERATOR BLOCK DIAGRAM



Note: Values of 0x00, 0x01 and 0x02 are not valid for SSPADD when used as a Baud Rate Generator for I^2C. This is an implementation limitation.

TABLE 27-2: MSSP CLOCK RATE W/BRG

F_{OSC}	F_{CY}	BRG Value	F_{CLOCK} (2 Rollovers of BRG)
8 MHz	2 MHz	04h	400 kHz(1)
8 MHz	2 MHz	0Bh	166 kHz
8 MHz	2 MHz	13h	100 kHz

Note 1: The I^2C interface does not conform to the 400 kHz I^2C specification (which applies to rates greater than 100 kHz) in all details, but may be used with care where higher rates are required by the application.

REGISTER 27-2: SSPSTAT: SSP STATUS REGISTER

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **SMP:** Data Input Sample bit
1 = Slew rate control disabled for standard speed mode (100 kHz and 1 MHz)
0 = Slew rate control enabled for high speed mode (400 kHz)

bit 6 **CKE:** Clock Edge Select bit
1 = Enable input logic so that thresholds are compliant with SMBus specification
0 = Disable SMBus specific inputs

bit 5 **D/$\overline{A}$:** Data/$\overline{\text{Address}}$ bit
1 = Indicates that the last byte received or transmitted was data
0 = Indicates that the last byte received or transmitted was address

bit 4 **P:** Stop bit
(This bit is cleared when the MSSP module is disabled, SSPEN is cleared.)
1 = Indicates that a Stop bit has been detected last (this bit is '0' on Reset)
0 = Stop bit was not detected last

bit 3 **S:** Start bit
(This bit is cleared when the MSSP module is disabled, SSPEN is cleared.)
1 = Indicates that a Start bit has been detected last (this bit is '0' on Reset)
0 = Start bit was not detected last

bit 2 **R/$\overline{W}$:** Read/$\overline{\text{Write}}$ bit information
This bit holds the R/$\overline{W}$ bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit or $\overline{\text{NACK}}$ bit.
In I^2C Slave mode:
1 = Read
0 = Write
In I^2C Master mode:
1 = Transmit is in progress
0 = Transmit is not in progress
OR-ing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSP is in Idle mode.

bit 1 **UA:** Update Address bit (10-bit I^2C mode only)
1 = Indicates that the user needs to update the address in the SSPADD register
0 = Address does not need to be updated

bit 0 **BF:** Buffer Full Status bit
Receive:
1 = Receive complete, SSPBUF is full
0 = Receive not complete, SSPBUF is empty
Transmit:
1 = Data transmit in progress (does not include the $\overline{\text{ACK}}$ and Stop bits), SSPBUF is full
0 = Data transmit complete (does not include the $\overline{\text{ACK}}$ and Stop bits), SSPBUF is empty

REGISTER 27-3: SSPCON1: SSP CONTROL REGISTER 1

R/C/HS-0	R/C/HS-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
HS = Bit is set by hardware	C = User cleared		

bit 7 **WCOL:** Write Collision Detect bit
Master mode:
1 = A write to the SSPBUF register was attempted while the I^2C conditions were not valid for a transmission to be started
0 = No collision
Slave mode:
1 = The SSPBUF register is written while it is still transmitting the previous word (must be cleared in software)
0 = No collision

bit 6 **SSPOV:** Receive Overflow Indicator bit (1)
1 = A byte is received while the SSPBUF register is still holding the previous byte. SSPOV is a "don't care" in Transmit mode (must be cleared in software).
0 = No overflow

bit 5 **SSPEN:** Synchronous Serial Port Enable bit
In both modes, when enabled, these pins must be properly configured as input or output
1 = Enables the serial port and configures the SDA and SCL pins as the source of the serial port pins (2)
0 = Disables serial port and configures these pins as I/O port pins

bit 4 **CKP:** Clock Polarity Select bit
In I^2C Slave mode:
SCL release control
1 = Enable clock
0 = Holds clock low (clock stretch). (Used to ensure data setup time.)
In I^2C Master mode:
Unused in this mode

bit 3-0 **SSPM<3:0>:** Synchronous Serial Port Mode Select bits
0000 = Reserved
0001 = Reserved
0010 = Reserved
0011 = Reserved
0100 = Reserved
0101 = Reserved
0110 = I^2C Slave mode, 7-bit address
0111 = I^2C Slave mode, 10-bit address
1000 = I^2C Master mode, clock = $F_{OSC}/(4 \times (SSPADD+1))$ (3)
1001 = Reserved
1010 = Reserved
1011 = I^2C firmware controlled Master mode (Slave idle)
1100 = Reserved
1101 = Reserved
1110 = I^2C Slave mode, 7-bit address with Start and Stop bit interrupts enabled
1111 = I^2C Slave mode, 10-bit address with Start and Stop bit interrupts enabled

Note 1: In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPBUF register.
2: When enabled, the SDA and SCL pins must be configured as inputs.
3: SSPADD values of 0, 1 or 2 are not supported for I^2C Mode.

REGISTER 27-4: SSPCON2: SSP CONTROL REGISTER 2

R/W-0/0	R-0/0	R/W-0/0	R/S/HS-0/0	R/S/HS-0/0	R/S/HS-0/0	R/S/HS-0/0	R/W/HS-0/0
GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown
H = Bit is set by hardware	S = User set	-n/n = Value at POR/Value at all other resets

bit 7 **GCEN:** General Call Enable bit (in I^2C Slave mode only)
1 = Enable interrupt when a general call address (0x00 or 00h) is received in the SSPSR
0 = General call address disabled

bit 6 **ACKSTAT:** Acknowledge Status bit
1 = Acknowledge was not received
0 = Acknowledge was received

bit 5 **ACKDT:** Acknowledge Data bit
In Receive mode:
Value transmitted when the user initiates an Acknowledge sequence at the end of a receive
1 = Not Acknowledge
0 = Acknowledge

bit 4 **ACKEN:** Acknowledge Sequence Enable bit (in I^2C Master mode only)
In Master Receive mode:
1 = Initiate Acknowledge sequence on SDA and SCL pins and transmit ACKDT data bit. Automatically cleared by hardware.
0 = Acknowledge sequence Idle

bit 3 **RCEN:** Receive Enable bit (in I^2C Master mode only)
1 = Enables Receive mode for I^2C
0 = Receive Idle

bit 2 **PEN:** Stop Condition Enable bit (in I^2C Master mode only)
SCK Release Control:
1 = Initiate Stop condition on SDA and SCL pins. Automatically cleared by hardware
0 = Stop condition Idle

bit 1 **RSEN:** Repeated Start Condition Enabled bit (in I^2C Master mode only)
1 = Initiate Repeated Start condition on SDA and SCL pins. Automatically cleared by hardware
0 = Repeated Start condition Idle

bit 0 **SEN:** Start Condition Enabled bit (in I^2C Master mode only)
In Master mode:
1 = Initiate Start condition on SDA and SCL pins. Automatically cleared by hardware
0 = Start condition Idle
In Slave mode:
1 = Clock stretching is enabled for both slave transmit and slave receive (stretch enabled)
0 = Clock stretching is disabled

Note 1: For bits ACKEN, RCEN, PEN, RSEN, SEN: If the I^2C module is not in the Idle mode, this bit may not be set (no spooling) and the SSPBUF may not be written (or writes to the SSPBUF are disabled).

REGISTER 27-5: SSPCON3: SSP CONTROL REGISTER 3

R-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n/n = Value at POR/Value at all other resets	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **ACKTIM:** Acknowledge Time Status bit(2)
1 = Indicates the I^2C bus is in an Acknowledge sequence, set on the 8th falling edge of SCL clock
0 = Not an Acknowledge sequence, cleared on the 9th rising edge of SCL clock

bit 6 **PCIE**: Stop Condition Interrupt Enable bit
1 = Enable interrupt on detection of Stop condition
0 = Stop detection interrupts are disabled(1)

bit 5 **SCIE**: Start Condition Interrupt Enable bit
1 = Enable interrupt on detection of Start or Restart conditions
0 = Start detection interrupts are disabled(1)

bit 4 **BOEN:** Buffer Overwrite Enable bit
In I^2C Master mode:
This bit is ignored.
In I^2C Slave mode:
1 = SSPBUF is updated and $\overline{ACK}$ is generated for a received address/data byte, ignoring the state of the SSPOV bit only if the BF bit = 0.
0 = SSPBUF is only updated when SSPOV is clear

bit 3 **SDAHT:** SDA Hold Time Selection bit
1 = Minimum of 300 ns hold time on SDA after the falling edge of SCL
0 = Minimum of 100 ns hold time on SDA after the falling edge of SCL

bit 2 **SBCDE:** Slave Mode Bus Collision Detect Enable bit (I^2C Slave mode only)
If on the rising edge of SCL, SDA is sampled low when the module is outputting a high state, the BCLIF bit in the PIR2 register is set, and bus goes Idle
1 = Enable slave bus collision interrupts
0 = Slave bus collision interrupts are disabled

bit 1 **AHEN:** Address Hold Enable bit (I^2C Slave mode only)
1 = Following the 8th falling edge of SCL for a matching received address byte; CKP bit in the SSPCON1 register will be cleared and the SCL will be held low.
0 = Address holding is disabled

bit 0 **DHEN:** Data Hold Enable bit (I^2C Slave mode only)
1 = Following the 8th falling edge of SCL for a received data byte; slave hardware clears the CKP bit in the SSPCON1 register and SCL is held low.
0 = Data holding is disabled

Note 1: This bit has no effect in slave modes where Start and Stop condition detection is explicitly listed as enabled.
2: The ACKTIM Status bit is only active when the AHEN bit or DHEN bit is set.

REGISTER 27-6: SSPMSK: SSP MASK REGISTER 1

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
MSK7	MSK6	MSK5	MSK4	MSK3	MSK2	MSK1	MSK0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-1 **MSK<7:1>:** Mask bits
1 = The received address bit n is compared to SSPADD<n> to detect I^2C address match
0 = The received address bit n is not used to detect I^2C address match

bit 0 **MSK<0>:** Mask bit for I^2C Slave mode, 10-bit Address
I^2C Slave mode, 10-bit address (SSPM<3:0> = 0111 or 1111):
1 = The received address bit 0 is compared to SSPADD<0> to detect I^2C address match
0 = The received address bit 0 is not used to detect I^2C address match
I^2C Slave mode, 7-bit address, the bit is ignored

REGISTER 27-7: SSPADD: MSSP ADDRESS AND BAUD RATE REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADD7	ADD6	ADD5	ADD4	ADD3	ADD2	ADD1	ADD0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

Master mode:

bit 7-0 **ADD<7:0>:** Baud Rate Clock Divider bits
SCL pin clock period = ((ADD<7:0> + 1) x 4)/F_{OSC}

10-Bit Slave mode — Most Significant Address byte:

bit 7-3 **Not used:** Unused for Most Significant Address byte. Bit state of this register is a "don't care". Bit pattern sent by master is fixed by I^2C specification and must be equal to '11110'. However, those bits are compared by hardware and are not affected by the value in this register.

bit 2-1 **ADD<2:1>:** Two Most Significant bits of 10-bit address

bit 0 **Not used:** Unused in this mode. Bit state is a "don't care"

10-Bit Slave mode — Least Significant Address byte:

bit 7-0 **ADD<7:0>:** Eight Least Significant bits of 10-bit address

7-Bit Slave mode:

bit 7-1 **ADD<7:1>:** 7-bit address

bit 0 **Not used:** Unused in this mode. Bit state is a "don't care"

REGISTER 27-8: SSPMSK2: SSP MASK REGISTER 2

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
MSK27	MSK26	MSK25	MSK24	MSK23	MSK22	MSK21	MSK20
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-1 **MSK2<7:1>:** Mask bits
1 = The received address bit n is compared to SSPADD2<n> to detect I^2C address match
0 = The received address bit n is not used to detect I^2C address match

bit 0 **MSK2<0>:** Mask bit for I^2C Slave mode, 10-bit Address
I^2C Slave mode, 10-bit address (SSPM<3:0> = 0111 or 1111):
1 = The received address bit 0 is compared to SSPADD2<0> to detect I^2C address match
0 = The received address bit 0 is not used to detect I^2C address match
I^2C Slave mode, 7-bit address, the bit is ignored

REGISTER 27-9: SSPADD2: MSSP ADDRESS 2

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADD27	ADD26	ADD25	ADD24	ADD23	ADD22	ADD21	ADD20
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

Master mode:

bit 7-0 **ADD2<7:0>:** Baud Rate Clock Divider bits
SCL pin clock period = ((ADD<7:0> + 1) *4)/FOSC

10-Bit Slave mode — Most Significant Address byte:

bit 7-3 **Not used:** Unused for Most Significant Address byte. Bit state of this register is a "don't care". Bit pattern sent by master is fixed by I^2C specification and must be equal to '11110'. However, those bits are compared by hardware and are not affected by the value in this register.

bit 2-1 **ADD2<2:1>:** Two Most Significant bits of 10-bit address

bit 0 **ADD2<0>:** SSPADD2 Enable bit.
1 = Enable address matching with SSPADD2
0 = Disable address matching with SSPADD2

10-Bit Slave mode — Least Significant Address byte:

bit 7-0 **ADD2<7:0>:** Eight Least Significant bits of 10-bit address

7-Bit Slave mode:

bit 7-1 **ADD2<7:1>:** 7-bit address

bit 0 **ADD2<0>:** SSPADD2 Enable bit.
1 = Enable address matching with SSPADD2
0 = Disable address matching with SSPADD2

28.0 IN-CIRCUIT SERIAL PROGRAMMING™ (ICSP™)

ICSP programming allows customers to manufacture circuit boards with unprogrammed devices. Programming can be done after the assembly process, allowing the device to be programmed with the most recent firmware or a custom firmware. Five pins are needed for ICSP programming:

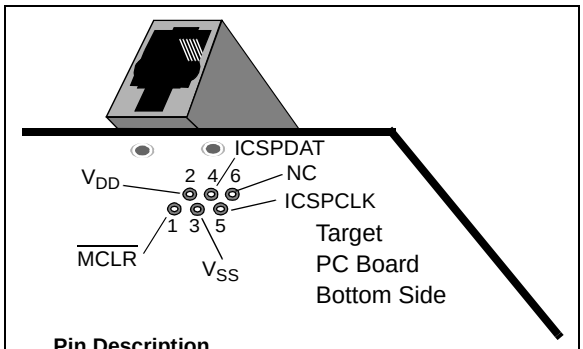
- ICSPCLK
- ICSPDAT
- $\overline{MCLR}$
- V_{DD}
- V_{SS}

In Program/Verify mode, the Program Memory, User IDs and the Configuration Words are programmed through serial communications. The ICSPDAT pin is a bidirectional I/O used for transferring the serial data and the ICSPCLK pin is the clock input. The device is placed into a Program/Verify mode by holding the ICSPDAT and ICSPCLK pins low, while raising the $\overline{MCLR}$ pin from V_{IL} to V_{IHH}.

28.1 Common Programming Interfaces

Connection to a target device is typically done through an ICSP header. A commonly found connector on development tools is the RJ-11 in the 6P6C (6-pin, 6-connector) configuration. See Figure 28-1.

FIGURE 28-1: ICD RJ-11 STYLE CONNECTOR INTERFACE

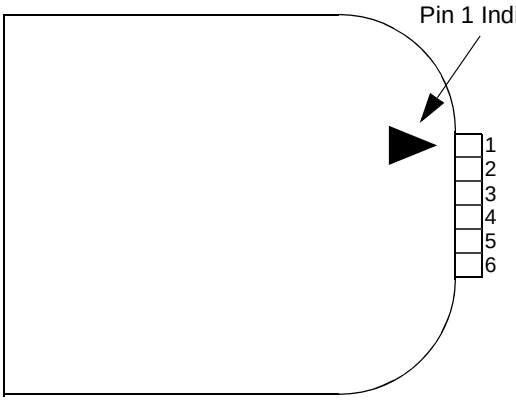


Pin Description

1	=	1 = $\overline{MCLR}$
2	=	2 = V_{DD}Target
3	=	3 = V_{SS} (ground)
4	=	4 = ICSPDAT
5	=	5 = ICSPCLK
6	=	6 = No Connect

Another connector often found in use with the PICkit™ programmers is a standard 6-pin header with 0.1 inch spacing. Refer to Figure 28-2.

FIGURE 28-2: PICKit™ PROGRAMMER-STYLE CONNECTOR INTERFACE



Pin Description*

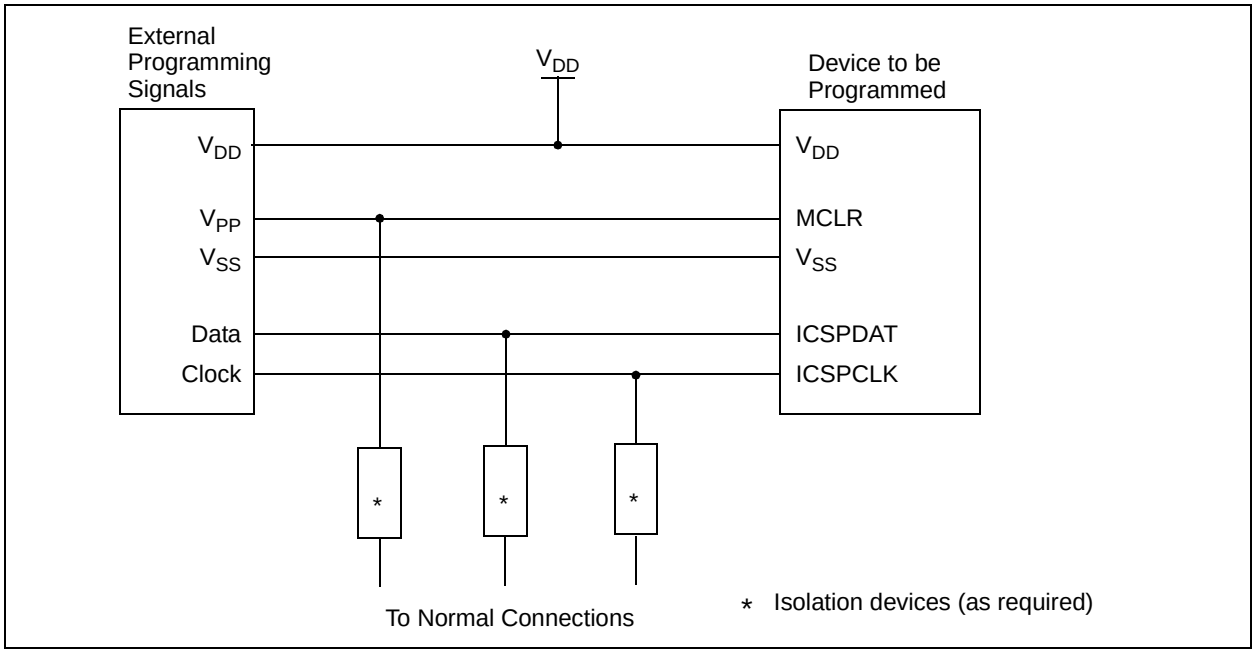
1	=	1 = $\overline{MCLR}$
2	=	2 = V_{DD}Target
3	=	3 = V_{SS} (ground)
4	=	4 = ICSPDAT
5	=	5 = ICSPCLK
6	=	6 = No Connect

* The 6-pin header (0.100" spacing) accepts 0.025" square pins.

For additional interface recommendations, refer to your specific device programmer manual prior to PCB design.

It is recommended that isolation devices be used to separate the programming pins from other circuitry. The type of isolation is highly dependent on the specific application and may include devices, such as resistors, diodes or even jumpers. See Figure 28-3 for more information.

FIGURE 28-3: TYPICAL CONNECTION FOR ICSP PROGRAMMING



28.2 In-Circuit Debugger

In-circuit debugging requires access to the ICDCLK, ICDDATA and MCLR pins. These pins are only available on the MCP19119 device.

29.0 INSTRUCTION SET SUMMARY

The MCP19118/19 instruction set is highly orthogonal and is comprised of three basic categories:

- **Byte-oriented** operations
- **Bit-oriented** operations
- **Literal and control** operations

Each instruction is a 14-bit word divided into an **opcode,** which specifies the instruction type, and one or more **operands,** which further specify the operation of the instruction. The formats for each of the categories are presented in Figure 29-1, while the various opcode fields are summarized in Table 29-1.

Table 29-2 lists the instructions recognized by the MPASM™ assembler.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator, which selects the bit affected by the operation, while 'f' represents the address of the file in which the bit is located.

For **literal and control** operations, 'k' represents an 8-bit or 11-bit constant, or literal value.

One instruction cycle consists of four oscillator periods; for an oscillator frequency of 4 MHz, this gives a normal instruction execution time of 1 µs. All instructions are executed within a single instruction cycle, unless a conditional test is true, or the program counter is changed as a result of an instruction. When this occurs, the execution takes two instruction cycles, with the second cycle executed as an `NOP`.

All instruction examples use the format '`0xhh`' to represent a hexadecimal number, where 'h' signifies a hexadecimal digit.

29.1 Read-Modify-Write Operations

Any instruction that specifies a file register as part of the instruction performs a Read-Modify-Write (RMW) operation. The register is read, the data is modified, and the result is stored according to either the instruction or the destination designator 'd'. A read operation is performed on a register even if the instruction writes to that register.

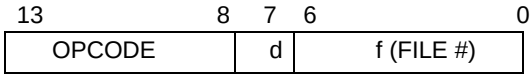
For example, a `CLRF PORTA` instruction will read PORTGPA, clear all the data bits, then write the result back to PORTGPA. This example would have the unintended consequence of clearing the condition that set the IOCF flag.

TABLE 29-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= `0` or `1`). The assembler will generate code with x = `0`. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = `0`: store result in W, d = `1`: store result in file register f. Default is d = `1`.
PC	Program Counter
$\overline{TO}$	Time Out bit
C	Carry bit
DC	Digit carry bit
Z	Zero bit
$\overline{PD}$	Power-Down bit

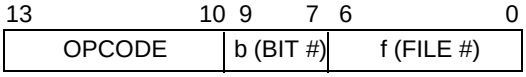
FIGURE 29-1: GENERAL FORMAT FOR INSTRUCTIONS

Byte-Oriented file register operations



d = `0` for destination W
d = `1` for destination f
f = 7-bit file register address

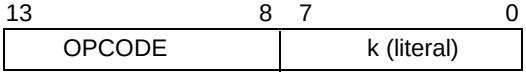
Bit-Oriented file register operations



b = 3-bit bit address
f = 7-bit file register address

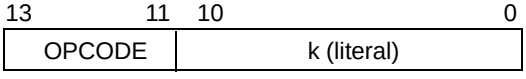
Literal and control operations

General



k = 8-bit immediate value

`CALL` and `GOTO` instructions only



k = 11-bit immediate value

TABLE 29-2: MCP19118/19 INSTRUCTION SET

Mnemonic, Operands		Description	Cycles	14-Bit Opcode MSb LSb	Status Affected	Notes
BYTE-ORIENTED FILE REGISTER OPERATIONS						
ADDWF	f, d	Add W and f	1	00 0111 dfff ffff	C, DC, Z	1, 2
ANDWF	f, d	AND W with f	1	00 0101 dfff ffff	Z	1, 2
CLRF	f	Clear f	1	00 0001 lfff ffff	Z	2
CLRW	–	Clear W	1	00 0001 0xxx xxxx	Z	
COMF	f, d	Complement f	1	00 1001 dfff ffff	Z	1, 2
DECF	f, d	Decrement f	1	00 0011 dfff ffff	Z	1, 2
DECFSZ	f, d	Decrement f, Skip if 0	1**(2)**	00 1011 dfff ffff		1, 2, 3
INCF	f, d	Increment f	1	00 1010 dfff ffff	Z	1, 2
INCFSZ	f, d	Increment f, Skip if 0	1**(2)**	00 1111 dfff ffff		1, 2, 3
IORWF	f, d	Inclusive OR W with f	1	00 0100 dfff ffff	Z	1, 2
MOVF	f, d	Move f	1	00 1000 dfff ffff	Z	1, 2
MOVWF	f	Move W to f	1	00 0000 lfff ffff		
NOP	–	No Operation	1	00 0000 0xx0 0000		
RLF	f, d	Rotate Left f through Carry	1	00 1101 dfff ffff	C	1, 2
RRF	f, d	Rotate Right f through Carry	1	00 1100 dfff ffff	C	1, 2
SUBWF	f, d	Subtract W from f	1	00 0010 dfff ffff	C, DC, Z	1, 2
SWAPF	f, d	Swap nibbles in f	1	00 1110 dfff ffff		1, 2
XORWF	f, d	Exclusive OR W with f	1	00 0110 dfff ffff	Z	1, 2
BIT-ORIENTED FILE REGISTER OPERATIONS						
BCF	f, b	Bit Clear f	1	01 00bb bfff ffff		1, 2
BSF	f, b	Bit Set f	1	01 01bb bfff ffff		1, 2
BTFSC	f, b	Bit Test f, Skip if Clear	1 **(2)**	01 10bb bfff ffff		3
BTFSS	f, b	Bit Test f, Skip if Set	1 **(2)**	01 11bb bfff ffff		3
LITERAL AND CONTROL OPERATIONS						
ADDLW	k	Add literal and W	1	11 111x kkkk kkkk	C, DC, Z	
ANDLW	k	AND literal with W	1	11 1001 kkkk kkkk	Z	
CALL	k	Call Subroutine	2	10 0kkk kkkk kkkk		
CLRWDT	–	Clear Watchdog Timer	1	00 0000 0110 0100	$\overline{TO}$, $\overline{PD}$	
GOTO	k	Go to address	2	10 1kkk kkkk kkkk		
IORLW	k	Inclusive OR literal with W	1	11 1000 kkkk kkkk	Z	
MOVLW	k	Move literal to W	1	11 00xx kkkk kkkk		
RETFIE	–	Return from interrupt	2	00 0000 0000 1001		
RETLW	k	Return with literal in W	2	11 01xx kkkk kkkk		
RETURN	–	Return from Subroutine	2	00 0000 0000 1000		
SLEEP	–	Go into Standby mode	1	00 0000 0110 0011	$\overline{TO}$, $\overline{PD}$	
SUBLW	k	Subtract W from literal	1	11 110x kkkk kkkk	C, DC, Z	
XORLW	k	Exclusive OR literal with W	1	11 1010 kkkk kkkk	Z	

Note 1: When an I/O register is modified as a function of itself (e.g., `MOVF PORTA, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 module.

3: If the Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as an `NOP`.

29.2 Instruction Descriptions

ADDLW	Add literal and W
Syntax:	[*label*] ADDLW k
Operands:	0 ≤ k ≤ 255
Operation:	(W) + k → (W)
Status Affected:	C, DC, Z
Description:	The contents of the W register are added to the eight-bit literal 'k' and the result is placed in the W register.

ADDWF	Add W and f
Syntax:	[*label*] ADDWF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(W) + (f) → (destination)
Status Affected:	C, DC, Z
Description:	Add the contents of the W register with register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

ANDLW	AND literal with W
Syntax:	[*label*] ANDLW k
Operands:	0 ≤ k ≤ 255
Operation:	(W) .AND. (k) → (W)
Status Affected:	Z
Description:	The contents of W register are AND'ed with the eight-bit literal 'k'. The result is placed in the W register.

ANDWF	AND W with f
Syntax:	[*label*] ANDWF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(W) .AND. (f) → (destination)
Status Affected:	Z
Description:	AND the W register with register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

BCF	Bit Clear f
Syntax:	[*label*] BCF f,b
Operands:	0 ≤ f ≤ 127 0 ≤ b ≤ 7
Operation:	0 → (f<b>)
Status Affected:	None
Description:	Bit 'b' in register 'f' is cleared.

BSF	Bit Set f
Syntax:	[*label*] BSF f,b
Operands:	0 ≤ f ≤ 127 0 ≤ b ≤ 7
Operation:	1 → (f<b>)
Status Affected:	None
Description:	Bit 'b' in register 'f' is set.

BTFSC	Bit Test f, Skip if Clear
Syntax:	[*label*] BTFSC f,b
Operands:	0 ≤ f ≤ 127 0 ≤ b ≤ 7
Operation:	skip if (f<b>) = 0
Status Affected:	None
Description:	If bit 'b' in register 'f' is '1', the next instruction is executed. If bit 'b' in register 'f' is '0', the next instruction is discarded, and an NOP is executed instead, making this a two-cycle instruction.

BTFSS	Bit Test f, Skip if Set
Syntax:	[*label*] BTFSS f,b
Operands:	0 ≤ f ≤ 127 0 ≤ b < 7
Operation:	skip if (f<b>) = 1
Status Affected:	None
Description	If bit 'b' in register 'f' is '0', the next instruction is executed. If bit 'b' is '1', then the next instruction is discarded and an NOP is executed instead, making this a two-cycle instruction.

CALL	Call Subroutine
Syntax:	[*label*] CALL k
Operands:	0 ≤ k ≤ 2047
Operation:	(PC)+ 1→ TOS, k → PC<10:0>, (PCLATH<4:3>) → PC<12:11>
Status Affected:	None
Description:	Call Subroutine. First, return address (PC + 1) is pushed onto the stack. The eleven-bit immediate address is loaded into PC bits <10:0>. The upper bits of the PC are loaded from PCLATH. CALL is a two-cycle instruction.

CLRF	Clear f
Syntax:	[*label*] CLRF f
Operands:	0 ≤ f ≤ 127
Operation:	00h → (f) 1 → Z
Status Affected:	Z
Description:	The contents of register 'f' are cleared and the Z bit is set.

CLRW	Clear W
Syntax:	[*label*] CLRW
Operands:	None
Operation:	00h → (W) 1 → Z
Status Affected:	Z
Description:	W register is cleared. Zero bit (Z) is set.

CLRWDT	Clear Watchdog Timer
Syntax:	[*label*] CLRWDT
Operands:	None
Operation:	00h → WDT 0 → WDT prescaler, 1 → $\overline{TO}$ 1 → $\overline{PD}$
Status Affected:	$\overline{TO}$, $\overline{PD}$
Description:	CLRWDT instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. Status bits $\overline{TO}$ and $\overline{PD}$ are set.

COMF	Complement f
Syntax:	[*label*] COMF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	($\bar{f}$) → (destination)
Status Affected:	Z
Description:	The contents of register 'f' are complemented. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.

DECF	Decrement f
Syntax:	[*label*] DECF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(f) - 1 → (destination)
Status Affected:	Z
Description:	Decrement register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

DECFSZ	Decrement f, Skip if 0
Syntax:	[*label*] DECFSZ f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(f) - 1 → (destination); skip if result = 0
Status Affected:	None
Description:	The contents of register 'f' are decremented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'. If the result is '1', the next instruction is executed. If the result is '0', then an NOP is executed instead, making it a two-cycle instruction.

GOTO	Unconditional Branch
Syntax:	[*label*] GOTO k
Operands:	0 ≤ k ≤ 2047
Operation:	k → PC<10:0> PCLATH<4:3> → PC<12:11>
Status Affected:	None
Description:	GOTO is an unconditional branch. The eleven-bit immediate value is loaded into PC bits <10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two-cycle instruction.

INCF	Increment f
Syntax:	[*label*] INCF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(f) + 1 → (destination)
Status Affected:	Z
Description:	The contents of register 'f' are incremented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.

INCFSZ	Increment f, Skip if 0
Syntax:	[*label*] INCFSZ f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(f) + 1 → (destination), skip if result = 0
Status Affected:	None
Description:	The contents of register 'f' are incremented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'. If the result is '1', the next instruction is executed. If the result is '0', an NOP is executed instead, making it a two-cycle instruction.

IORLW	Inclusive OR literal with W
Syntax:	[*label*] IORLW k
Operands:	0 ≤ k ≤ 255
Operation:	(W) .OR. k → (W)
Status Affected:	Z
Description:	The contents of the W register are OR'ed with the eight-bit literal 'k'. The result is placed in the W register.

IORWF	Inclusive OR W with f
Syntax:	[*label*] IORWF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(W) .OR. (f) → (destination)
Status Affected:	Z
Description:	Inclusive OR the W register with register 'f'. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.

MOVF	Move f
Syntax:	[*label*] MOVF f,d
Operands:	0 ≤ f ≤ 127 d ∈ [0,1]
Operation:	(f) → (dest)
Status Affected:	Z
Description:	The contents of register 'f' is moved to a destination dependent upon the status of 'd'. If d = 0, destination is W register. If d = 1, the destination is file register 'f' itself. d = 1 is useful to test a file register since Status flag Z is affected.
Words:	1
Cycles:	1
Example:	MOVF FSR, 0 After Instruction W = value in FSR register Z = 1

MOVWF	Move W to f
Syntax:	[*label*] MOVWF f
Operands:	0 ≤ f ≤ 127
Operation:	(W) → (f)
Status Affected:	None
Description:	Move data from W register to register 'f'.
Words:	1
Cycles:	1
Example:	MOVW OPTION F Before Instruction OPTION = 0xFF W = 0x4F After Instruction OPTION = 0x4F W = 0x4F

MOVLW	Move literal to W
Syntax:	[*label*] MOVLW k
Operands:	0 ≤ k ≤ 255
Operation:	k → (W)
Status Affected:	None
Description:	The eight-bit literal 'k' is loaded into W register. The "don't cares" will assemble as '0's.
Words:	1
Cycles:	1
Example:	MOVLW 0x5A After Instruction W = 0x5A

NOP	No Operation
Syntax:	[*label*] NOP
Operands:	None
Operation:	No operation
Status Affected:	None
Description:	No operation.
Words:	1
Cycles:	1
Example:	NOP

RETFIE	Return from Interrupt
Syntax:	[*label*] RETFIE
Operands:	None
Operation:	TOS → PC, 1 → GIE
Status Affected:	None
Description:	Return from Interrupt. Stack is POPed and Top-of-Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two-cycle instruction.
Words:	1
Cycles:	2

Example:	`RETFIE`
	After Interrupt
	`PC = TOS`
	`GIE = 1`

RETLW	Return with literal in W
Syntax:	[*label*] RETLW k
Operands:	0 ≤ k ≤ 255
Operation:	k → (W); TOS → PC
Status Affected:	None
Description:	The W register is loaded with the eight-bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.
Words:	1
Cycles:	2

Example:	`CALL TABLE;W contains`
	`;table offset`
	`;value`
	`GOTO DONE`
	`TABLE`
	•
	•
	`ADDWF PC ;W = offset`
	`RETLW k1 ;Begin table`
	`RETLW k2 ;`
	•
	•
	•
	`RETLW kn ;End of table`
	`DONE`
	Before Instruction
	`W = 0x07`
	After Instruction
	`W = value of k8`

RETURN	Return from Subroutine
Syntax:	[*label*] RETURN
Operands:	None
Operation:	TOS → PC
Status Affected:	None
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two-cycle instruction.

RLF **Rotate Left f through Carry**

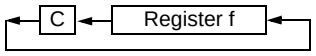
Syntax: [*label*] RLF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: See description below

Status Affected: C

Description: The contents of register ‘f’ are rotated one bit to the left through the Carry flag. If ‘d’ is ‘0’, the result is placed in the W register. If ‘d’ is ‘1’, the result is stored back in register ‘f’.



Words: 1

Cycles: 1

Example:

```
RLF     REG1,0
```

Before Instruction
```
REG1   =   1110
0110
C      =   0
```
After Instruction
```
REG1   =   1110
0110
W      =   1100
1100
C      =   1
```

RRF **Rotate Right f through Carry**

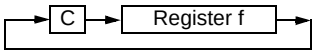
Syntax: [*label*] RRF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: See description below

Status Affected: C

Description: The contents of register ‘f’ are rotated one bit to the right through the Carry flag. If ‘d’ is ‘0’, the result is placed in the W register. If ‘d’ is ‘1’, the result is placed back in register ‘f’.



SLEEP **Enter Sleep mode**

Syntax: [*label*] SLEEP

Operands: None

Operation: 00h → WDT,
0 → WDT prescaler,
1 → $\overline{TO}$,
0 → $\overline{PD}$

Status Affected: $\overline{TO}$, $\overline{PD}$

Description: The power-down Status bit, $\overline{PD}$ is cleared. Time-out Status bit, $\overline{TO}$ is set. Watchdog Timer and its prescaler are cleared.
The processor is put into Sleep mode with the oscillator stopped.

SUBLW **Subtract W from literal**

Syntax: [*label*] SUBLW k

Operands: $0 \le k \le 255$

Operation: k - (W) → (W)

Status Affected: C, DC, Z

Description: The W register is subtracted (two’s complement method) from the eight-bit literal ‘k’. The result is placed in the W register.

Result	Condition
C = 0	W > k
C = 1	W ≤ k
DC = 0	W<3:0> > k<3:0>
DC = 1	W<3:0> ≤ k<3:0>

SUBWF	Subtract W from f
Syntax:	[*label*] SUBWF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(f) - (W) → (destination)
Status Affected:	C, DC, Z
Description:	Subtract (two's complement method) W register from register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

C = 0	W > f
C = 1	W ≤ f
DC = 0	W<3:0> > f<3:0>
DC = 1	W<3:0> ≤ f<3:0>

SWAPF	Swap Nibbles in f
Syntax:	[*label*] SWAPF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(f<3:0>) → (destination<7:4>), (f<7:4>) → (destination<3:0>)
Status Affected:	None
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed in register 'f'.

XORLW	Exclusive OR literal with W
Syntax:	[*label*] XORLW k
Operands:	$0 \le k \le 255$
Operation:	(W) .XOR. k → (W)
Status Affected:	Z
Description:	The contents of the W register are XOR'ed with the eight-bit literal 'k'. The result is placed in the W register.

XORWF	Exclusive OR W with f
Syntax:	[*label*] XORWF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(W) .XOR. (f) → (destination)
Status Affected:	Z
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

NOTES:

30.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers (MCU) and dsPIC® digital signal controllers (DSC) are supported with a full range of software and hardware development tools:

- Integrated Development Environment
  - MPLAB® X IDE Software
- Compilers/Assemblers/Linkers
  - MPLAB XC Compiler
  - MPASM™ Assembler
  - MPLINK™ Object Linker/ MPLIB™ Object Librarian
  - MPLAB Assembler/Linker/Librarian for Various Device Families
- Simulators
  - MPLAB X SIM Software Simulator
- Emulators
  - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers/Programmers
  - MPLAB ICD 3
  - PICkit™ 3
- Device Programmers
  - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits and Starter Kits
- Third-party Development Tools

30.1 MPLAB X Integrated Development Environment Software

The MPLAB X IDE is a single, unified graphical user interface for Microchip and third-party software, and hardware development tool that runs on Windows®, Linux and Mac OS® X. Based on the NetBeans IDE, MPLAB X IDE is an entirely new IDE with a host of free software components and plug-ins for high-performance application development and debugging. Moving between tools and upgrading from software simulators to hardware debugging and programming tools is simple with the seamless user interface.

With complete project management, visual call graphs, a configurable watch window and a feature-rich editor that includes code completion and context menus, MPLAB X IDE is flexible and friendly enough for new users. With the ability to support multiple tools on multiple projects with simultaneous debugging, MPLAB X IDE is also suitable for the needs of experienced users.

Feature-Rich Editor:

- Color syntax highlighting
- Smart code completion makes suggestions and provides hints as you type
- Automatic code formatting based on user-defined rules
- Live parsing

User-Friendly, Customizable Interface:

- Fully customizable interface: toolbars, toolbar buttons, windows, window placement, etc.
- Call graph window

Project-Based Workspaces:

- Multiple projects
- Multiple tools
- Multiple configurations
- Simultaneous debugging sessions

File History and Bug Tracking:

- Local file history feature
- Built-in support for Bugzilla issue tracker

30.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16, and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

30.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB X IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

30.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

30.5 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

30.6 MPLAB X SIM Software Simulator

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

30.7 MPLAB REAL ICE In-Circuit Emulator System

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradeable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE In-circuit emulator offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

30.8 MPLAB ICD 3 In-Circuit Debugger System

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

30.9 PICkit 3 In-Circuit Debugger/ Programmer

The MPLAB PICkit 3 In-Circuit Debugger allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 In-Circuit Debugger is connected to the design engineer's PC using a full-speed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE In-Circuit Emulator). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming™ (ICSP™).

30.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at V_{DDMIN} and V_{DDMAX} for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 Device Programmer connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 Device Programmer has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

30.11 Demonstration/Development Boards, Evaluation Kits and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

30.12 Third-Party Development Tools

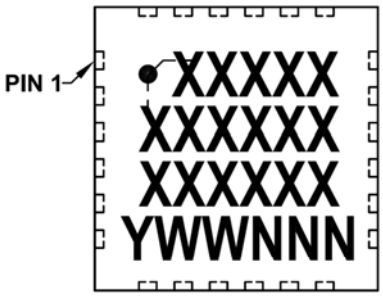
Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent® and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika®

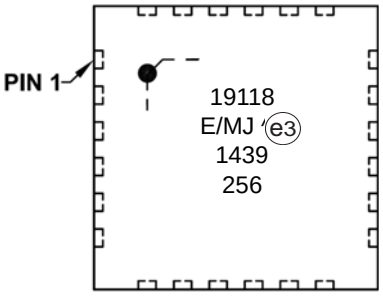
31.0 PACKAGING INFORMATION

31.1 Package Marking Information

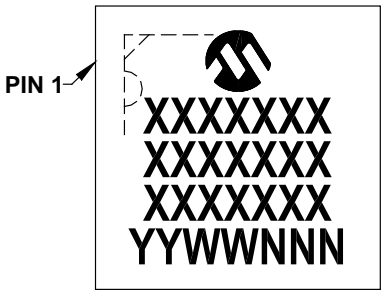
24-Lead QFN (4x4x0.9 mm) **(MCP19118 only)**



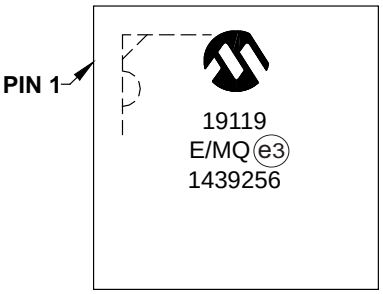
Example



28-Lead QFN (5x5x0.9 mm) **(MCP19119 only)**



Example

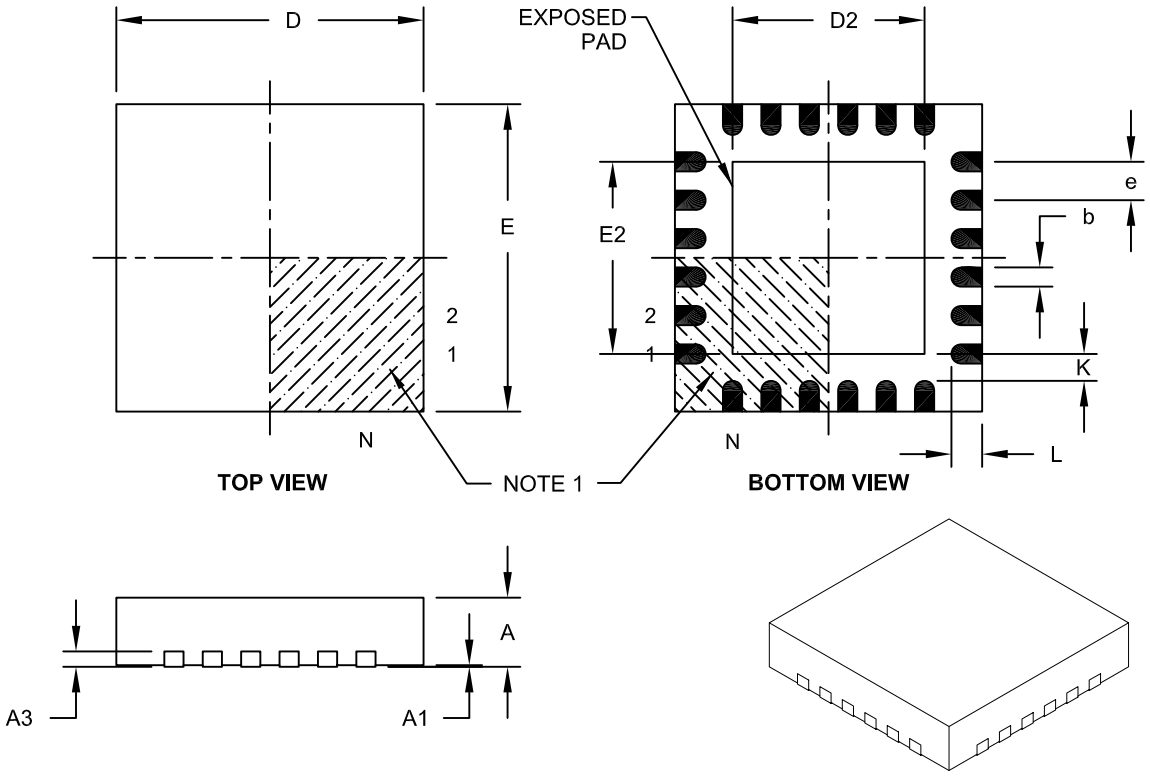


Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
	(e3)	RoHS Compliant JEDEC® designator for Matte Tin (Sn)
	*	This package is RoHS Compliant. The RoHS Compliant JEDEC designator ((e3)) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

24-Lead Plastic Quad Flat, No Lead Package (MJ) – 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		24	
Pitch	e		0.50 BSC	
Overall Height	A	0.80	0.85	0.90
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Width	E		4.00 BSC	
Exposed Pad Width	E2	2.40	2.50	2.60
Overall Length	D		4.00 BSC	
Exposed Pad Length	D2	2.40	2.50	2.60
Contact Width	b	0.20	0.25	0.30
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

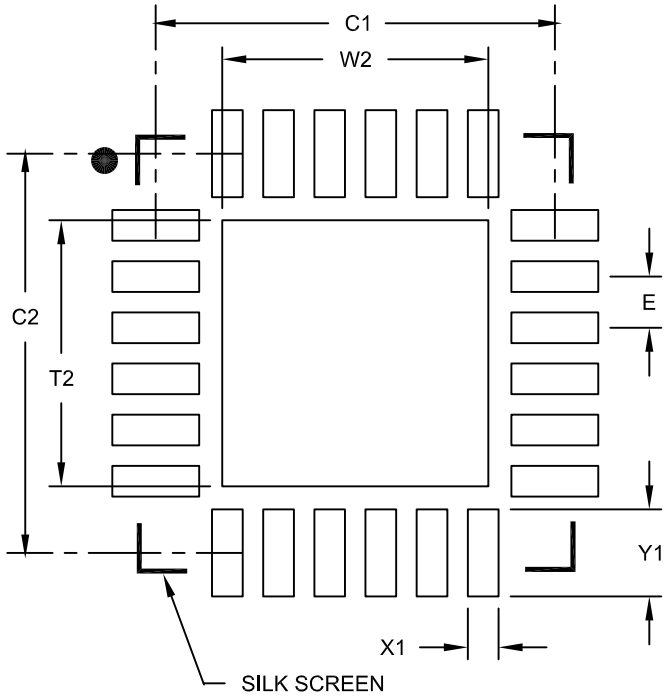
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-143A

24-Lead Plastic Quad Flat, No Lead Package (MJ) - 4x4 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Optional Center Pad Width	W2			2.60
Optional Center Pad Length	T2			2.60
Contact Pad Spacing	C1		3.90	
Contact Pad Spacing	C2		3.90	
Contact Pad Width	X1			0.30
Contact Pad Length	Y1			0.85

Notes:

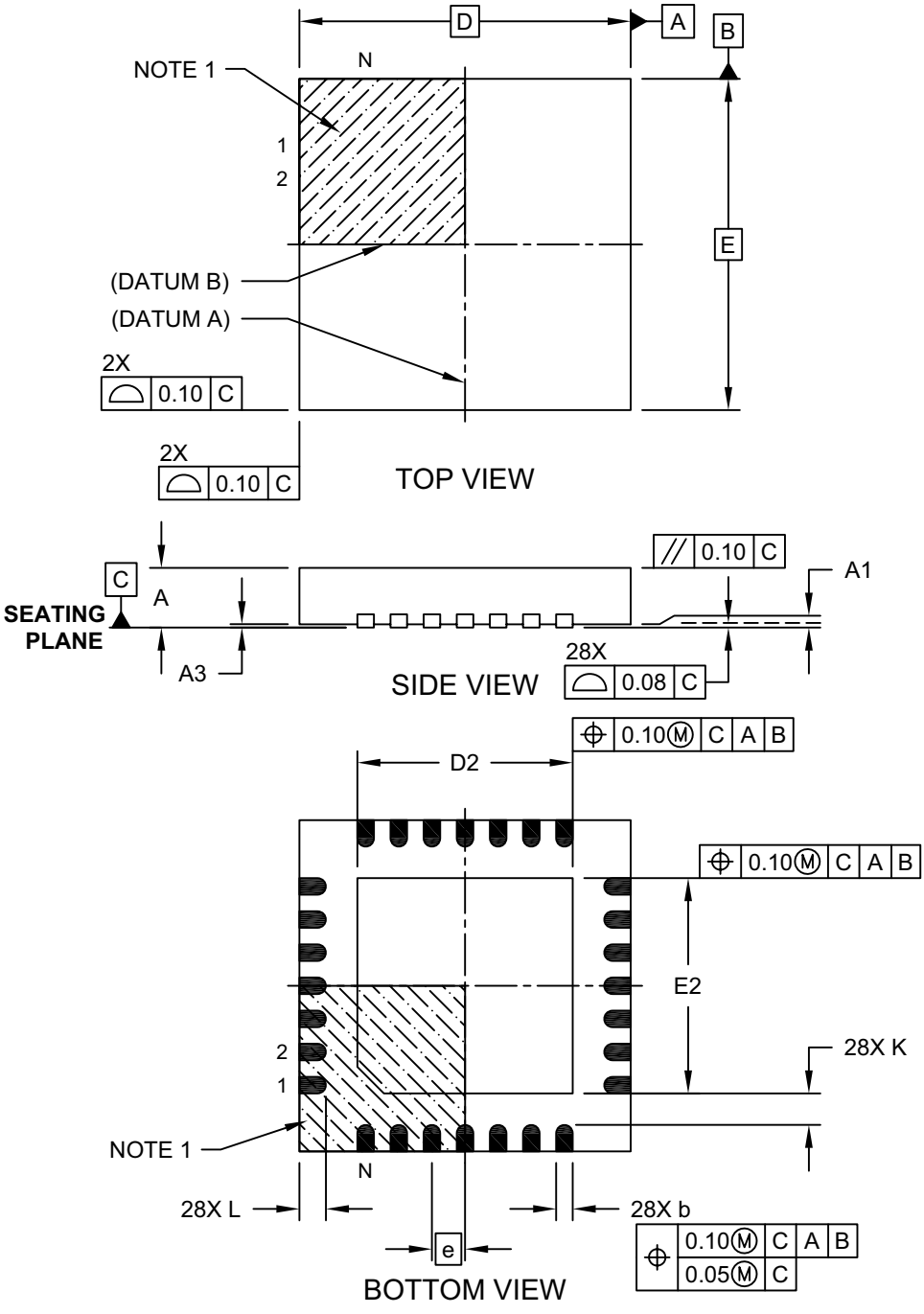
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2143B

28-Lead Plastic Quad Flat, No Lead Package (MQ) – 5x5x0.9 mm Body [QFN or VQFN]

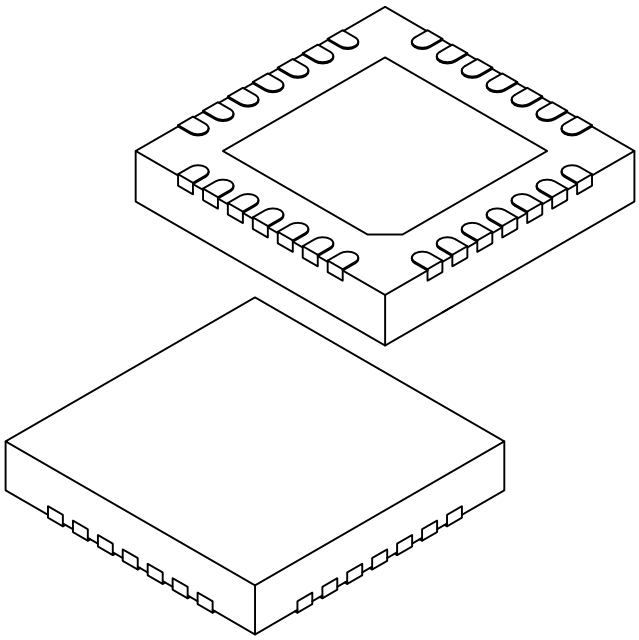
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-140C Sheet 1 of 2

28-Lead Plastic Quad Flat, No Lead Package (MQY) – 5x5x0.9 mm Body [QFN or VQFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		0.50 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Width	E		5.00 BSC	
Exposed Pad Width	E2	3.15	3.25	3.35
Overall Length	D		5.00 BSC	
Exposed Pad Length	D2	3.15	3.25	3.35
Contact Width	b	0.18	0.25	0.30
Contact Length	L	0.35	0.40	0.45
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

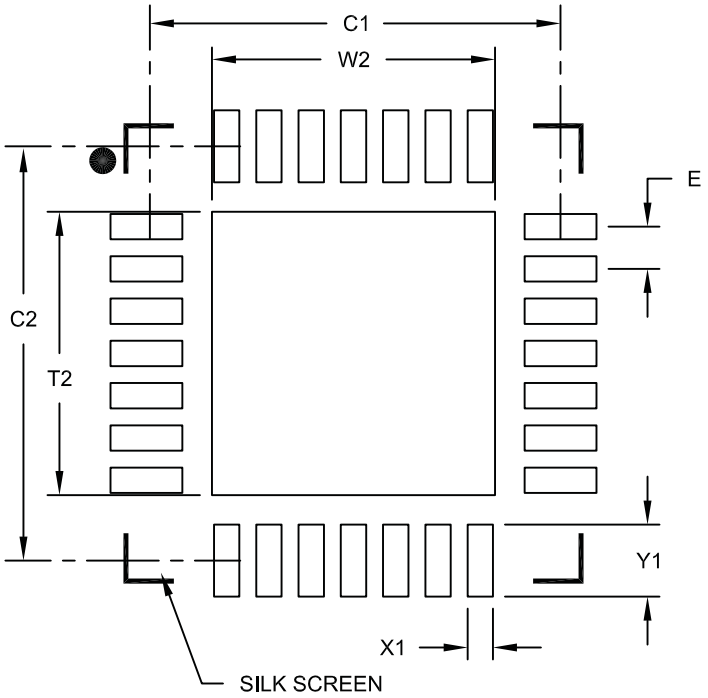
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-140C Sheet 2 of 2

28-Lead Plastic Quad Flat, No Lead Package (MQ) – 5x5 mm Body [QFN] Land Pattern With 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.50 BSC	
Optional Center Pad Width	W2			3.35
Optional Center Pad Length	T2			3.35
Contact Pad Spacing	C1		4.90	
Contact Pad Spacing	C2		4.90	
Contact Pad Width (X28)	X1			0.30
Contact Pad Length (X28)	Y1			0.85

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2140A

APPENDIX A: REVISION HISTORY

Revision A (October 2014)

- Original Release of this Document.

NOTES:

INDEX

S

T

U

V

W

THE MICROCHIP WEB SITE

Microchip provides online support via our web site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- **Product Support** – Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- **General Technical Support** – Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- **Business of Microchip** – Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com. Under "Support", click on "Customer Change Notification" and follow the registration instructions.

CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative or Field Application Engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://www.microchip.com/support

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	[X](1)	-	X	/XX
Device	Tape and Reel Option		Temperature Range	Package

Device:	MCP19118: Digitally Enhanced Power Analog Controller with Integrated Synchronous Driver MCP19119: Digitally Enhanced Power Analog Controller with Integrated Synchronous Driver
Tape and Reel Option:	Blank = Standard packaging (tube) T = Tape and Reel
Temperature Range:	E = -40°C to+125°C(Extended)
Package:	MJ = 24-lead Plastic Quad Flat, No Lead Package - 4x4x0.9 mm body (QFN) MQ = 28-lead Plastic Quad Flat, No Lead Package - 5x5x0.9 mm body (QFN)

Examples:

a) MCP19118-E/MJ: Extended temperature, 24LD QFN 4x4 package

b) MCP19118T-E/MJ: Tape and Reel, Extended temperature, 24LD QFN 4x4 package

a) MCP19119-E/MQ: Extended temperature, 28LD QFN 5x5 package

b) MCP19119T-E/MQ: Tape and Reel, Extended temperature, 28LD QFN 5x5 package

Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

NOTICE TO CUSTOMERS

This product is subject to a license from Power-One®, Inc. related to digital power technology (DPT) patents owned by Power-One, Inc. This license does not extend to stand-alone power supply products.

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Trademarks

ISBN: 978-1-63276-693-9

QUALITY MANAGEMENT SYSTEM
CERTIFIED BY DNV
ISO/TS 16949

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

Worldwide Sales and Service

AMERICAS

Corporate Office
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7200
Fax: 480-792-7277
Technical Support:
http://www.microchip.com/support
Web Address:
www.microchip.com

Atlanta
Duluth, GA
Tel: 678-957-9614
Fax: 678-957-1455

Austin, TX
Tel: 512-257-3370

Boston
Westborough, MA
Tel: 774-760-0087
Fax: 774-760-0088

Chicago
Itasca, IL
Tel: 630-285-0071
Fax: 630-285-0075

Cleveland
Independence, OH
Tel: 216-447-0464
Fax: 216-447-0643

Dallas
Addison, TX
Tel: 972-818-7423
Fax: 972-818-2924

Detroit
Novi, MI
Tel: 248-848-4000

Houston, TX
Tel: 281-894-5983

Indianapolis
Noblesville, IN
Tel: 317-773-8323
Fax: 317-773-5453

Los Angeles
Mission Viejo, CA
Tel: 949-462-9523
Fax: 949-462-9608

New York, NY
Tel: 631-435-6000

San Jose, CA
Tel: 408-735-9110

Canada - Toronto
Tel: 905-673-0699
Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office
Suites 3707-14, 37th Floor
Tower 6, The Gateway
Harbour City, Kowloon
Hong Kong
Tel: 852-2943-5100
Fax: 852-2401-3431

Australia - Sydney
Tel: 61-2-9868-6733
Fax: 61-2-9868-6755

China - Beijing
Tel: 86-10-8569-7000
Fax: 86-10-8528-2104

China - Chengdu
Tel: 86-28-8665-5511
Fax: 86-28-8665-7889

China - Chongqing
Tel: 86-23-8980-9588
Fax: 86-23-8980-9500

China - Hangzhou
Tel: 86-571-8792-8115
Fax: 86-571-8792-8116

China - Hong Kong SAR
Tel: 852-2943-5100
Fax: 852-2401-3431

China - Nanjing
Tel: 86-25-8473-2460
Fax: 86-25-8473-2470

China - Qingdao
Tel: 86-532-8502-7355
Fax: 86-532-8502-7205

China - Shanghai
Tel: 86-21-5407-5533
Fax: 86-21-5407-5066

China - Shenyang
Tel: 86-24-2334-2829
Fax: 86-24-2334-2393

China - Shenzhen
Tel: 86-755-8864-2200
Fax: 86-755-8203-1760

China - Wuhan
Tel: 86-27-5980-5300
Fax: 86-27-5980-5118

China - Xian
Tel: 86-29-8833-7252
Fax: 86-29-8833-7256

China - Xiamen
Tel: 86-592-2388138
Fax: 86-592-2388130

China - Zhuhai
Tel: 86-756-3210040
Fax: 86-756-3210049

ASIA/PACIFIC

India - Bangalore
Tel: 91-80-3090-4444
Fax: 91-80-3090-4123

India - New Delhi
Tel: 91-11-4160-8631
Fax: 91-11-4160-8632

India - Pune
Tel: 91-20-3019-1500

Japan - Osaka
Tel: 81-6-6152-7160
Fax: 81-6-6152-9310

Japan - Tokyo
Tel: 81-3-6880- 3770
Fax: 81-3-6880-3771

Korea - Daegu
Tel: 82-53-744-4301
Fax: 82-53-744-4302

Korea - Seoul
Tel: 82-2-554-7200
Fax: 82-2-558-5932 or
82-2-558-5934

Malaysia - Kuala Lumpur
Tel: 60-3-6201-9857
Fax: 60-3-6201-9859

Malaysia - Penang
Tel: 60-4-227-8870
Fax: 60-4-227-4068

Philippines - Manila
Tel: 63-2-634-9065
Fax: 63-2-634-9069

Singapore
Tel: 65-6334-8870
Fax: 65-6334-8850

Taiwan - Hsin Chu
Tel: 886-3-5778-366
Fax: 886-3-5770-955

Taiwan - Kaohsiung
Tel: 886-7-213-7830

Taiwan - Taipei
Tel: 886-2-2508-8600
Fax: 886-2-2508-0102

Thailand - Bangkok
Tel: 66-2-694-1351
Fax: 66-2-694-1350

EUROPE

Austria - Wels
Tel: 43-7242-2244-39
Fax: 43-7242-2244-393

Denmark - Copenhagen
Tel: 45-4450-2828
Fax: 45-4485-2829

France - Paris
Tel: 33-1-69-53-63-20
Fax: 33-1-69-30-90-79

Germany - Dusseldorf
Tel: 49-2129-3766400

Germany - Munich
Tel: 49-89-627-144-0
Fax: 49-89-627-144-44

Germany - Pforzheim
Tel: 49-7231-424750

Italy - Milan
Tel: 39-0331-742611
Fax: 39-0331-466781

Italy - Venice
Tel: 39-049-7625286

Netherlands - Drunen
Tel: 31-416-690399
Fax: 31-416-690340

Poland - Warsaw
Tel: 48-22-3325737

Spain - Madrid
Tel: 34-91-708-08-90
Fax: 34-91-708-08-91

Sweden - Stockholm
Tel: 46-8-5090-4654

UK - Wokingham
Tel: 44-118-921-5800
Fax: 44-118-921-5820

03/25/14